

# Smoke Detector Flash MCU with 12V Piezoelectric Horn Driver

**BA45F5360** 

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# **Table of Contents**

Features	7
CPU Features	
Peripheral Features	
Piezoelectric Horn Driver Feature	.8
General Description	8
Block Diagram	9
Pin Assignment1	0
Pin Description1	1
Absolute Maximum Ratings1	5
MCU Absolute Maximum Ratings1	
Piezoelectric Horn Driver Absolute Maximum Ratings1	5
D.C. Characteristics1	6
Operating Voltage Characteristics1	6
Operating Current Characteristics1	6
Standby Current Characteristics	7
A.C. Characteristics1	
High Speed Internal Oscillator – HIRC – Frequency Accuracy1	
Low Speed Internal Oscillator – LIRC	
Low Speed Crystal Oscillator Characteristics – LXT	
Operating Frequency Characteristic Curves	
Input/Output Characteristics	
Input/Output (with Multi-power) D.C. Characteristics	
Memory Characteristics2	
•	
LVD & LVR Electrical Characteristics	
A/D Converter Electrical Characteristics2	
Temperature Sensor Characteristics2	
Internal Reference Voltage Characteristics2	
Sink Current Generator Electrical Characteristics2	4
Operational Amplifier Electrical Characteristics2	6
Smoke Detector AFE	
Power Line Data Transceiver	27
D/A Converter (for Power Line Transceiver) Electrical Characteristics2	9
16-bit Vioce D/A Converter Electrical Characteristics2	9
Comparator (for Power Line Transceiver) Electrical Characteristics3	0
Piezoelectric Horn Driver Electrical Characteristics3	



32
32
33
33
34
34
34
35
35
36
37
38
38
54
54
55
55
55
57
57
57
59
59
59
59
60
60
62
62
62
63
64
64
64
64
66
66
66
67
68
68
69



Operating Modes and System Clocks	
System Clocks	
System Operation Modes	
Control Registers	
Operating Mode Switching Standby Current Considerations	
Wake-up	
·	
Watchdog Timer	
Watchdog Timer Clock Source	
Watchdog Timer Control Register	
Watchdog Timer Operation	
Reset and Initialisation	
Reset Functions	
Reset Initial Conditions	83
Input/Output Ports	
Pull-high Resistors	
Port A Wake-up	89
I/O Port Control Registers	89
I/O Port Power Source Control	
I/O Port Source Current Control	90
Pin-shared Functions	92
I/O Pin Structures	
Programming Considerations	97
Timer Modules - TM	98
Introduction	98
TM Operation	98
TM Clock Source	98
TM Interrupts	99
TM External Pins	
Programming Considerations	100
Standard Type TM – STM	101
Standard TM Operation	101
Standard Type TM Register Description	101
Standard Type TM Operation Modes	106
Periodic Type TM – PTM	116
Periodic TM Operation	
Periodic Type TM Register Description	117
Periodic Type TM Operating Modes	122
Smoke Detector AFE	136
Smoke Detector AFE Registers	
Operational Amplifier Operation	
Operational Amplifier Input Offset Calibration	



Power Line Tranasceiver – PLT	141
Power Line Transceiver Registers	141
Offset Calibration Procedure	146
Analog to Digital Converter	148
A/D Converter Overview	148
A/D Converter Register Description	149
A/D Converter Operation	153
A/D Converter Reference Voltage	154
A/D Converter Input Signals	154
Conversion Rate and Timing Diagram	155
Summary of A/D Conversion Steps	156
Programming Considerations	157
A/D Conversion Function	157
Temperature Measurement Function	157
A/D Conversion Programming Examples	158
Sink Current Generator	160
Sink Current Generator Registers	160
16-bit Voice D/A Converter	161
D/A Converter Registers	
Serial Interface Module – SIM	
SPI Interface	
I <sup>2</sup> C Interface	
UART Interface	
UART External Pins	
UART Single Wire Mode	
UART Data Transfer Scheme	
UART Status and Control Registers	
-	
Baud Rate Generator	
Baud Rate GeneratorUART Setup and Control	
UART Setup and Control	188
UART Setup and ControlUART Transmitter	188
UART Setup and Control UART Transmitter UART Receiver	188 189 191
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors	
UART Setup and Control UART Transmitter UART Receiver	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up.	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up  Piezoelectric Horn Driver	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up  Piezoelectric Horn Driver  External-driving(2-pin) Buzzer Driver Mode Settings	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up.  Piezoelectric Horn Driver  External-driving(2-pin) Buzzer Driver Mode Settings  Self-driving(3-pin) Buzzer Driver Mode Settings	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up  Piezoelectric Horn Driver  External-driving(2-pin) Buzzer Driver Mode Settings  Self-driving(3-pin) Buzzer Driver Mode Settings  Low Voltage Detector – LVD	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up  Piezoelectric Horn Driver  External-driving(2-pin) Buzzer Driver Mode Settings  Self-driving(3-pin) Buzzer Driver Mode Settings  Low Voltage Detector – LVD  LVD Register	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up  Piezoelectric Horn Driver  External-driving(2-pin) Buzzer Driver Mode Settings  Self-driving(3-pin) Buzzer Driver Mode Settings  Low Voltage Detector – LVD  LVD Register  LVD Operation	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up  Piezoelectric Horn Driver  External-driving(2-pin) Buzzer Driver Mode Settings  Self-driving(3-pin) Buzzer Driver Mode Settings  Low Voltage Detector – LVD  LVD Register  LVD Operation	
UART Setup and Control  UART Transmitter  UART Receiver  Managing Receiver Errors  UART Interrupt Structure  UART Power Down and Wake-up  Piezoelectric Horn Driver  External-driving(2-pin) Buzzer Driver Mode Settings  Self-driving(3-pin) Buzzer Driver Mode Settings  Low Voltage Detector – LVD  LVD Register  LVD Operation	



	External Interrupts	206
	PLT Comparator Interrupts	207
	A/D Converter Interrupt	207
	Time Base Interrupts	207
	Multi-function Interrupts	209
	SIM Interrupt	209
	UART Interrupts	209
	LVD Interrupt	209
	EEPROM Interrupt	210
	TM Interrupts	210
	Interrupt Wake-up Function	210
	Programming Considerations	211
C	onfiguration Options	211
Αı	pplication Circuits	212
•	External-driving (2-pin) Buzzer	
	Self-driving (3-pin) Buzzer	212
ln:	struction Set	213
	Introduction	
	Instruction Timing	213
	Moving and Transferring Data	213
	Arithmetic Operations	213
	Logical and Rotate Operation	214
	Branches and Control Transfer	214
	Bit Operations	214
	Table Read Operations	214
	Other Operations	214
ln:	struction Set Summary	215
	Table Conventions	
	Extended Instruction Set	217
ln:	struction Definition	219
	Extended Instruction Definition	
Pa	ackage Information	235
	28-pin SOP (300mil) Outline Dimensions	
	48-nin LOEP (7mmx7mm) Outline Dimensions	227



#### **Features**

#### **CPU Features**

- · Operating Voltage
  - $f_{SYS}=2MHz: 2.2V\sim5.5V$
  - $f_{SYS}$ =4MHz: 2.2V~5.5V
  - ◆ f<sub>SYS</sub>=8MHz: 2.2V~5.5V
  - $f_{SYS}=12MHz: 2.7V\sim5.5V$
  - f<sub>SYS</sub>=16MHz: 3.3V~5.5V
- Up to  $0.25\mu s$  instruction cycle with 16MHz system clock at  $V_{DD}=5V$
- · Power down and wake-up functions to reduce power consumption
- · Oscillator types
  - Internal High Speed 2/4/8MHz RC HIRC
  - Internal Low Speed 32kHz RC LIRC
  - External High Speed Crystal HXT
  - External Low Speed 32.768kHz Crystal LXT
- Multi-mode operation: FAST, SLOW, IDLE and SLEEP
- · Fully integrated internal oscillators require no external components
- All instructions executed in 1~3 instruction cycles
- · Table read instructions
- 115 powerful instructions
- 8-level subroutine nesting
- · Bit manipulation instruction

#### **Peripheral Features**

- Flash Program Memory: 16K×16
- RAM Data Memory: 2048×8
- True EEPROM Memory: 256×8
- · Watchdog Timer function
- In Application Programming IAP
- Up to 26 bidirectional I/O lines
- Two external interrupt lines shared with I/O pins
- Programmable I/O port source current for LED applications
- · Sink current generator for constant current output
- Smoke Detector AFE including two operational amplifiers
- Power Line Data Transceiver including two comparators, one Operational Amplifier and three D/A converters
- Multiple Timer Modules for time measure, input capture, compare match output, PWM output or single pulse output function
- Dual Time Base functions for generation of fixed time interrupt signals
- Serial Interface Module SIM, for SPI or I<sup>2</sup>C communication
- Dual Fully-duplex Universal Asynchronous Receiver and Transmitter Interfaces UART

Rev. 1.00 7 August 27, 2021



- 12 external channel 12-bit resolution A/D converter with Internal Reference Voltage V<sub>BGREF</sub>
- Temperature Sensor with internal reference voltage
- 16-bit Voice D/A converter
- Low Voltage Reset function
- · Low Voltage Detect function
- Package types: 28-pin SOP, 48-pin LQFP

#### Piezoelectric Horn Driver Feature

- Input voltage (BDV<sub>DD</sub>): 2.2V~5.5V
- Supports self-driving(3-pin) or external-driving(2-pin) buzzer
- Integrated 12V boost converter

## **General Description**

The BA45F5360 is a Flash Memory A/D type 8-bit high performance RISC architecture microcontroller, which includes a piezoelectric horn driver with boost converter, especially designed for smoke detector applications.

For memory features, the Flash Memory offers users the convenience of multi-programming features. Other memory includes an area of RAM Data Memory as well as an area of true EEPROM memory for storage of non-volatile data such as serial numbers, calibration data etc.

Analog features include a multi-channel Analog to Digital converter, an integrated temperature sensor circuitry, two comparators and three operational amplifiers and four D/A converters. With regard to internal timers, the device includes multiple and extremely flexible Timer Modules providing functions for timing, pulse generation and PWM output operations. Communication with the outside world is catered for by including fully integrated SPI, I<sup>2</sup>C and UART interface functions, three popular interfaces which provide designers with a means of easy communication with external peripheral hardware. Protective features such as an internal Watchdog Timer, Low Voltage Reset and Low Voltage Detector coupled with excellent noise immunity and ESD protection ensure that reliable operation is maintained in hostile electrical environments.

The device also includes fully integrated high and low speed oscillators which require no external components for their implementation. The ability to operate and switch dynamically between a range of operating modes using different clock sources gives users the ability to optimise microcontroller operation and minimise power consumption.

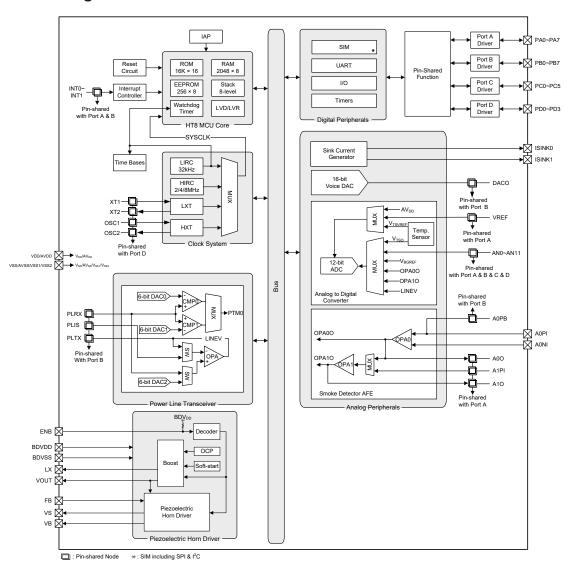
The device contains a piezoelectric horn driver with a 12V boost converter. The piezoelectric horn driver supports 2-pin or 3-pin buzzer.

This device contains a programmable I/O port source current function which is used to implement LED driving function. While the inclusion of flexible I/O programming features, Time Base functions, piezoelectric horn driver, Sink Current generator along with many other features ensure that the device will find excellent use in the smoke detector applications.

Rev. 1.00 8 August 27, 2021

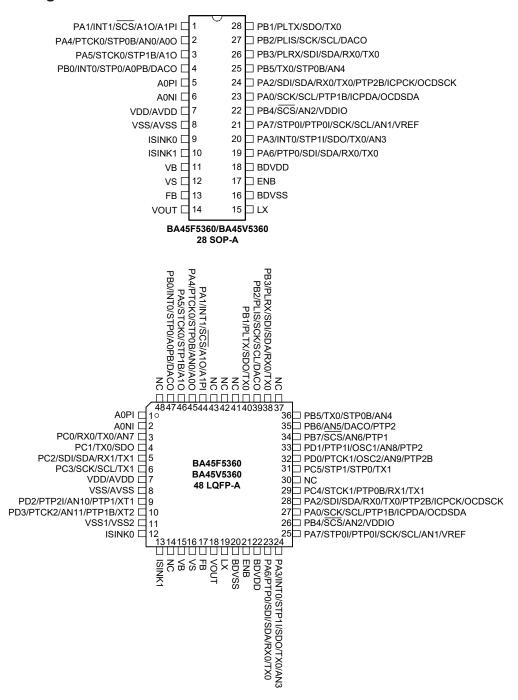


# **Block Diagram**





# **Pin Assignment**



Note: 1. If the pin-shared pin functions have multiple outputs, the desired pin-shared function is determined by the corresponding software control bits.

- 2. The OCDSDA and OCDSCK pins are supplied as OCDS dedicated pins and as such only available for the BA45V5360 device which is the OCDS EV chip for the BA45F5360 device.
- 3. For less pin-count package types there will be unbonded pins which should be properly configured to avoid unwanted current consumption resulting from floating input conditions. Refer to the "Standby Current Considerations" and "Input/Output Ports" sections.

Rev. 1.00 10 August 27, 2021



# **Pin Description**

The function of each pin is listed in the following table, however the details behind how each pin is configured is contained in other sections of the datasheet. As the Pin Description table shows the situation for the package type with the most pins, not all pins in the table will be available on smaller package sizes.

Pin Name	Function	OPT	I/T	O/T	Description
	PA0	PAPU PAWU PAS0	ST	CMOS	General purpose I/O. Register enabled pull-high and wake-up
PA0/SCK/SCL/	SCK	PAS0 IFS0	ST	CMOS	SPI serial clock
PTP1B/ICPDA/ OCDSDA	SCL	PAS0 IFS0	ST	NMOS	I <sup>2</sup> C clock line
	PTP1B	PAS0	_	CMOS	PTM1 inverting output
	ICPDA	_	ST	CMOS	ICP data/address
	OCDSDA	_	ST	CMOS	OCDS data/address, for EV chip only
	PA1	PAPU PAWU PAS0	ST	CMOS	General purpose I/O. Register enabled pull-high and wake-up
PA1/INT1/SCS/ A10/A1PI	INT1	PAS0 INTC0 INTEG	ST	_	External Interrupt 1
	SCS	PAS0 IFS0	ST	CMOS	SPI slave device select
	A10	PAS0	_	AN	Operational Amplifier 1 output
	A1PI	PAS0	AN	_	SD Operational Amplifier 1 positive input
	PA2	PAPU PAWU PAS0	ST	CMOS	General purpose I/O. Register enabled pull-high and wake-up
	SDI	PAS0 IFS0	ST	_	SPI serial data input
PA2/SDI/SDA/RX0/ TX0/PTP2B/ICPCK/	SDA	PAS0 IFS0	ST	NMOS	I <sup>2</sup> C data line
OCDSCK	RX0/TX0	PAS0 IFS1	ST	_	UART0 serial data input in full-duplex communication or UART0 serial data input/output in Single Wire Mode communication
	PTP2B	PAS0	_	CMOS	PTM2 inverting output
	ICPCK	_	ST	_	ICP clock pin
	OCDSCK	_	ST	_	OCDS clock pin, for EV chip only
	PA3	PAPU PAWU PAS0	ST	CMOS	General purpose I/O. Register enabled pull-high and wake-up
PA3/INT0/STP1I/ SDO/TX0/AN3	INT0	PAS0 INTC0 INTEG IFS1	ST	_	External Interrupt 0
	STP1I	PAS0	ST		STM1 capture input
	SDO	PAS0	_	CMOS	SPI serial data output
	TX0	PAS0		CMOS	UART0 serial data output
	AN3	PAS0	AN		A/D Converter anolog input channel 3

Rev. 1.00 11 August 27, 2021



Pin Name	Function	OPT	I/T	O/T	Description
	PA4	PAPU PAWU PAS1	ST	CMOS	General purpose I/O. Register enabled pull-high and wake-up
PA4/PTCK0/	PTCK0	PAS1	ST	_	PTM0 clock input or capture input
STP0B/AN0/A0O	STP0B	PAS1	_	CMOS	STM0 inverting output
	AN0	PAS1	AN	_	A/D Converter anolog input channel 0
	A0O	PAS1	_	AN	SD Operational Amplifier 0 output
PA5/STCK0/	PA5	PAPU PAWU PAS1	ST	CMOS	General purpose I/O. Register enabled pull-high and wake-up
STP1B/A1O	STCK0	PAS1	ST	_	STM0 clock input
	STP1B	PAS1	_	CMOS	STM1 inverting output
	A10	PAS1	_	AN	SD Operational Amplifier 1 output
	PA6	PAPU PAWU PAS1	ST	CMOS	General purpose I/O. Register enabled pull-high and wake-up
	PTP0	PAS1		CMOS	PTM0 output
PA6/PTP0/SDI/ SDA/RX0/TX0	SDI	PAS1 IFS0	ST	_	SPI serial data input
057,410.0717.0	SDA	PAS1 IFS0	ST	NMOS	I <sup>2</sup> C data line
	RX0/TX0	PAS1 IFS1	ST	_	UART0 serial data input in full-duplex communication or UART0 serial data input/output in Single Wire Mode communication
	PA7	PAPU PAWU PAS1	ST	CMOS	General purpose I/O. Register enabled pull-high and wake-up
	STP0I	PAS1	ST	_	STM0 capture input
PA7/STP0I/PTP0I/	PTP0I	PAS1 IFS0	ST	_	PTM0 capture Input
SCK/SCL/AN1/ VREF	SCK	PAS1 IFS0	ST	CMOS	SPI serial clock
	SCL	PAS1 IFS0	ST	NMOS	I <sup>2</sup> C clock line
	AN1	PAS1	AN	_	A/D Converter anolog input channel 1
	VREF	PAS1	AN	_	A/D Converter external reference voltage
	PB0	PBPU PBS0	ST	CMOS	General purpose I/O. Register enabled pull-high
PB0/INT0/STP0/ A0PB/DACO	INT0	PBS0 INTC0 INTEG IFS1	ST	_	External Interrupt 0
	STP0	PBS0	_	CMOS	STM0 output
	A0PB	PBS0	AN	_	SD Operational Amplifier 0 bias input
	DACO	PBS0	_	AN	16-bit D/A Converter output
	PB1	PBPU PBS0	ST	CMOS	General purpose I/O. Register enabled pull-high
PB1/PLTX/SDO/TX0	PLTX	PBS0	_	AN	Power Line TX
	SDO	PBS0	_	CMOS	SPI serial data output
	TX0	PBS0	_	CMOS	UART0 serial data output

Rev. 1.00 12 August 27, 2021



Pin Name	Function	ОРТ	I/T	O/T	Description
PB2/PLIS/SCK/ SCL/DACO	PB2	PBPU PBS0	ST	CMOS	General purpose I/O. Register enabled pull-high
	PLIS	PBS0	AN	_	Power Line IS input
	SCK	PBS0 IFS0	ST	CMOS	SPI serial clock
	SCL	PBS0 IFS0	ST	NMOS	I <sup>2</sup> C clock line
	DACO	PBS0	_	AN	16-bit D/A Converter output
	PB3	PBPU PBS0	ST	CMOS	General purpose I/O. Register enabled pull-high
	PLRX	PBS0	AN	_	Power Line RX
PB3/PLRX/SDI/	SDI	PBS0 IFS0	ST	_	SPI serial data input
SDA/RX0/TX0	SDA	PBS0 IFS0	ST	NMOS	I <sup>2</sup> C data line
	RX0/TX0	PBS0 IFS1	ST	_	UART0 serial data input in full-duplex communication or UART0 serial data input/output in Single Wire Mode communication
	PB4	PBPU PBS1	ST	смоѕ	General purpose I/O. Register enabled pull-high
PB4/SCS/AN2/	SCS	PBS1 IFS0	ST	CMOS	SPI slave device select
VDDIO	AN2	PBS1	AN	_	A/D Converter anolog input channel 2
	VDDIO	PBS1 PMPS0 PMPS1	PWR	_	Power for PA0, PA2, PA3, PA6, PA7, PC4, PC5
	PB5	PBPU PBS1	ST	CMOS	General purpose I/O. Register enabled pull-high
PB5/TX0/STP0B/ AN4	TX0	PBS1	_	CMOS	UART0 serial data output
	STP0B	PBS1	_	CMOS	STM0 signal inverting output
	AN4	PBS1	AN	_	A/D Converter anolog input channel 4
DDC/ANE/DACO/	PB6	PBPU PBS1	ST	CMOS	General purpose I/O. Register enabled pull-high
PB6/AN5/DACO/ PTP2	AN5	PBS1	AN	_	A/D Converter anolog input channel 5
2	DACO	PBS1	_	AN	16-bit D/A Converter output
	PTP2	PBS1	_	CMOS	PTM2 output
	PB7	PBPU PBS1	ST	CMOS	General purpose I/O. Register enabled pull-high
PB7/SCS/AN6/PTP1	SCS	PBS1 IFS0	ST	CMOS	SPI slave device select
	AN6	PBS1	AN	_	A/D Converter anolog input channel 6
	PTP1	PBS1	_	CMOS	PTM1 output
	PC0	PCPU PCS0	ST	смоѕ	General purpose I/O. Register enabled pull-high
PC0/RX0/TX0/AN7	RX0/TX0	PCS0 IFS1	ST	_	UART0 serial data input in full-duplex communication or UART0 serial data input/output in Single Wire Mode communication
	AN7	PCS0	AN	_	A/D Converter anolog input channel 7
DO4/TV0/CD 0	PC1	PCPU PCS0	ST	CMOS	General purpose I/O. Register enabled pull-high
PC1/TX0/SDO	TX0	PCS0	_	CMOS	UART0 serial data output
	SDO	PCS0	_	CMOS	SPI serial data output



Pin Name	Function	ОРТ	I/T	O/T	Description
	PC2	PCPU	ST	CMOS	General purpose I/O. Register enabled pull-high
PC2/SDI/SDA/	1 02	PCS0	01	CIVIOS	General purpose I/O. Register enabled pull-riigh
	SDI	PCS0 IFS0	ST	_	SPI serial data input
RX1/TX1	SDA	PCS0 IFS0	ST	NMOS	I <sup>2</sup> C data line
	RX1/TX1	PCS0 IFS1	ST	_	UART1 serial data input in full-duplex communication or UART1 serial data input/output in Single Wire Mode communication
	PC3	PCPU PCS0	ST	CMOS	General purpose I/O. Register enabled pull-high
PC3/SCK/SCL/TX1	SCK	PCS0 IFS0	ST	CMOS	SPI serial clock
	SCL	PCS0 IFS0	ST	NMOS	I <sup>2</sup> C clock line
	TX1	PCS0	_	CMOS	UART1 serial data output
	PC4	PCPU PCS1	ST	CMOS	General purpose I/O. Register enabled pull-high
PC4/STCK1/	STCK1	PCS1	ST	_	STM1 clock input
PTP0B/RX1/TX1	PTP0B	PCS1	_	CMOS	PTM0 inverting output
	RX1/TX1	PCS1 IFS1	ST	_	UART1 serial data input in full-duplex communication or UART1 serial data input/output in Single Wire Mode communication
	PC5	PCPU PCS1	ST	CMOS	General purpose I/O. Register enabled pull-high
PC5/STP1/ STP0/TX1	STP1	PCS1	_	CMOS	STM1 output
51P0/1X1	STP0	PCS1	_	CMOS	STM0 output
	TX1	PCS1	_	CMOS	UART1 serial data output
	PD0	PDPU PDS0	ST	CMOS	General purpose I/O. Register enabled pull-high
PD0/PTCK1/OSC2/	PTCK1	PDS0	ST	_	PTM1 clock input
AN9/PTP2B	OSC2	PDS0	_	HXT	HXT oscillator pin
	AN9	PDS0	AN	_	A/D Converter anolog input channel 9
	PTP2B	PDS0	_	CMOS	PTM2 inverting output
	PD1	PDPU PDS0	ST	CMOS	General purpose I/O. Register enabled pull-high
PD1/PTP1I/OSC1/	PTP1I	PDS0	ST	_	PTM1 capture input
AN8/PTP2	OSC1	PDS0	HXT	_	HXT oscillator pin
	AN8	PDS0	AN	_	A/D Converter anolog input channel 8
	PTP2	PDS0	_	CMOS	PTM2 output
	PD2	PDPU PDS0	ST	CMOS	General purpose I/O. Register enabled pull-high
PD2/PTP2I/AN10/	PTP2I	PDS0	ST		PTM2 capture input
PTP1/XT1	AN10	PDS0	AN	_	A/D Converter anolog input channel 10
	PTP1	PDS0	_	CMOS	PTM1 output
	XT1	PDS0	LXT	-	LXT oscillator pin
	PD3	PDPU PDS0	ST	CMOS	General purpose I/O. Register enabled pull-high
PD3/PTCK2/AN11/	PTCK2	PDS0	ST		PTM2 clock input
PTP1B/XT2	AN11	PDS0	AN		A/D Converter anolog input channel 11
	PTP1B	PDS0	_	CMOS	PTM1 inverting output
	XT2	PDS0	_	LXT	LXT oscillator pin
ISINK0	ISINK0	_	_	AN	Sink current 0 source
ISINK1	ISINK1	_	_	AN	Sink current 1 source

Rev. 1.00 14 August 27, 2021



Pin Name	Function	ОРТ	I/T	O/T	Description
A0NI	A0NI	_	AN	_	Operational Amplifier 0 negative input
A0PI	A0PI	_	AN	_	Operational Amplifier 0 positive input
VDD/AVDD	VDD	_	PWR	_	Digital positive power supply
VDD/AVDD	AVDD	_	PWR	_	A/D Converter positive power supply
	VSS	_	PWR	_	Digital negative power supply
VSS/AVSS/	AVSS	_	PWR	_	A/D Converter negative power supply
VSS1/VSS2	VSS1	_	PWR	_	Sink Current Generator negative power supply
	VSS2	_	PWR	_	Sink Current Generator negative power supply
BDVDD	BDVDD	_	PWR	_	Piezoelectric horn driver positive power supply
BDVSS	BDVSS	_	PWR	_	Piezoelectric horn driver negative power supply, ground
VOUT	VOUT	_	_	PWR	Boost converter output
LX	LX	_	_	PWR	Power switch output
ENB	ENB	_	ST	_	Enable pin with pull-high resister, used to control boost converter and buzzer driver mode
FB	FB	_	ST	_	Feedback pin for self-driving(3-pin) buzzer driver
VS	VS	_	_	CMOS	Output for buzzer driver
VB	VB	_	_	CMOS	Complementary output for buzzer driver

Legend: I/T: Input type; O/T: Output type;
OPT: Optional by register option; PWR: Power;

ST: Schmitt Trigger input; CMOS: CMOS output; NMOS: NMOS output; AN: Analog signal;

LXT: Low frequency crystal oscillator; HXT: High frequency crystal oscillator.

# **Absolute Maximum Ratings**

## **MCU Absolute Maximum Ratings**

Supply Voltage	V <sub>SS</sub> -0.3V to 6.0V
Input Voltage	$V_{SS}$ -0.3V to $V_{DD}$ +0.3V
Storage Temperature	-50°C to 125°C
Operating Temperature	-40°C to 85°C
I <sub>OL</sub> Total	80mA
I <sub>OH</sub> Total	-80mA
Total Power Dissipation	500mW

#### Piezoelectric Horn Driver Absolute Maximum Ratings

Output V	oltage
$I_{\text{OL}}$ Total	200mA
Iон Total	-200mA

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of the device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect devices reliability.



# **D.C. Characteristics**

For data in the following tables, note that factors such as oscillator type, operating voltage, operating frequency, pin load conditions, temperature and program instruction type, etc., can all exert an influence on the measured values.

# **Operating Voltage Characteristics**

Ta=-40°C~85°C

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
		f <sub>SYS</sub> =f <sub>HIRC</sub> =2MHz	2.2	_	5.5	
	Operating Voltage – HIRC	f <sub>SYS</sub> =f <sub>HIRC</sub> =4MHz	2.2	_	5.5	V
		f <sub>SYS</sub> =f <sub>HIRC</sub> =8MHz	2.2	_	5.5	
V <sub>DD</sub>		f <sub>SYS</sub> =4MHz	2.2	_	5.5	
	Operating Voltage LIVT	f <sub>SYS</sub> =8MHz	2.2	_	5.5	V
	Operating Voltage – HXT	f <sub>SYS</sub> =12MHz	2.7	_	5.5	V
		f <sub>SYS</sub> =16MHz	3.3	_	5.5	
.,	Operating Voltage – LIRC	f <sub>SYS</sub> =f <sub>LIRC</sub> =32kHz	2.2	_	5.5	V
$V_{DD}$	Operating Voltage – LXT	f <sub>SYS</sub> =32768Hz	2.2	_	5.5	V

## **Operating Current Characteristics**

Ta=-40°C~85°C

Complete L	On another Marks		Test Conditions	Min	T	Mari	11:4
Symbol	Operating Mode	V <sub>DD</sub>	Conditions	Min.	Тур.	Max.	Unit
		2.2V		_	3	24	
	SLOW Mode (LIRC)	3V	f <sub>SYS</sub> =32kHz	_	4	30	μΑ
		5V		_	14	40	
		2.2V		_	3.5	24.5	
	SLOW Mode (LXT)	3V	f <sub>SYS</sub> =32768Hz	_	5	31	μΑ
		5V		_	16	42	
		2.2V		_	150	200	
		3V	f <sub>SYS</sub> =2MHz	_	200	300	
		5V		_	400	600	
	FAST Mode (HIRC)	2.2V		_	200	500	
		3V	f <sub>SYS</sub> =4MHz	_	250	800	μΑ
		5V		_	500	1300	
		2.2V	f <sub>SYS</sub> =8MHz	_	320	700	
I <sub>DD</sub>		3V		_	500	1000	
		5V		_	1000	1600	
		2.2V		_	200	500	
		3V	f <sub>SYS</sub> =4MHz	_	250	800	
		5V		_	500	1300	
		2.2V		_	320	700	μΑ
		3V	f <sub>SYS</sub> =8MHz	_	500	1000	
	FAST Mode (HXT)	5V		_	1000	1600	
	,	2.7V		_	0.7	1.2	
		3V	f <sub>SYS</sub> =12MHz	_	0.75	1.60	
		5V		_	1.5	2.4	mA
		3.3V	f =1CMU=	_	1.5	3.0	
		5V	f <sub>sys</sub> =16MHz	_	2.5	5.0	

Rev. 1.00 16 August 27, 2021



Note: When using the characteristic table data, the following notes should be taken into consideration:

- 1. Any digital inputs are setup in a non-floating condition.
- 2. All measurements are taken under conditions of no load and with all peripherals in an off state.
- 3. There are no DC current paths.
- 4. All Operating Current values are measured using a continuous NOP instruction program loop.

#### **Standby Current Characteristics**

Ta=-40°C~85°C, unless otherwise specified

0	Ota a dia Manda		Test Conditions	841	-	NA -	Max.	11.24
Symbol	Standby Mode	<b>V</b> <sub>DD</sub>	Conditions	Min.	Тур.	Max.	@85°C	Unit
		2.2V		_	1.2	2.4	3.0	
	SLEEP Mode	3V	WDT on	_	1.5	3.0	3.7	μΑ
		5V		_	3	5	6	
		2.2V		_	2.4	4.0	4.6	
	IDLE0 Mode (LIRC)	3V	f <sub>SUB</sub> on	_	3.0	5.0	5.7	μA
		5V		_	5	10	11	
		2.2V		_	2.4	4.0	4.6	
	IDLE0 Mode (LXT)	3V	f <sub>SUB</sub> on	_	3.0	5.0	5.7	μΑ
		5V		_	5	10	11	
		2.2V	<u> </u>		60	120	140	
		3V	f <sub>SUB</sub> on, f <sub>SYS</sub> =2MHz	_	70	140	160	μА
		5V		_	130	260	280	
	IDLE1 Mode (HIRC)	2.2V		_	144	200	240	
		3V	f <sub>SUB</sub> on, f <sub>SYS</sub> =4MHz	_	180	250	300	μΑ
I <sub>STB</sub>		5V		_	400	600	720	
		2.2V		_	288	400	480	μА
		3V	f <sub>SUB</sub> on, f <sub>SYS</sub> =8MHz	_	360	500	600	
		5V		_	600	800	960	
		2.2V		_	144	200	240	
		3V	f <sub>SUB</sub> on, f <sub>SYS</sub> =4MHz	_	180	250	300	μΑ
		5V		_	400	600	720	
		2.2V		_	288	400	480	
		3V	f <sub>SUB</sub> on, f <sub>SYS</sub> =8MHz	_	360	500	600	μΑ
	IDLE1 Mode (HXT)	5V		_	600	800	960	
		2.7V		_	432	600	720	
		3V	f <sub>SUB</sub> on, f <sub>SYS</sub> =12MHz	_	540	750	900	μΑ
		5V		_	800	1200	1440	
		3.3V	f <sub>SUB</sub> on, f <sub>SYS</sub> =16MHz	_	1.1	1.6	1.9	mA
		5V	ISUB OIT, ISYS-TOWINZ	-	1.4	2.0	2.4	ША

Note: When using the characteristic table data, the following notes should be taken into consideration:

- 1. Any digital inputs are setup in a non-floating condition.
- 2. All measurements are taken under conditions of no load and with all peripherals in an off state.
- 3. There are no DC current paths.
- 4. All Standby Current values are taken after a HALT instruction execution thus stopping all instruction execution.

Rev. 1.00 17 August 27, 2021



## A.C. Characteristics

For data in the following tables, note that factors such as oscillator type, operating voltage, operating frequency and temperature etc., can all exert an influence on the measured values.

#### High Speed Internal Oscillator - HIRC - Frequency Accuracy

During the program writing operation the writer will trim the HIRC oscillator at a user selected HIRC frequency and user selected voltage of either 3V or 5V.

Comple al	Parameter	Test	Conditions	Min.	Tress	Max.	Unit
Symbol	Parameter	V <sub>DD</sub>	Temp.	IVIIII.	Тур.	wax.	Unit
	2MHz Writer Trimmed HIRC Frequency	3V/5V	25°C	-1%	2	+1%	
		30/30	-20°C~60°C	-2%	2	+2%	MHz
		2.2V~5.5V	25°C	-6%	2	+9%	IVITZ
_		2.20~5.50	-40°C~85°C	-6%	2	+10%	1
		3V/5V	25°C	-1%	4	+1%	
f <sub>HIRC</sub>	4MHz Writer Trimmed HIRC Frequency	2 2)/, E 5)/	25°C	-2.5%	4	+2.5%	MHz
		2.2V~5.5V	-40°C~85°C	-3%	4	+3%	
		3V/5V	25°C	-1%	8	+1%	
	OMILIE With a Tripers of LUDG Francisco	30/30	-10°C~70°C	-2.5%	8	+2.5%	MHz
	8MHz Writer Trimmed HIRC Frequency	2.2V~5.5V	25°C	-10%	8	+3%	
		2.20~3.50	-40°C~85°C	-15%	8	+5%	

Note: 1. The 3V/5V values for  $V_{DD}$  are provided as these are the two selectable fixed voltages at which the HIRC frequency is trimmed by the writer.

- 2. The row below the 3V/5V trim voltage row is provided to show the values for the full  $V_{DD}$  range operating voltage. It is recommended that the trim voltage is fixed at 3V for application voltage ranges from 2.2V to 3.6V and fixed at 5V for application voltage ranges from 3.3V to 5.5V.
- 3. The minimum and maximum tolerance values provided in the table are only for the frequency at which the writer trims the HIRC oscillator. After trimming at this chosen specific frequency any change in HIRC oscillator frequency using the oscillator register control bits by the application program will give a frequency tolerance to within ±20%.

## Low Speed Internal Oscillator - LIRC

Symbol	Doromotor	Tes	Min.	Typ.	Max.	Unit	
Symbol	Parameter V <sub>DD</sub>	Temp.	IVIIII.	тур.	Wax.	Onit	
f <sub>LIRC</sub>	LIRC Frequency	2.2V~5.5V	-40°C~85°C	-7%	32	+7%	kHz
tstart	LIRC Start-up Time	_	-40°C~85°C	_	_	100	μs

#### Low Speed Crystal Oscillator Characteristics - LXT

Ta=25°C

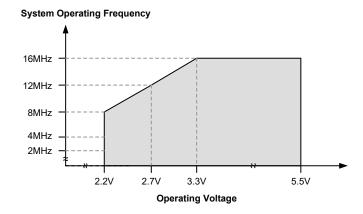
Symbol	Parameter	Test	Conditions	Min.	Тур.	Max.	Unit
Symbol	Parameter	<b>V</b> <sub>DD</sub>	Conditions	IVIIII.	тур.	IVIAX.	Unit
f <sub>LXT</sub>	LXT Frequency	2.2V~5.5V	_	_	32768	_	Hz
	LXT Start Up Time	3V	_	_	_	1000	mo
t <sub>START</sub>	LAT Start Op Time	5V	_	_	_	1000	ms
Duty Cycle	Duty Cycle	_	_	40	_	60	%
R <sub>NEG</sub>	Negative Resistance	2.2V	_	3×ESR	_	_	Ω

Note: C1, C2 and  $R_P$  are external components, C1=C2=10pF,  $R_P$ =10M $\Omega$ , C<sub>L</sub>=7pF, ESR=30k $\Omega$ .

Rev. 1.00 18 August 27, 2021



## **Operating Frequency Characteristic Curves**



#### **System Start Up Time Characteristics**

Ta=-40°C~85°C

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
		f <sub>SYS</sub> =f <sub>H</sub> ~f <sub>H</sub> /64, f <sub>H</sub> =f <sub>HXT</sub>	_	128	_	t <sub>HXT</sub>
	System Start-up Time	f <sub>SYS</sub> =f <sub>H</sub> ~f <sub>H</sub> /64, f <sub>H</sub> =f <sub>HIRC</sub>	_	16	_	t <sub>HIRC</sub>
	Wake-up from Condition where f <sub>SYS</sub> is off	f <sub>SYS</sub> =f <sub>SUB</sub> =f <sub>LXT</sub>	_	1024	_	t <sub>LXT</sub>
		f <sub>SYS</sub> =f <sub>SUB</sub> =f <sub>LIRC</sub>	_	2	_	t <sub>LIRC</sub>
t <sub>SST</sub>	System Start-up Time	f <sub>SYS</sub> =f <sub>H</sub> ~f <sub>H</sub> /64, f <sub>H</sub> =f <sub>HXT</sub> or f <sub>HIRC</sub>	_	2	_	t <sub>H</sub>
	Wake-up from Condition where f <sub>SYS</sub> is on	f <sub>SYS</sub> =f <sub>SUB</sub> =f <sub>LXT</sub> or f <sub>LIRC</sub>	_	2	_	t <sub>SUB</sub>
	System Speed Switch Time	$f_{\text{HXT}}$ switches from off $\rightarrow$ on	_	1024	_	t <sub>HXT</sub>
	FAST to SLOW Mode or	$f_{\text{HIRC}}  \text{switches from off} \to \text{on}$	_	16	_	t <sub>HIRC</sub>
	SLOW to FAST Mode	$f_{LXT}$ switches from off $\rightarrow$ on	_	1024	_	t <sub>LXT</sub>
	System Reset Delay Time Reset source from Power-on reset or LVR Hardware Reset	RR <sub>POR</sub> =5V/ms	42	48	54	
t <sub>RSTD</sub>	System Reset Delay Time WDTC Register Software Reset	_				ms
S S	System Reset Delay Time WDT Overflow Reset	_	14	16	18	
t <sub>SRESET</sub>	Minimum Software Reset Width to Reset	_	45	90	120	μs

- Note: 1. For the System Start-up time values, whether  $f_{SYS}$  is on or off depends upon the mode type and the chosen  $f_{SYS}$  system oscillator. Details are provided in the System Operating Modes section.
  - 2. The time units, shown by the symbols  $t_{HIRC}$  etc. are the inverse of the corresponding frequency values as provided in the frequency tables. For example  $t_{HIRC} = 1/f_{HIRC}$ ,  $t_{SYS} = 1/f_{SYS}$  etc.
  - 3. If the LIRC is used as the system clock and if it is off when in the SLEEP Mode, then an additional LIRC start up time, t<sub>START</sub>, as provided in the LIRC frequency table, must be added to the t<sub>SST</sub> time in the table above.
  - 4. The System Speed Switch Time is effectively the time taken for the newly activated oscillator to start up.

Rev. 1.00 19 August 27, 2021



# Input/Output Characteristics

Ta=-40°C~85°C

#### Input/Output (without Multi-power) D.C. Characteristics

Symbol	Parameter		Test Conditions	Min.	Time	Max.	Unit
Symbol	Parameter	V <sub>DD</sub>	Conditions	IVIIII.	Тур.	wax.	Unit
.,	Input I aw Valtage for I/O Dorte	5V		0	_	1.5	V
V <sub>IL</sub>	Input Low Voltage for I/O Ports	_	_	0	_	0.2V <sub>DD</sub>	V
.,	Innut High Voltage for I/O Dorte	5V		3.5	_	5.0	V
V <sub>IH</sub>	Input High Voltage for I/O Ports	_	_	$0.8V_{\text{DD}}$	_	V <sub>DD</sub>	V
	Sink Current for I/O Ports	3V	Voi =0.1Vpp	16	32	_	m Λ
I <sub>OL</sub>	Sink Current for I/O Ports	5V	VoL=U.TVDD	32	65	_	mA
		3V	V <sub>OH</sub> =0.9V <sub>DD</sub> , SLEDCn[m+1:m]=00	-0.7	-1.5	_	
		5V	(n=0, 1, m=0, 2, 4, 6)	-1.5	-2.9	_	
		3V	V <sub>OH</sub> =0.9V <sub>DD</sub> , SLEDCn[m+1:m]=01	-1.3	-2.5	_	mA
	Source Current for I/O Ports	5V	(n=0, 1, m=0, 2, 4, 6)	-2.5	-5.1	_	
I <sub>OH</sub>	Source current for 1/O 1 orts	3V	V <sub>OH</sub> =0.9V <sub>DD</sub> , SLEDCn[m+1:m]=10	-1.8	-3.6	_	ША
		5V	(n=0, 1, m=0, 2, 4, 6)	-3.6	-7.3	_	
		3V	V <sub>OH</sub> =0.9V <sub>DD</sub> ,	-4	-8	_	
		5V	SLEDCn[m+1:m]=11 (n=0, 1, m=0, 2, 4, 6)	-8	-16	_	
_	Dull binb Desistance for I/O Desta (Note)	3V		20	60	100	kΩ
R <sub>PH</sub>	Pull-high Resistance for I/O Ports (Note)	5V	_	10	30	50	K(2
I <sub>LEAK</sub>	Input Leakage Current	5V	V <sub>IN</sub> =V <sub>DD</sub> or V <sub>IN</sub> =V <sub>SS</sub>	_	_	±1	μΑ
t <sub>TPI</sub>	TM Capture Input Pin Minimum Pulse Width	_	_	0.3	_	_	μs
t <sub>TCK</sub>	TM Clock Input Pin Minimum Pulse Width	_	_	0.3	_		μs
t <sub>INT</sub>	Interrupt Pin Minimum Pulse Width	_	_	10	_	_	μs
f <sub>TMCLK</sub>	PTM0 Maximum Timer Clock Source Frequency	5V	_	_	_	1	f <sub>SYS</sub>
t <sub>CPW</sub>	PTM0 Minimum Capture Pulse Width	_	_	2	_	_	t <sub>TMCLK</sub>

Note: 1. The  $R_{PH}$  internal pull-high resistance value is calculated by connecting to ground and enabling the input pin with a pull-high resistor and then measuring the pin current at the specified supply voltage level. Dividing the voltage by this measured current provides the  $R_{PH}$  value.

- 2.  $t_{TMCLK}=1/f_{TMCLK}$ .
- $3. \ If \ PTCAPTS=1, \ then \ t_{CPW}=max(2\times t_{TMCLK}, \ t_{TPI,min}); \ if \ PTCAPTS=1, \ then \ t_{CPW}=max(2\times t_{TMCLK}, \ t_{TCK,min}).$

## Input/Output (with Multi-power) D.C. Characteristics

Cumb al	Parameter		Test Conditions	Min.	Trees	Max.	Unit
Symbol	Parameter	<b>V</b> <sub>DD</sub>	Conditions	WIII.	Тур.	wax.	Unit
V <sub>DD</sub>	V <sub>DD</sub> Power Supply for PA0, PA2, PA3, PA6, PA7, PC4, PC5 Pins	_	_	2.2	5.0	5.5	٧
V <sub>DDIO</sub>	V <sub>DDIO</sub> Power Supply for PA0, PA2, PA3, PA6, PA7, PC4, PC5 Pins	_	_	1.8	_	V <sub>DD</sub>	٧
VIL	Input Low Voltage for PA0, PA2, PA3, PA6, PA7, PC4,	5V	$\begin{array}{c} \text{Pin power=V}_{\text{DD}} \text{ or V}_{\text{DDIO}} \\ \text{V}_{\text{DDIO}}\text{=V}_{\text{DD}} \end{array}$	0	_	1.5	V
VIL	PC5 Pins		Pin power=V <sub>DD</sub> or V <sub>DDIO</sub>	0	_	0.2 (V <sub>DD</sub> /V <sub>DDIO</sub> )	V

Rev. 1.00 20 August 27, 2021



0	D		Test Conditions	241			11.26
Symbol	Parameter	V <sub>DD</sub>	Conditions	Min.	Тур.	Max.	Unit
VIH	Input High Voltage for PA0,	5V	Pin power=V <sub>DD</sub> or V <sub>DDIO</sub> V <sub>DDIO</sub> =V <sub>DD</sub>	3.5	_	5.0	V
VIH	PA2, PA3, PA6, PA7, PC4, PC5 Pins	_	Pin power=V <sub>DD</sub> or V <sub>DDIO</sub>	0.8 (V <sub>DD</sub> /V <sub>DDIO</sub> )	_	V <sub>DD</sub> /V <sub>DDIO</sub>	V
		3V	V <sub>OL</sub> =0.1(V <sub>DD</sub> /V <sub>DDIO</sub> )	16	32	_	mA
I <sub>OL</sub>	Sink Current for PA0, PA2, PA3, PA6, PA7, PC4, PC5	5V	V <sub>DDIO</sub> =V <sub>DD</sub>	32	65	_	mA
	Pins	5V	V <sub>OL</sub> =0.1V <sub>DDIO</sub> V <sub>DDIO</sub> =3V	20	40	_	mA
		3V	V <sub>OH</sub> =0.9 (V <sub>DD</sub> /V <sub>DDIO</sub> ),	-0.7	-1.5	_	mA
		5V	-SLEDCn[m+1:m]=00 (n=0, 1, m=0 or 2 or 4 or 6) V <sub>DDIO</sub> =V <sub>DD</sub>	-1.5	-2.9	_	mA
		5V	V <sub>OH</sub> =0.9 (V <sub>DD</sub> /V <sub>DDIO</sub> ), SLEDCn[m+1:m]=00 (n=0, 1, m=0 or 2 or 4 or 6) V <sub>DDIO</sub> =3V	-0.40	-0.85	_	mA
		3V	V <sub>OH</sub> =0.9 (V <sub>DD</sub> /V <sub>DDIO</sub> ), SLEDCn[m+1:m]=01	-1.3	-2.5	_	mA
	Source Current for PA0, PA2,	5V	(n=0, 1, m=0 or 2 or 4 or 6) V <sub>DDIO</sub> =V <sub>DD</sub>	-2.5	-5.1	_	mA
		5V	V <sub>OH</sub> =0.9 (V <sub>DD</sub> /V <sub>DDIO</sub> ), SLEDCn[m+1:m]=01 (n=0, 1, m=0 or 2 or 4 or 6) V <sub>DDIO</sub> =3V	-0.70	-1.35	_	mA
I <sub>OH</sub>	PA3, PA6, PA7, PC4, PC5 Pins	3V	V <sub>OH</sub> =0.9 (V <sub>DD</sub> /V <sub>DDIO</sub> ), SLEDCn[m+1:m]=10	-1.8	-3.6	_	mA
		5V	(n=0, 1, m=0 or 2 or 4 or 6) V <sub>DDIO</sub> =V <sub>DD</sub>	-3.6	-7.3	_	mA
		5V	V <sub>OH</sub> =0.9 (V <sub>DD</sub> /V <sub>DDIO</sub> ), SLEDCn[m+1:m]=10 (n=0, 1, m=0 or 2 or 4 or 6) V <sub>DDIO</sub> =3V	-0.95	-1.90	_	mA
		3V	V <sub>OH</sub> =0.9 (V <sub>DD</sub> /V <sub>DDIO</sub> ),	-4	-8	_	mA
		5V	SLEDCn[m+1:m]=11 (n=0, 1, m=0 or 2 or 4 or 6) V <sub>DDIO</sub> =V <sub>DD</sub>	-8	-16	_	mA
		5V	V <sub>OH</sub> =0.9 (V <sub>DD</sub> /V <sub>DDIO</sub> ), SLEDCn[m+1:m]=11 (n=0, 1, m=0 or 2 or 4 or 6) V <sub>DDIO</sub> =3V	-2.5	-5.0	_	mA
	Dull high Posistance for DAG	3V	Pin power=V <sub>DD</sub> or V <sub>DDIO</sub>	20	60	100	kΩ
R <sub>PH</sub>	Pull-high Resistance for PA0, PA2, PA3, PA6, PA7, PC4,	5V	V <sub>DDIO</sub> =V <sub>DD</sub>	10	30	50	kΩ
	PC5 Pins Note	5V	V <sub>DDIO</sub> =3V	36	110	180	kΩ
I <sub>LEAK</sub>	Input Leakage Current for PA0, PA2, PA3, PA6, PA7, PC4, PC5 Pins	5V	V <sub>IN</sub> =V <sub>SS</sub> or V <sub>IN</sub> =V <sub>DD</sub> or V <sub>DDIO</sub>	_	_	±1	μA

Note: The  $R_{PH}$  internal pull-high resistance value is calculated by connecting to ground and enabling the input pin with a pull-high resistor and then measuring the pin current at the specified supply voltage level. Dividing the voltage by this measured current provides the  $R_{PH}$  value.



# **Memory Characteristics**

Ta=-40°C~85°C, unless otherwise specified.

Symbol	Parameter		Test Conditions	Min.	Time	Max.	Unit
Symbol	Parameter	V <sub>DD</sub>	Conditions	wiin.	Тур.	wax.	Unit
V <sub>RW</sub>	V <sub>DD</sub> for Read/Write	_	_	$V_{\text{DDmin}}$	_	$V_{DDmax}$	V
Flash Pr	ogram/Data EEPROM Memory						
t <sub>DEW</sub>	Erase/Write Cycle Time – Flash Program Memory	_	_	_	2	3	ms
	Write Cycle Time – Data EEPROM Memory	_	_	_	4	6	ms
I <sub>DDPGM</sub>	Programming/Erase Current on V <sub>DD</sub>	_	_	_	_	5.0	mA
_	Cell Endurance – Flash Program Memory	_	_	10K	_	_	E/W
E <sub>P</sub>	Cell Endurance – Data EEPROM Memory	_	_	100K	_	_	E/W
t <sub>RETD</sub>	ROM Data Retention Time	_	Ta=25°C	_	40	_	Year
RAM Da	ta Memory						
V <sub>DR</sub>	RAM Data Retention Voltage	_	Device in SLEEP Mode	1.0	_	_	V

Note: "E/W" means Erase/Write times.

# **LVD & LVR Electrical Characteristics**

Ta=-40°C~85°C

Councile and	D		Test Conditions	Min	T	Mass	11:4
Symbol	Parameter	V <sub>DD</sub>	Conditions	Min.	Тур.	Max.	Unit
V <sub>LVR</sub>	Low Voltage Reset Voltage	_	LVR enable	-5%	2.1	+5%	V
			LVD enable, voltage select 2.0V		2.0		
			LVD enable, voltage select 2.2V		2.2		
			LVD enable, voltage select 2.4V		2.4		
$V_{LVD}$	Low Voltage Detection Voltage	—	LVD enable, voltage select 2.7V	-5%	2.7	+5%	V
V LVD	Low voltage Detection voltage		LVD enable, voltage select 3.0V	-5%	3.0	+5%	V
	LVD en	LVD enable, voltage select 3.3V		3.3			
			LVD enable, voltage select 3.6V		3.6		
			LVD enable, voltage select 4.0V		4.0		
		3V	LVD enable, LVR enable,	_	_	20	
	Operating Current	5V	VBGEN=0	_	20	25	μA
LVRLVDBG	Operating Current	3V	LVD enable, LVR enable,	_	_	25	
		5V	VBGEN=1	_	25	30	μA
t <sub>LVDS</sub>	LVDO Stable Time	_	For LVR enable, VBGEN=0, LVD off → on	_	_	18	μs
t <sub>LVR</sub>	Minimum Low Voltage Width to Reset	_	_	120	240	480	μs
t <sub>LVD</sub>	Minimum Low Voltage Width to Interrupt	_	_	60	120	240	μs
I <sub>LVR</sub>	Additional Current for LVR Enable	_	LVD disable, VBGEN=0	_	_	24	μA

Rev. 1.00 22 August 27, 2021



# A/D Converter Electrical Characteristics

Ta=-40°C~85°C

Courada a l	Barrara da ra		Test Conditions	Min	T	N4	11:4
Symbol	Parameter	<b>V</b> <sub>DD</sub>	Conditions	Min.	Тур.	Max.	Unit
V <sub>ADI</sub>	Input Voltage	_	_	0	_	$V_{REF}$	V
V <sub>REF</sub>	Reference Voltage	_	_	2.2	_	V <sub>DD</sub>	V
N <sub>R</sub>	Resolution	_	_	_	_	12	Bit
DNL	Differential Non-linearity	_	V <sub>REF</sub> =V <sub>DD</sub> , t <sub>ADCK</sub> =0.5µs	-3	_	3	LSB
INL	Integral Non-linearity	_	V <sub>REF</sub> =V <sub>DD</sub> , t <sub>ADCK</sub> =0.5µs	-4	_	4	LSB
		2.2V		_	300	420	
I <sub>ADC</sub>	Additional Current for A/D Converter Enable	3V	No load, t <sub>ADCK</sub> =0.5µs	_	340	500	μA
	Litable	5V		_	500	700	
		_	AN ≠ Temperature Sensor	0.5	_	10.0	μs
t <sub>ADCK</sub>	Clock Period	2.2V~ 5.5V	AN = Temperature Sensor	1	_	2	μs
t <sub>ON2ST</sub>	A/D Converter On-to-Start Time	_	_	4	_	_	μs
	Carata and Time	_	AN ≠ Temperature Sensor	_	16	_	t <sub>ADCK</sub>
t <sub>ADC</sub>	Conversion Time (Include A/D Sample and Hold Time)	2.2V~ 5.5V	AN = Temperature Sensor	_	58	_	t <sub>ADCK</sub>
tstart	A/D Converter START=1 Width	_	AN = Temperature Sensor only	2	_	_	μs

# **Temperature Sensor Characteristics**

Ta=-40°C~85°C, unless otherwise specified

Comple of	Parameter		Test Conditions	Min.	Time	Max.	Unit
Symbol	Parameter	V <sub>DD</sub>	Conditions	wiin.	Тур.	IVIAX.	Unit
I	Temp Sensor Operating Current	3V	TSEN=1, t <sub>ADCK</sub> =1µs	_	700	900	μA
I <sub>TS</sub>	Temp Sensor Operating Current	5V	ADC NOT included	_	900	1200	μΑ
	Temperature Sensor Turn on	3V	_	_	_	100	μs
t <sub>TSS</sub>	Stable Time	5V	_	_	_	100	μs
V	Temperature Sensor Reference	3V	_	-5%	2.01	+5%	V
V <sub>TSVREF</sub>	Voltage	5V	_	-5%	2.01	+5%	V
.,	Proportional to Absolute	3V	25°C, Trim @V <sub>DD</sub> =5V	-2%	1.14	+2%	V
V <sub>PTATO</sub>	Temperature Voltage	5V	G5XEN=1	-2%	1.14	+2%	V
		2.7V~ 4.5V		-2	_	+2	
		2.7V~ 5.5V	V <sub>REF</sub> =V <sub>TSVREF</sub> , Ta=0°C~70°C, with linear calibration (Note)	-2.5	_	+2.5	°C
T <sub>ACC</sub>	Temperature Accuracy (Error)	_		_	±4	_	
		2.7V~ 5.5V	V <sub>REF</sub> =V <sub>TSVREF</sub> , Ta=-40°C~85°C, with linear calibration (Note)	-4	_	+4	°C
		_	Will lillear calibration (1889)	_	±5	_	

Note: Linear calibration is implemented using the linear formula which is established on the relation between the two calibrated temperatures and their corresponding ADC code. The temperature accuracy  $T_{ACC}$  is defined as the error between the actual temperature and the temperature obtained by the conversion of the ADC code through the formula.



# **Internal Reference Voltage Characteristics**

Ta=-40°C~85°C, unless otherwise specified

Cumbal	Parameter	٦	Test Conditions	Min.	Tres	Max.	Unit
Symbol	Parameter	V <sub>DD</sub>	Conditions	wiin.	Тур.	IVIAX.	Unit
$V_{DD}$	Operating Voltage	_	_	2.2	_	5.5	V
V <sub>BGREF</sub>	Bandgap Reference Voltage	_	_	-1%	1.2	+1%	V
I <sub>BGREF</sub>	Operating Current	5.5V	_	_	25	40	μA
PSRR	Power Supply Rejection Ratio	_	Ta=25°C, V <sub>RIPPLE</sub> =1V <sub>P-P</sub> , f <sub>RIPPLE</sub> =100Hz	75	_	_	dB
En	Output Noise	_	Ta=25°C, No load current, f=0.1Hz~10Hz	_	300	_	μV <sub>RMS</sub>
I <sub>DRV</sub>	Buffer Driving Capability	_	ΔV <sub>BGREF</sub> =-1%	1	_	_	mA
I <sub>SD</sub>	Shutdown Current	_	VBGREN=0	_	_	0.1	μA
t <sub>START</sub>	Startup Time	2.2V~5.5V	Ta=25°C	_	_	400	μs

Note: 1. All the above parameters are measured under conditions of no load condition unless otherwise described.

- $2.\,A\,0.1\mu F$  ceramic capacitor should be connected between VDD and GND.
- 3. The V<sub>BGREF</sub> voltage is used as the A/D converter input.

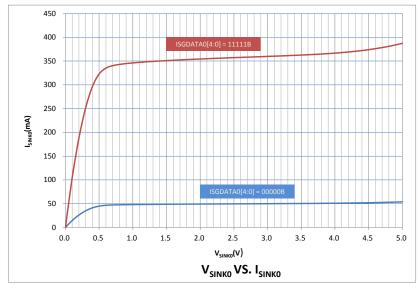
## **Sink Current Generator Electrical Characteristics**

Ta=-40°C~85°C, unless otherwise specified

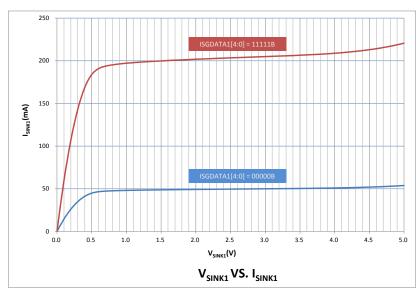
Symbol	Parameter		Test Conditions	Min.	Tyro	Max.	Unit
Symbol	Parameter	<b>V</b> <sub>DD</sub>	Conditions	IVIII.	Тур.	wax.	Unit
		5V	Ta=25°C, V <sub>ISINK0</sub> =3.0V, ISGDATA0[4:0]=00000B	47.5	50.0	52.5	
		_	V <sub>ISINK0</sub> =1.0V~4.5V ISGDATA0[4:0]=00000B	41	50	59	
1	0:10 11 10 11 10 11 10 11	_	V <sub>ISINK0</sub> =0.7V~1.0V ISGDATA0[4:0]=00000B	37.5	50.0	50.0	m Λ
I <sub>SINK0</sub>	Sink Current for ISINK0 Pin	5V	Ta=25°C, V <sub>ISINK0</sub> =3.0V, ISGDATA0[4:0]=11111B	330	360	390	mA
		_	V <sub>ISINK0</sub> =1.0V~4.5V ISGDATA0[4:0]=11111B	295	360	425	
		_	V <sub>ISINK0</sub> =0.7V~1.0V ISGDATA0[4:0]=11111B	270	360	360	
		5V	Ta=25°C, V <sub>ISINK1</sub> =3.0V, ISGDATA1[4:0]=00000B	43.5	50.0	56.5	
		_	V <sub>ISINK1</sub> =1.0V~4.5V ISGDATA1[4:0]=00000B	41	50	59	
1	Sink ourrant for ISINI/1 nin	_	V <sub>ISINK1</sub> =0.7V~1.0V ISGDATA1[4:0]=00000B	37.5	50.0	50.0	mA
Isink1	Sink current for ISINK1 pin	5V	Ta=25°C, V <sub>ISINK1</sub> =3.0V, ISGDATA1[4:0]=11111B	178	205	231	IIIA
		_	V <sub>ISINK1</sub> =1.0V~4.5V ISGDATA1[4:0]=11111B	168	205	242	
		_	V <sub>ISINK1</sub> =0.7V~1.0V ISGDATA1[4:0]=11111B	154	205	205	

Rev. 1.00 24 August 27, 2021





I<sub>SINK0</sub> Electrical Characteristic Curve



I<sub>SINK1</sub> Electrical Characteristic Curve



# **Operational Amplifier Electrical Characteristics**

## **Smoke Detector AFE**

V<sub>DD</sub>=5V, Ta=-40°C~85°C

Symbol	Parameter		Test Conditions	Min.	Trem	Max.	Unit
Symbol	Parameter	<b>V</b> <sub>DD</sub>	Conditions	wiin.	Тур.	iviax.	Unit
V <sub>DD</sub>	Operating Voltage	_	_	2.2	_	5.5	V
			SDAmBW [1:0]=00B (m=0, 1), no load	_	3.0	5.0	
	On a nation of Commonst	5V	SDAmBW [1:0]=01B (m=0, 1), no load	_	10	16	
I <sub>OPA</sub>	Operating Current	οv	SDAmBW [1:0]=10B (m=0, 1), no load	_	80	128	μA
			SDAmBW [1:0]=11B (m=0, 1), no load	_	200	320	
Vos	Input Offset Voltage	5V	Without calibration SDAmOF[5:0]=100000B	-15	_	+15	mV
			With calibration	-2	_	+2	
los	Input Offset Current	5V	V <sub>IN</sub> =1/2V <sub>CM</sub>	_	1	10	nA
V <sub>CM</sub>	Common Mode Voltage Range	_	SDAmBW [1:0]=00, 01, 10, 11 (m=0, 1)	V <sub>SS</sub>	_	V <sub>DD</sub> -1.4	V
PSRR	Power Supply Rejection Ratio	5V	SDAmBW [1:0]=00, 01, 10, 11 (m=0, 1)	50	70	_	dB
CMRR	Common Mode Rejection Ratio	5V	SDAmBW [1:0]=00, 01, 10, 11 (m=0, 1)	50	80	_	dB
Aol	Open Loop Gain	_	SDAmBW [1:0]=00, 01, 10, 11 (m=0, 1)	60	80	_	dB
	Slew Rate	5V	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=00B (m=0, 1)	0.5	1.5	_	
SR			R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=01B (m=0, 1)	5	15	_	V/ms
SIX	Siew Nate	J V	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=10B (m=0, 1)	180	500	_	V/IIIS
			R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=11B (m=0, 1)	600	1800	_	
			R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=00B (m=0, 1)	2.5	5.0	_	
GBW	Gain Bandwidth	5V	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=01B (m=0, 1)	20	40	_	kHz
ODW	Cam Bandwidth	JV	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=10B (m=0, 1)	400	600	_	KIIZ
			R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=11B (m=0, 1)	1300	2000	_	
			SDAmBW [1:0]=00, 01 (m=0, 1)	Vss		V <sub>DD</sub>	
Vor	Maximum Output Voltage	5V	$R_{LOAD}$ =5kΩ to $V_{DD}/2$	+140		-160	mV
• OR	Range		SDAmBW [1:0]=10, 11 (m=0, 1)	Vss	_	V <sub>DD</sub>	''''
			$R_{LOAD}$ =5k $\Omega$ to $V_{DD}/2$	+120		-140	
I <sub>sc</sub>	Output Short Circuit	5V	R <sub>LOAD</sub> =5.1Ω, SDAmBW[1:0]=00, 01 (m=0, 1)	±6	±12	_	mA
130	Current		R <sub>LOAD</sub> =5.1Ω, SDAmBW[1:0]=10, 11 (m=0, 1)	±10	±20	_	1117

Note: These parameters are characterized but not tested.

Rev. 1.00 26 August 27, 2021



V<sub>DD</sub>=2.2~5.5V, Ta=-40°C~85°C

Symbol	Parameter		Test Conditions	Min.	Turn	Max.	Unit
Symbol	Parameter	<b>V</b> <sub>DD</sub>	Conditions	Wiin.	Тур.	wax.	Unit
			SDAmBW [1:0]=00B (m=0, 1), no load	_	2.5	4.0	
	Operating Current		SDAmBW [1:0]=01B (m=0, 1), no load	_	10	16	
I <sub>OPA</sub>	Operating Current	_	SDAmBW [1:0]=10B (m=0, 1), no load	_	80	128	μA
			SDAmBW [1:0]=11B (m=0, 1), no load	_	200	320	
Vos	Input Offset Voltage	_	Without calibration SDAmOF[5:0]=100000B	-15	_	+15	mV
			With calibration	-2	_	+2	
Ios	Input Offset Current	_	V <sub>IN</sub> =1/2V <sub>CM</sub>	_	1	10	nA
V <sub>СМ</sub>	Common Mode Voltage Range	_	SDAmBW [1:0]=00, 01, 10, 11 (m=0, 1)	Vss	_	V <sub>DD</sub> -1.4	V
PSRR	Power Supply Rejection Ratio	_	SDAmBW [1:0]=00, 01, 10, 11 (m=0, 1)	50	70	_	dB
CMRR	Common Mode Rejection Ratio	_	SDAmBW [1:0]=00, 01, 10, 11 (m=0, 1)	50	80	_	dB
Aol	Open Loop Gain	_	SDAmBW [1:0]=00, 01, 10, 11 (m=0, 1)	60	80	_	dB
			R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=00B (m=0, 1)	0.5	1.5	_	
SR	Slew Rate		R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=01B (m=0, 1)	5	15	_	V/ms
SK	Siew Rate	_	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=10B (m=0, 1)	180	500		V/IIIS
			R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=11B (m=0, 1)	600	1800	_	
			R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=00B (m=0, 1)	2	5	_	
GBW	Gain Bandwidth		R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=01B (m=0, 1)	15	40	_	kHz
GBW	Gain Bandwidth	_	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=10B (m=0, 1)	250	600	_	KMZ
			R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, SDAmBW[1:0]=11B (m=0, 1)	800	2000	_	
			SDAmBW [1:0]=00, 01 (m=0, 1)	Vss		V <sub>DD</sub>	
$V_{OR}$	Maximum Output Voltage	_	$R_{LOAD}$ =5k $\Omega$ to $V_{DD}/2$	+140		-160	mV
V OR	Range		SDAmBW [1:0]=10, 11 (m=0, 1)	Vss	_	$V_{DD}$	1111
			$R_{LOAD}=5k\Omega$ to $V_{DD}/2$	+120		-140	
Isc	Output Short Circuit	_	R <sub>LOAD</sub> =5.1Ω, SDAmBW[1:0]=00, 01 (m=0, 1)	±1.2	±12.0	_	mA
130	Current		R <sub>LOAD</sub> =5.1Ω, SDAmBW[1:0]=10, 11 (m=0, 1)	±2	±20		1117

Note: These parameters are characterized but not tested.

## **Power Line Data Transceiver**

V<sub>DD</sub>=5V, Ta=-40°C~85°C

Symbol	Parameter		Test Conditions		Typ.	Max.	Unit
Syllibol	raiailletei	<b>V</b> <sub>DD</sub>	Conditions	Min.	iyp.	Wax.	Offic
$V_{DD}$	Operating Voltage	_	_	2.2	_	5.5	V
	Operating Current	E\/	PLTABW=0, no load	_	80	128	
IOPA	Operating Current	5V	PLTABW=1, no load	_	200	320	μΑ



Courada a l	Damanatan		Test Conditions	NA:	T	Mari	1114
Symbol	Parameter	V <sub>DD</sub>	Conditions	Min.	Тур.	Max.	Unit
Vos	Input Offset Voltage	5V	Without calibration (PLTAOF[5:0]=100000B)	-15	_	15	mV
			With calibration	-2	_	2	
los	Input Offset Current	5V	V <sub>IN</sub> =1/2V <sub>CM</sub>	_	1	10	nA
V <sub>СМ</sub>	Common Mode Voltage Range	_	PLTABW=0,1	Vss	_	V <sub>DD</sub> - 1.4	V
PSRR	Power Supply Rejection Ratio	5V	PLTABW=0,1	50	70	_	dB
CMRR	Common Mode Rejection Ratio	5V	PLTABW=0,1	50	80	_	dB
Aol	Open Loop Gain	_	PLTABW=0,1	60	80	_	dB
CD.	Class Bata	<i></i>	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, PLTABW=0	180	500	_	Mara
SR	Slew Rate	5V	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, PLTABW=1	600	1800	_	V/ms
GBW	Gain Bandwidth	5V	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, PLTABW=0	400	600	_	1.11=
GBW	Gain Bandwidth	50	R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, PLTABW=1	1300	2000	_	kHz
V <sub>OR</sub>	Maximum Output Voltage Range	5V	PLTABW=0, 1 R <sub>LOAD</sub> =5kΩ to V <sub>DD</sub> /2	V <sub>SS</sub> +210	_	V <sub>DD</sub> -230	mV
Isc	Output Short Circuit Current	5V	R <sub>LOAD</sub> =5.1Ω, PLTABW=0, 1	±8.5	±20.0	_	mA

Note: These parameters are characterized but not tested.

V<sub>DD</sub>=2.2~5.5V, Ta=-40°C~85°C

Comple - I	Parameter		Test Conditions	Min.	Trees	Max	Unit
Symbol	Parameter	V <sub>DD</sub>	Conditions	Wiln.	Тур.	Max.	Unit
	On another of Comment		PLTABW=0, no load	I —	80	128	
I <sub>OPA</sub>	Operating Current	_	PLTABW=1, no load	I —	200	320	μA
Vos	Input Offset Voltage	_	Without calibration PLTAOF [5:0]=100000B	-15	_	15	mV
			With calibration	-2	_	2	
los	Input Offset Current	_	V <sub>IN</sub> =1/2V <sub>CM</sub>	_	1	10	nA
V <sub>CM</sub>	Common Mode Voltage Range	_	PLTABW=0, 1	V <sub>SS</sub>	_	V <sub>DD</sub> -1.4	V
PSRR	Power Supply Rejection Ratio	_	PLTABW=0, 1	50	70	_	dB
CMRR	Common Mode Rejection Ratio	_	PLTABW=0, 1	50	80	_	dB
Aol	Open Loop Gain	_	PLTABW=0, 1	60	80	_	dB
SR	Slew Rate		R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, PLTABW=0	180	500	_	V/ms
SK	Siew Rate		R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, PLTABW=1	600	1800	_	V/IIIS
GBW	Gain Bandwidth		R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, PLTABW=0	250	600	_	Id Ia
GDVV	Gairi Dariuwidiri		R <sub>LOAD</sub> =1MΩ, C <sub>LOAD</sub> =60pF, PLTABW=1	800	2000	_	kHz
Vor	Maximum Output Voltage Range	_	PLTABW=0, 1 R <sub>LOAD</sub> =5kΩ to V <sub>DD</sub> /2	V <sub>SS</sub> +210	_	V <sub>DD</sub> -230	mV
Isc	Output Short Circuit Current	_	R <sub>LOAD</sub> =5.1Ω, PLTABW=0, 1	±2	±20	_	mA

Note: These parameters are characterized but not tested.

Rev. 1.00 28 August 27, 2021



# D/A Converter (for Power Line Transceiver) Electrical Characteristics

Ta=-40°C~85°C

Symbol	Parameter		Test Conditions	Min.	Tun	Max.	Unit
Symbol	Parameter	V <sub>DD</sub>	Conditions	Wiin.	Тур.	wax.	Unit
V <sub>DD</sub>	Operating Voltage	_	_	2.2	_	5.5	V
V <sub>DACO</sub>	Output Voltage Range	_	_	Vss	_	$V_{REF}$	V
V <sub>REF</sub>	Reference Voltage	_	_	2	_	$V_{DD}$	V
	Additional Current for D/A Converter Enable	3V	_	_	_	12	μA
I <sub>DAC</sub>	(DAC0&DAC1)	5V	_	_	_	20	μΑ
IDAC	Additional Current for D/A Converter Enable	3V	_	_	_	360	
	(DAC2)	5V	_	_	_	600	μA
	Settling Time	3V	C =50pE	_	_	5	
t <sub>st</sub>	Settling Time	5V	C <sub>LOAD</sub> =50pF	_	_	_ 5	μs
DNL	Differential Nepline with	3V	V <sub>REF</sub> =V <sub>DD</sub>	-1	_	+1	LSB
DINL	Differential Nonlinearity	5V	VREF-VDD	-1	_	+1	LOD
INL	Integral Nonlinearity	3V	· V <sub>REF</sub> =V <sub>DD</sub>	-1.5	_	+1.5	LSB
IINL	integral Nonlinearity	5V	VREF-VDD	-1.5	_	+1.5	LOD
	Resistor-String Output Resistor	3V	_	_	1000	_	kΩ
Ro	(DAC0&DAC1)	5V	_	_	1000	_	K12
Ro	DOD Output Decistor	3V	_	_	10	_	kΩ
	R2R Output Resistor	5V	_	_	10	_	K12
OSDB	Offset Error	3V	_	_	_	6	mV
OSRR	Oliset Ellor	5V	_	_	_	10	mv
GERR	Gain Error	3V	_	_	_	12	mV
GERR	Gain Endi	5V	_	_	_	20	IIIV

# 16-bit Vioce D/A Converter Electrical Characteristics

Ta=-40°C~85°C

Cumbal	Parameter		Test Conditions	Min.	Time	Max	Unit
Symbol	r ai ailietei		Conditions	WIII.	Тур.	Max.	Unit
V <sub>DD</sub>	Operating Voltage	_	_	2.2	5.0	5.5	V
	Additional Current for D/A Converter Enable	3V	_	_	_	3	Λ
IDAC	With Buffer	5V	_	_	_	3	mA
I <sub>STB(DAC)</sub>	Standby Current	5V	DACEN=0	_	_	1	μA
THD+N	Total Harmonic Distortion+Noise <sup>(Note)</sup>	3V	10kΩ load	_	-55	_	dB
V <sub>оит</sub>	Output Voltage Range	5V	No load	0.01	_	0.99	V <sub>DD</sub>
t <sub>DACS</sub>	D/A Converter Circuit Turn on Stable Time	5V	_	_	_	1	ms

Note: Sin wave input @ 1kHz, -6dBFS.



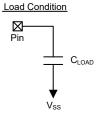
# **Comparator (for Power Line Transceiver) Electrical Characteristics**

Ta=-40°C~85°C

Symbol	Parameter		Test Conditions	Min.	Time	Max.	Unit
Symbol	Parameter	<b>V</b> <sub>DD</sub>	Conditions	wiin.	Тур.	wax.	Unit
V <sub>DD</sub>	Comparator Operating Voltage	_	_	2.2	_	5.5	V
			No load, PLTCmIS[1:0]=00B (m=0, 1)	_	1.7	2.7	
Ісмр	Additional Current for Comparator		No load, PLTCmIS[1:0]=01B (m=0, 1)	_	14	22	μA
	Enable	_	No load PLTCmIS[1:0]=10B (m=0, 1)	_	36	57	μΑ
			No load, PLTCmIS[1:0]=11B (m=0, 1)	_	58	92	
Vos	Comparator Input Offset Voltage	5V	Without calibration (PLTCmOF[4:0]=10000B, m=0, 1)	-10	_	+10	mV
			With calibration	-4	_	+4	
V <sub>CM</sub>	Common Mode Voltage Range	_	_	Vss	_	V <sub>DD</sub> -1.4V	V
		3V	With 10mV overdrive(Note),	_	_	35	
		5V	No debounce PLTCmIS[1:0]=00B (m=0, 1)	_	_	35	
		3V	With 10mV overdrive <sup>(Note)</sup> ,	_	_	2.5	
		5V	No debounce PLTCmIS[1:0]=01B (m=0, 1)	_	_	2.5	
t <sub>RP</sub>	Response Time	3V	With 10mV overdrive(Note),	_	_	1	μs
		5V	No debounce PLTCmIS[1:0]=10B (m=0, 1)	_	_	1	
		3V	With 10mV overdrive(Note),	_	_	0.7	
		5V	No debounce PLTCmIS[1:0]=11B (m=0, 1)	_	_	0.7	
		3V	PLTCmHYS[1:0]=00,	0	0	5	
		5V	PLTCmIS[1:0]=00 (m=0,1)	0	0	5	
		3V	PLTCmHYS[1:0]=01,	20	40	60	
V <sub>HYS</sub>	Hysteresis	5V	PLTCmIS[1:0]=01 (m=0,1)	20	40	60	m\/
VHYS	i iyatereala	3V	PLTCmHYS[1:0]=10,	50	100	150	mV
		5V PLTCmIS[1:0]=10 (m=0,1) 50		100	150	]	
		3V	PLTCmHYS[1:0]=11,	80	160	240	
		5V	PLTCmIS[1:0]=11 (m=0,1)	80	160	240	

Note: All the above parameters are measured under condition of Comp. input voltage= $(V_{DD}$  - 1.4)/2 and remain constant.

Load Condition:  $C_{LOAD}$ =50pF



Rev. 1.00 30 August 27, 2021



# **Piezoelectric Horn Driver Electrical Characteristics**

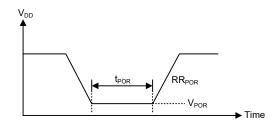
BDV\_DD=V\_DD=3V, V\_OUT=12V, Ta=25°C, unless otherwise specified

Cumbal	Parameter		Test Conditions	Min.	Тур.	Max.	Unit	
Symbol		BDV <sub>DD</sub>	Conditions	IVIIII.				
Supply \	Supply Voltage							
BDV <sub>DD</sub>	Input Voltage Range	_	_	_	$V_{DD}$	_	V	
I <sub>IN</sub>	Supply Current	_	No load, boost converter enable, external-driving buzzer mode, f=4kHz	_	2	4	mA	
I <sub>SHDN</sub>	Shutdown Current		V <sub>ENB</sub> =BDV <sub>DD</sub>	_	0.5	1.0	μΑ	
Boost C	Boost Converter							
V <sub>оит</sub>	Output Voltage Range	_	_	10.8	12.0	13.2	V	
IOCP	Over Current Protection Current	_	_	_	0.95	_	Α	
fsw	Switching Frequency	_	V <sub>OUT</sub> =12V	0.8	1.0	1.2	MHz	
Piezoele	Piezoelectric Horn Driver							
V <sub>IH</sub>	High-Level Input Voltage	_	FB Pin	0.7V <sub>OUT</sub>	_	Vout	V	
			ENB Pin	0.7BDV <sub>DD</sub>	_	BDV <sub>DD</sub>	V	
VIL	Low-Level Input Voltage	_	FB Pin	0	_	0.3V <sub>OUT</sub>	V	
			ENB Pin	0	_	0.3BDV <sub>DD</sub>	V	
Іон	Source Current for VB and VS Pins	_	V <sub>OUT</sub> =12V, V <sub>OH</sub> =0.9V <sub>OUT</sub>	-120	-150	_	mA	
IoL	Sink Current for VB and VS Pins	_	V <sub>OUT</sub> =12V, V <sub>OL</sub> =0.1V <sub>OUT</sub>	120	150	_	mA	
I <sub>LEAK</sub>	Input Leakage Current	_	V <sub>FB</sub> =V <sub>OUT</sub> or =V <sub>SS</sub>		_	±0.1	μA	
			V <sub>ENB</sub> =BDV <sub>DD</sub>		_	-0.1	μΑ	
R <sub>PH</sub>	Pull-high Resistance	_	ENB Pin	0.7	1.0	1.3	МΩ	

# **Power-on Reset Characteristics**

Ta=-40°C~85°C

Cumbal	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
Symbol	Farameter		Conditions				
V <sub>POR</sub>	V <sub>DD</sub> Start Voltage to Ensure Power-on Reset	_	_	_	_	100	mV
RR <sub>POR</sub>	V <sub>DD</sub> Rising Rate to Ensure Power-on Reset	_	_	0.035	_	_	V/ms
t <sub>POR</sub>	Minimum Time for $V_{\text{DD}}$ Stays at $V_{\text{POR}}$ to Ensure Power-on Reset	_	_	1	_	_	ms



Rev. 1.00 31 August 27, 2021



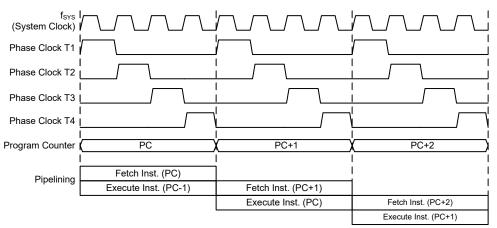
## **System Architecture**

A key factor in the high-performance features of the Holtek range of microcontrollers is attributed to their internal system architecture. The device takes advantage of the usual features found within RISC microcontrollers providing increased speed of operation and enhanced performance. The pipelining scheme is implemented in such a way that instruction fetching and instruction execution are overlapped, hence instructions are effectively executed in one or two cycles for most of the standard or extended instructions respectively. The exceptions to these are branch or call instructions which need one more cycle. An 8-bit wide ALU is used in practically all instruction set operations, which carries out arithmetic operations, logic operations, rotation, increment, decrement, branch decisions, etc. The internal data path is simplified by moving data through the Accumulator and the ALU. Certain internal registers are implemented in the Data Memory and can be directly or indirectly addressed. The simple addressing methods of these registers along with additional architectural features ensure that a minimum of external components is required to provide a functional I/O and A/D control system with maximum reliability and flexibility. This makes the device suitable for low-cost, high-volume production for controller applications.

#### **Clocking and Pipelining**

The main system clock, derived from either an HIRC, LIRC, HXT or LXT oscillator is subdivided into four internally generated non-overlapping clocks, T1~T4. The Program Counter is incremented at the beginning of the T1 clock during which time a new instruction is fetched. The remaining T2~T4 clocks carry out the decoding and execution functions. In this way, one T1~T4 clock cycle forms one instruction cycle. Although the fetching and execution of instructions takes place in consecutive instruction cycles, the pipelining structure of the microcontroller ensures that instructions are effectively executed in one instruction cycle. The exception to this are instructions where the contents of the Program Counter are changed, such as subroutine calls or jumps, in which case the instruction will take one more instruction cycle to execute.

For instructions involving branches, such as jump or call instructions, two machine cycles are required to complete instruction execution. An extra cycle is required as the program takes one cycle to first obtain the actual jump or call address and then another cycle to actually execute the branch. The requirement for this extra cycle should be taken into account by programmers in timing sensitive applications.



System Clocking and Pipelining

Rev. 1.00 32 August 27, 2021





Instruction Fetching

#### **Program Counter**

During program execution, the Program Counter is used to keep track of the address of the next instruction to be executed. It is automatically incremented by one each time an instruction is executed except for instructions, such as "JMP" or "CALL" that demands a jump to a nonconsecutive Program Memory address. For the device with a program memory capacity in excess of 8K words, the program memory high byte address must be setup by selecting a certain program memory bank which is implemented using the program memory bank pointer bit, PBP0.Only the lower 8 bits, known as the Program Counter Low Register, are directly addressable by the application program.

When executing instructions requiring jumps to non-consecutive addresses such as a jump instruction, a subroutine call, interrupt or reset, etc., the microcontroller manages program control by loading the required address into the Program Counter. For conditional skip instructions, once the condition has been met, the next instruction, which has already been fetched during the present instruction execution, is discarded and a dummy cycle takes its place while the correct instruction is obtained.

Program	Program Counter		
High Byte	Low Byte (PCL)		
PBP0, PC12~PC8	PCL7~PCL0		

**Program Counter** 

The lower byte of the Program Counter, known as the Program Counter Low register or PCL, is available for program control and is a readable and writeable register. By transferring data directly into this register, a short program jump can be executed directly; however, as only this low byte is available for manipulation, the jumps are limited to the present page of memory that is 256 locations. When such program jumps are executed it should also be noted that a dummy cycle will be inserted. Manipulating the PCL register may cause program branching, so an extra cycle is needed to pre-fetch.

#### Stack

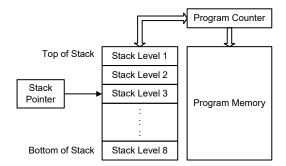
This is a special part of the memory which is used to save the contents of the Program Counter only. The stack is organized into 8 levels and neither part of the data nor part of the program space, and is neither readable nor writeable. The activated level is indexed by the Stack Pointer, and is neither readable nor writeable. At a subroutine call or interrupt acknowledge signal, the contents of the Program Counter are pushed onto the stack. At the end of a subroutine or an interrupt routine, signaled by a return instruction, RET or RETI, the Program Counter is restored to its previous value from the stack. After a device reset, the Stack Pointer will point to the top of the stack.

If the stack is full and an enabled interrupt takes place, the interrupt request flag will be recorded but the acknowledge signal will be inhibited. When the Stack Pointer is decremented, by RET or RETI, the interrupt will be serviced. This feature prevents stack overflow allowing the programmer to use the structure more easily. However, when the stack is full, a CALL subroutine instruction can still be executed which will result in a stack overflow. Precautions should be taken to avoid such cases which might cause unpredictable program branching.

Rev. 1.00 33 August 27, 2021



If the stack is overflow, the first Program Counter save in the stack will be lost.



## Arithmetic and Logic Unit - ALU

The arithmetic-logic unit or ALU is a critical area of the microcontroller that carries out arithmetic and logic operations of the instruction set. Connected to the main microcontroller data bus, the ALU receives related instruction codes and performs the required arithmetic or logical operations after which the result will be placed in the specified register. As these ALU calculation or operations may result in carry, borrow or other status changes, the status register will be correspondingly updated to reflect these changes. The ALU supports the following functions:

- Arithmetic operations: ADD, ADDM, ADC, ADCM, SUB, SUBM, SBC, SBCM, DAA, LADD, LADDM, LADC, LADCM, LSUB, LSUBM, LSBC, LSBCM, LDAA
- Logic operations: AND, OR, XOR, ANDM, ORM, XORM, CPL, CPLA, LAND, LOR, LXOR, LANDM, LORM, LXORM, LCPL, LCPLA
- Rotation: RRA, RR, RRCA, RRC, RLA, RL, RLCA, RLC, LRR, LRRA, LRRCA, LRRC, LRLA, LRL, LRLCA, LRLC
- Increment and Decrement: INCA, INC, DECA, DEC, LINCA, LINC, LDECA, LDEC
- Branch decision: JMP, SZ, SZA, SNZ, SIZ, SDZ, SIZA, SDZA, CALL, RET, RETI, LSZ, LSZA, LSNZ, LSIZ, LSDZ, LSIZA, LSDZA

#### Flash Program Memory

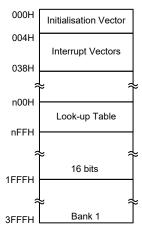
The Program Memory is the location where the user code or program is stored. For the device the Program Memory is Flash type, which means it can be programmed and re-programmed a large number of times, allowing the user the convenience of code modification on the same device. By using the appropriate programming tools, the Flash device offers users the flexibility to conveniently debug and develop their applications while also offering a means of field programming and updating.

#### Structure

The Program Memory has a capacity of 16K×16 bits. The Program Memory is addressed by the Program Counter and also contains data, table information and interrupt entries. Table data, which can be setup in any location within the Program Memory, is addressed by a separate table pointer register.

Rev. 1.00 34 August 27, 2021





**Program Memory Structure** 

#### **Special Vectors**

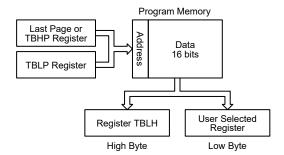
Within the Program Memory, certain locations are reserved for the reset and interrupts. The location 0000H is reserved for use by the device reset for program initialisation. After a device reset is initiated, the program will jump to this location and begin execution.

#### Look-up Table

Any location within the Program Memory can be defined as a look-up table where programmers can store fixed data. To use the look-up table, the table pointer must first be setup by placing the address of the look up data to be retrieved in the table pointer registers, TBLP and TBHP. These registers define the total address of the look-up table.

After setting up the table pointer, the table data can be retrieved from the Program Memory using the corresponding table read instruction such as "TABRD [m]" or "TABRDL [m]" respectively when the memory [m] is located in Sector 0. If the memory [m] is located in other sectors, the data can be retrieved from the program memory using the corresponding extended table read instruction such as "LTABRD [m]" or "LTABRDL [m]" respectively. When the instruction is executed, the lower order table byte from the Program Memory will be transferred to the user defined Data Memory register [m] as specified in the instruction. The higher order table data byte from the Program Memory will be transferred to the TBLH special register.

The accompanying diagram illustrates the addressing data flow of the look-up table.



Rev. 1.00 35 August 27, 2021



#### Table Program Example

The following example shows how the table pointer and table data is defined and retrieved from the microcontroller. This example uses raw table data located in the Program Memory which is stored there using the ORG statement. The value at this ORG statement is "1F00H" which refers to the start address of the last page within the 16K Program Memory of the device. The table pointer low byte register is setup here to have an initial value of "06H". This will ensure that the first data read from the data table will be at the Program Memory address "3F06H" or 6 locations after the start of the last page. Note that the value for the table pointer is referenced to the first address specified by TBLP and TBHP if the "TABRD [m]" or "LTABRD [m]" instruction is being used. The high byte of the table data which in this case is equal to zero will be transferred to the TBLH register automatically when the "TABRD [m]" or "LTABRD [m]" instruction is executed.

Because the TBLH register is a read/write register and can be restored, care should be taken to ensure its protection if both the main routine and Interrupt Service Routine use table read instructions. If using the table read instructions, the Interrupt Service Routines may change the value of the TBLH and subsequently cause errors if used again by the main routine. As a rule it is recommended that simultaneous use of the table read instructions should be avoided. However, in situations where simultaneous use cannot be avoided, the interrupts should be disabled prior to the execution of any main routine table-read instructions. Note that all table related instructions require two instruction cycles to complete their operation.

#### **Table Read Program Example**

```
rombank 1 code1
ds .section 'data'
tempreg1 db ?
                ; temporary register #1
tempreg2 db ?
                  ; temporary register #2
code0 .section 'code'
mov a,06h
                  ; initialise low table pointer - note that this address is referenced
mov tblp,a
                  ; to the last page or the page that thhp pointed
mov a,3Fh
                  ; initialise high table pointer
mov tbhp, a
tabrd tempred1
                   ; transfers value in table referenced by table pointer data at program
                   ; memory address "3F06H" transferred to tempreg1 and TBLH
dec tblp
                  ; reduce value of table pointer by one
                  ; transfers value in table referenced by table pointer data at program
tabrd tempreg2
                   ; memory address "3F05H" transferred to tempreg2 and TBLH
                   ; in this example the data "1AH" is transferred to tempreg1 and data
                   ; "OFH" to register tempreg2
codel .section 'code'
                ; sets initial address of program memory
dc 00Ah, 00Bh, 00Ch, 00Dh, 00Eh, 00Fh, 01Ah, 01Bh
```

Rev. 1.00 36 August 27, 2021



# In Circuit Programming - ICP

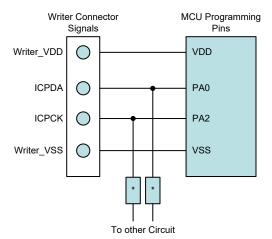
The provision of Flash type Program Memory provides the user with a means of convenient and easy upgrades and modifications to their programs on the same device. As an additional convenience, a means of programming the microcontroller in-circuit has provided using a 4-pin interface. This provides manufacturers with the possibility of manufacturing their circuit boards complete with a programmed or un-programmed microcontroller, and then programming or upgrading the program at a later stage. This enables product manufacturers to easily keep their manufactured products supplied with the latest program releases without removal and re-insertion of the device.

The Holtek Flash MCU to Writer Programming Pin correspondence table is as follows:

Holtek Writer Pins	MCU Programming Pins	Pin Description
ICPDA	PA0	Programming Serial Data/Address
ICPCK	PA2	Programming Clock
VDD	VDD	Power Supply
VSS	VSS	Ground

The Program Memory can be programmed serially in-circuit using this 4-wire interface. Data is downloaded and uploaded serially on a single pin with an additional line for the clock. Two additional lines are required for the power supply. The technical details regarding the incircuit programming of the device is beyond the scope of this document and will be supplied in supplementary literature.

During the programming process, taking control of the ICPDA and ICPCK pins for data and clock programming purposes. The user must there take care to ensure that no other outputs are connected to these two pins.



Note: \* may be resistor or capacitor. The resistance of \* must be greater than  $1k\Omega$  or the capacitance of \* must be less than 1nF.

Rev. 1.00 37 August 27, 2021



# On Chip Debug Support - OCDS

An EV chip exists for the purposes of device emulation. This EV chip device also provides an "On-Chip Debug" function to debug the real MCU device during the development process. The EV chip and the real MCU device are almost functionally compatible except for "On-Chip Debug" function. Users can use the EV chip device to emulate the real chip device behavior by connecting the OCDSDA and OCDSCK pins to the Holtek HT-IDE development tools. The OCDSDA pin is the OCDS Data/Address input/output pin while the OCDSCK pin is the OCDS clock input pin. When users use the EV chip for debugging, other functions which are shared with the OCDSDA and OCDSCK pins in the device will have no effect in the EV chip. However, the two OCDS pins which are pin-shared with the ICP programming pins are still used as the Flash Memory programming pins for ICP. For more detailed OCDS information, refer to the corresponding document named "Holtek e-Link for 8-bit MCU OCDS User's Guide".

Holtek e-Link Pins	EV Chip Pins	Pin Description			
OCDSDA	OCDSDA	On-Chip Debug Support Data/Address input/output			
OCDSCK	OCDSCK	On-Chip Debug Support Clock input			
VDD	VDD	Power Supply			
VSS	VSS	Ground			

# In Application Programming - IAP

Flash type Program Memory provides the user with a means of convenient and easy upgrades and modifications to their programs on the same device. The provision of the IAP function offers users the convenience of Flash Memory multi-programming features. The convenience of the IAP function is that it can execute the updated program procedure using its internal firmware, without requiring an external Program Writer or PC. In addition, the IAP interface can also be any type of communication protocol, such as UART, using I/O pins. Regarding the internal firmware, the user can select versions provided by Holtek or create their own. The following section illustrates the procedures regarding how to implement the IAP firmware.

#### Flash Memory Read/Write Size

The Flash memory Erase and Write operations are carried out in a page format while the Read operation is carried out in a word format. The page size and write buffer size are both assigned with a capacity of 64 words. Note that the Erase operation should be executed before the Write operation is executed.

When the Flash Memory Erase/Write Function is successfully enabled, the CFWEN bit will be set high. When the CFWEN bit is set high, the data can be written into the write buffer. The FWT bit is used to initiate the write process and then indicate the write operation status. This bit is set high by application programs to initiate a write process and will be cleared by hardware if the write process is finished.

The Read operation can be carried out by executing a specific read procedure. The FRDEN bit is used to enable the read function and the FRD bit is used to initiate the read process by application programs and then indicate the read operation status. When the read process is finished, this bit will be cleared by hardware.

Operations	Format					
Erase	1 page/time					
Write	64 words/time					
Read	1 word/time					
Note: Page size=Write buffer size=64 words.						

**IAP Operation Format** 

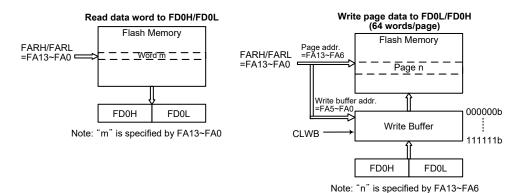
Rev. 1.00 38 August 27, 2021



Erase Page	FARH	FARL[7:6]	FARL[5:0]
0	0000 0000	00	xx xxxx
1	0000 0000	01	xx xxxx
2	0000 0000	10	xx xxxx
3	0000 0000	11	xx xxxx
4	0000 0000	00	xx xxxx
:	:	:	:
:	:	:	:
254	0011 1111	10	xx xxxx
255	0011 1111	11	xx xxxx

"x": don't care

#### **Erase Page Number and Selection**



Flash Memory IAP Read/Write Structure

#### Write Buffer

The write buffer is used to store the written data temporarily when executing the write operation. The Write Buffer can be filled with written data after the Flash Memory Erase/Write Function has been successfully enabled by executing the Flash Memory Erase/Write Function Enable procedure. The write buffer can be cleared by configuring the CLWB bit in the FC2 register. The CLWB bit can be set high to enable the Clear Write Buffer procedure. When the procedure is finished this bit will be cleared to low by the hardware. It is recommended that the write buffer should be cleared by setting the CLWB bit high before the write buffer is used for the first time or when the data in the write buffer is updated.

The write buffer size is 64 words corresponding to a page. The write buffer address is mapped to a specific flash memory page specified by the memory address bits, FA13~FA6. The data written into the FD0L and FD0H registers will be loaded into the write buffer. When data is written into the high byte data register, FD0H, it will result in the data stored in the high and low byte data registers both being written into the write buffer. It will also cause the flash memory address to be incremented by one, after which the new address will be loaded into the FARH and FARL address registers. When the flash memory address reaches the page boundary, 111111b of a page with 64 words, the address will now not be incremented but will stop at the last address of the page. At this point a new page address should be specified for any other erase/write operations.

After a write process is finished, the write buffer will automatically be cleared by the hardware. Note that the write buffer should be cleared manually by the application program when the data written into the flash memory is incorrect in the data verification step. The data should again be written into the write buffer after the write buffer has been cleared when the data is found to be incorrect during the data verification step.

Rev. 1.00 39 August 27, 2021



# **IAP Flash Program Memory Registers**

There are two address registers, four 16-bit data registers and three control registers. Read and Write operations to the Flash memory are carried out by 16-bit data operations using the address and data registers and the control register. Several registers control the overall operation of the internal Flash Program Memory. The address registers are named FARL and FARH, the data registers are named FDnL and FDnH and the control registers are named FC0, FC1 and FC2.

Register				В	it			
Name	7	6	5	4	3	2	1	0
FC0	CFWEN	FMOD2	FMOD1	FMOD0	FWPEN	FWT	FRDEN	FRD
FC1	D7	D6	D5	D4	D3	D2	D1	D0
FC2	_	_	_	_	_	_	_	CLWB
FARL	FA7	FA6	FA5	FA4	FA3	FA2	FA1	FA0
FARH	_	_	FA13	FA12	FA11	FA10	FA9	FA8
FD0L	D7	D6	D5	D4	D3	D2	D1	D0
FD0H	D15	D14	D13	D12	D11	D10	D9	D8
FD1L	D7	D6	D5	D4	D3	D2	D1	D0
FD1H	D15	D14	D13	D12	D11	D10	D9	D8
FD2L	D7	D6	D5	D4	D3	D2	D1	D0
FD2H	D15	D14	D13	D12	D11	D10	D9	D8
FD3L	D7	D6	D5	D4	D3	D2	D1	D0
FD3H	D15	D14	D13	D12	D11	D10	D9	D8

**IAP Register List** 

# • FARL Register

Bit	7	6	5	4	3	2	1	0
Name	FA7	FA6	FA5	FA4	FA3	FA2	FA1	FA0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **FA7~FA0**: Flash Memory Address bit  $7 \sim$  bit 0

#### • FARH Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	FA13	FA12	FA11	FA10	FA9	FA8
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5~0 **FA13~FA8**: Flash Memory Address bit 13 ~ bit 8

### FD0L Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **D7\simD0**: The first Flash Memory data bit  $7 \sim$  bit 0

Note that data written into the low byte data register FD0L will only be stored in the FD0L register and not loaded into the lower 8-bit write buffer.

Rev. 1.00 40 August 27, 2021



### • FD0H Register

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **D15\simD8**: The first Flash Memory data bit  $15 \sim$  bit 8

Note that when 8-bit data is written into the high byte data register FD0H, the whole 16 bits of data stored in the FD0H and FD0L registers will simultaneously be loaded into the 16-bit write buffer after which the contents of the Flash memory address register pair, FARH and FARL, will be incremented by one.

# • FD1L Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **D7~D0**: The second Flash Memory data bit  $7 \sim \text{bit } 0$ 

# • FD1H Register

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7\sim0$  **D15\simD8**: The second Flash Memory data bit  $15\sim$  bit 8

### • FD2L Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **D7~D0**: The third Flash Memory data bit  $7 \sim \text{bit } 0$ 

# • FD2H Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **D7~D0**: The third Flash Memory data bit  $7 \sim$  bit 0

### • FD3L Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **D7~D0**: The fourth Flash Memory data bit  $7 \sim \text{bit } 0$ 

Rev. 1.00 41 August 27, 2021



### • FD3H Register

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **D15\simD8**: The fourth Flash Memory data bit  $15 \sim$  bit  $8 \sim$ 

#### FC0 Register

Bit	7	6	5	4	3	2	1	0
Name	CFWEN	FMOD2	FMOD1	FMOD0	FWPEN	FWT	FRDEN	FRD
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7 CFWEN: Flash Memory Erase/Write function enable control

0: Flash Memory erase/write function is disabled

1: Flash Memory erase/write function has been successfully enabled

When this bit is cleared to zero by application program, the Flash Memory erase/write function is disabled. Note that this bit cannot be set high by application programs. Writing "1" into this bit results in no action. This bit is used to indicate that the Flash Memory erase/write function status. When this bit is set high by hardware, it means that the Flash Memory erase/write function is enabled successfully. Otherwise, the Flash Memory erase/write function is disabled as the bit content is zero.

Bit 6~4 FMOD2~FMOD0: Flash Memory Mode selection

000: Write Mode

001: Page Erase Mode

010: Reserved

011: Read Mode

100: Reserved

101: Reserved

110: Flash Memory Erase/Write function Enable Mode

111: Reserved

These bits are used to select the Flash Memory operation modes. Note that the "Flash memory Erase/Write function Enable Mode" should first be successfully enabled before the Erase or Write Flash memory operation is executed.

Bit 3 FWPEN: Flash Memory Erase/Write function enable procedure trigger

- 0: Erase/Write function enable procedure is not triggered or procedure timer times out
- 1: Erase/Write function enable procedure is triggered and procedure timer starts to count

This bit is used to activate the flash memory Erase/Write function enable procedure and an internal timer. It is set by the application programs and then cleared to zero by the hardware when the internal timer times out. The correct patterns must be written into the FD1L/FD1H, FD2L/FD2H and FD3L/FD3H register pairs respectively as soon as possible after the FWPEN bit is set high.

Bit 2 **FWT**: Flash Memory write initiate control

- 0: Do not initiate Flash Memory write or indicating that a Flash Memory write process has completed
- 1: Initiate a Flash Memory write process

This bit is set by software and cleared to zero by the hardware when the Flash memory write process has completed.

Rev. 1.00 42 August 27, 2021



Bit 1 FRDEN: Flash Memory read enabled bit

0: Flash Memory read disable

1: Flash Memory read enable

This is the Flash memory Read Enable bit which must be set high before any Flash memory read operations are carried out. Clearing this bit to zero will inhibit Flash memory read operations.

Bit 0 FRD: Flash Memory read control bit

- 0: Do not initiate Flash Memory read or indicating that a Flash Memory read process has completed
- 1: Initiate a Flash Memory read process

This bit is set by software and cleared to zero by the hardware when the Flash memory read process has completed.

- Note: 1. The FWT, FRDEN and FRD bits cannot be set to "1" at the same time with a single instruction.
  - 2. Ensure that the  $f_{SUB}$  clock is stable before executing the erase or write operation.
  - 3. Note that the CPU will be stopped when a read, erase or write operation is successfully activated.
  - 4. Ensure that the read, erase or write operation is totally complete before executing other operations.

#### FC1 Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0 **D7~D0**: Chip Reset Pattern

When a specific value of "55H" is written into this register, a reset signal will be generated to reset the whole chip.

# • FC2 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	_	CLWB
R/W	_	_	_	_	_	_	_	R/W
POR	_	_	_	_	_	_	_	0

Bit 7~1 Unimplemented, read as "0"

Bit 0 CLWB: Flash Memory Write buffer clear control

- 0: Do not initiate a Write Buffer Clear process or indicating that a Write Buffer Clear process has completed
- 1: Initiate a Write Buffer Clear process

This bit is set by software and cleared to zero by hardware when the Write Buffer Clear process has completed.

Rev. 1.00 43 August 27, 2021



### Flash Memory Erase/Write Flow

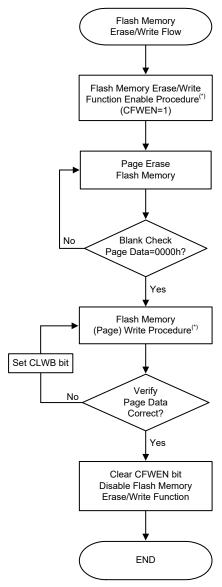
It is important to understand the Flash memory Erase/Write flow before the Flash memory contents are updated. Users can refer to the corresponding operation procedures when developing their IAP program to ensure that the flash memory contents are correctly updated.

Flash Memory Erase/Write Flow Descriptions:

- Activate the "Flash Memory Erase/Write function enable procedure" first. When the Flash Memory Erase/Write function is successfully enabled, the CFWEN bit in the FC0 register will automatically be set high by hardware. After this, Erase or Write operations can be executed on the Flash memory. Refer to the "Flash Memory Erase/Write Function Enable Procedure" for details.
- 2. Configure the flash memory address to select the desired erase page and then erase this page.
- 3. Execute a Blank Check operation to ensure whether the page erase operation is successful or not. The "TABRD" instruction should be executed to read the flash memory contents and to check if the contents is 0000h or not. If the flash memory page erase operation fails, users should go back to Step 2 and execute the page erase operation again.
- 4. Write data into the specific page. Refer to the "Flash Memory Write Procedure" for details.
- 5. Execute the "TABRD" instruction to read the flash memory contents and check if the written data is correct or not. If the data read from the flash memory is different from the written data, it means that the page write operation has failed. The CLWB bit should be set high to clear the write buffer and then write the data into the specific page again if the write operation has failed.
- Clear the CFWEN bit to disable the Flash Memory Erase/Write function enable mode if the current page Erase and Write operations are completed and no more pages need to be erased or written.

Rev. 1.00 44 August 27, 2021





Flash Memory Erase/Write Flow

Note: The Flash Memory Erase/Write Function Enable procedure and Flash Memory Write procedure will be described in the following sections.



#### Flash Memory Erase/Write Function Enable Procedure

The Flash Memory Erase/Write Function Enable Mode is specially designed to prevent the flash memory contents from being wrongly modified. In order to allow users to change the Flash memory data using the IAP control registers, users must first enable the Flash memory Erase/Write function.

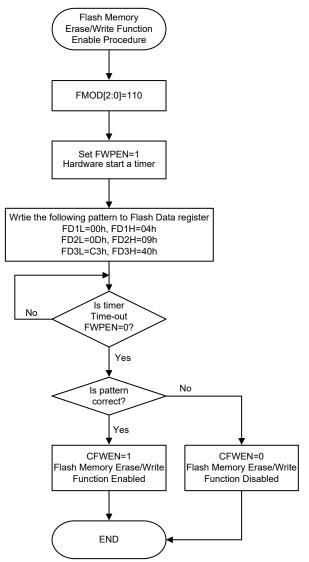
### Flash Memory Erase/Write Function Enable Procedure Description

- 1. Write data "110" to the FMOD [2:0] bits in the FC0 register to select the Flash Memory Erase/Write Function Enable Mode.
- 2. Set the FWPEN bit in the FC0 register to "1" to activate the Flash Memory Erase/Write Enable Function. This will also activate an internal timer.
- 3. Write the correct data pattern into the Flash data registers, FD1L~FD3L and FD1H~FD3H, as soon as possible after the FWPEN bit is set high. The enable Flash memory erase/write function data pattern is 00H, 0DH, C3H, 04H, 09H and 40H corresponding to the FD1L~FD3L and FD1H~FD3H registers respectively.
- 4. Once the timer has timed out, the FWPEN bit will automatically be cleared to zero by hardware regardless of the input data pattern.
- 5. If the written data pattern is incorrect, the Flash memory erase/write function will not be enabled successfully and the above steps should be repeated. If the written data pattern is correct, the Flash memory erase/write function will be enabled successfully.
- 6. Once the Flash memory erase/write function is enabled, the Flash memory contents can be updated by executing the page erase and write operations using the IAP control registers.

To disable the Flash memory erase/write function, the CFWEN bit in the FC0 register can be cleared. There is no need to execute the above procedure.

Rev. 1.00 46 August 27, 2021





Flash Memory Erase/Write Function Enable Procedure



#### Flash Memory Write Procedure

After the Flash memory erase/write function has been successfully enabled as the CFWEN bit is set high, the data to be written into the flash memory can be loaded into the write buffer. The selected flash memory page data should be erased by properly configuring the IAP control registers before the data write procedure is executed.

The write buffer size is 64 words, known as a page, whose address is mapped to a specific flash memory page specified by the memory address bits, FA13~FA6. It is important to ensure that the page where the write buffer data is located is the same one which the memory address bits, FA13~FA6, specify.

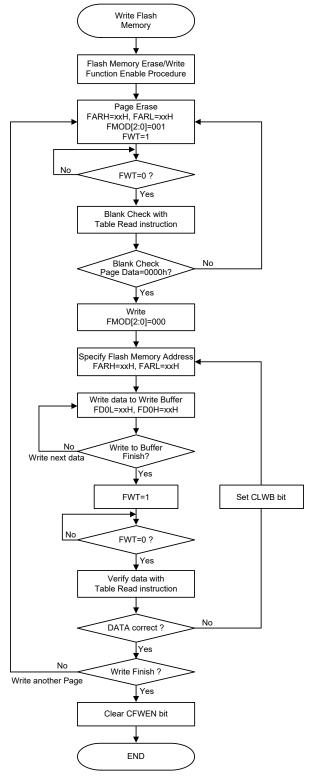
## **Flash Memory Consecutive Write Description**

The maximum amount of write data is 64 words for each write operation. The write buffer address will be automatically incremented by one when consecutive write operations are executed. The start address of a specific page should first be written into the FARL and FARH registers. Then the data word should first be written into the FD0L register and then the FD0H register. At the same time the write buffer address will be incremented by one and then the next data word can be written into the FD0L and FD0H registers for the next address without modifying the address register pair, FARH and FARL. When the write buffer address reaches the page boundary the address will not be further incremented but will stop at the last address of the page.

- 1. Activate the "Flash Memory Erase/Write function enable procedure". Check the CFWEN bit value and then execute the erase/write operations if the CFWEN bit is set high. Refer to the "Flash Memory Erase/Write function enable procedure" for more details.
- Set the FMOD field to "001" to select the erase operation. Set the FWT bit high to erase the desired page which is specified by the FARH and FARL registers. Wait until the FWT bit goes low
- 3. Execute a Blank Check operation using the table read instruction to ensure that the erase operation has successfully completed.
  - Go to step 2 if the erase operation is not successful.
  - Go to step 4 if the erase operation is successful.
- 4. Set the FMOD field to "000" to select the write operation.
- 5. Setup the desired start address in the FARH and FARL registers. Write the desired data words consecutively into the FD0L and FD0H registers within a page as specified by their consecutive addresses. The maximum written data number is 64 words.
- 6. Set the FWT bit high to write the data words from the write buffer to the flash memory. Wait until the FWT bit goes low.
- Verify the data using the table read instruction to ensure that the write operation has successfully completed.
  - If the write operation has not successfully completed, set the CLWB bit high to clear the write buffer and then go to step 5.
  - Go to step 8 if the write operation is successful.
- 8. Clear the CFWEN bit low to disable the Flash memory erase/write function.

Rev. 1.00 48 August 27, 2021





Flash Memory Consecutive Write Procedure

Note: 1. When the erase or write operation is successfully activated, all CPU operations will temporarily cease.

2. It will take a typical time of 2.2ms for the FWT bit state changing from high to low.



### Flash Memory Non-Consecutive Write Description

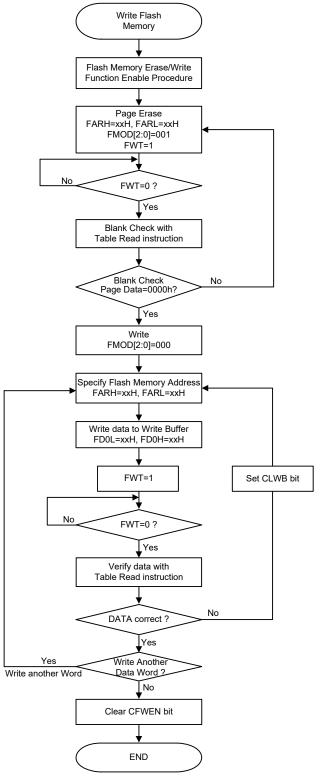
The main difference between Flash Memory Consecutive and Non-Consecutive Write operations is whether the data words to be written are located in consecutive addresses or not. If the data to be written is not located in consecutive addresses the desired address should be re-assigned after a data word is successfully written into the Flash Memory.

A two data word non-consecutive write operation is taken as an example here and described as follows:

- 1. Activate the "Flash Memory Erase/Write function enable procedure". Check the CFWEN bit value and then execute the erase/write operation if the CFWEN bit is set high. Refer to the "Flash Memory Erase/Write function enable procedure" for more details.
- Set the FMOD field to "001" to select the erase operation. Set the FWT bit high to erase the desired page which is specified by the FARH and FARL registers. Wait until the FWT bit goes low.
- 3. Execute a Blank Check operation using the table read instruction to ensure that the erase operation has successfully completed.
  - Go to step 2 if the erase operation is not successful.
  - Go to step 4 if the erase operation is successful.
- 4. Set the FMOD field to "000" to select the write operation.
- 5. Setup the desired address ADDR1 in the FARH and FARL registers. Write the desired data word DATA1 first into the FD0L register and then into the FD0H register.
- 6. Set the FWT bit high to transfer the data word from the write buffer to the flash memory. Wait until the FWT bit goes low.
- Verify the data using the table read instruction to ensure that the write operation has successfully completed.
  - If the write operation has not successfully completed, set the CLWB bit high to clear the write buffer and then go to step 5.
  - Go to step 8 if the write operation is successful.
- 8. Setup the desired address ADDR2 in the FARH and FARL registers. Write the desired data word DATA2 first into the FD0L register and then into the FD0H register.
- 9. Set the FWT bit high to transfer the data word from the write buffer to the flash memory. Wait until the FWT bit goes low.
- 10. Verify the data using the table read instruction to ensure that the write operation has successfully completed.
  - If the write operation has not successfully completed, set the CLWB bit high to clear the write buffer and then go to step 8.
  - Go to step 11 if the write operation is successful.
- 11. Clear the CFWEN bit low to disable the Flash memory erase/write function.

Rev. 1.00 50 August 27, 2021





Flash Memory Non-Consecutive Write Procedure

Note: 1. When the erase or write operation is successfully activated, all CPU operations will temporarily cease.

2. It will take a typical time of 2.2ms for the FWT bit state changing from high to low.



### Important Points to Note for Flash Memory Write Operations

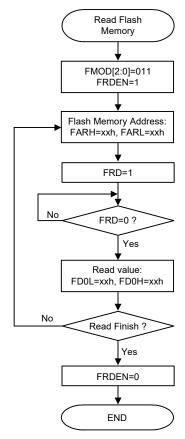
- 1. The "Flash Memory Erase/Write Function Enable Procedure" must be successfully activated before the Flash Memory erase/write operation is executed.
- 2. The Flash Memory erase operation is executed to erase a whole page.
- 3. The whole write buffer data will be written into the flash memory in a page format. The corresponding address cannot exceed the page boundary.
- 4. After the data is written into the flash memory the flash memory contents must be read out using the table read instruction, TABRD, and checked if it is correct or not. If the data written into the flash memory is incorrect, the write buffer should be cleared by setting the CLWB bit high and then write the data again into the write buffer. Then activate a write operation on the same flash memory page without erasing it. The data check, buffer clear and data re-write steps should be repeatedly executed until the data written into the flash memory is correct.
- 5. The system frequency should be setup to the maximum application frequency when data write and data check operations are executed using the IAP function.

#### Flash Memory Read Procedure

To activate the Flash Memory Read procedure, the FMOD field should be set to "011" to select the flash memory read mode and the FRDEN bit should be set high to enable the read function. The desired flash memory address should be written into the FARH and FARL registers and then the FRD bit should be set high. After this the flash memory read operation will be activated. The data stored in the specified address can be read from the data registers, FD0H and FD0L, when the FRD bit goes low. There is no need to first activate the Flash Memory Erase/Write Function Enable Procedure before the flash memory read operation is executed.

Rev. 1.00 52 August 27, 2021





Flash Memory Read Procedure

Note: 1. When the read operation is successfully activated, all CPU operations will temporarily cease.

2. It will take a typical time of three instruction cycles for the FRD bit state changing from high to low.



# **Data Memory**

The Data Memory is a volatile area of 8-bit wide RAM internal memory and is the location where temporary information is stored.

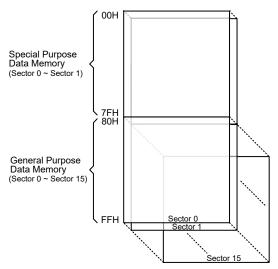
Categorized into two types, the first of these is an area of RAM where special function registers are located. These registers have fixed locations and are necessary for correct operation of the device. Many of these registers can be read from and written to directly under program control, however, some remain protected from user manipulation. The second area of Data Memory is reserved for general purpose use. All locations within this area are read and write accessible under program control

Switching between the different Data Memory sectors is achieved by properly setting the Memory Pointers to correct value.

# **Structure**

The Data Memory is subdivided into several sectors, all of which are implemented in 8-bit wide RAM. Each of the Data Memory Sector is categorized into two types, the special Purpose Data Memory and the General Purpose Data Memory. The address range of the Special Purpose Data Memory for the device is from 00H to 7FH while the General Purpose Data Memory address range is from 80H to FFH.

Special Purpose Data Memory	General Purpose Data Memory			
Located Sectors	Capacity	Sector: Address		
0, 1	2048×8	0: 80H~FFH 1: 80H~FFH : 15: 80H~FFH		



**Data Memory Structure** 

Rev. 1.00 54 August 27, 2021



# **Data Memory Addressing**

For the device that supports the extended instructions, there is no Bank Pointer for Data Memory addressing. The Bank Pointer, PBP, is only available for Program Memory. For Data Memory the desired Sector is pointed by the MP1H or MP2H register and the certain Data Memory address in the selected sector is specified by the MP1L or MP2L register when using indirect addressing access.

Direct Addressing can be used in all sectors using the corresponding instruction which can address all available data memory space. For the accessed data memory which is located in any data memory sectors except Sector 0, the extended instructions can be used to access the data memory instead of using the indirect addressing access. The main difference between standard instructions and extended instructions is that the data memory address "m" in the extended instructions has 12 valid bits, the high byte indicates a sector and the low byte indicates a specific address within the sector.

## **General Purpose Data Memory**

All microcontroller programs require an area of read/write memory where temporary data can be stored and retrieved for use later. It is this area of RAM memory that is known as General Purpose Data Memory. This area of Data Memory is fully accessible by the user programing for both reading and writing operations. By using the bit operation instructions individual bits can be set or reset under program control giving the user a large range of flexibility for bit manipulation in the Data Memory.

## **Special Purpose Data Memory**

This area of Data Memory is where registers, necessary for the correct operation of the microcontroller, are stored. Most of the registers are both readable and writeable but some are protected and are readable only, the details of which are located under the relevant Special Function Register section. Note that for locations that are unused, any read instruction to these addresses will return the value "00H".

Rev. 1.00 55 August 27, 2021



Sector 0  00H IAR0	Sector 1
01H MP0	
02H IAR1	
03H MP1L	
04H MP1H	
05H ACC	
06H PCL	
07H TBLP	
08H TBLH	
09H TBHP	
0AH STATUS	
OBH PBP	
0CH IAR2	
0DH MP2L	
0EH MP2H	
0FH RSTFC	
10H SCC	
11H HIRCC	
12H HXTC	
13H LXTC	
14H PA	
15H PAC	
16H PAPU	
17H PAWU	
18H PB	
19H PBC	
1AH PBPU	STM1C0
1BH PC	STM1C1
1CH PCC	STM1DL
1DH PCPU	STM1DH
1EH PD	STM1AL
1FH PDC	STM1AH
20H PDPU	0111111111
21H WDTC	PTM1C0
22H SDSW	PTM1C1
23H SDPGAC0	PTM1DL
24H SDPGAC1	PTM1DH
25H SDA0C	PTM1AL
26H SDA0VOS	PTM1AH
27H SDA1C	PTM1RPL
28H SDA1VOS	PTM1RPH
29H	
2AH SADC0	PTM2C0
2BH SADC1	PTM2C1
2CH SADC2	PTM2DL
2DH SADOH	PTM2DH
2EH SADOL	PTM2AL
2FH LMSADOH	PTM2AH
30H LMSADOL	PTM2RPL
31H PLTSW	PTM2RPH
32H PLTDACC	
33H PLTDA0L	SLEDC0
34H PLTDA1L	SLEDC1
35H PLTDA2L	522501
36H PLTC0C	PMPS0
37H PLTCOVOS	PMPS1
38H PLTC1C	1 1,111 01
39H PLTC1VOS	U1SR
3AH PLTCHYC	U1CR1
3BH PLTAC	U1CR2
3CH PLTAVOS	U1CR3
3DH EEA	TXR RXR1
3EH EED	BRG1
3FH ISGENC	וטוום
- IOGLINO	

	Sector 0	Sector 1
40H	ISGDATA0	EEC
41H	ISGDATA1	
42H	INTEG	PAS0
43H	INTC0	PAS1
44H	INTC1	PBS0
45H	INTC2	PBS1
46H	INTC3	PCS0
47H	MFI0	PCS1
48H	MFI1	PDS0
49H	MFI2	
4AH	MFI3	IFS0
4BH	MFI4	IFS1
4CH	MFI5	
4DH	VBGRC	
4EH	ORMC	
4FH	LVDC	
50H	PSCR	
51H	TB0C	
52H	TB1C	
53H	SIMC0	
54H	SIMC1	
55H	SIMD	
56H	SIMA/SIMC2	
57H	SIMTOC	
58H	GIWITOC	
59H	U0SR	
5AH	U0CR1	
5BH	U0CR2	
5CH	U0CR3	
5DH	TXR RXR0	
5EH	BRG0	
	STM0C0	-
5FH	STM0C0	-
60H	STM0C1 STM0DL	-
61H 62H	STMODE	
63H	STM0DI1	
64H	STM0AH	
65H	PTM0C0	
	PTM0C0	
66H	PTM0C1	-
67H	PTM0C2 PTM0DL	-
68H 69H	PTM0DH	
6AH	PTM0AL	-
6BH	PTM0AH	-
6CH	PTM0BL	-
6DH	PTM0BH	
6EH	PTM0RPL	
oE⊓ 6FH	PTM0RPH	-
70H		-
71H	DAH DAL	
		-
72H	DACC FC0	-
73H	FC1	-
74H		
75H	FC2 FARL	
76H		
77H	FARH	
78H	FD0L	
79H	FD0H	
7AH	FD1L	
7BH	FD1H	
7CH	FD2L	
7DH	FD2H	
7EH	FD3L	
7FH [	FD3H	

: Unused, read as 00H

**Special Purpose Data Memory Structure** 

Rev. 1.00 56 August 27, 2021



# **Special Function Register Description**

Most of the Special Function Register details will be described in the relevant functional sections however several registers require a separate description in this section.

# Indirect Addressing Registers - IAR0, IAR1, IAR2

The Indirect Addressing Registers, IAR0, IAR1 and IAR2, although having their locations in normal RAM register space, do not actually physically exist as normal registers. The method of indirect addressing for RAM data manipulation uses these Indirect Addressing Registers and Memory Pointers, in contrast to direct memory addressing, where the actual memory address is specified. Actions on the IAR0, IAR1 and IAR2 registers will result in no actual read or write operation to these registers but rather to the memory location specified by their corresponding Memory Pointers, MP0, MP1L/MP1H or MP2L/MP2H. Acting as a pair, IAR0 and MP0 can together access data only from Sector 0 while the IAR1 register together with the MP1L/MP1H register pair and IAR2 register together with the MP2L/MP2H register pair can access data from any Data Memory Sector. As the Indirect Addressing Registers are not physically implemented, reading the Indirect Addressing Registers will return a result of "00H" and writing to the registers will result in no operation.

# Memory Pointers - MP0, MP1L, MP1H, MP2L, MP2H

Five Memory Pointers, known as MP0, MP1L, MP1H, MP2L, MP2H, are provided. These Memory Pointers are physically implemented in the Data Memory and can be manipulated in the same way as normal registers providing a convenient way with which to address and track data. When any operation to the relevant Indirect Addressing Registers is carried out, the actual address that the microcontroller is directed to is the address specified by the related Memory Pointer. MP0, together with Indirect Addressing Register, IAR0, are used to access data from Sector 0, while MP1L/MP1H together with IAR1 and MP2L/MP2H together with IAR2 are used to access data from all sectors according to the corresponding MP1H or MP2H register. Direct Addressing can be used in all sectors using the corresponding instruction which can address all available data memory space.

The following example shows how to clear a section of four Data Memory locations already defined as locations adres1 to adres4.

#### **Indirect Addressing Program Example 1**

```
data .section 'data
adres1 db?
        db?
adres2
adres3
        db?
adres4
        dh?
        db?
block
code .section at 0 'code'
org 00h
start:
     mov a, 04h
                             ; setup size of block
    mov block, a
    mov a, offset adres1
                             ; Accumulator loaded with first RAM address
     mov mp0, a
                             ; setup memory pointer with first RAM address
loop:
     clr IAR0
                             ; clear the data at address defined by MPO
     inc mp0
                             ; increment memory pointer
                             ; check if last memory location has been cleared
     sdz block
     jmp loop
continue:
```



# **Indirect Addressing Program Example 2**

```
data .section 'data'
adres1 db?
adres2 db?
adres3 db?
adres4 db?
block db?
code .section at 0 'code'
org 00h
start:
                          ; setup size of block
    mov a, 04h
    mov block, a
    mov a, 01h
                          ; setup the memory sector
    mov mp1h, a
    mov a, offset adres1
                          ; Accumulator loaded with first RAM address
    mov mp11, a
                          ; setup memory pointer with first RAM address
loop:
    clr IAR1
                          ; clear the data at address defined by MP1L
                           ; increment memory pointer MP1L
    inc mp11
    sdz block
                          ; check if last memory location has been cleared
    jmp loop
continue:
```

The important point to note here is that in the example shown above, no reference is made to specific Data Memory addresses.

#### **Direct Addressing Program Example using extended instructions**

```
data .section 'data'
temp db?
code .section at 0 'code'
org 00h
start:
    lmov a, [m]
                         ; move [m] data to acc
    lsub a, [m+1]
                         ; compare [m] and [m+1] data
    snz c
                          ; [m]>[m+1]?
    jmp continue
                         ; no
    lmov a, [m]
                          ; yes, exchange [m] and [m+1] data
    mov temp, a
    lmov a, [m+1]
    lmov [m], a
    mov a, temp
    lmov [m+1], a
```

Note: Here "m" is a data memory address located in any data memory sectors. For example, m=1F0H, it indicates address 0F0H in Sector 1.

Rev. 1.00 58 August 27, 2021



# Program Memory Bank Pointer - PBP

For the device the program memory is divided into two banks. Selecting the required program memory area is achieved using the program memory bank pointer, PBP. The PBP register should be properly configured before the device executes the "Branch" operation using the "JMP" or "CALL" instruction. After that a jump to a non-consecutice program memory address which is located in a certain bank selected by the program memory bank pointer bits will occur.

#### PBP Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	_	PBP0
R/W	_	_	_	_	_	_	_	R/W
POR	_	_	_	_	_	_	-	0

Bit 7~1 Unimplemented, read as "0"

**PBP0**: Program memory bank pointer bit 0

0: Bank 0 1: Bank 1

#### Accumulator - ACC

Bit 0

The Accumulator is central to the operation of any microcontroller and is closely related with operations carried out by the ALU. The Accumulator is the place where all intermediate results from the ALU are stored. Without the Accumulator it would be necessary to write the result of each calculation or logical operation such as addition, subtraction, shift, etc., to the Data Memory resulting in higher programming and timing overheads. Data transfer operations usually involve the temporary storage function of the Accumulator; for example, when transferring data between one user-defined register and another, it is necessary to do this by passing the data through the Accumulator as no direct transfer between two registers is permitted.

# Program Counter Low Register – PCL

To provide additional program control functions, the low byte of the Program Counter is made accessible to programmers by locating it within the Special Purpose area of the Data Memory. By manipulating this register, direct jumps to other program locations are easily implemented. Loading a value directly into this PCL register will cause a jump to the specified Program Memory location, however, as the register is only 8-bit wide, only jumps within the current Program Memory page are permitted. When such operations are used, note that a dummy cycle will be inserted.

# Look-up Table Registers - TBLP, TBHP, TBLH

These three special function registers are used to control operation of the look-up table which is stored in the Program Memory. TBLP and TBHP are the table pointers and indicate the location where the table data is located. Their value must be setup before any table read commands are executed. Their value can be changed, for example using the "INC" or "DEC" instructions, allowing for easy table data pointing and reading. TBLH is the location where the high order byte of the table data is stored after a table read data instruction has been executed. Note that the lower order table data byte is transferred to a user defined location.

Rev. 1.00 59 August 27, 2021



# **Option Memory Mapping Register - ORMC**

The ORMC register is used to enable Option Memory Mapping function. The Option Memory capacity is 32 words. When a specific pattern of 55H and AAH is consecutively written into this register, the Option Memory Mapping function will be enabled and then the Option Memory code can be read by using the table read instruction. The Option Memory addresses  $00H\sim1FH$  will be mapped to Program Memory last page addresses  $E0H\simFFH$ .

To successfully enable the Option Memory Mapping function, the specific pattern of 55H and AAH must be written into the ORMC register in two consecutive instruction cycles. It is therefore recommended that the global interrupt bit EMI should first be cleared before writing the specific pattern, and then set high again at a proper time according to users' requirements after the pattern is successfully written. An internal timer will be activated when the pattern is successfully written. The mapping operation will be automatically finished after a period of 4×t<sub>LIRC</sub>. Therefore, users should read the data in time, otherwise the Option Memory Mapping function needs to be restarted. After the completion of each consecutive write operation to the ORMC register, the timer will recount.

When the table read instructions are used to read the Option Memory code, both "TABRD [m]" and "TABRDL [m]" instructions can be used. However, care must be taken if the "TABRD [m]" instruction is used, the table pointer defined by the TBHP register must be referenced to the last page. Refer to corresponding sections about the table read instruction for more details.

### ORMC Register

Bit	7	6	5	4	3	2	1	0
Name	ORMC7	ORMC6	ORMC5	ORMC4	ORMC3	ORMC2	ORMC1	ORMC0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0 **ORMC7~ORMC0**: Option Memory Mapping specific pattern

When a specific pattern of 55H and AAH is written into this register, the Option Memory Mapping function will be enabled. Note that the register content will be cleared after the MCU is woken up from the IDLE/SLEEP mode.

#### Status Register - STATUS

This 8-bit register contains the SC flag, CZ flag, zero flag (Z), carry flag (C), auxiliary carry flag (AC), overflow flag (OV), power down flag (PDF), and watchdog time-out flag (TO). These arithmetic/logical operation and system management flags are used to record the status and operation of the microcontroller.

With the exception of the TO and PDF flags, bits in the status register can be altered by instructions like most other registers. Any data written into the status register will not change the TO or PDF flag. In addition, operations related to the status register may give different results due to the different instruction operations. The TO flag can be affected only by a system power-up, a WDT time-out or by executing the "CLR WDT" or "HALT" instruction. The PDF flag is affected only by executing the "HALT" or "CLR WDT" instruction or during a system power-up.

The Z, OV, AC, C, SC and CZ flags generally reflect the status of the latest operations.

- C is set if an operation results in a carry during an addition operation or if a borrow does not take place during a subtraction operation; otherwise C is cleared. C is also affected by a rotate through carry instruction.
- AC is set if an operation results in a carry out of the low nibbles in addition, or no borrow from the high nibble into the low nibble in subtraction; otherwise AC is cleared.
- Z is set if the result of an arithmetic or logical operation is zero; otherwise Z is cleared.

Rev. 1.00 60 August 27, 2021



- OV is set if an operation results in a carry into the highest-order bit but not a carry out of the highest-order bit, or vice versa; otherwise OV is cleared.
- PDF is cleared by a system power-up or executing the "CLR WDT" instruction. PDF is set by executing the "HALT" instruction.
- TO is cleared by a system power-up or executing the "CLR WDT" or "HALT" instruction. TO is set by a WDT time-out.
- CZ is the operational result of different flags for different instructions. Refer to register definitions for more details.
- SC is the result of the "XOR" operation which is performed by the OV flag and the MSB of the current instruction operation result.

In addition, on entering an interrupt sequence or executing a subroutine call, the status register will not be pushed onto the stack automatically. If the contents of the status register are important and if the subroutine can corrupt the status register, precautions must be taken to correctly save it.

### STATUS Register

Bit	7	6	5	4	3	2	1	0
Name	SC	CZ	TO	PDF	OV	Z	AC	С
R/W	R/W	R/W	R	R	R/W	R/W	R/W	R/W
POR	Х	Х	0	0	Х	х	Х	х

"x": Unknown

- Bit 7 SC: The result of the "XOR" operation which is performed by the OV flag and the MSB of the instruction operation result.
- Bit 6 CZ: The operational result of different flags for different instructions.

For SUB/SUBM/LSUB/LSUBM instructions, the CZ flag is equal to the Z flag.

For SBC/SBCM/LSBC/LSBCM instructions, the CZ flag is the "AND" operation result which is performed by the previous operation CZ flag and current operation zero flag.

For other instructions, the CZ flag will not be affected.

- Bit 5 TO: Watchdog Time-out flag
  - 0: After power up or executing the "CLR WDT" or "HALT" instruction
  - 1: A watchdog time-out occurred.
- Bit 4 **PDF**: Power down flag
  - 0: After power up or executing the "CLR WDT" instruction
  - 1: By executing the "HALT" instruction
- Bit 3 **OV**: Overflow flag
  - 0: No overflow
  - 1: An operation results in a carry into the highest-order bit but not a carry out of the highest-order bit or vice versa.
- Bit 2 Z: Zero flag
  - 0: The result of an arithmetic or logical operation is not zero
  - 1: The result of an arithmetic or logical operation is zero
- Bit 1 AC: Auxiliary flag
  - 0: No auxiliary carry
  - 1: An operation results in a carry out of the low nibbles in addition, or no borrow from the high nibble into the low nibble in subtraction
- Bit 0 C: Carry flag
  - 0: No carry-out
  - 1: An operation results in a carry during an addition operation or if a borrow does not take place during a subtraction operation

The "C" flag is also affected by a rotate through carry instruction.

Rev. 1.00 61 August 27, 2021



# **EEPROM Data Memory**

The device contains an area of internal EEPROM Data Memory. EEPROM is by its nature a non-volatile form of re-programmable memory, with data retention even when its power supply is removed. By incorporating this kind of data memory, a whole new host of application possibilities are made available to the designer. The availability of EEPROM storage allows information such as product identification numbers, calibration values, specific user data, system setup data or other product information to be stored directly within the product microcontroller. The process of reading and writing data to the EEPROM memory has been reduced to a very trivial affair.

# **EEPROM Data Memory Structure**

The EEPROM Data Memory capacity is 256×8 bits for the device. Unlike the Program Memory and RAM Data Memory, the EEPROM Data Memory is not directly mapped into memory space and is therefore not directly addressable in the same way as the other types of memory. Read and Write operations to the EEPROM are carried out in single byte operations using an address and a data register in Sector 0 and a single control register in Sector 1.

# **EEPROM Registers**

Three registers control the overall operation of the internal EEPROM Data Memory. These are the address register, EEA, the data register, EED and a single control register, EEC. As both the EEA and EED registers are located in Sector 0, they can be directly accessed in the same way as any other Special Function Register. The EEC register however, being located in Sector 1, can only be read from or written to indirectly using the MP1L/MP1H or MP2L/MP2H Memory Pointer and Indirect Addressing Register, IAR1/IAR2. Because the EEC control register is located at address 40H in Sector 1, the MP1L or MP2L Memory Pointer must first be set to the value 40H and the MP1H or MP2H Memory Pointer high byte set to the value, 01H, before any operations on the EEC register are executed.

Register		Bit										
Name	7	6	5	4	3	2	1	0				
EEA	EEA7	EEA6	EEA5	EEA4	EEA3	EEA2	EEA1	EEA0				
EED	D7	D6	D5	D4	D3	D2	D1	D0				
EEC	_	_	_	_	WREN	WR	RDEN	RD				

**EEPROM Register List** 

## • EEA Register

Bit	7	6	5	4	3	2	1	0
Name	EEA7	EEA6	EEA5	EEA4	EEA3	EEA2	EEA1	EEA0
R/W								
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **EEA7~EEA0**: Data EEPROM address bit  $7 \sim$  bit  $0 \sim 0$ 

#### EED Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  **D7\simD0**: Data EEPROM data bit  $7 \sim$  bit 0

Rev. 1.00 62 August 27, 2021



### • EEC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	WREN	WR	RDEN	RD
R/W	_	_	_	_	R/W	R/W	R/W	R/W
POR	_	_	_	_	0	0	0	0

Bit 7~4 Unimplemented, read as "0"

Bit 3 WREN: Data EEPROM Write Enable

0: Disable 1: Enable

This is the Data EEPROM Write Enable Bit which must be set high before Data EEPROM write operations are carried out. Clearing this bit to zero will inhibit Data EEPROM write operations.

Bit 2 WR: EEPROM Write Control

0: Write cycle has finished1: Activate a write cycle

This is the Data EEPROM Write Control Bit and when set high by the application program will activate a write cycle. This bit will be automatically reset to zero by the hardware after the write cycle has finished. Setting this bit high will have no effect if the WREN has not first been set high.

Bit 1 RDEN: Data EEPROM Read Enable

0: Disable 1: Enable

This is the Data EEPROM Read Enable Bit which must be set high before Data EEPROM read operations are carried out. Clearing this bit to zero will inhibit Data EEPROM read operations.

Bit 0 **RD**: EEPROM Read Control

0: Read cycle has finished1: Activate a read cycle

This is the Data EEPROM Read Control Bit and when set high by the application program will activate a read cycle. This bit will be automatically reset to zero by the hardware after the read cycle has finished. Setting this bit high will have no effect if the RDEN has not first been set high.

Note: 1. The WREN, WR, RDEN and RD cannot be set high at the same time in one instruction. The WR and RD cannot be set high at the same time.

- 2. Ensure that the  $f_{SUB}$  clock is stable before executing the write operation.
- 3. Ensure that the write operation is totally complete before changing the contents of the EEPROM related registers.

# Reading Data from the EEPROM

To read data from the EEPROM, the EEPROM address of the data to be read must first be placed in the EEA register. Then the read enable bit, RDEN, in the EEC register must be set high to enable the read function. If the RD bit in the EEC register is now set high, a read cycle will be initiated. Setting the RD bit high will not initiate a read operation if the RDEN bit has not been set. When the read cycle terminates, the RD bit will be automatically cleared to zero, after which the data can be read from the EED register. The data will remain in the EED register until another read or write operation is executed. The application program can poll the RD bit to determine when the data is valid for reading.

Rev. 1.00 63 August 27, 2021



# Writing Data to the EEPROM

To write data to the EEPROM, the EEPROM address of the data to be written must first be placed in the EEA register and the data placed in the EED register. To initiate a write cycle, the write enable bit, WREN, in the EEC register must first be set high to enable the write function. After this, the WR bit in the EEC register must be immediately set high to initiate a write cycle. These two instructions must be executed in two consecutive instruction cycles. The global interrupt bit EMI should also first be cleared before implementing any write operations, and then set again after the write cycle has started. Note that setting the WR bit high will not initiate a write cycle if the WREN bit has not been set. As the EEPROM write cycle is controlled using an internal timer whose operation is asynchronous to microcontroller system clock, a certain time will elapse before the data will have been written into the EEPROM. Detecting when the write cycle has finished can be implemented either by polling the WR bit in the EEC register or by using the EEPROM interrupt. When the write cycle terminates, the WR bit will be automatically cleared to zero by the microcontroller, informing the user that the data has been written to the EEPROM. The application program can therefore poll the WR bit to determine when the write cycle has ended.

#### **Write Protection**

Protection against inadvertent write operation is provided in several ways. After the device is powered-on the Write Enable bit in the control register will be cleared preventing any write operations. Also at power-on the Memory Pointer high byte register, MP1H or MP2H, will be reset to zero, which means that Data Memory Sector 0 will be selected. As the EEPROM control register is located in Sector 1, this adds a further measure of protection against spurious write operations. During normal program operation, ensuring that the Write Enable bit in the control register is cleared will safeguard against incorrect write operations.

### **EEPROM Interrupt**

The EEPROM write interrupt is generated when an EEPROM write cycle has ended. The EEPROM interrupt must first be enabled by setting the DEE bit in the relevant interrupt register. However as the EEPROM is contained within a Multi-function Interrupt, the associated multi-function interrupt enable bit must also be set. When an EEPROM write cycle ends, the DEF request flag will be set. If the global, EEPROM interrupts and Multi-function interrupts are enabled and the stack is not full, a jump to the Data EEPROM Interrupt vector will take place. When the interrupt is serviced only the Multi-function interrupt flag will be automatically reset, the EEPROM interrupt flag must be manually reset by the application program. More details can be obtained in the Interrupt section.

### **Programming Considerations**

Care must be taken that data is not inadvertently written to the EEPROM. Protection can be enhanced by ensuring that the Write Enable bit is normally cleared to zero when not writing. Also the Memory Pointer high byte register, MP1H or MP2H, could be normally cleared to zero as this would inhibit access to Sector 1 where the EEPROM control register exists. Although certainly not necessary, consideration might be given in the application program to the checking of the validity of new write data by a simple read back process.

When writing data the WR bit must be set high immediately after the WREN bit has been set high, to ensure the write cycle executes correctly. The global interrupt bit EMI should also be cleared before a write cycle is executed and then re-enabled after the write cycle starts. Note that the device should not enter the IDLE or SLEEP mode until the EEPROM read or write operation is totally complete. Otherwise, the EEPROM read or write operation will fail.

Rev. 1.00 64 August 27, 2021



### **Programming Examples**

### Reading data from the EEPROM - polling method

```
MOV A, EEPROM ADRES ; user defined address
MOV EEA, A
                       ; setup memory pointer MP1L
MOV A, 040H
MOV MP1L, A
                        ; MP1L points to EEC register
MOV A, 01H
                        ; setup memory pointer MP1H
MOV MP1H, A
SET IAR1.1
                        ; set RDEN bit, enable read operations
SET IAR1.0
                         ; start Read Cycle - set RD bit
BACK:
SZ IAR1.0
                      ; check for read cycle end
JMP BACK
CLR IAR1
                         ; disable EEPROM read if no more read operations are required
CLR MP1H
MOV A, EED
                          ; move read data to register
MOV READ DATA, A
```

Note: For each read operation, the address register should be re-specified followed by setting the RD bit high to activate a read cycle even if the target address is consecutive.

### Writing Data to the EEPROM - polling method

```
MOV A, EEPROM ADRES
                          ; user defined address
MOV EEA, A
MOV A, EEPROM DATA
                         ; user defined data
MOV EED, A
MOV A, 040H
                          ; setup memory pointer MP1L
MOV MP1L, A
                          ; MP1L points to EEC register
MOV A, 01H
                          ; setup memory pointer MP1H
MOV MP1H, A
CLR EMI
SET IAR1.3
                          ; set WREN bit, enable write operations
SET IAR1.2
                           ; start Write Cycle - set WR bit - executed immediately
                           ; after set WREN bit
SET EMI
BACK:
                         ; check for write cycle end
SZ IAR1.2
JMP BACK
CLR MP1H
```

Rev. 1.00 65 August 27, 2021



# **Oscillators**

Various oscillator options offer the user a wide range of functions according to their various application requirements. The flexible features of the oscillator functions ensure that the best optimisation can be achieved in terms of speed and power saving. Oscillator operations are selected through a combination of configuration options and relevant control registers.

#### **Oscillator Overview**

In addition to being the source of the main system clock the oscillators also provide clock sources for the Watchdog Timer and Time Base Interrupts. External oscillators requiring some external components as well as fully integrated internal oscillators, requiring no external components, are provided to form a wide range of both fast and slow system oscillators. The higher frequency oscillators provide higher performance but carry with it the disadvantage of higher power requirements, while the opposite is of course true for the lower frequency oscillators. With the capability of dynamically switching between fast and slow system clock, the device have the flexibility to optimize the performance/power ratio, a feature especially important in power sensitive portable applications.

Туре	Name	Frequency	Pins
Internal High Speed RC	HIRC	2/4/8MHz	_
External High Speed Crystal/Resonator Oscillator	HXT	400kHz~16MHz	OSC1/OSC2
Internal Low Speed RC	LIRC	32kHz	_
External Low Speed Crystal Oscillator	LXT	32.768kHz	XT1/XT2

**Oscillator Types** 

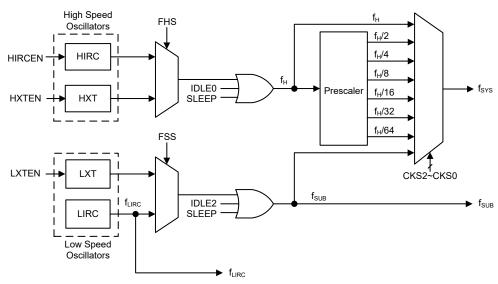
# **System Clock Configurations**

There are four methods of generating the system clock, two high speed oscillators and two low speed oscillators. The high speed system clocks are sourced from the internal 2/4/8MHz RC oscillator, HIRC, and the external crystal/ceramic oscillator, HXT. The low speed oscillators are the internal 32kHz RC oscillator, LIRC, and the external 32.768kHz crystal oscillator, LXT. Selecting whether the low or high speed oscillator is used as the system oscillator is implemented using the CKS2~CKS0 bits in the SCC register and as the system clock can be dynamically selected.

The actual source clock used for the low speed oscillators is chosen via the FSS bit in the SCC register. The frequency of the slow speed or high speed system clock is determined using the CKS2~CKS0 bits in the SCC register. Note that two oscillator selections must be made namely one high speed and one low speed system oscillators.

Rev. 1.00 66 August 27, 2021



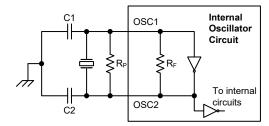


**System Clock Configurations** 

# External Crystal/Ceramic Oscillator - HXT

The External Crystal/Ceramic System Oscillator is the high frequency oscillator. For most crystal oscillator configurations, the simple connection of a crystal across OSC1 and OSC2 will create the necessary phase shift and feedback for oscillation, without requiring external capacitors. However, for some crystal types and frequencies, to ensure oscillation, it may be necessary to add two small value capacitors, C1 and C2. Using a ceramic resonator will usually require two small value capacitors, C1 and C2, to be connected as shown for oscillation to occur. The values of C1 and C2 should be selected in consultation with the crystal or resonator manufacturer's specification.

For oscillator stability and to minimise the effects of noise and crosstalk, it is important to ensure that the crystal and any associated resistors and capacitors along with interconnecting lines are all located as close to the MCU as possible.



Note: 1. R<sub>P</sub> is normally not required. C1 and C2 are required.
2. Although not shown OSC1/OSC2 pins have a parasitic capacitance of around 7pF.

Crystal/Resonator Oscillator - HXT

Rev. 1.00 67 August 27, 2021



HXT Oscillator C1 and C2 Values									
Crystal Frequency	C1	C2							
16MHz 0 pF 0 pF									
12MHz 0 pF 0 pF									
8MHz	0 pF	0 pF							
4MHz	0 pF	0 pF							
1MHz 100 pF 100 pF									
Note: C1 and C2 values are for guidance only.									

**Crystal Recommended Capacitor Values** 

# Internal High Speed RC Oscillator - HIRC

The high speed internal RC oscillator is a fully integrated system oscillator requiring no external components. The internal RC oscillator has three fixed frequencies of 2MHz, 4MHz and 8MHz, which are selected by the HIRC1~HIRC0 bits in the HIRCC register. These bits must also be setup to match the selected configuration option frequency to ensure that the HIRC frequency accuracy specified in the A.C. Characteristics is achieved. Device trimming during the manufacturing process and the inclusion of internal frequency compensation circuits are used to ensure that the influence of the power supply voltage, temperature and process variations on the oscillation frequency are minimised.

# External 32.768kHz Crystal Oscillator - LXT

The external 32.768kHz crystal system oscillator is one of the low frequency oscillator choices, which is selected via a software control bit, FSS. This clock source has a fixed frequency of 32.768kHz and requires a 32.768kHz crystal to be connected between pins XT1 and XT2. The external resistor and capacitor components connected to the 32.768kHz crystal are necessary to provide oscillation. For applications where precise frequencies are essential, these components may be required to provide frequency compensation due to different crystal manufacturing tolerances. After the LXT oscillator is enabled by setting the LXTEN bit to 1, there is a time delay associated with the LXT oscillator waiting for it to start-up.

When the microcontroller enters the SLEEP or IDLE Mode, the system clock is switched off to stop microcontroller activity and to conserve power. However, in many microcontroller applications it may be necessary to keep the internal timers operational even when the microcontroller is in the SLEEP or IDLE Mode. To do this, another clock, independent of the system clock, must be provided.

However, for some crystals, to ensure oscillation and accurate frequency generation, it is necessary to add two small value external capacitors, C1 and C2. The exact values of C1 and C2 should be selected in consultation with the crystal or resonator manufacturer's specification. The external parallel feedback resistor,  $R_{P_s}$  is required.

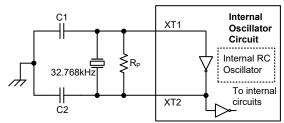
The pin-shared software control bits determine if the XT1/XT2 pins are used for the LXT oscillator or as I/O or other pin-shared functional pins.

- If the LXT oscillator is not used for any clock source, the XT1/XT2 pins can be used as normal I/O or other pin-shared functional pins.
- If the LXT oscillator is used for any clock source, the 32.768kHz crystal should be connected to the XT1/XT2 pins.

Rev. 1.00 68 August 27, 2021



For oscillator stability and to minimise the effects of noise and crosstalk, it is important to ensure that the crystal and any associated resistors and capacitors along with interconnecting lines are all located as close to the MCU as possible.



Note: 1. R<sub>P</sub>, C1 and C2 are required.

2. Although not shown XT1/XT2 pins have a parasitic capacitance of around 7pF.

#### **External LXT Oscillator**

LXT Oscillator C1 and C2 Values							
Crystal Frequency C1 C2							
32.768kHz	10pF	10pF					
Note: 1. C1 and C2 values a 2. R <sub>P</sub> =5MΩ~10MΩ is r							

32.768kHz Crystal Recommended Capacitor Values

#### **LXT Oscillator Low Power Function**

The LXT oscillator can function in one of two modes, the Speed-Up Mode and the Low Power Mode. The mode selection is executed using the LXTSP bit in the register.

LXTSP	LXT Mode		
0	Low Power		
1	Speed Up		

When the LXTSP bit is set to high, the LXT Speed-Up Mode will be enabled. In the Speed-Up Mode the LXT oscillator will power up and stabilise quickly. However, after the LXT oscillator has fully powered up, it can be placed into the Low-Power Mode by clearing the LXTSP bit to zero and the oscillator will continue to run but with reduced current consumption. It is important to note that the LXT operating mode switching must be properly controlled before the LXT oscillator clock is selected as the system clock source. Once the LXT oscil-lator clock is selected as the system clock source using the CKS bit field and FSS bit in the SCC register, the LXT oscillator operating mode can not be changed.

It should be noted that, no matter what condition the LXTSP bit is set to, the LXT oscillator will be always function normally, the only difference is that it will take more time to start up if it is in the Low-power mode.

#### Internal 32kHz Oscillator - LIRC

The internal 32kHz System Oscillator is also a fully integrated RC oscillator with a typical frequency of 32kHz, requiring no external components for its implementation. Device trimming during the manufacturing process and the inclusion of internal frequency compensation circuits are used to ensure that the influence of the power supply voltage, temperature and process variations on the oscillation frequency are minimised.

Rev. 1.00 69 August 27, 2021



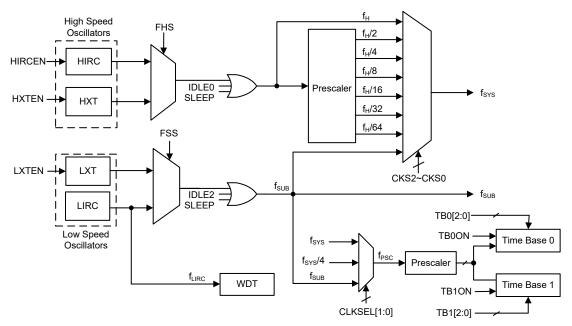
# **Operating Modes and System Clocks**

Present day applications require that their microcontrollers have high performance but often still demand that they consume as little power as possible, conflicting requirements that are especially true in battery powered portable applications. The fast clocks required for high performance will by their nature increase current consumption and of course vice versa, lower speed clocks reduce current consumption. As Holtek has provided the device with both high and low speed clock sources and the means to switch between them dynamically, the user can optimise the operation of their microcontroller to achieve the best performance/power ratio.

# **System Clocks**

The device has many different clock sources for both the CPU and peripheral function operation. By providing the user with a wide range of clock options using register programming, a clock system can be configured to obtain maximum application performance.

The main system clock, can come from a high frequency,  $f_{\rm H}$ , or low frequency,  $f_{\rm SUB}$ , source, and is selected using the CKS2~CKS0 bits in the SCC register. The high speed system clock is sourced from the HXT or HIRC oscillator, selected via configuring the FHS bit in the SCC register. The low speed system clock source can be sourced from the LXT or LIRC oscillator, selected via configuring the FSS bit in the SCC register. The other choice, which is a divided version of the high speed system oscillator has a range of  $f_{\rm H}/2\sim f_{\rm H}/64$ .



**Device Clock Configurations** 

Note: When the system clock source  $f_{SYS}$  is switched to  $f_{SUB}$  from  $f_H$ , the high speed oscillator will stop to conserve the power or continue to oscillate to provide the clock source,  $f_H \sim f_H/64$ , for peripheral circuit to use, which is determined by configuring the corresponding high speed oscillator enable control bit.

Rev. 1.00 70 August 27, 2021



# **System Operation Modes**

There are six different modes of operation for the microcontroller, each one with its own special characteristics and which can be chosen according to the specific performance and power requirements of the application. There are two modes allowing normal operation of the microcontroller, the FAST Mode and SLOW Mode. The remaining four modes, the SLEEP, IDLE0, IDLE1 and IDLE2 Modes are used when the microcontroller CPU is switched off to conserve power.

Operation	CPU		Register Se	tting		fн		furc
Mode	CPU	FHIDEN	FSIDEN	CKS2~CKS0	fsys	TH	fsuB	TLIRC
FAST	On	х	х	000~110	f <sub>H</sub> ∼f <sub>H</sub> /64	On	On	On
SLOW	On	х	х	111	f <sub>SUB</sub>	On/Off (1)	On	On
IDLE0	0 Off 0		1	000~110	Off	Off	On	On
IDLEO	Oii	0	ı	111	On	Oii	OII	On
IDLE1	Off	1	1	xxx	On	On	On	On
IDLE2	Off	1	0	000~110	On	05	Off	On
IDLEZ	IDLE2 Off 1 0	0	111	Off	On	Oll	On	
SLEEP	Off	0	0	xxx	Off	Off	Off	On <sup>(2)</sup>

"x": Don't care

- Note: 1. The  $f_H$  clock will be switched on or off by configuring the corresponding oscillator enable bit in the SLOW mode.
  - 2. The f<sub>LIRC</sub> clock will be switched on since the WDT function is always enabled even in the SLEEP mode.

#### **FAST Mode**

This is one of the main operating modes where the microcontroller has all of its functions operational and where the system clock is provided by the high speed oscillator. This mode operates allowing the microcontroller to operate normally with a clock source come from the high speed oscillators, either the HIRC or HXT, selected by the FHS bit in the SCC register. The high speed oscillator will however first be divided by a ratio ranging from 1 to 64, the actual ratio being selected by the CKS2~CKS0 bits in the SCC register. Although a high speed oscillator is used, running the microcontroller at a divided clock ratio reduces the operating current.

#### **SLOW Mode**

This is also a mode where the microcontroller operates normally although now with a slower speed clock source. The clock source used will be from  $f_{SUB}$ . The  $f_{SUB}$  clock is derived from the LIRC or LXT oscillator, selected by the FSS bit in the SCC register.

# **SLEEP Mode**

The SLEEP Mode is entered when a HALT instruction is executed and when the FHIDEN and FSIDEN bit both are low. In the SLEEP mode the CPU will be stopped. The  $f_{SUB}$  clock provided to the peripheral function will also be stopped. However, the  $f_{LIRC}$  clock still continues to operate since the WDT function is always enabled.

#### **IDLE0 Mode**

The IDLE0 Mode is entered when a HALT instruction is executed and when the FHIDEN bit in the SCC register is low and the FSIDEN bit in the SCC register is high. In the IDLE0 Mode the CPU will be switched off but the low speed oscillator will be turned on to drive some peripheral functions.

Rev. 1.00 71 August 27, 2021



#### **IDLE1 Mode**

The IDLE1 Mode is entered when a HALT instruction is executed and when the FHIDEN bit in the SCC register is high and the FSIDEN bit in the SCC register is high. In the IDLE1 Mode the CPU will be switched off but both the high and low speed oscillators will be turned on to provide a clock source to keep some peripheral functions operational.

#### **IDLE2 Mode**

The IDLE2 Mode is entered when a HALT instruction is executed and when the FHIDEN bit in the SCC register is high and the FSIDEN bit in the SCC register is low. In the IDLE2 Mode the CPU will be switched off but the high speed oscillator will be turned on to provide a clock source to keep some peripheral functions operational.

# **Control Registers**

The SCC, HIRCC, HXTC and LXTC registers are used to control the system clock and the corresponding oscillator configurations.

Register	Bit									
Name	7	6	5	4	3	2	1	0		
SCC	CKS2	CKS1	CKS0	_	FHS	FSS	FHIDEN	FSIDEN		
HIRCC	_	_	_	_	HIRC1	HIRC0	HIRCF	HIRCEN		
HXTC	_	_	_	_	_	HXTM	HXTF	HXTEN		
LXTC	_	_	_	_	_	LXTSP	LXTF	LXTEN		

System Operating Mode Control Register List

#### SCC Register

Bit	7	6	5	4	3	2	1	0
Name	CKS2	CKS1	CKS0	_	FHS	FSS	FHIDEN	FSIDEN
R/W	R/W	R/W	R/W	_	R/W	R/W	R/W	R/W
POR	0	0	0	_	0	0	0	0

Bit 7~5 CKS2~CKS0: System clock selection

000: f<sub>H</sub> 001: f<sub>H</sub>/2 010: f<sub>H</sub>/4 011: f<sub>H</sub>/8 100: f<sub>H</sub>/16 101: f<sub>H</sub>/32 110: f<sub>H</sub>/64 111: f<sub>SUB</sub>

These three bits are used to select which clock is used as the system clock source. In addition to the system clock source directly derived from  $f_H$  or  $f_{SUB}$ , a divided version of the high speed system oscillator can also be chosen as the system clock source.

Bit 4 Unimplemented, read as "0"

Bit 3 FHS: High frequency clock selection

0: HIRC 1: HXT

Bit 2 FSS: Low frequency clock selection

0: LIRC 1: LXT

Bit 1 FHIDEN: High Frequency oscillator control when CPU is switched off

0: Disable 1: Enable

This bit is used to control whether the high speed oscillator is activated or stopped when the CPU is switched off by executing a "HALT" instruction.

Rev. 1.00 72 August 27, 2021



Bit 0 **FSIDEN**: Low Frequency oscillator control when CPU is switched off

0: Disable 1: Enable

This bit is used to control whether the low speed oscillator is activated or stopped when the CPU is switched off by executing a "HALT" instruction.

Note: A certain delay is required before the relevant clock is successfully switched to the target clock source after any clock switching setup using the CKS2~CKS0 bits. A proper delay time must be arranged before executing the following operations which require immediate reaction with the target clock source.

Clock switching delay time =  $4 \times t_{SYS} + [0 \sim (1.5 \times t_{Curr.} + 0.5 \times t_{Tar.})]$ , where  $t_{Curr.}$  indicates the current clock period,  $t_{Tar.}$  indicates the target clock period and  $t_{SYS}$  indicates the current system clock period.

#### HIRCC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	HIRC1	HIRC0	HIRCF	HIRCEN
R/W	_	_	_	_	R/W	R/W	R	R/W
POR	_	_	_	_	0	0	0	1

Bit 7~4 Unimplemented, read as "0".

Bit 3~2 HIRC1~HIRC0: HIRC frequency selection

00: 2MHz 01: 4MHz 10: 8MHz 11: 2MHz

When the HIRC oscillator is enabled or the HIRC frequency selection is changed by the application program, the clock frequency will automatically be changed after the HIRCF flag is set to 1.

It is recommended that the HIRC frequency selected by these two bits should be the same with the frequency determined by the configuration option to achieve the HIRC frequency accuracy specified in the A.C. Characteristics.

Bit 1 HIRCF: HIRC oscillator stable flag

0: HIRC unstable 1: HIRC stable

This bit is used to indicate whether the HIRC oscillator is stable or not. When the HIRCEN bit is set to 1 to enable the HIRC oscillator, the HIRCF bit will first be cleared to 0 and then set to 1 after the HIRC oscillator is stable.

Bit 0 HIRCEN: HIRC oscillator enable control

0: Disable 1: Enable

# HXTC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	HXTM	HXTF	HXTEN
R/W	_	_	_	_	_	R/W	R	R/W
POR	_	_	_	_	_	0	0	0

Bit 7~3 Unimplemented, read as "0".

Bit 2 **HXTM**: HXT mode selection

0: HXT frequency ≤ 10MHz (sink/source current is smaller)
1: HXT frequency > 10MHz (sink/source current is larger)

Note that this bit should be configured correctly according to the used HXT frequency. If HXTM=0 while the HXT frequency is larger than 10MHz, the oscillation performance at a low voltage condition may be not well. If HXTM=1 while the HXT frequency is

less than 10MHz, the oscillator frequency and the current may be abnormal.

# BA45F5360 Smoke Detector Flash MCU with 12V Piezoelectric Horn Driver

This bit must be properly configured before the HXT is enabled. When the OSC1 and OSC2 pin functions have been enabled using relevant pin shared control bits and the HXTEN bit has been set to 1 to enable the HXT oscillator, it is invalid to change the value of the HXTM bit. When the OSC1 and OSC2 pin function is disabled, then the HXTM bit can be changed by software, regardless of the HXTEN bit value.

Bit 1 HXTF: HXT oscillator stable flag

0: HXT unstable 1: HXT stable

This bit is used to indicate whether the HXT oscillator is stable or not. When the HXTEN bit is set to 1 to enable the HXT oscillator, the HXTF bit will first be cleared to 0 and then set to 1 after the HXT oscillator is stable.

Bit 0 **HXTEN**: HXT oscillator enable control

0: Disable 1: Enable

#### LXTC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	LXTSP	LXTF	LXTEN
R/W	_	_	_	_	_	R/W	R	R/W
POR	_	_	_	_	_	0	0	0

Bit 7~3 Unimplemented, read as "0"

Bit 2 LXTSP: LXT speed-up control

0: Disable 1: Enable

This bit is used to control whether the LXT oscillator is operating in the low power or Speed-Up mode. When the LXTSP bit is set high, the LXT oscillator will oscillate quickly but consume more power. If the LXTSP bit is cleared to zero, the LXT oscillator will consume less power but take longer time to stablise. It is important to note that this bit cannot be changed after the LXT oscillator is selected as the system clock source using the CKS2~CKS0 and FSS bits in the SCC register

Bit 1 LXTF: LXT oscillator stable flag

0: LXT unstable 1: LXT stable

This bit is used to indicate whether the LXT oscillator is stable or not. When the LXTEN bit is set to 1 to enable the LXT oscillator, the LXTF bit will first be cleared to 0 and then set to 1 after the LXT oscillator is stable.

Bit 0 LXTEN: LXT oscillator enable control

0: Disable 1: Enable

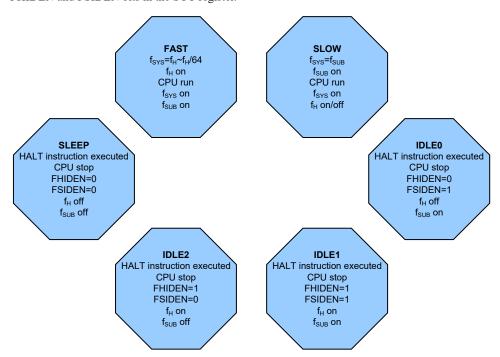
Rev. 1.00 74 August 27, 2021



# **Operating Mode Switching**

The device can switch between operating modes dynamically allowing the user to select the best performance/power ratio for the present task in hand. In this way microcontroller operations that do not require high performance can be executed using slower clocks thus requiring less operating current and prolonging battery life in portable applications.

In simple terms, Mode Switching between the FAST Mode and SLOW Mode is executed using the CKS2~CKS0 bits in the SCC register while Mode Switching from the FAST/SLOW Modes to the SLEEP/IDLE Modes is executed via the HALT instruction. When a HALT instruction is executed, whether the device enter the IDLE Mode or the SLEEP Mode is determined by the condition of the FHIDEN and FSIDEN bits in the SCC register.



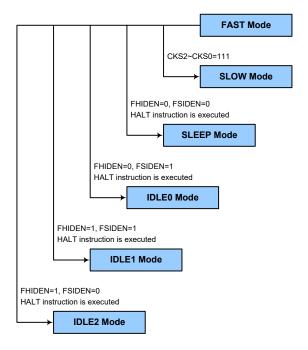
## **FAST Mode to SLOW Mode Switching**

When running in the FAST Mode, which uses the high speed system oscillator, and therefore consumes more power, the system clock can switch to run in the SLOW Mode by setting the CKS2~CKS0 bits to "111" in the SCC register. This will then use the low speed system oscillator which will consume less power. Users may decide to do this for certain operations which do not require high performance and can subsequently reduce power consumption.

The SLOW Mode system clock is sourced from the LXT or LIRC oscillator determined by the FSS bit in the SCC register and therefore requires these oscillators to be stable before full mode switching occurs.

Rev. 1.00 75 August 27, 2021

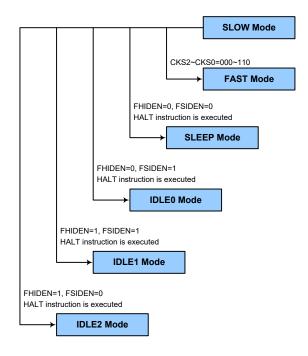




#### **SLOW Mode to FAST Mode Switching**

In SLOW mode the system clock is derived from  $f_{SUB}$ . When system clock is switched back to the FAST mode from  $f_{SUB}$ , the CKS2~CKS0 bits should be set to "000"~"110" and then the system clock will respectively be switched to  $f_{H}$ ~ $f_{H}$ /64.

However, if  $f_H$  is not used in SLOW mode and thus switched off, it will take some time to reoscillate and stabilise when switching to the FAST mode from the SLOW Mode. This is monitored using the HXTF bit in the HXTC register or the HIRCF bit in the HIRCC register. The time duration required for the high speed system oscillator stabilization is specified in the System Start Up Time Characteristics.



Rev. 1.00 76 August 27, 2021



#### **Entering the SLEEP Mode**

There is only one way for the device to enter the SLEEP Mode and that is to execute the "HALT" instruction in the application program with both the FHIDEN and FSIDEN bits in the SCC register equal to "0". In this mode all the clocks and functions will be switched off except the WDT function. When this instruction is executed under the conditions described above, the following will occur:

- The system clock will be stopped and the application program will stop at the "HALT" instruction.
- The Data Memory contents and registers will maintain their present condition.
- The I/O ports will maintain their present conditions.
- In the status register, the Power Down flag, PDF, will be set and the Watchdog time-out flag, TO, will be cleared.
- The WDT will be cleared and resume counting as the WDT function is always enabled.

#### **Entering the IDLE0 Mode**

There is only one way for the device to enter the IDLE0 Mode and that is to execute the "HALT" instruction in the application program with the FHIDEN bit in the SCC register equal to "0" and the FSIDEN bit in the SCC register equal to "1". When this instruction is executed under the conditions described above, the following will occur:

- The  $f_H$  clock will be stopped and the application program will stop at the "HALT" instruction, but the  $f_{SUB}$  clock will be on.
- The Data Memory contents and registers will maintain their present condition.
- · The I/O ports will maintain their present conditions.
- In the status register, the Power Down flag, PDF, will be set and the Watchdog time-out flag, TO, will be cleared.
- The WDT will be cleared and resume counting as the WDT function is always enabled.

## **Entering the IDLE1 Mode**

There is only one way for the device to enter the IDLE1 Mode and that is to execute the "HALT" instruction in the application program with both the FHIDEN and FSIDEN bits in the SCC register equal to "1". When this instruction is executed under the conditions described above, the following will occur:

- The f<sub>H</sub> and f<sub>SUB</sub> clocks will be on but the application program will stop at the "HALT" instruction.
- The Data Memory contents and registers will maintain their present condition.
- The I/O ports will maintain their present conditions.
- In the status register, the Power Down flag, PDF, will be set and the Watchdog time-out flag, TO, will be cleared.
- The WDT will be cleared and resume counting as the WDT function is always enabled.

#### **Entering the IDLE2 Mode**

There is only one way for the device to enter the IDLE2 Mode and that is to execute the "HALT" instruction in the application program with the FHIDEN bit in the SCC register equal to "1" and the FSIDEN bit in the SCC register equal to "0". When this instruction is executed under the conditions described above, the following will occur:

- The  $f_H$  clock will be on but the  $f_{SUB}$  clock will be off and the application program will stop at the "HALT" instruction.
- The Data Memory contents and registers will maintain their present condition.
- The I/O ports will maintain their present conditions.

Rev. 1.00 77 August 27, 2021



- In the status register, the Power Down flag, PDF, will be set and the Watchdog time-out flag, TO, will be cleared.
- The WDT will be cleared and resume counting as the WDT function is always enabled.

# **Standby Current Considerations**

As the main reason for entering the SLEEP or IDLE Mode is to keep the current consumption of the device to as low a value as possible, perhaps only in the order of several micro-amps in the IDLE1 and IDLE2 Mode, there are other considerations which must also be taken into account by the circuit designer if the power consumption is to be minimised. Special attention must be made to the I/O pins on the device. All high-impedance input pins must be connected to either a fixed high or low level as any floating input pins could create internal oscillations and result in increased current consumption. This also applies to the device which has different package types, as there may be unbonded pins. These must either be setup as outputs or if setup as inputs must have pull-high resistors connected.

Care must also be taken with the loads, which are connected to I/O pins, which are setup as outputs. These should be placed in a condition in which minimum current is drawn or connected only to external circuits that do not draw current, such as other CMOS inputs. Also note that additional standby current will also be required if the LIRC oscillator has enabled.

In the IDLE1 and IDLE2 Mode the high speed oscillator is on, if the peripheral function clock source is derived from the high speed oscillator, the additional standby current will also be perhaps in the order of several hundred micro-amps.

### Wake-up

To minimise power consumption the device can enter the SLEEP or any IDLE Mode, where the CPU will be switched off. However, when the device is woken up again, it will take a considerable time for the original system oscillator to restart, stabilise and allow normal operation to resume.

After the system enters the SLEEP or IDLE Mode, it can be woken up from one of various sources listed as follows:

- · An external falling edge on Port A
- · A system interrupt
- · A WDT overflow

When the device executes the "HALT" instruction, it will enter the IDLE or SLEEP mode and the PDF flag will be set high. The PDF flag is cleared to 0 if the device experiences a system power-up or executs the clear Watchdog Timer instruction.

If the system is woken up by a WDT overflow, a Watchdog Timer Time-out reset will be initiated and the TO flag will be set to 1. The TO flag is set high if a WDT time-out occurs, and causes a wake-up that only resets the Program Counter and Stack Pointer, the other flags remain in their original status.

Each pin on Port A can be setup using the PAWU register to permit a negative transition on the pin to wake-up the system. When a pin wake-up occurs, the program will resume execution at the instruction following the "HALT" instruction.

If the system is woken up by an interrupt, then two possible situations may occur. The first is where the related interrupt is disabled or the interrupt is enabled but the stack is full, in which case the program will resume execution at the instruction following the "HALT" instruction. In this situation, the interrupt which woke-up the device will not be immediately serviced, but will rather be serviced later when the related interrupt is finally enabled or when a stack level becomes free. The other situation is where the related interrupt is enabled and the stack is not full, in which case the regular interrupt response takes place. If an interrupt request flag is set high before entering the SLEEP or IDLE Mode, the wake-up function of the related interrupt will be disabled.

Rev. 1.00 78 August 27, 2021



# **Watchdog Timer**

The Watchdog Timer is provided to prevent program malfunctions or sequences from jumping to unknown locations, due to certain uncontrollable external events such as electrical noise.

# **Watchdog Timer Clock Source**

The Watchdog Timer clock source is provided by the internal clock,  $f_{LIRC}$  which is sourced from the LIRC oscillator. The LIRC internal oscillator has an approximate frequency of 32kHz and this specified internal clock period can vary with  $V_{DD}$ , temperature and process variations. The Watchdog Timer source clock is then subdivided by a ratio of  $2^8$  to  $2^{18}$  to give longer timeouts, the actual value being chosen using the WS2~WS0 bits in the WDTC register.

# **Watchdog Timer Control Register**

A single register, WDTC, controls the required timeout period as well as the enable and reset MCU operation.

## • WDTC Register

Bit	7	6	5	4	3	2	1	0
Name	WE4	WE3	WE2	WE1	WE0	WS2	WS1	WS0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	1	0	1	0	0	1	1

Bit 7~3 **WE4~WE0**: WDT function software control

01010/10101: Enable Others: Reset MCU

When these bits are changed by the environmental noise or software setting to reset the microcontroller, the reset operation will be activated after a delay time, t<sub>SRESET</sub> and the WRF bit in the RSTFC register will be set high.

Bit 2~0 WS2~WS0: WDT time-out period selection

000: 28/f<sub>LIRC</sub> 001: 2<sup>10</sup>/f<sub>LIRC</sub> 010: 2<sup>12</sup>/f<sub>LIRC</sub> 011: 2<sup>14</sup>/f<sub>LIRC</sub> 100: 2<sup>15</sup>/f<sub>LIRC</sub> 101: 2<sup>16</sup>/f<sub>LIRC</sub> 110: 2<sup>17</sup>/f<sub>LIRC</sub> 111: 2<sup>18</sup>/f<sub>LIRC</sub>

These three bits determine the division ratio of the watchdog timer source clock, which in turn determines the time-out period.

# RSTFC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	LVRF	_	WRF
R/W	_	_	_	_	_	R/W	_	R/W
POR	_	_	_	_	_	Х	_	0

"x": unknown

Bit 7~3 Unimplemented, read as "0"
Bit 2 LVRF: LVR function reset flag

Refer to the Low Voltage Reset section.

Bit 1 Unimplemented, read as "0"



Bit 0 WRF: WDTC register software reset flag

0: Not occurred 1: Occurred

This bit is set to 1 by the WDTC register software reset and cleared to zero by the application program. Note that this bit can be cleared to zero only by the application program.

# **Watchdog Timer Operation**

The Watchdog Timer operates by providing a device reset when its timer overflows. This means that in the application program and during normal operation the user has to strategically clear the Watchdog Timer before it overflows to prevent the Watchdog Timer from executing a reset. This is done using the clear watchdog instruction. If the program malfunctions for whatever reason, jumps to an unknown location, or enters an endless loop, the clear instruction will not be executed in the correct manner, in which case the Watchdog Timer will overflow and reset the device. There are five bits, WE4~WE0, in the WDTC register to offer the enable control and reset control of the Watchdog Timer. The WDT function will be enabled if the WE4~WE0 bits are equal to 01010B or 10101B. If the WE4~WE0 bits are set to any other values, other than 01010B and 10101B, it will reset the device after a delay time, t<sub>SRESET</sub>. After power on these bits will have a value of 01010B.

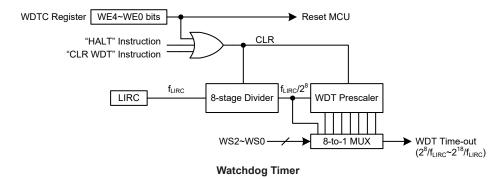
WE4~WE0 Bits	WDT Function
01010B or 10101B	Enable
Any other values	Reset MCU

Watchdog Timer Enable/Reset Control

Under normal program operation, a Watchdog Timer time-out will initialise a device reset and set the status bit TO high. However, if the system is in the SLEEP or IDLE Mode, when a Watchdog Timer time-out occurs, the TO bit in the status register will be set high and only the Program Counter and Stack Pointer will be reset. Three methods can be adopted to clear the contents of the Watchdog Timer. The first is a WDTC software reset, which means a certain value except 01010B and 10101B written into the WE4~WE0 bits, the second is using the Watchdog Timer software clear instruction and the third is via a HALT instruction.

There is only one method of using software instruction to clear the Watchdog Timer. That is to use the single "CLR WDT" instruction to clear the WDT.

The maximum time out period is when the  $2^{18}$  division ratio is selected. As an example, with a 32kHz LIRC oscillator as its source clock, this will give a maximum watchdog period of around 8 seconds for the  $2^{18}$  division ratio, and a minimum timeout of 8ms for the  $2^{8}$  division ration.



Rev. 1.00 80 August 27, 2021



# Reset and Initialisation

A reset function is a fundamental part of any microcontroller ensuring that the device can be set to some predetermined condition irrespective of outside parameters. The most important reset condition is after power is first applied to the microcontroller. In this case, internal circuitry will ensure that the microcontroller, after a short delay, will be in a well-defined state and ready to execute the first program instruction. After this power-on reset, certain important internal registers will be set to defined states before the program commences. One of these registers is the Program Counter, which will be reset to zero forcing the microcontroller to begin program execution from the lowest Program Memory address.

Another reset exists in the form of a Low Voltage Reset, LVR, where a full reset is implemented in situations where the power supply voltage falls below a certain threshold.

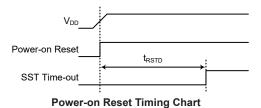
Another type of reset is when the Watchdog Timer overflows and resets the microcontroller. All types of reset operations result in different register conditions being setup.

#### **Reset Functions**

There are several ways in which a microcontroller reset can occur, through events occurring internally.

#### **Power-on Reset**

The most fundamental and unavoidable reset is the one that occurs after power is first applied to the microcontroller. As well as ensuring that the Program Memory begins execution from the first memory address, a power-on reset also ensures that certain other registers are preset to known conditions. All the I/O port and port control registers will power up in a high condition ensuring that all pins will be first set to inputs.



# Low Voltage Reset - LVR

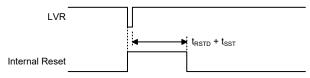
The microcontroller contains a low voltage reset circuit in order to monitor the supply voltage of the device and provide an MCU reset when the value falls below a certain predefined level.

The LVR function is always enabled in normal operation with a specific LVR voltage  $V_{LVR}$ . For the device the  $V_{LVR}$  value is fixed at 2.1V. If the supply voltage of the device drop to within a range of  $0.9V\sim V_{LVR}$  such as might occur when changing the battery in battery powered applications, the LVR will automatically reset the device internally and the LVRF bit in the RSTFC register will also be set to 1. For a valid LVR signal, a low supply voltage, i.e., a voltage in the range between  $0.9V\sim V_{LVR}$  must exist for a time greater than that specified by  $t_{LVR}$  in the LVD & LVR Electrical Characteristics. If the low supply voltage state does not exceed this value, the LVR will ignore the low supply voltage and will not perform a reset function.

Note that the LVR function will be automatically disabled when the device enters the SLEEP or IDLE mode.

Rev. 1.00 81 August 27, 2021





Low Voltage Reset Timing Chart

# • RSTFC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	LVRF	_	WRF
R/W	_	_	_	_	_	R/W	_	R/W
POR	_	_	_	_	_	Х	_	0

"x": unknown

Bit 7~3 Unimplemented, read as "0"
Bit 2 LVRF: LVR function reset flag

0: Not occur 1: Occurred

This bit is set to 1 when an actual Low Voltage Reset situation condition occurs. This

bit can be cleared to 0 only by the application program.

Bit 1 Unimplemented, read as "0"

Bit 0 WRF: WDTC register software reset flag

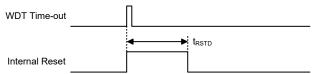
Refer to the Watchdog Timer Control Register section.

#### **IAP Reset**

When a specific value of "55H" is written into the FC1 register, a reset signal will be generated to reset the whole device. Refer to the IAP section for more associated details.

#### **Watchdog Time-out Reset during Normal Operation**

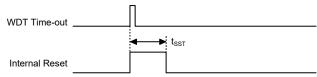
The Watchdog time-out Reset during normal operation in the FAST or SLOW mode is the same as a Power On reset except that the Watchdog time-out flag TO will be set to "1".



WDT Time-out Reset during Normal Operation Timing Chart

# Watchdog Time-out Reset during SLEEP or IDLE Mode

The Watchdog time-out Reset during SLEEP or IDLE Mode is a little different from other kinds of reset. Most of the conditions remain unchanged except that the Program Counter and the Stack Pointer will be cleared to "0" and the TO flag will be set to "1". Refer to the System Start Up Time Characteristics for t<sub>SST</sub> details.



WDT Time-out Reset during SLEEP or IDLE Timing Chart

Rev. 1.00 82 August 27, 2021



### **Reset Initial Conditions**

The different types of reset described affect the reset flags in different ways. These flags, known as PDF and TO are located in the status register and are controlled by various microcontroller operations, such as the SLEEP or IDLE Mode function or Watchdog Timer. The reset flags are shown in the table:

то	PDF	Reset Conditions			
0	0	Power-on reset			
u	u	LVR reset during FAST or SLOW Mode operation			
1	u	WDT time-out reset during FAST or SLOW Mode operation			
1	1	WDT time-out reset during IDLE or SLEEP Mode operation			

"u" stands for unchanged

The following table indicates the way in which the various components of the microcontroller are affected after a power-on reset occurs.

Item	Condition after Reset
Program Counter	Reset to zero
Interrupts	All interrupts will be disabled
WDT, Time Bases	Clear after reset, WDT begins counting
Timer Modules	Timer Modules will be turned off
Input/Output Ports	I/O ports will be setup as inputs
Stack Pointer	Stack Pointer will point to the top of the stack

The different kinds of resets all affect the internal registers of the microcontroller in different ways. To ensure reliable continuation of normal program execution after a reset occurs, it is important to know what condition the microcontroller is in after a particular reset occurs. The following table describes how each type of reset affects each of the microcontroller internal registers

Register	Power On Reset	WDT Time-out (Normal Operation)	WDT Time-out (IDLE/SLEEP)
IAR0	0000 0000	0000 0000	uuuu uuuu
MP0	0000 0000	0000 0000	uuuu uuuu
IAR1	0000 0000	0000 0000	uuuu uuuu
MP1L	0000 0000	0000 0000	uuuu uuuu
MP1H	0000 0000	0000 0000	uuuu uuuu
ACC	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	0000 0000	0000 0000	0000 0000
TBLP	xxxx xxxx	uuuu uuuu	uuuu uuuu
TBLH	xxxx xxxx	uuuu uuuu	uuuu uuuu
ТВНР	xx xxxx	uu uuuu	uu uuuu
STATUS	xx00 xxxx	uu1u uuuu	uu11 uuuu
PBP	0	0	u
IAR2	0000 0000	0000 0000	uuuu uuuu
MP2L	0000 0000	0000 0000	uuuu uuuu
MP2H	0000 0000	0000 0000	uuuu uuuu
RSTFC	x - 0	u - u	u - u
SCC	000-0000	000- 0000	uuu- uuuu
HIRCC	0001	0001	uuuu
HXTC	000	000	u u u

Rev. 1.00 83 August 27, 2021



Register	Power On Reset	WDT Time-out (Normal Operation)	WDT Time-out (IDLE/SLEEP)
LXTC	000	000	u u u
PA	1111 1111	1111 1111	uuuu uuuu
PAC	1111 1111	1111 1111	uuuu uuuu
PAPU	0000 0000	0000 0000	uuuu uuuu
PAWU	0000 0000	0000 0000	uuuu uuuu
PB	1111 1111	1111 1111	uuuu uuuu
PBC	1111 1111	1111 1111	uuuu uuuu
PBPU	0000 0000	0000 0000	uuuu uuuu
PC	11 1111	11 1111	uu uuuu
PCC	11 1111	11 1111	uu uuuu
PCPU	00 0000	00 0000	uu uuuu
PD	1111	1111	uuuu
PDC	1111	1111	uuuu
PDPU	0000	0000	uuuu
WDTC	0101 0011	0101 0011	uuuu uuuu
SDSW	-000 0000	-000 0000	-uuu uuuu
SDPGAC0	00 0000	00 0000	uu uuuu
SDPGAC1	0000 0000	0000 0000	uuuu uuuu
SDA0C	-0000	-0000	-uuuu
SDA0VOS	0010 0000	0010 0000	uuuu uuuu
SDA1C	-0000	-0000	- u u u u
SDA1VOS	0010 0000	0010 0000	uuuu uuuu
SADC0	0000 0000	0000 0000	uuuu uuuu
SADC1	0000 0000	0000 0000	uuuu uuuu
SADC2	1 0	1 0	u u
SADOH	xxxx xxxx (ADRFS=0)	xxxx xxxx (ADRFS=0)	uuuu uuuu (ADRFS=0)
SADON	xxxx (ADRFS=1)	xxxx (ADRFS=1)	uuuu (ADRFS=1)
SADOL	xxxx (ADRFS=0)	xxxx (ADRFS=0)	uuuu (ADRFS=0)
SADOL	xxxx xxxx (ADRFS=1)	xxxx xxxx (ADRFS=1)	uuuu uuuu (ADRFS=1)
LMSADOH	xxxx xxxx	uuuu uuuu	uuuu uuuu
LMSADOL	x x x x	uuuu	uuuu
PLTSW	001	001	u u u
PLTDACC	000	000	u u u
PLTDA0L	00 0000	00 0000	uu uuuu
PLTDA1L	00 0000	00 0000	uu uuuu
PLTDA2L	00 0000	00 0000	uu uuuu
PLTC0C	000- 0000	000- 0000	uuu- uuuu
PLTC0VOS	-001 0000	-001 0000	-uuu uuuu



Register	Power On Reset	WDT Time-out (Normal Operation)	WDT Time-out (IDLE/SLEEP)
PLTC1C	000- 0000	000-0000	uuu- uuuu
PLTC1VOS	-001 0000	-001 0000	-uuu uuuu
PLTCHYC	-000 0000	-000 0000	-uuu uuuu
PLTAC	-000	-000	- u u u
PLTAVOS	0010 0000	0010 0000	uuuu uuuu
EEA	0000 0000	0000 0000	uuuu uuuu
EED	0000 0000	0000 0000	uuuu uuuu
ISGENC	0 0 0	0 0 0	u u u
ISGDATA0	0 0000	0 0000	u uuuu
ISGDATA1	0 0000	0 0000	u uuuu
INTEG	0000	0000	uuuu
INTC0	-000 0000	-000 0000	-uuu uuuu
INTC1	0000 0000	0000 0000	uuuu uuuu
INTC2	0000 0000	0000 0000	uuuu uuuu
INTC3	-000 -000	-000 -000	-uuu -uuu
MFI0	0000	0000	uuuu
MFI1	0000	0000	uuuu
MFI2	0000	0000	uuuu
MFI3	-000 -000	-000 -000	-uuu -uuu
MFI4	-000 -000	-000 -000	-uuu -uuu
MFI5	0000	0000	uuuu
VBGRC	0	0	u
ORMC	0000 0000	0000 0000	0000 0000
LVDC	00 0000	00 0000	uu uuuu
PSCR	0 0	0 0	u u
TB0C	0000	0000	uuuu
TB1C	0000	0000	uuuu
SIMC0	111- 0000	111- 0000	uuu- uuu0
SIMC1	1000 0001	1000 0001	uuuu uuuu
SIMD	xxxx xxxx	xxxx xxxx	uuuu uuuu
SIMA	0000 0000	0000 0000	uuuu uuuu
SIMC2	0000 0000	0000 0000	uuuu uuuu
SIMTOC	0000 0000	0000 0000	uuuu uuuu
UOSR	0000 1011	0000 1011	uuuu uuuu
U0CR1	0000 00x0	0000 00x0	uuuu uuuu
U0CR2	0000 0000	0000 0000	uuuu uuuu
U0CR3	0	0	u
TXR_RXR0	xxxx xxxx	xxxx xxxx	uuuu uuuu
BRG0	xxxx xxxx	xxxx xxxx	uuuu uuuu
STM0C0	0000 0000	0000 0000	uuuu uuuu
STM0C1	0000 0000	0000 0000	uuuu uuuu
STM0DL	0000 0000	0000 0000	uuuu uuuu



Register	Power On Reset	WDT Time-out (Normal Operation)	WDT Time-out (IDLE/SLEEP)
STM0DH	00	0 0	u u
STM0AL	0000 0000	0000 0000	uuuu uuuu
STM0AH	00	0 0	u u
PTM0C0	0000 0	0000 0	uuuu u
PTM0C1	0000 0000	0000 0000	uuuu uuuu
PTM0C2	000	000	u u u
PTM0DL	0000 0000	0000 0000	uuuu uuuu
PTM0DH	0 0	0 0	u u
PTM0AL	0000 0000	0000 0000	uuuu uuuu
PTM0AH	0 0	0 0	u u
PTM0BL	0000 0000	0000 0000	uuuu uuuu
РТМ0ВН	0 0	0 0	u u
PTM0RPL	0000 0000	0000 0000	uuuu uuuu
PTM0RPH	0 0	0 0	u u
DAH	0000 0000	0000 0000	uuuu uuuu
DAL	0000 0000	0000 0000	uuuu uuuu
DACC	0	0	u
FC0	0000 0000	0000 0000	uuuu uuuu
FC1	0000 0000	0000 0000	uuuu uuuu
FC2	0	0	u
FARL	0000 0000	0000 0000	uuuu uuuu
FARH	00 0000	00 0000	uu uuuu
FD0L	0000 0000	0000 0000	uuuu uuuu
FD0H	0000 0000	0000 0000	uuuu uuuu
FD1L	0000 0000	0000 0000	uuuu uuuu
FD1H	0000 0000	0000 0000	uuuu uuuu
FD2L	0000 0000	0000 0000	uuuu uuuu
FD2H	0000 0000	0000 0000	uuuu uuuu
FD3L	0000 0000	0000 0000	uuuu uuuu
FD3H	0000 0000	0000 0000	uuuu uuuu
STM1C0	0000 0000	0000 0000	uuuu uuuu
STM1C1	0000 0000	0000 0000	uuuu uuuu
STM1DL	0000 0000	0000 0000	uuuu uuuu
STM1DH	00	0 0	u u
STM1AL	0000 0000	0000 0000	uuuu uuuu
STM1AH	0 0	0 0	u u
PTM1C0	0000 0	0000 0	uuuu u
PTM1C1	0000 0000	0000 0000	uuuu uuuu
PTM1DL	0000 0000	0000 0000	uuuu uuuu
PTM1DH	0 0	0 0	u u
PTM1AL	0000 0000	0000 0000	uuuu uuuu
PTM1AH	0 0	0 0	u u



Register	Power On Reset	WDT Time-out (Normal Operation)	WDT Time-out (IDLE/SLEEP)
PTM1RPL	0000 0000	0000 0000	uuuu uuuu
PTM1RPH	0 0	0 0	u u
PTM2C0	0000 0	0000 0	uuuu u
PTM2C1	0000 0000	0000 0000	uuuu uuuu
PTM2DL	0000 0000	0000 0000	uuuu uuuu
PTM2DH	0 0	0 0	u u
PTM2AL	0000 0000	0000 0000	uuuu uuuu
PTM2AH	0 0	0 0	u u
PTM2RPL	0000 0000	0000 0000	uuuu uuuu
PTM2RPH	0 0	0 0	u u
SLEDC0	0000 0000	0000 0000	uuuu uuuu
SLEDC1	00 0000	00 0000	uu uuuu
PMPS0	0000 0000	0000 0000	uuuu uuuu
PMPS1	00 0000	00 0000	uu uuuu
U1SR	0000 1011	0000 1011	uuuu uuuu
U1CR1	0000 00x0	0000 00x0	uuuu uuuu
U1CR2	0000 0000	0000 0000	uuuu uuuu
U1CR3	0	0	u
TXR_RXR1	xxxx xxxx	xxxx xxxx	uuuu uuuu
BRG1	xxxx xxxx	xxxx xxxx	uuuu uuuu
EEC	0000	0000	uuuu
PAS0	0000 0000	0000 0000	uuuu uuuu
PAS1	0000 0000	0000 0000	uuuu uuuu
PBS0	0000 0000	0000 0000	uuuu uuuu
PBS1	0000 0000	0000 0000	uuuu uuuu
PCS0	0000 0000	0000 0000	uuuu uuuu
PCS1	0000	0000	uuuu
PDS0	0000 0000	0000 0000	uuuu uuuu
IFS0	0000 0000	0000 0000	uuuu uuuu
IFS1	00 0000	00 0000	uu uuuu

Note: "u" stands for unchanged

"x" stands for unknown
"-" stands for unimplemented



# **Input/Output Ports**

Holtek microcontrollers offer considerable flexibility on their I/O ports. With the input or output designation of every pin fully under user program control, pull-high selections for all ports and wake-up selections on certain pins, the user is provided with an I/O structure to meet the needs of a wide range of application possibilities.

The device provide bidirectional input/output lines labeled with port names PA~PD. These I/O ports are mapped to the RAM Data Memory with specific addresses as shown in the Special Purpose Data Memory table. All of these I/O ports can be used for input and output operations. For input operation, these ports are non-latching, which means the inputs must be ready at the T2 rising edge of instruction "MOV A, [m]", where m denotes the port address. For output operation, all the data is latched and remains unchanged until the output latch is rewritten.

Register				В	it			
Name	7	6	5	4	3	2	1	0
PA	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0
PAC	PAC7	PAC6	PAC5	PAC4	PAC3	PAC2	PAC1	PAC0
PAPU	PAPU7	PAPU6	PAPU5	PAPU4	PAPU3	PAPU2	PAPU1	PAPU0
PAWU	PAWU7	PAWU6	PAWU5	PAWU4	PAWU3	PAWU2	PAWU1	PAWU0
РВ	PB7	PB6	PB5	PB4	PB3	PB2	PB1	PB0
PBC	PBC7	PBC6	PBC5	PBC4	PBC3	PBC2	PBC1	PBC0
PBPU	PBPU7	PBPU6	PBPU5	PBPU4	PBPU3	PBPU2	PBPU1	PBPU0
PC	_	_	PC5	PC4	PC3	PC2	PC1	PC0
PCC	_	_	PCC5	PCC4	PCC3	PCC2	PCC1	PCC0
PCPU	_	_	PCPU5	PCPU4	PCPU3	PCPU2	PCPU1	PCPU0
PD	_	_	_	_	PD3	PD2	PD1	PD0
PDC	_	_	_	_	PDC3	PDC2	PDC1	PDC0
PDPU	_	_	_	_	PDPU3	PDPU2	PDPU1	PDPU0

"-": Unimplemented, read as "0"

I/O Logic Function Register List

#### **Pull-high Resistors**

Many product applications require pull-high resistors for their switch inputs usually requiring the use of an external resistor. To eliminate the need for these external resistors, all I/O pins, when configured as a digital input have the capability of being connected to an internal pull-high resistor. These pull-high resistors are selected using registers PAPU~PDPU, and are implemented using weak PMOS transistors.

Note that the pull-high resistor can be controlled by the relevant pull-high control register only when the pin-shared functional pin is selected as a digital input or NMOS output. Otherwise, the pull-high resistors cannot be enabled.

#### PxPU Register

Bit	7	6	5	4	3	2	1	0
Name	PxPU7	PxPU6	PxPU5	PxPU4	PxPU3	PxPU2	PxPU1	PxPU0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

PxPUn: I/O Port x Pin pull-high function control

0: Disable

1: Enable

The PxPUn bit is used to control the pin pull-high function. Here the "x" can be A, B, C and D. However, the actual available bits for each I/O Port may be different.

Rev. 1.00 88 August 27, 2021



### Port A Wake-up

The HALT instruction forces the microcontroller into the SLEEP or IDLE Mode which preserves power, a feature that is important for battery and other low-power applications. Various methods exist to wake-up the microcontroller, one of which is to change the logic condition on one of the Port A pins from high to low. This function is especially suitable for applications that can be woken up via external switches. Each pin on Port A can be selected individually to have this wake-up feature using the PAWU register.

Note that the wake-up function can be controlled by the wake-up control registers only when the pin is selected as a general purpose input and the MCU enters the IDLE or SLEEP mode.

## PAWU Register

Bit	7	6	5	4	3	2	1	0
Name	PAWU7	PAWU6	PAWU5	PAWU4	PAWU3	PAWU2	PAWU1	PAWU0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0 PAWU7~PAWU0: PA7~PA0 wake-up function control

0: Disable 1: Enable

## I/O Port Control Registers

Each I/O port has its own control register known as PAC~PDC, to control the input/output configuration. With this control register, each CMOS output or input can be reconfigured dynamically under software control. Each pin of the I/O ports is directly mapped to a bit in its associated port control register. For the I/O pin to function as an input, the corresponding bit of the control register must be written as a "1". This will then allow the logic state of the input pin to be directly read by instructions. When the corresponding bit of the control register is written as a "0", the I/O pin will be setup as a CMOS output. If the pin is currently setup as an output, instructions can still be used to read the output register. However, it should be noted that the program will in fact only read the status of the output data latch and not the actual logic status of the output pin.

#### PxC Register

Bit	7	6	5	4	3	2	1	0
Name	PxC7	PxC6	PxC5	PxC4	PxC3	PxC2	PxC1	PxC0
R/W								
POR	1	1	1	1	1	1	1	1

PxCn: I/O Port x Pin type selection

0: Output 1: Input

The PxCn bit is used to control the pin type selection. Here the "x" can be A, B, C and D. However, the actual available bits for each I/O Port may be different.

## I/O Port Power Source Control

This device supports different I/O port power source selections for PA0, PA2, PA3, PA6, PA7, PC4 and PC5 pins. The port power can come from the power pin VDD or VDDIO, which is determined using the corresponding bit fields in the PMPS0~PMPS1 registers. The VDDIO power pin function should first be selected using the corresponding pin-shared function selection bits if the port power is supposed to come from the VDDIO pin. An important point to know is that the input power voltage on the VDDIO pin should be equal to or less than the device supply power voltage VDD when the VDDIO pin is selected as the port power supply pin. Note that the multi-power function is only available when the pin function is selected as digital input or output function.



### • PMPS0 Register

Bit	7	6	5	4	3	2	1	0
Name	PMPS07	PMPS06	PMPS05	PMPS04	PMPS03	PMPS02	PMPS01	PMPS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 PMPS07~PMPS06: PA6 pin power supply selection

 $0x: V_{DD}$  $1x: V_{DDIO}$ 

Bit 5~4 PMPS05~PMPS04: PA3 pin power supply selection

 $0x: V_{DD}$  $1x: V_{DDIO}$ 

Bit 3~2 PMPS03~PMPS02: PA2 pin power supply selection

 $0x: V_{DD}$  $1x: V_{DDIO}$ 

Bit 1~0 **PMPS01~PMPS00**: PA0 pin power supply selection

 $0x: V_{DD}$  $1x: V_{DDIO}$ 

#### • PMPS1 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	PMPS15	PMPS14	PMPS13	PMPS12	PMPS11	PMPS10
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5~4 PMPS15~PMPS14: PC5 pin power supply selection

 $0x: V_{DD}$  $1x: V_{DDIO}$ 

Bit 3~2 **PMPS13~PMPS12**: PC4 pin power supply selection

 $0x: V_{DD}$  $1x: V_{DDIO}$ 

Bit 1~0 **PMPS11~PMPS10**: PA7 pin power supply selection

 $0x: V_{DD} \\ 1x: V_{DDIO}$ 

If the PB4 pin is switched to the VDDIO function, and the PMPS07~PMPS00 and PMPS15~PMPS10 bits are set to "1x", the VDDIO pin input voltage can be used for PA0, PA2, PA3, PA6, PA7, PC4, PC5 pin power.

# I/O Port Source Current Control

Each pin in this device can be configured with different output source current which is selected by the corresponding source current selection bits. These source current selection bits are available when the corresponding pin is configured as a CMOS output. Otherwise, these select bits have no effect. Users should refer to the Input/Output Characteristics section to obtain the exact value for different applications.

Register				В	it			
Name	7	6	5	4	3	2	1	0
SLEDC0	SLEDC07	SLEDC06	SLEDC05	SLEDC04	SLEDC03	SLEDC02	SLEDC01	SLEDC00
SLEDC1	_	_	SLEDC15	SLEDC14	SLEDC13	SLEDC12	SLEDC11	SLEDC10

**Source Current Selection Register List** 

Rev. 1.00 90 August 27, 2021



# SLEDC0 Register

Bit	7	6	5	4	3	2	1	0
Name	SLEDC07	SLEDC06	SLEDC05	SLEDC04	SLEDC03	SLEDC02	SLEDC01	SLEDC00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

#### Bit 7~6 **SLEDC07~SLEDC06**: PB7~PB4 source current selection

00: Source current=Level 0 (Min.)

01: Source current=Level 1

10: Source current=Level 2

11: Source current=Level 3 (Max.)

# Bit 5~4 **SLEDC05~SLEDC04**: PB3~PB0 source current selection

00: Source current=Level 0 (Min.)

01: Source current=Level 1

10: Source current=Level 2

11: Source current=Level 3 (Max.)

#### Bit 3~2 SLEDC03~SLEDC02: PA7~PA4 source current selection

00: Source current=Level 0 (Min.)

01: Source current=Level 1

10: Source current=Level 2

11: Source current=Level 3 (Max.)

#### Bit 1~0 SLEDC01~SLEDC00: PA3~PA0 source current selection

00: Source current=Level 0 (Min.)

01: Source current=Level 1

10: Source current=Level 2

11: Source current=Level 3 (Max.)

#### SLEDC1 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	SLEDC15	SLEDC14	SLEDC13	SLEDC12	SLEDC11	SLEDC10
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

#### Bit 7~6 Unimplemented, read as "0"

#### Bit 5~4 SLEDC15~SLEDC14: PD3~PD0 source current selection

00: Source current=Level 0 (Min.)

01: Source current=Level 1

10: Source current=Level 2

11: Source current=Level 3 (Max.)

# Bit 3~2 **SLEDC13~SLEDC12**: PC5~PC4 source current selection

00: Source current=Level 0 (Min.)

01: Source current=Level 1

10: Source current=Level 2

11: Source current=Level 3 (Max.)

# Bit 1~0 SLEDC11~SLEDC10: PC3~PC0 source current selection

00: Source current=Level 0 (Min.)

01: Source current=Level 1

10: Source current=Level 2

11: Source current=Level 3 (Max.)



### **Pin-shared Functions**

The flexibility of the microcontroller range is greatly enhanced by the use of pins that have more than one function. Limited numbers of pins can force serious design constraints on designers but by supplying pins with multi-functions, many of these difficulties can be overcome. For these pins, the desired function of the multi-function I/O pins is selected by a series of registers via the application program control.

#### **Pin-shared Function Selection Registers**

The limited number of supplied pins in a package can impose restrictions on the amount of functions a certain device can contain. However by allowing the same pins to share several different functions and providing a means of function selection, a wide range of different functions can be incorporated into even relatively small package sizes. The device includes Port "x" Output Function Selection register "n", labeled as PxSn, and Input Function Selection register, labeled as IFSn, which can select the desired functions of the multi-function pin-shared pins.

The most important point to note is to make sure that the desired pin-shared function is properly selected and also deselected. For most pin-shared functions, to select the desired pin-shared function, the pin-shared function should first be correctly selected using the corresponding pin-shared control register. After that the corresponding peripheral functional setting should be configured and then the peripheral function can be enabled. However, a special point must be noted for some digital input pins, such as INTn, xTCKn, xTPnI, etc, which share the same pin-shared control configuration with their corresponding general purpose I/O functions when setting the relevant pin-shared control bit fields. To select these pin functions, in addition to the necessary pin-shared control and peripheral functional setup aforementioned, they must also be set as an input by setting the corresponding bit in the I/O port control register. To correctly deselect the pin-shared function, the peripheral function should first be disabled and then the corresponding pin-shared function control register can be modified to select other pin-shared functions.

Register				В	it			
Name	7	6	5	4	3	2	1	0
PAS0	PAS07	PAS06	PAS05	PAS04	PAS03	PAS02	PAS01	PAS00
PAS1	PAS17	PAS16	PAS15	PAS14	PAS13	PAS12	PAS11	PAS10
PBS0	PBS07	PBS06	PBS05	PBS04	PBS03	PBS02	PBS01	PBS00
PBS1	PBS17	PBS16	PBS15	PBS14	PBS13	PBS12	PBS11	PBS10
PCS0	PCS07	PCS06	PCS05	PCS04	PCS03	PCS02	PCS01	PCS00
PCS1	_	_	_	_	PCS13	PCS12	PCS11	PCS10
PDS0	PDS07	PDS06	PDS05	PDS04	PDS03	PDS02	PDS01	PDS00
IFS0	IFS07	IFS06	IFS05	IFS04	IFS03	IFS02	IFS01	IFS00
IFS1	_	_	IFS15	IFS14	IFS13	IFS12	IFS11	IFS10

**Pin-shared Function Selection Register List** 

#### PAS0 Register

Bit	7	6	5	4	3	2	1	0
Name	PAS07	PAS06	PAS05	PAS04	PAS03	PAS02	PAS01	PAS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 PAS07~PAS06: PA3 Pin-shared function selection

00: PA3/INT0/STP1I

01: SDO 10: TX0 11: AN3

Rev. 1.00 92 August 27, 2021



Bit 5~4 PAS05~PAS04: PA2 Pin-shared function selection

00: PA2 01: SDI/SDA 10: RX0/TX0 11: PTP2B

Bit 3~2 PAS03~PAS02: PA1 Pin-shared function selection

00: PA1/INT1 01: SCS 10: A1O 11: A1PI

Bit 1~0 PAS01~PAS00: PA0 Pin-shared function selection

00: PA0 01: SCL/SCK 10:PTP1B 11: PA0

# • PAS1 Register

Bit	7	6	5	4	3	2	1	0
Name	PAS17	PAS16	PAS15	PAS14	PAS13	PAS12	PAS11	PAS10
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 PAS17~PAS16: PA7 Pin-shared function selection

00: PA7/STP0I/PTP0I 01: SCK/SCL 10: AN1

Bit 5~4 PAS15~PAS14: PA6 Pin-shared function selection

00: PA6 01: PTP0 10: SDI/SDA 11: RX0/TX0

11: VREF

Bit 3~2 PAS13~PAS12: PA5 Pin-shared function selection

00: PA5/STCK0 01: STP1B 10: A1O 11: PA5/STCK0

Bit 1~0 PAS11~PAS10: PA4 Pin-shared function selection

00: PA4/PTCK0 01: STP0B 10: AN0 11: A0O

# • PBS0 Register

Bit	7	6	5	4	3	2	1	0
Name	PBS07	PBS06	PBS05	PBS04	PBS03	PBS02	PBS01	PBS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 **PBS07~PBS06**: PB3 Pin-shared function selection

00: PB3 01: PLRX 10: SDI/SDA 11: RX0/TX0



Bit 5~4 **PBS05~PBS04**: PB2 Pin-shared function selection

00: PB2 01: PLIS 10: SCK/SCL 11: DACO

Bit 3~2 **PBS03~PBS02**: PB1 Pin-shared function selection

00: PB1 01: PLTX 10: SDO 11: TX0

Bit 1~0 **PBS01~PBS00**: PB0 Pin-shared function selection

00: PB0/INT0 01: STP0 10: A0PB 11: DACO

# • PBS1 Register

Bit	7	6	5	4	3	2	1	0
Name	PBS17	PBS16	PBS15	PBS14	PBS13	PBS12	PBS11	PBS10
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 **PBS17~PBS16**: PB7 Pin-shared function selection

00: <u>PB7</u> 01: <u>SCS</u> 10: AN6 11: PTP1

Bit 5~4 PBS15~PBS14: PB6 Pin-shared function selection

00: PB6 01: AN5 10: DACO 11: PTP2

Bit 3~2 **PBS13~PBS12**: PB5 Pin-shared function selection

00: PB5 01: TX0 10: STP0B 11: AN4

Bit 1~0 **PBS11~PBS10**: PB4 Pin-shared function selection

00: <u>PB4</u> 01: <u>SCS</u> 10: AN2 11: VDDIO

# PCS0 Register

Bit	7	6	5	4	3	2	1	0
Name	PCS07	PCS06	PCS05	PCS04	PCS03	PCS02	PCS01	PCS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 PCS07~PCS06: PC3 Pin-shared function selection

00: PC3 01: SCK/SCL 10: TX1 11: PC3



Bit 5~4 PCS05~PCS04: PC2 Pin-shared function selection

00: PC2 01: SDI/SDA 10: RX1/TX1 11: PC2

Bit 3~2 PCS03~PCS02: PC1 Pin-shared function selection

00: PC1 01: TX0 10: SDO 11: PC1

Bit 1~0 PCS01~PCS00: PC0 Pin-shared function selection

00: PC0 01: RX0/TX0 10: AN7 11: PC0

# PCS1 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	PCS13	PCS12	PCS11	PCS10
R/W	_	_	_	_	R/W	R/W	R/W	R/W
POR	_	_	_	_	0	0	0	0

Bit 7~4 Unimplemented, read as "0"

Bit 3~2 PCS13~PCS12: PC5 Pin-shared function selection

00: PC5 01: STP1 10: STP0 11: TX1

Bit 1~0 PCS11~PCS10: PC4 Pin-shared function selection

00: PC4/STCK1 01: PTP0B 10: RX1/TX1 11: PC4/STCK1

## PDS0 Register

Bit	7	6	5	4	3	2	1	0
Name	PDS07	PDS06	PDS05	PDS04	PDS03	PDS02	PDS01	PDS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 PDS07~PDS06: PD3 Pin-shared function selection

00: PD3/PTCK2 01: AN11 10: PTP1B 11: XT2

Bit 5~4 **PDS05~PDS04**: PD2 Pin-shared function selection

00: PD2/PTP2I 01: AN10 10: PTP1 11: XT1

Bit 3~2 **PDS03~PDS02**: PD1 Pin-shared function selection

00: PD1/PTP1I 01: AN8 10: PTP2 11: OSC1



Bit 1~0 **PDS01~PDS00**: PD0 Pin-shared function selection

00: PD0/PTCK1

01: AN9 10: PTP2B 11: OSC2

# • IFS0 Register

Bit	7	6	5	4	3	2	1	0
Name	IFS07	IFS06	IFS05	IFS04	IFS03	IFS02	IFS01	IFS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 IFS07~IFS06: PTP0I input source selection

00: CXCAP

01: PA7

10: CXCAP

11: CXCAP

Note: the CXCAP signal is from the Power Line Transceiver Comparator output signal, refer to "Power Line Transceiver – PLT" section for details.

Bit 5~4 IFS05~IFS04: SCS input source pin selection

00: PB4

01: PB7

10: PA1

11: PB4

Bit 3~2 IFS03~IFS02: SCK/SCL input source pin selection

00: PB2

01: PA0

10: PA7

11: PC3

Note: If the SPI Master mode is selected, when the SIMEN bit is set high, the PA0, PA7, PB2 and PC3 pins all can be used as the SCK pin function ignoring the IFS0[3:2] bit settings.

Bit 1~0 IFS01~IFS00: SDI/SDA input source pin selection

00: PB3

01: PA2

10: PA6

11: PC2

# • IFS1 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	IFS15	IFS14	IFS13	IFS12	IFS11	IFS10
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5~4 IFS15~IFS14: RX1/TX1 input source pin selection

00: PC4

01: PC2

10: PC4

11: PC4

Bit 3~2 IFS13~IFS12: INT0 input source pin selection

00: PB0

01: PA3

10: PB0

11: PB0

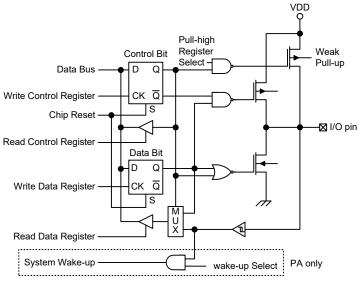


Bit 1~0 IFS11~IFS10: RX0/TX0 input source pin selection

00: PB3 01: PA2 10: PA6 11: PC0

#### I/O Pin Structures

The accompanying diagram illustrates the internal structures of the I/O logic function. As the exact logical construction of the I/O pin will differ from this diagram, it is supplied as a guide only to assist with the functional understanding of the logic function I/O pins. The wide range of pin-shared structures does not permit all types to be shown.



Logic Function Input/Output Structure

#### **Programming Considerations**

Within the user program, one of the first things to consider is port initialisation. After a reset, all of the I/O data and port control registers will be set high. This means that all I/O pins will default to an input state, the level of which depends on the other connected circuitry and whether pull-high selections have been chosen. If the port control registers are then programmed to setup some pins as outputs, these output pins will have an initial high output value unless the associated port data registers are first programmed. Selecting which pins are inputs and which are outputs can be achieved byte-wide by loading the correct values into the appropriate port control register or by programming individual bits in the port control register using the "SET [m].i" and "CLR [m].i" instructions. Note that when using these bit control instructions, a read-modify-write operation takes place. The microcontroller must first read in the data on the entire port, modify it to the required new bit values and then rewrite this data back to the output ports.

Port A has the additional capability of providing wake-up functions. When the device is in the SLEEP or IDLE Mode, various methods are available to wake the device up. One of these is a high to low transition of any of the Port A pins. Single or multiple pins on Port A can be setup to have this function.

Rev. 1.00 97 August 27, 2021



# **Timer Modules - TM**

One of the most fundamental functions in any microcontroller device is the ability to control and measure time. To implement time related functions the device includes several Timer Modules, abbreviated to the name TM. The TMs are multi-purpose timing units and serve to provide operations such as Timer/Counter, Input Capture, Compare Match Output and Single Pulse Output as well as being the functional unit for the generation of PWM signals. Each of the TMs has two individual interrupts. The addition of input and output pins for each TM ensures that users are provided with timing units with a wide and flexible range of features.

The common features of the different TM types are described here with more detailed information provided in the individual Standard and Periodic Type TM sections.

#### Introduction

The device contains five TMs and each individual TM can be categorised as a certain type, namely Standard Type TM and Periodic Type TM. Although similar in nature, the different TM types vary in their feature complexity. The common features to all of the Standard and Periodic TMs will be described in this section. The detailed operation regarding each of the TM types will be described in separate sections. The main features and differences between the two types of TMs are summarised in the accompanying table.

Function	STM	PTM
Timer/Counter	√	√
Input Capture	√	√
Compare Match Output	√	√
PWM Output	√	√
Single Pulse Output	√	√
PWM Alignment	Edge	Edge
PWM Adjustment Period & Duty	Duty or Period	Duty or Period

**TM Function Summary** 

#### **TM Operation**

The different types of TM offer a diverse range of functions, from simple timing operations to PWM signal generation. The key to understanding how the TM operates is to see it in terms of a free running counter whose value is then compared with the value of pre-programmed internal comparators. When the free running count-up counter has the same value as the pre-programmed comparator, known as a compare match situation, a TM interrupt signal will be generated which can clear the counter and perhaps also change the condition of the TM output pin. The internal TM counter is driven by a user selectable clock source, which can be an internal clock or an external pin.

#### **TM Clock Source**

The clock source which drives the main counter in each TM can originate from various sources. The selection of the required clock source is implemented using the  $xTnCK2\sim xTnCK0$  bits in the xTMn control registers, where "x" stands for S or P type TM and "n" stands for the specific TM serial number. The clock source can be a ratio of the system clock  $f_{SYS}$  or the internal high clock  $f_{H}$ , the  $f_{SUB}$  clock source or the external xTCKn pin. The xTCKn pin clock source is used to allow an external signal to drive the TM as an external clock source or for event counting.

Rev. 1.00 98 August 27, 2021



# **TM** Interrupts

The Standard and Periodic type TMs each have two internal interrupts, one for each of the internal comparator A or comparator P, which generate a TM interrupt when a compare match condition occurs. When a TM interrupt is generated it can be used to clear the counter and also to change the state of the TM output pin.

#### **TM External Pins**

Each of the TMs, irrespective of what type, has two TM input pins, with the label xTCKn and xTPnI respectively. The xTMn input pin, xTCKn, is essentially a clock source for the xTMn and is selected using the xTnCK2~xTnCK0 bits in the xTMnC0 register. This external TM input pin allows an external clock source to drive the internal TM. The xTCKn input pin can be chosen to have either a rising or falling active edge. The xTCKn pin is also used as the external trigger input pin in single pulse output mode.

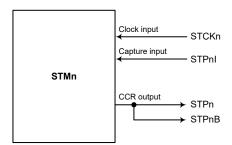
The other xTMn input pin, xTPnI, is the capture input whose active edge can be a rising edge, a falling edge or both rising and falling edges and the active edge transition type is selected using the xTnIO1~xTnIO0 bits in the xTMnC1 register. There is another capture input, PTCKn, for PTMn capture input mode, which can be used as the external trigger input source.

The TMs each have two output pins, xTPn and xTPnB. The xTPnB pin outputs the inverted signal of the xTPn. The TM output pins can be selected using the corresponding pin-shared function selection bits described in the Pin-shared Function section. When the TM is in the Compare Match Output Mode, these pins can be controlled by the TM to switch to a high or low level or to toggle when a compare match situation occurs. The external xTPn and xTPnB output pin are also the pins where the TM generates the PWM output waveform.

As the TM input and output pins are pin-shared with other functions, the TM input and output functions must first be setup using the relevant pin-shared function selection bits described in the Pin-shared Function section. The details of the pin-shared function selection are described in the pin-shared function section.

ST	Mn	PT	Mn
Input Output		Input	Output
STCKn, STPnl STPn, STPnB		PTCKn, PTPnI	PTPn, PTPnB

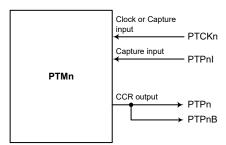
TM External Pins



STMn Function Pin Block Diagram (n=0~1)

Rev. 1.00 99 August 27, 2021



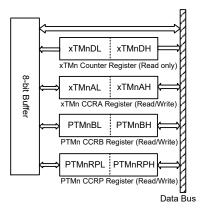


PTMn Function Pin Block Diagram(n=0~2)

## **Programming Considerations**

The TM Counter Registers and the Capture/Compare CCRA, CCRP and PTM0 CCRB registers, all have a low and high byte structure. The high bytes can be directly accessed, but as the low bytes can only be accessed via an internal 8-bit buffer, reading or writing to these register pairs must be carried out in a specific way. The important point to note is that data transfer to and from the 8-bit buffer and its related low byte only takes place when a write or read operation to its corresponding high byte is executed.

As the CCRA, CCRP and CCRB registers are implemented in the way shown in the following diagram and accessing these register pairs is carried out in a specific way as described above, it is recommended to use the "MOV" instruction to access the CCRA, CCRP and CCRB low byte registers, named xTMnAL, PTMnRPL, PTMnBL, using the following access procedures. Accessing the CCRA, CCRB or CCRP low byte register without following these access procedures will result in unpredictable values.



The following steps show the read and write procedures:

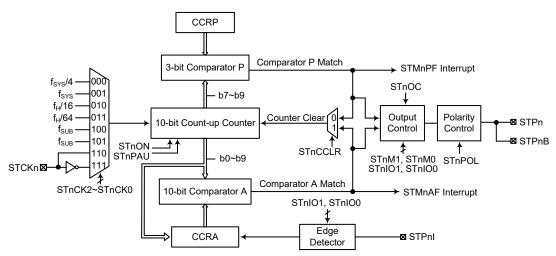
- · Writing Data to CCRA, CCRB or CCRP
  - Step 1. Write data to Low Byte xTMnAL, PTMnBL or PTMnRPL
    - Note that here data is only written to the 8-bit buffer.
  - Step 2. Write data to High Byte xTMnAH, PTMnBH or PTMnRPH
    - Here data is written directly to the high byte registers and simultaneously data is latched from the 8-bit buffer to the Low Byte registers.
- · Reading Data from the Counter Registers, CCRA, CCRB or CCRP
  - Step 1. Read data from the High Byte xTMnDH, xTMnAH, PTMnBH or PTMnRPH
    - Here data is read directly from the High Byte registers and simultaneously data is latched from the Low Byte register into the 8-bit buffer.
  - Step 2. Read data from the Low Byte xTMnDL, xTMnAL, PTMnBL or PTMnRPL
    - This step reads data from the 8-bit buffer.

Rev. 1.00 100 August 27, 2021



# Standard Type TM - STM

The Standard Type TM contains five operating modes, which are Compare Match Output, Timer/ Event Counter, Capture Input, Single Pulse Output and PWM Output modes. The Standard TM can also be controlled with two external input pins and can drive two external output pins.



Note: 1. The STPnB is the inverted output of the STPn.

2. The STMn external pins are pin-shared with other functions and can input or output on different pins, so before using the STMn function, the pin-shared function registers must be set properly.

#### Standard Type TM Block Diagram (n=0~1)

# **Standard TM Operation**

The size of Standard TM is 10-bit wide and its core is a 10-bit count-up counter which is driven by a user selectable internal or external clock source. There are also two internal comparators with the names, Comparator A and Comparator P. These comparators will compare the value in the counter with CCRP and CCRA registers. The CCRP comparator is 3-bit wide whose value is compared with the highest 3 bits in the counter while the CCRA is 10 bits and therefore compares all counter bits.

The only way of changing the value of the 10-bit counter using the application program, is to clear the counter by changing the STnON bit from low to high. The counter will also be cleared automatically by a counter overflow or a compare match with one of its associated comparators. When these conditions occur, a STMn interrupt signal will also usually be generated. The Standard Type TM can operate in a number of different operational modes, can be driven by different clock sources including an input pin and can also control two output pins. All operating setup conditions are selected using relevant internal registers.

#### Standard Type TM Register Description

Overall operation of the Standard TM is controlled using a series of registers. A read only register pair exists to store the internal counter 10-bit value, while a read/write register pair exists to store the internal 10-bit CCRA value. The remaining two registers are control registers which setup the different operating and control modes as well as the 3-bit CCRP value.

Rev. 1.00 101 August 27, 2021

Register		Bit										
Name	7	6	5	4	3	2	1	0				
STMnC0	STnPAU	STnCK2	STnCK1	STnCK0	STnON	STnRP2	STnRP1	STnRP0				
STMnC1	STnM1	STnM0	STnIO1	STnIO0	STnOC	STnPOL	STnDPX	STnCCLR				
STMnDL	D7	D6	D5	D4	D3	D2	D1	D0				
STMnDH	_	_	_	_	_	_	D9	D8				
STMnAL	D7	D6	D5	D4	D3	D2	D1	D0				
STMnAH	_	_	_	_	_	_	D9	D8				

10-bit Standard TM Register List (n=0~1)

# STMnC0 Register

Bit	7	6	5	4	3	2	1	0
Name	STnPAU	STnCK2	STnCK1	STnCK0	STnON	STnRP2	STnRP1	STnRP0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7 STPnAU: STMn Counter Pause Control

0: Run 1: Pause

The counter can be paused by setting this bit high. Clearing the bit to zero restores normal counter operation. When in a Pause condition the STMn will remain powered up and continue to consume power. The counter will retain its residual value when this bit changes from low to high and resume counting from this value when the bit changes to a low value again.

Bit 6~4 STnCK2~STnCK0: Select STMn Counter Clock

 $\begin{array}{c} 000: \, f_{SYS}/4 \\ 001: \, f_{SYS} \\ 010: \, f_{H}/16 \\ 011: \, f_{H}/64 \\ 100: \, f_{SUB} \\ 101: \, f_{SUB} \end{array}$ 

110: STCKn rising edge clock111: STCKn falling edge clock

These three bits are used to select the clock source for the STMn. The external pin clock source can be chosen to be active on the rising or falling edge. The clock source  $f_{SYS}$  is the system clock, while  $f_H$  and  $f_{SUB}$  are other internal clocks, the details of which can be found in the oscillator section.

Bit 3 STnON: STMn Counter On/Off Control

0: Off 1: On

This bit controls the overall on/off function of the STMn. Setting the bit high enables the counter to run while clearing the bit disables the STMn. Clearing this bit to zero will stop the counter from counting and turn off the STMn which will reduce its power consumption. When the bit changes state from low to high the internal counter value will be reset to zero, however when the bit changes from high to low, the internal counter will retain its residual value until the bit returns high again. If the STMn is in the Compare Match Output Mode then the STMn output pin will be reset to its initial condition, as specified by the STnOC bit, when the STnON bit changes from low to high.

Rev. 1.00 102 August 27, 2021



# Bit 2~0 STnRP2~STnRP0: STMn CCRP 3-bit register, compared with the STMn counter bit 9 ~ bit 7

Comparator P Match Period= 000: 1024 STMn clocks 001: 128 STMn clocks 010: 256 STMn clocks

011: 384 STMn clocks 100: 512 STMn clocks 101: 640 STMn clocks 110: 768 STMn clocks 111: 896 STMn clocks

These three bits are used to setup the value on the internal CCRP 3-bit register, which are then compared with the internal counter's highest three bits. The result of this comparison can be selected to clear the internal counter if the STnCCLR bit is set to zero. Setting the STnCCLR bit to zero ensures that a compare match with the CCRP values will reset the internal counter. As the CCRP bits are only compared with the highest three counter bits, the compare values exist in 128 clock cycle multiples. Clearing all three bits to zero is in effect allowing the counter to overflow at its maximum value.

#### STMnC1 Register

Bit	7	6	5	4	3	2	1	0
Name	STnM1	STnM0	STnIO1	STnIO0	STnOC	STnPOL	STnDPX	STnCCLR
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

# Bit 7~6 **STnM1~STnM0**: Select STMn Operating Mode

00: Compare Match Output Mode

01: Capture Input Mode

10: PWM Output Mode or Single Pulse Output Mode

11: Timer/Counter Mode

These bits setup the required operating mode for the STMn. To ensure reliable operation the STMn should be switched off before any changes are made to the STnM1 and STnM0 bits. In the Timer/Counter Mode, the STMn output pin state is undefined.

#### Bit 5~4 **STnIO1~STnIO0**: Select STMn External Pins Function

Compare Match Output Mode

00: No change

01: Output low

10: Output high

11: Toggle output

PWM Output Mode/Single Pulse Output Mode

00: PWM output inactive state

01: PWM output active state

10: PWM output

11: Single Pulse Output

Capture Input Mode

00: Input capture at rising edge of STPnI

01: Input capture at falling edge of STPnI

10: Input capture at both rising and falling edges of STPnI

11: Input capture disabled

Timer/Counter Mode

Unused

These two bits are used to determine how the STMn output pin changes state when a certain condition is reached. The function that these bits select depends upon in which mode the STMn is running.

# BA45F5360 Smoke Detector Flash MCU with 12V Piezoelectric Horn Driver

In the Compare Match Output Mode, the STnIO1 and STnIO0 bits determine how the STMn output pin changes state when a compare match occurs from the Comparator A. The TM output pin can be setup to switch high, switch low or to toggle its present state when a compare match occurs from the Comparator A. When the bits are both zero, then no change will take place on the output. The initial value of the STMn output pin should be setup using the STnOC bit in the STMnC1 register. Note that the output level requested by the STnIO1 and STnIO0 bits must be different from the initial value setup using the STnOC bit otherwise no change will occur on the STMn output pin when a compare match occurs. After the STMn output pin changes state, it can be reset to its initial level by changing the level of the STnON bit from low to high.

In the PWM Output Mode, the STnIO1 and STnIO0 bits determine how the STMn output pin changes state when a certain compare match condition occurs. The PWM output function is modified by changing these two bits. It is necessary to only change the values of the STnIO1 and STnIO0 bits only after the STMn has been switched off. Unpredictable PWM outputs will occur if the STnIO1 and STnIO0 bits are changed when the STMn is running.

Bit 3 STnOC: STPn Output Control

Compare Match Output Mode

0: Initial low

1: Initial high

PWM Output Mode/Single Pulse Output Mode

0: Active low

1: Active high

This is the output control bit for the STMn output. Its operation depends upon whether STMn is being used in the Compare Match Output Mode or in the PWM Output Mode/Single Pulse Output Mode. It has no effect if the STMn is in the Timer/Counter Mode. In the Compare Match Output Mode it determines the logic level of the STMn output pin before a compare match occurs. In the PWM Output Mode/Single Pulse Output Mode it determines if the PWM signal is active high or active low.

Bit 2 STPnOL: STPn Output Polarity Control

0: Non-inverted

1: Inverted

This bit controls the polarity of the STPn output. When the bit is set high the STMn output pin will be inverted and not inverted when the bit is zero. It has no effect if the STMn is in the Timer/Counter Mode.

Bit 1 STnDPX: STMn PWM Duty/Period Control

0: CCRP - period; CCRA - duty

1: CCRP – duty; CCRA – period

This bit determines which of the CCRA and CCRP registers are used for period and duty control of the PWM waveform.

Bit 0 STnCCLR: STMn Counter Clear Condition Selection

0: Comparator P match

1: Comparator A match

This bit is used to select the method which clears the counter. Remember that the Standard TM contains two comparators, Comparator A and Comparator P, either of which can be selected to clear the internal counter. With the STnCCLR bit set high, the counter will be cleared when a compare match occurs from the Comparator A. When the bit is low, the counter will be cleared when a compare match occurs from the Comparator P or with a counter overflow. A counter overflow clearing method can only be implemented if the CCRP bits are all cleared to zero. The STnCCLR bit is not used in the PWM Output, Single Pulse Output or Capture Input Mode.

Rev. 1.00 104 August 27, 2021



# • STMnDL Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R	R	R	R	R	R	R	R
POR	0	0	0	0	0	0	0	0

Bit  $7\sim0$  **D7\simD0**: STMn Counter Low Byte Register bit  $7\sim$  bit 0 STMn 10-bit Counter bit  $7\sim$  bit 0

# • STMnDH Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	D9	D8
R/W	_	_	_	_	_	_	R	R
POR	_	_	_	_	_	_	0	0

Bit 7~2 Unimplemented, read as "0"

Bit 1~0 **D9~D8**: STMn Counter High Byte Register bit 1 ~ bit 0 STMn 10-bit Counter bit 9 ~ bit 8

# • STMnAL Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0 **D7~D0**: STMn CCRA Low Byte Register bit  $7 \sim$  bit 0 STMn 10-bit CCRA bit  $7 \sim$  bit 0

# STMnAH Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	D9	D8
R/W	_	_	_	_	_	_	R/W	R/W
POR	_	_	_	_	_	_	0	0

Bit 7~2 Unimplemented, read as "0"

STMn 10-bit CCRA bit 9  $\sim$  bit 8



# Standard Type TM Operation Modes

The Standard Type TM can operate in one of five operating modes, Compare Match Output Mode, PWM Output Mode, Single Pulse Output Mode, Capture Input Mode or Timer/Counter Mode. The operating mode is selected using the STnM1 and STnM0 bits in the STMnC1 register.

#### **Compare Match Output Mode**

To select this mode, bits STnM1 and STnM0 in the STMnC1 register, should be set to 00 respectively. In this mode once the counter is enabled and running it can be cleared by three methods. These are a counter overflow, a compare match from Comparator A and a compare match from Comparator P. When the STnCCLR bit is low, there are two ways in which the counter can be cleared. One is when a compare match from Comparator P, the other is when the CCRP bits are all zero which allows the counter to overflow. Here both STMnAF and STMnPF interrupt request flags for Comparator A and Comparator P respectively, will both be generated.

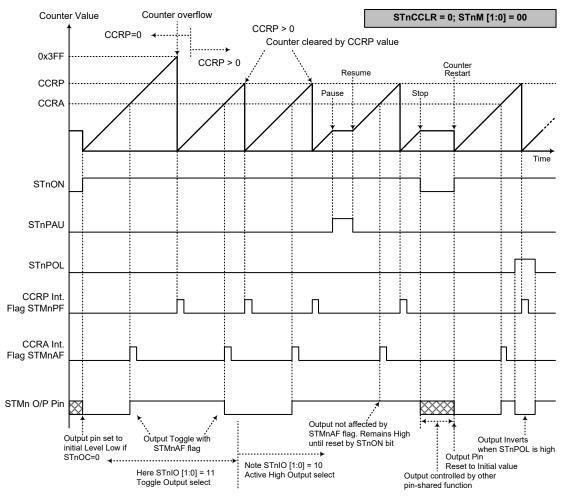
If the STnCCLR bit in the STMnC1 register is high then the counter will be cleared when a compare match occurs from Comparator A. However, here only the STMnAF interrupt request flag will be generated even if the value of the CCRP bits is less than that of the CCRA registers. Therefore when STnCCLR is high no STMnPF interrupt request flag will be generated. In the Compare Match Output Mode, the CCRA can not be set to "0".

If the CCRA bits are all zero, the counter will overflow when it reaches its maximum 10-bit, 3FF Hex, value, however here the STMnAF interrupt request flag will not be generated.

As the name of the mode suggests, after a comparison is made, the STMn output pin, will change state. The STMn output pin condition however only changes state when a STMnAF interrupt request flag is generated after a compare match occurs from Comparator A. The STMnPF interrupt request flag, generated from a compare match occurs from Comparator P, will have no effect on the STMn output pin. The way in which the STMn output pin changes state are determined by the condition of the STnIO1 and STnIO0 bits in the STMnC1 register. The STMn output pin can be selected using the STnIO1 and STnIO0 bits to go high, to go low or to toggle from its present condition when a compare match occurs from Comparator A. The initial condition of the STMn output pin, which is setup after the STnON bit changes from low to high, is setup using the STnOC bit. Note that if the STnIO1 and STnIO0 bits are zero then no pin change will take place.

Rev. 1.00 106 August 27, 2021



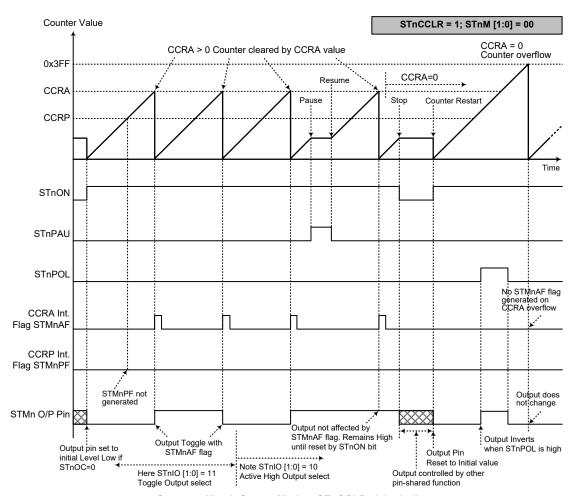


Compare Match Output Mode - STnCCLR=0 (n=0~1)

Note: 1. With STnCCLR=0 a Comparator P match will clear the counter

- 2. The STMn output pin is controlled only by the STMnAF flag
- 3. The output pin is reset to itsinitial state by a STnON bit rising edge





Compare Match Output Mode - STnCCLR=1 (n=0~1)

Note: 1. With STnCCLR=1 a Comparator A match will clear the counter

- 2. The STMn output pin is controlled only by the STMnAF flag
- 3. The output pin is reset to its initial state by a STnON bit rising edge
- 4. A STMnPF flag is not generated when STnCCLR=1

Rev. 1.00 108 August 27, 2021



#### **Timer/Counter Mode**

To select this mode, bits STnM1 and STnM0 in the STMnC1 register should be set to 11 respectively. The Timer/Counter Mode operates in an identical way to the Compare Match Output Mode generating the same interrupt flags. The exception is that in the Timer/Counter Mode the STMn output pin is not used. Therefore the above description and Timing Diagrams for the Compare Match Output Mode can be used to understand its function. As the STMn output pin is not used in this mode, the pin can be used as a normal I/O pin or other pin-shared function.

#### **PWM Output Mode**

To select this mode, bits STnM1 and STnM0 in the STMnC1 register should be set to 10 respectively and also the STnIO1 and STnIO0 bits should be set to 10 respectively. The PWM function within the STMn is useful for applications which require functions such as motor control, heating control, illumination control etc. By providing a signal of fixed frequency but of varying duty cycle on the STMn output pin, a square wave AC waveform can be generated with varying equivalent DC RMS values.

As both the period and duty cycle of the PWM waveform can be controlled, the choice of generated waveform is extremely flexible. In the PWM Output mode, the STnCCLR bit has no effect as the PWM period. Both of the CCRA and CCRP registers are used to generate the PWM waveform, one register is used to clear the internal counter and thus control the PWM waveform frequency, while the other one is used to control the duty cycle. Which register is used to control either frequency or duty cycle is determined using the STnDPX bit in the STMnC1 register. The PWM waveform frequency and duty cycle can therefore be controlled by the values in the CCRA and CCRP registers.

An interrupt flag, one for each of the CCRA and CCRP, will be generated when a compare match occurs from either Comparator A or Comparator P. The STnOC bit in the STMnC1 register is used to select the required polarity of the PWM waveform while the two STnIO1 and STnIO0 bits are used to enable the PWM output or to force the STMn output pin to a fixed high or low level. The STnPOL bit is used to reverse the polarity of the PWM output waveform.

#### • 10-bit STMn, PWM Output Mode, Edge-aligned Mode, STnDPX=0

CCRP	1~7	0			
Period	CCRP×128	1024			
Duty	CCRA				

If  $f_{SYS}$ =4MHz, TM clock source is  $f_{SYS}$ /4, CCRP = 4 and CCRA = 128,

The STMn PWM output frequency =  $(f_{SYS}/4)/(4\times128) = f_{SYS}/2048 = 2kHz$ , duty =  $128/(4\times128) = 25\%$ .

If the Duty value defined by the CCRA register is equal to or greater than the Period value, then the PWM output duty is 100%.

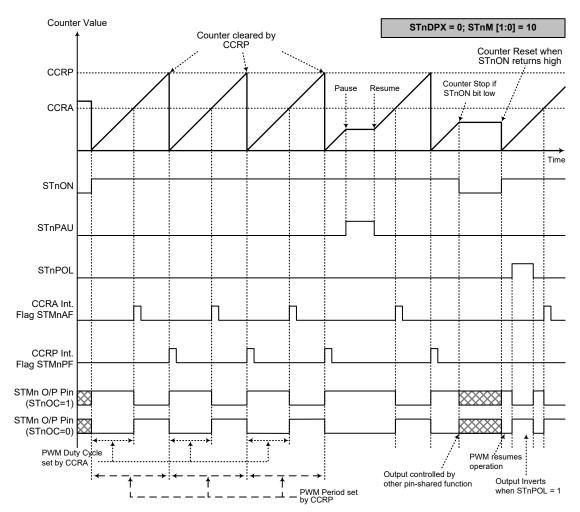
## • 10-bit STMn, PWM Output Mode, Edge-aligned Mode, STnDPX=1

CCRP	1~7	0		
Period	CCRA			
Duty	CCRP×128	1024		

The PWM output period is determined by the CCRA register value together with the STMn clock while the PWM duty cycle is defined by the CCRP register value.

Rev. 1.00 109 August 27, 2021





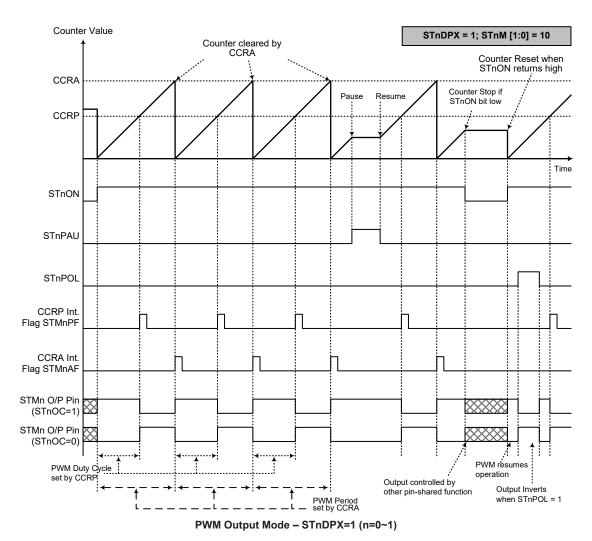
PWM Output Mode - STnDPX=0 (n=0~1)

Note: 1. Here STnDPX=0 - Counter cleared by CCRP

- 2. A counter clear sets the PWM Period
- 3. The internal PWM function continues running even when STnIO[1:0]=00 or 01
- 4. The STnCCLR bit has no influence on PWM operation

Rev. 1.00 110 August 27, 2021





Note: 1. Here STnDPX=1 – Counter cleared by CCRA

- 2. A counter clear sets the PWM Period
- 3. The internal PWM function continues even when STnIO[1:0]=00 or 01
- 4. The STnCCLR bit has no influence on PWM operation

Rev. 1.00 111 August 27, 2021

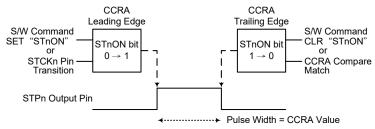


#### **Single Pulse Output Mode**

To select this mode, bits STnM1 and STnM0 in the STMnC1 register should be set to 10 respectively and also the STnIO1 and STnIO0 bits should be set to 11 respectively. The Single Pulse Output Mode, as the name suggests, will generate a single shot pulse on the STMn output pin.

The trigger for the pulse output leading edge is a low to high transition of the STnON bit, which can be implemented using the application program. However in the Single Pulse Mode, the STnON bit can also be made to automatically change from low to high using the external STCKn pin, which will in turn initiate the Single Pulse output. When the STnON bit transitions to a high level, the counter will start running and the pulse leading edge will be generated. The STnON bit should remain high when the pulse is in its active state. The generated pulse trailing edge will be generated when the STnON bit is cleared to zero, which can be implemented using the application program or when a compare match occurs from Comparator A.

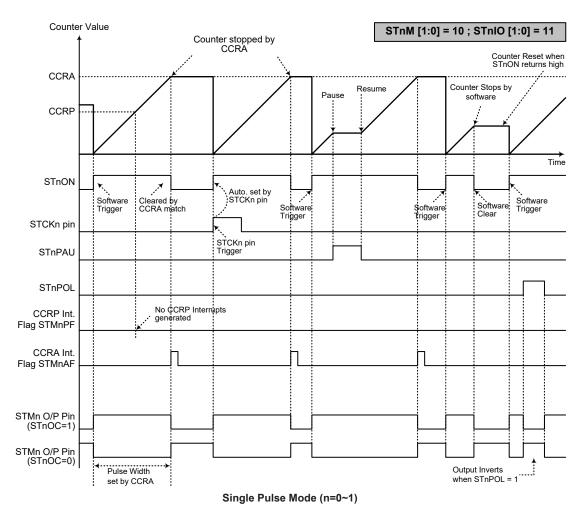
However a compare match from Comparator A will also automatically clear the STnON bit and thus generate the Single Pulse output trailing edge. In this way the CCRA value can be used to control the pulse width. A compare match from Comparator A will also generate a STMn interrupt. The counter can only be reset back to zero when the STnON bit changes from low to high when the counter restarts. In the Single Pulse Mode CCRP is not used. The STnCCLR and STnDPX bits are not used in this Mode.



Single Pulse Generation

Rev. 1.00 112 August 27, 2021





Note: 1. Counter stopped by CCRA

- 2. CCRP is not used
- 3. The pulse triggered by the STCKn pin or by setting the STnON bit high
- 4. A STnCK pin active edge will automatically set the STnON bit high.
- 5. In the Single Pulse Mode, STnIO[1:0] must be set to "11" and can not be changed.

Rev. 1.00 113 August 27, 2021



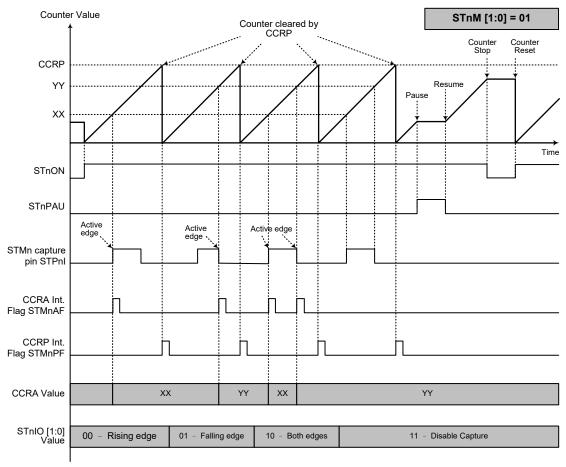
#### **Capture Input Mode**

To select this mode bits STnM1 and STnM0 in the STMnC1 register should be set to 01 respectively. This mode enables external signals to capture and store the present value of the internal counter and can therefore be used for applications such as pulse width measurements. The external signal is supplied on the STPnI pin, whose active edge can be a rising edge, a falling edge or both rising and falling edges; the active edge transition type is selected using the STnIO1 and STnIO0 bits in the STMnC1 register. The counter is started when the STnON bit changes from low to high which is initiated using the application program.

When the required edge transition appears on the STPnI pin the present value in the counter will be latched into the CCRA registers and a STMn interrupt generated. Irrespective of what events occur on the STPnI pin the counter will continue to free run until the STnON bit changes from high to low. When a CCRP compare match occurs the counter will reset back to zero; in this way the CCRP value can be used to control the maximum counter value. When a CCRP compare match occurs from Comparator P, a STMn interrupt will also be generated. Counting the number of overflow interrupt signals from the CCRP can be a useful method in measuring long pulse widths. The STnIO1 and STnIO0 bits can select the active trigger edge on the STnPI pin to be a rising edge, falling edge or both edge types. If the STnIO1 and STnIO0 bits are both set high, then no capture operation will take place irrespective of what happens on the STPnI pin, however it must be noted that the counter will continue to run. The STnCCLR and STnDPX bits are not used in this Mode.

Rev. 1.00 114 August 27, 2021





Capture Input Mode (n=0~1)

Note: 1. STnM[1:0]=01 and active edge set by the STnIO[1:0] bits

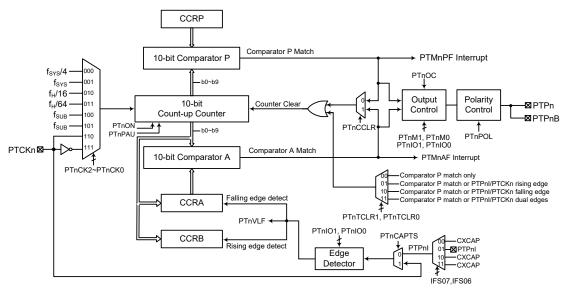
- 2. A STMn Capture input pin active edge transfers the counter value to CCRA
- 3. STnCCLR bit not used
- 4. No output function STnOC and STnPOL bits are not used
- 5. CCRP determines the counter value and the counter has a maximum count value when CCRP is equal to zero

Rev. 1.00 115 August 27, 2021



# Periodic Type TM - PTM

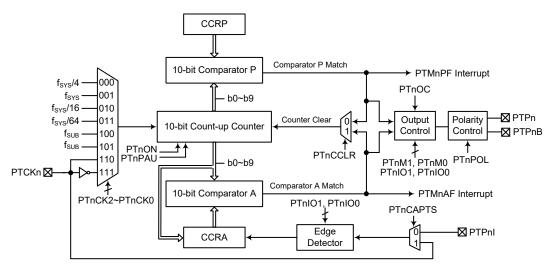
The Periodic Type TM contains five operating modes, which are Compare Match Output, Timer/ Event Counter, Capture Input, Single Pulse Output and PWM Output modes. The Periodic TM can be controlled with external input pins and can drive some external output pins.



Note: 1. The CXCAP is the PowerLine Transceiver comparator output signal.

- 2. The PTMn PTPnI signal can be from the external PTPnI pin input or from the internal CXCAP signal, which is selected using the IFS0[7:6] bits.
- 3. If the PTMn external pins will be used and as these pins are pin-shared with other functions, before using the PTMn function, the pin-shared function registers should be set properly.

# Periodic Type TM Block Diagram (n=0)



Note: If the PTMn external pins will be used and as these pins are pin-shared with other functions, before using the PTMn function, the pin-shared function registers should be set properly.

#### Periodic Type TM Block Diagram (n=1~2)

Rev. 1.00 116 August 27, 2021



# **Periodic TM Operation**

The Periodic Type TM core is a 10-bit count-up counter which is driven by a user selectable internal or external clock source. There are also two internal comparators with the names, Comparator A and Comparator P. These comparators will compare the value in the counter with CCRP and CCRA registers. The CCRA and CCRP comparators are 10-bit wide whose value is respectively compared with all counter bits.

The only way of changing the value of the 10-bit counter using the application program, is to clear the counter by changing the PTnON bit from low to high. The counter will also be cleared automatically by a counter overflow or a compare match with one of its associated comparators. When these conditions occur, a PTMn interrupt signal will also usually be generated. The Periodic Type TM can operate in a number of different operational modes and can be driven by different clock sources including two input pins and also control more than one output pins. All operating setup conditions are selected using relevant internal registers.

# **Periodic Type TM Register Description**

Overall operation of the Periodic Type TM is controlled using a series of registers. A read only register pair exists to store the internal 10-bit counter value, while three read/write register pairs exist to store the internal 10-bit CCRA value, CCRP value and CCRB value. The remaining three registers are control registers which setup the different operating and control modes.

Register					Bit			
Name	7	6	5	4	3	2	1	0
PTMnC0	PTnPAU	PTnCK2	PTnCK1	PTnCK0	PTnON	_	_	_
PTMnC1	PTnM1	PTnM0	PTnIO1	PTnIO0	PTnOC	PTnPOL	PTnCAPTS	PTnCCLR
PTMnC2*	_	_	_	_	_	PTnTCLR1	PTnTCLR0	PTnVLF
PTMnDL	D7	D6	D5	D4	D3	D2	D1	D0
PTMnDH	_	_	_	_	_	_	D9	D8
PTMnAL	D7	D6	D5	D4	D3	D2	D1	D0
PTMnAH	_	_	_	_	_	_	D9	D8
PTMnBL*	D7	D6	D5	D4	D3	D2	D1	D0
PTMnBH*	_	_	_	_	_	_	D9	D8
PTMnRPL	D7	D6	D5	D4	D3	D2	D1	D0
PTMnRPH	_	_	_	_	_	_	D9	D8

<sup>\*:</sup> The Registers with \* symbol are only available for PTM0.

## 10-bit Periodic TM Register List (n=0~2)

#### PTMnC0 Register

Bit	7	6	5	4	3	2	1	0
Name	PTnPAU	PTnCK2	PTnCK1	PTnCK0	PTnON	_	_	_
R/W	R/W	R/W	R/W	R/W	R/W	_	_	_
POR	0	0	0	0	0	_	-	_

Bit 7 **PTnPAU**: PTMn Counter Pause Control

0: Run 1: Pause

The counter can be paused by setting this bit high. Clearing the bit to zero restores normal counter operation. When in a Pause condition the PTMn will remain powered up and continue to consume power. The counter will retain its residual value when this bit changes from low to high and resume counting from this value when the bit changes to a low value again.

Rev. 1.00 117 August 27, 2021



#### Bit 6~4 PTnCK2~PTnCK0: Select PTMn Counter clock

 $\begin{array}{c} 000: \, f_{SYS}/4 \\ 001: \, f_{SYS} \\ 010: \, f_H/16 \\ 011: \, f_H/64 \\ 100: \, f_{SUB} \\ 101: \, f_{SUB} \end{array}$ 

110: PTCKn rising edge clock111: PTCKn falling edge clock

These three bits are used to select the clock source for the PTMn. The external pin clock source can be chosen to be active on the rising or falling edge. The clock source  $f_{SYS}$  is the system clock, while  $f_H$  and  $f_{SUB}$  are other internal clocks, the details of which can be found in the oscillator section.

#### Bit 3 **PTnON**: PTMn Counter On/Off Control

0: Off 1: On

This bit controls the overall on/off function of the PTMn. Setting the bit high enables the counter to run, clearing the bit disables the PTMn. Clearing this bit to zero will stop the counter from counting and turn off the PTMn which will reduce its power consumption. When the bit changes state from low to high the internal counter value will be reset to zero, however when the bit changes from high to low, the internal counter will retain its residual value until the bit returns high again.

If the PTMn is in the Compare Match Output Mode, PWM output Mode or Single Pulse Output Mode then the PTMn output pin will be reset to its initial condition, as specified by the PTnOC bit, when the PTnON bit changes from low to high.

Bit 2~0 Unimplemented, read as "0"

## • PTMnC1 Register

Bit	7	6	5	4	3	2	1	0
Name	PTnM1	PTnM0	PTnIO1	PTnIO0	PTnOC	PTnPOL	PTnCAPTS	PTnCCLR
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

# Bit 7~6 **PTnM1~PTnM0**: Select PTMn Operating Mode

00: Compare Match Output Mode

01: Capture Input Mode

10: PWM Output Mode or Single Pulse Output Mode

11: Timer/Counter Mode

These bits setup the required operating mode for the PTMn. To ensure reliable operation the PTMn should be switched off before any changes are made to the PTnM1 and PTnM0 bits. In the Timer/Counter Mode, the PTMn output pin state is undefined.

#### Bit 5~4 **PTnIO1~PTnIO0**: Select PTMn External Pins Function

Compare Match Output Mode

00: No change

01: Output low 10: Output high

11: Toggle output

PWM Output Mode/Single Pulse Output Mode

00: PWM output inactive state

01: PWM output active state

10: PWM output

11: Single pulse output

Rev. 1.00 118 August 27, 2021



Capture Input Mode (n=0)

PTnTCLR[1:0]=00B:

- 00: Input capture at rising edge of PTPnI or PTCKn, and the counter value will be latched into CCRA
- 01: Input capture at falling edge of PTPnI or PTCKn, and the counter value will be latched into CCRA
- 10: Input capture at both falling and rising edges of PTPnI or PTCKn, and the counter value will be latched into CCRA
- 11: Input capture disabled

PTnTCLR[1:0]=01B,10B or 11B:

- 00: Input capture at rising edge of PTPnI or PTCKn, and the counter value will be latched into CCRB
- 01: Input capture at falling edge of PTPnI or PTCKn, and the counter value will be latched into CCRA
- 10: Input capture at both falling and rising edges of PTPnI or PTCKn, and the counter value will be latched into CCRA at falling edge or CCRB at rising edge
- 11: Input capture disabled

Capture Input Mode (n=1~2)

- 00: Input capture at rising edge of PTPnI or PTCKn
- 01: Input capture at falling edge of PTPnI or PTCKn
- 10: Input capture at rising/falling edge of PTPnI or PTCKn
- 11: Input capture disabled

Timer/Counter Mode

Unused

These two bits are used to determine how the PTMn functions when a certain condition is reached. The function that these bits select depends upon in which mode the PTMn is running.

In the Compare Match Output Mode, the PTnIO1 and PTnIO0 bits determine how the PTMn output pin changes state when a compare match occurs from the Comparator A. The PTMn output can be setup to switch high, switch low or to toggle its present state when a compare match occurs from the Comparator A. When the bits are both zero, then no change will take place on the output. The initial value of the PTMn output should be setup using the PTnOC bit in the PTMnC1 register. Note that the output level requested by the PTnIO1 and PTnIO0 bits must be different from the initial value setup using the PTnOC bit otherwise no change will occur on the PTMn noutput when a compare match occurs. After the PTMn output pin changes state, it can be reset to its initial level by changing the level of the PTnON bit from low to high.

In the PWM Output Mode, the PTnIO1 and PTnIO0 bits determine how the PTMn output changes state when a certain compare match condition occurs. The PWM output function is modified by changing these two bits. It is necessary to only change the values of the PTnIO1 and PTnIO0 bits only after the PTMn has been switched off. Unpredictable PWM outputs will occur if the PTnIO1 and PTnIO0 bits are changed when the PTMn is running.

Bit 3 **PTnOC**: PTMn PTPn Output control bit

Compare Match Output Mode

0: Initial low

1: Initial high

PWM Output Mode/Single Pulse Output Mode

0: Active low

1: Active high

This is the output control bit for the PTMn output. Its operation depends upon whether PTMn is being used in the Compare Match Output Mode or in the PWM Output Mode/ Single Pulse Output Mode. It has no effect if the PTMn is in the Timer/Counter Mode. In the Compare Match Output Mode it determines the logic level of the PTMn output before a compare match occurs. In the PWM Output Mode it determines if the PWM signal is active high or active low. In the Single Pulse Output Mode it determines the logic level of the PTMn output when the PTnON bit changes from low to high.

Rev. 1.00 119 August 27, 2021



Bit 2 **PTnPOL**: PTMn PTPn Output polarity Control

0: Non-invert

1: Invert

This bit controls the polarity of the PTPn output. When the bit is set high the PTMn output will be inverted and not inverted when the bit is zero. It has no effect if the PTMn is in the Timer/Counter Mode.

Bit 1 PTnCAPTS: PTMn Capture Trigger Source Selection

n=0

- 0: From PTPnI input signal (can be from the external PTPnI pin input or from the internal CXCAP signal, which is selected using the IFS0[7:6] bits)
- 1: From PTCKn input

 $n=1\sim2$ 

0: From PTPnI input signal

1: From PTCKn input

Bit 0 **PTnCCLR**: Select PTMn Counter clear condition

0: PTMn Comparator P match

1: PTMn Comparator A match

This bit is used to select the method which clears the counter. Remember that the Periodic TM contains two comparators, Comparator A and Comparator P, either of which can be selected to clear the internal counter. With the PTnCCLR bit set high, the counter will be cleared when a compare match occurs from the Comparator A. When the bit is low, the counter will be cleared when a compare match occurs from the Comparator P or with a counter overflow. A counter overflow clearing method can only be implemented if the CCRP bits are all cleared to zero. The PTnCCLR bit is not used in the PWM Output Mode, Single Pulse Output Mode or Capture Input Mode.

# • PTMnC2 Register (n=0 only)

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	PTnTCLR1	PTnTCLR0	PTnVLF
R/W	_	_	_	_	_	R/W	R/W	R
POR	_	_	_	_	_	0	0	0

- Bit 7~3 Unimplemented, read as "0"
- Bit 2~1 **PTnTCLR1~PTnTCLR0**: Select PTMn Counter clear condition in capture input mode only

00: Comparator P match

01: Comparator P match or PTCKn/PTPnI rising edge

10: Comparator P match or PTCKn/PTPnI falling edge

11: Comparator P match or PTCKn/PTPnI dual edges

Note that these bits selection can be available only when the PTMn operates in the Capture Input Mode.

Bit 0 **PTnVLF**: PTMn counter value latch edge flag

0: Falling edge trigger the counter value latch

1: Rising edge trigger the counter value latch

When the PTnTCLR1~PTnTCLR0 bits equal to 00B, ignore this flag status.

## PTMnDL Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R	R	R	R	R	R	R	R
POR	0	0	0	0	0	0	0	0

Bit  $7 \sim 0$  D7 $\sim$ D0: PTMn Counter Low Byte Register bit  $7 \sim$  bit 0

PTMn 10-bit Counter bit 7 ~ bit 0

Rev. 1.00 120 August 27, 2021



# • PTMnDH Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	D9	D8
R/W	_	_	_	_	_	_	R	R
POR	_	_	_	_	_	_	0	0

Bit 7~2 Unimplemented, read as "0"

Bit  $1\sim 0$  **D9\simD8**: PTMn Counter High Byte Register bit  $1\sim$  bit 0

PTMn 10-bit Counter bit  $9 \sim bit 8$ 

# • PTMnAL Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7\sim0$  **D7~D0**: PTMn CCRA Low Byte Register bit  $7\sim$  bit 0

PTMn 10-bit CCRA bit  $7 \sim bit 0$ 

## • PTMnAH Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	D9	D8
R/W	_	_	_	_	_	_	R/W	R/W
POR	_	_	_	_	_	_	0	0

Bit 7~2 Unimplemented, read as "0"

PTMn 10-bit CCRA bit 9 ~ bit 8

# • PTMnBL Register (n=0 only)

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0 **D7~D0**: PTMn CCRB Low Byte Register bit  $7 \sim$  bit 0 PTMn 10-bit CCRB bit  $7 \sim$  bit 0

# • PTMnBH Register (n=0 only)

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	D9	D8
R/W	_	_	_	_	_	_	R/W	R/W
POR	_	_	_	_	_	_	0	0

Bit 7~2 Unimplemented, read as "0"

Bit  $1\sim 0$  **D9\simD8**: PTMn CCRB High Byte Register bit  $1\sim$  bit 0

PTMn 10-bit CCRB bit 9 ~ bit 8



#### • PTMnRPL Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit  $7\sim 0$  **D7\simD0**: PTMn CCRP Low Byte Register bit  $7\sim$  bit 0

PTMn 10-bit CCRP bit  $7 \sim bit 0$ 

## • PTMnRPH Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	D9	D8
R/W	_	_	_	_	_	_	R/W	R/W
POR	_	_	_	_	_	_	0	0

Bit 7~2 Unimplemented, read as "0"

Bit 1~0 **D9~D8**: PTMn CCRP High Byte Register bit 1 ~ bit 0

PTMn 10-bit CCRP bit 9 ~ bit 8

## **Periodic Type TM Operating Modes**

The Periodic Type TM can operate in one of five operating modes, Compare Match Output Mode, PWM Output Mode, Single Pulse Output Mode, Capture Input Mode or Timer/Counter Mode. The operating mode is selected using the PTnM1 and PTnM0 bits in the PTMnC1 register.

## **Compare Match Output Mode**

To select this mode, bits PTnM1 and PTnM0 in the PTMnC1 register, should be set to 00 respectively. In this mode once the counter is enabled and running it can be cleared by three methods. These are a counter overflow, a compare match from Comparator A and a compare match from Comparator P. When the PTnCCLR bit is low, there are two ways in which the counter can be cleared. One is when a compare match from Comparator P, the other is when the CCRP bits are all zero which allows the counter to overflow. Here both PTMnAF and PTMnPF interrupt request flags for Comparator A and Comparator P respectively, will both be generated.

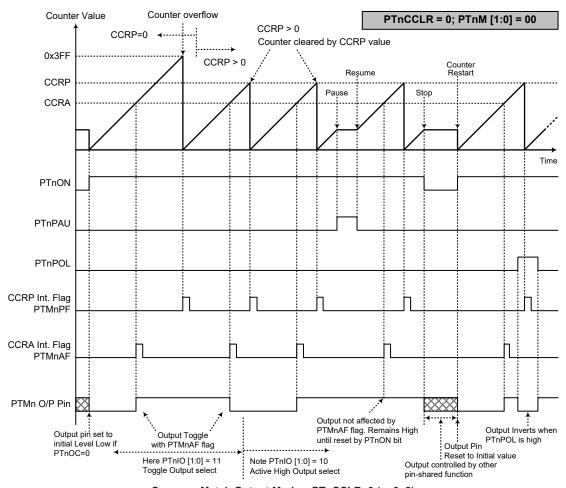
If the PTnCCLR bit in the PTMnC1 register is high then the counter will be cleared when a compare match occurs from Comparator A. However, here only the PTMnAF interrupt request flag will be generated even if the value of the CCRP bits is less than that of the CCRA registers. Therefore when PTnCCLR is high no PTMnPF interrupt request flag will be generated. In the Compare Match Output Mode, the CCRA can not be cleared to zero.

If the CCRA bits are all zero, the counter will overflow when its reaches its maximum 3FF Hex value, however here the PTMnAF interrupt request flag will not be generated.

As the name of the mode suggests, after a comparison is made, the PTMn output will change state. The PTMn output condition however only changes state when a PTMnAF interrupt request flag is generated after a compare match occurs from Comparator A. The PTMnPF interrupt request flag, generated from a compare match occurs from Comparator P, will have no effect on the PTMn output. The way in which the PTMn output changes state are determined by the condition of the PTnIO1 and PTnIO0 bits in the PTMnC1 register. The PTMn output can be selected using the PTnIO1 and PTnIO0 bits to go high, to go low or to toggle from its present condition when a compare match occurs from Comparator A. The initial condition of the PTMn output, which is setup after the PTnON bit changes from low to high, is setup using the PTnOC bit. Note that if the PTnIO1 and PTnIO0 bits are zero then no output change will take place.

Rev. 1.00 122 August 27, 2021





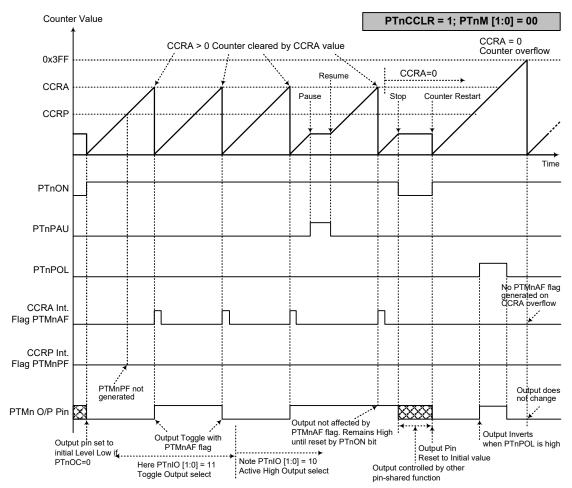
Compare Match Output Mode - PTnCCLR=0 (n=0~2)

Note: 1. With PTnCCLR=0 a Comparator P match will clear the counter

- 2. The PTMn output is controlled only by the PTMnAF flag
- 3. The output is reset to its initial state by a PTnON bit rising edge

Rev. 1.00 123 August 27, 2021





Compare Match Output Mode - PTnCCLR=1 (n=0~2)

Note: 1. With PTnCCLR=1 a Comparator A match will clear the counter

- 2. The PTMn output is controlled only by the PTMnAF flag
- 3. The output is reset to its initial state by a PTnON bit rising edge
- 4. A PTMnPF flag is not generated when PTnCCLR=1

Rev. 1.00 124 August 27, 2021



#### **Timer/Counter Mode**

To select this mode, bits PTnM1 and PTnM0 in the PTMnC1 register should be set to 11 respectively. The Timer/Counter Mode operates in an identical way to the Compare Match Output Mode generating the same interrupt flags. The exception is that in the Timer/Counter Mode the PTMn output pins are not used. Therefore the above description and Timing Diagrams for the Compare Match Output Mode can be used to understand its function. As the PTMn output pins are not used in this mode, the pins can be used as normal I/O pins or other pin-shared function.

#### **PWM Output Mode**

To select this mode, bits PTnM1 and PTnM0 in the PTMnC1 register should be set to 10 respectively. The PWM function within the PTMn is useful for applications which require functions such as motor control, heating control, illumination control etc. By providing a signal of fixed frequency but of varying duty cycle on the PTMn output pin, a square wave AC waveform can be generated with varying equivalent DC RMS values.

As both the period and duty cycle of the PWM waveform can be controlled, the choice of generated waveform is extremely flexible. In the PWM Output Mode, the PTnCCLR bit has no effect on the PWM operation. Both of the CCRA and CCRP registers are used to generate the PWM waveform, the CCRP is used to clear the internal counter and thus control the PWM waveform frequency, while the CCRA is used to control the duty cycle. The PWM waveform frequency and duty cycle can therefore be controlled by the values in the CCRA and CCRP registers.

An interrupt flag, one for each of the CCRA and CCRP, will be generated when a compare match occurs from either Comparator A or Comparator P. The PTnOC bit in the PTMnC1 register is used to select the required polarity of the PWM waveform while the two PTnIO1 and PTnIO0 bits are used to enable the PWM output or to force the PTMn output to a fixed high or low level. The PTnPOL bit is used to reverse the polarity of the PWM output waveform.

## • 10-bit PTMn, PWM Output Mode, Edge-aligned Mode

CCRP	1~1023	0			
Period	1~1023	1024			
Duty	CCRA				

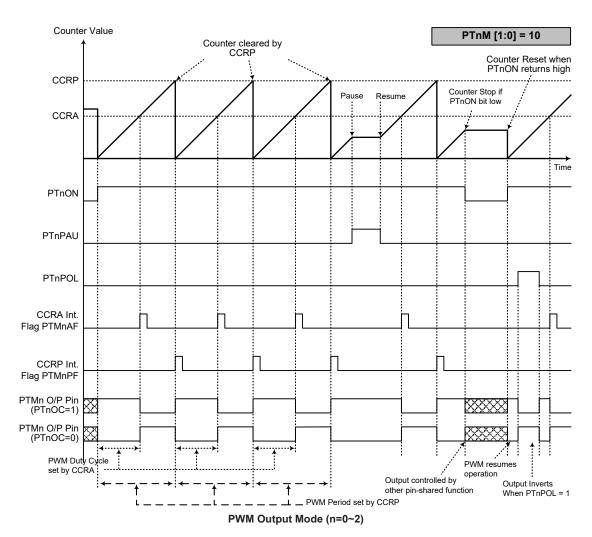
If  $f_{SYS} = 8MHz$ , PTMn clock source select  $f_{SYS}/4$ , CCRP = 512 and CCRA = 128,

The PTMn PWM output frequency =  $(f_{SYS}/4)/512 = f_{SYS}/2048 = 4kHz$ , duty = 128/512 = 25%.

If the Duty value defined by the CCRA register is equal to or greater than the Period value, then the PWM output duty is 100%.

Rev. 1.00 125 August 27, 2021





Note: 1. Counter cleared by CCRP

- 2. A counter clear sets the PWM Period
- 3. The internal PWM function continues running even when PTnIO[1:0]=00 or 01
- 4. The PTnCCLR bit has no influence on PWM operation

Rev. 1.00 126 August 27, 2021

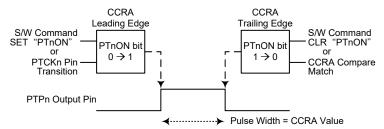


## Single Pulse Output Mode

To select this mode, bits PTnM1 and PTnM0 in the PTMnC1 register should be set to 10 respectively and also the PTnIO1 and PTnIO0 bits should be set to 11 respectively. The Single Pulse Output Mode, as the name suggests, will generate a single shot pulse on the PTMn output pin.

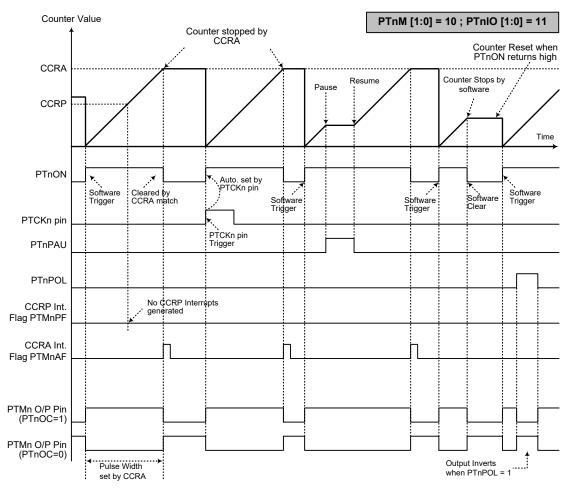
The trigger for the pulse output leading edge is a low to high transition of the PTnON bit, which can be implemented using the application program. However, in the Single Pulse Mode, the PTnON bit can also be made to automatically change from low to high using the external PTCKn pin, which will in turn initiate the Single Pulse output. When the PTnON bit transitions to a high level, the counter will start running and the pulse leading edge will be generated. The PTnON bit should remain high when the pulse is in its active state. The generated pulse trailing edge will be generated when the PTnON bit is cleared to zero, which can be implemented using the application program or when a compare match occurs from Comparator A.

However, a compare match from Comparator A will also automatically clear the PTnON bit and thus generate the Single Pulse output trailing edge. In this way the CCRA value can be used to control the pulse width. A compare match from Comparator A will also generate a PTMn interrupt. The counter can only be reset back to zero when the PTnON bit changes from low to high when the counter restarts. In the Single Pulse Output Mode CCRP is not used. The PTnCCLR bit is not used in this Mode.



Single Pulse Generation (n=0~2)





Single Pulse Output Mode (n=0~2)

Note: 1. Counter stopped by CCRA

- 2. CCRP is not used
- 3. The pulse is triggered by the PTCKn pin or by setting the PTnON bit high
- 4. A PTCKn pin active edge will automatically set the PTnON bit high
- 5. In the Single Pulse Mode, PTnIO[1:0] must be set to "11" and cannot be changed.

Rev. 1.00 128 August 27, 2021



#### Capture Input Mode (n=0)

To select this mode bits PTnM1 and PTnM0 in the PTMnC1 register should be set to 01 respectively. This mode enables external or internal signals to capture and store the present value of the internal counter and can therefore be used for applications such as pulse width measurements. The external or internal signal is supplied on the PTPnI or PTCKn pin which is selected using the PTnCAPTS bit in the PTMnC1 register. While the PTPnI signal can be from the external PTPnI pin input or from the internal CXCAP signal, which is selected using the IFS0[7:6] bits in the IFS0 register. The input pin active edge can be either a rising edge, a falling edge or both rising and falling edges; the active edge transition type is selected using the PTnIO1 and PTnIO0 bits in the PTMnC1 register. The counter is started when the PTnON bit changes from low to high which is initiated using the application program.

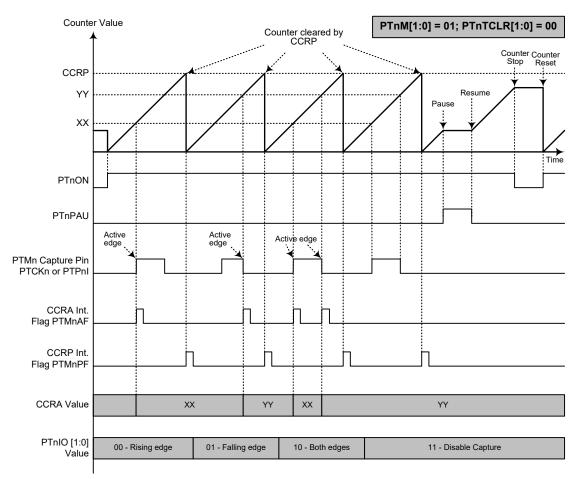
The PTnIO1 and PTnIO0 bits decide which active edge transition type to be latched and interrupted. The PTnTCLR1 and PTnTCLR0 bits decide the condition that the counter reset back to zero. The present counter value latched into CCRA or CCRB is decided by both PTnIO1~PTnIO0 and PTnTCLR1~PTnTCLR0 setting. The PTnIO1~PTnIO0 and PTnTCLR1~PTnTCLR0 are independent on and uninfluenced each other.

When the required edge transition appears on the PTCKn or PTPnI pin or CXCAP signal the present value in the counter will be latched into the CCRA registers or CCRB registers and a PTMn interrupt generated. Irrespective of what events occur on the PTCKn or PTPnI pin or CXCAP signal, the counter will continue to free run until the PTnON bit changes from high to low. When a CCRP compare match occurs the counter will reset back to zero; in this way the CCRP value can be used to control the maximum counter value. When a CCRP compare match occurs from Comparator P, a PTM interrupt will also be generated. Counting the number of overflow interrupt signals from the CCRP can be a useful method in measuring long pulse widths. The PTnIO1 and PTnIO0 bits can select the active trigger edge on the PTCKn or PTPnI pin or CXCAP signal to be a rising edge, falling edge or both edge types. If the PTnIO1 and PTnIO0 bits are both set high, then no capture operation will take place irrespective of what happens on the PTCKn or PTPnI pin or CXCAP signal, however it must be noted that the counter will continue to run.

There are some considerations that should be noted. If PTCK is used as the capture input source, then it cannot be selected as the PTM clock source. If the captured pulse width is less than 2 timer clock periods, it may be ignored by hardware. After the counter value is latched to the CCRA or CCRB registers by an active capture edge, the PTMAF flag will be set high and the PTVLF flag status will be changed after 0.5 timer clock periods. The delay time from the active capture edge received to the action of latching counter value to CCRA or CCRB registers is less than 1.5 timer clock periods. The PTnCCLR, PTnOC and PTnPOL bits are not used in this Mode.

Rev. 1.00 129 August 27, 2021





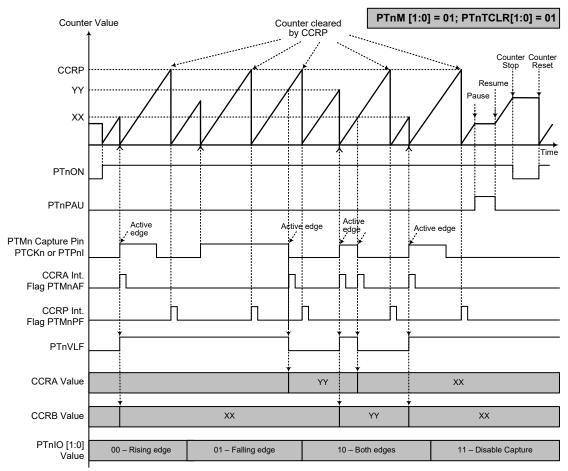
Capture Input Mode - PTnTCLR[1:0]=00 (n=0)

Note: 1. PTnM[1:0]=01, PTnTCLR[1:0]=00 and active edge set by the PTnIO[1:0] bits

- 2. A PTMn Capture input active edge transfers the counter value to CCRA
- 3. Comparator P match will clear the counter
- 4. PTnCCLR bit is not used
- 5. No output function PTnOC and PTnPOL bits are not used
- 6. CCRP determines the counter value and the counter has a maximum count value when CCRP is equal to zero
- 7. Ignore the PTnVLF bit status when PTnTCLR[1:0]=00

Rev. 1.00 130 August 27, 2021





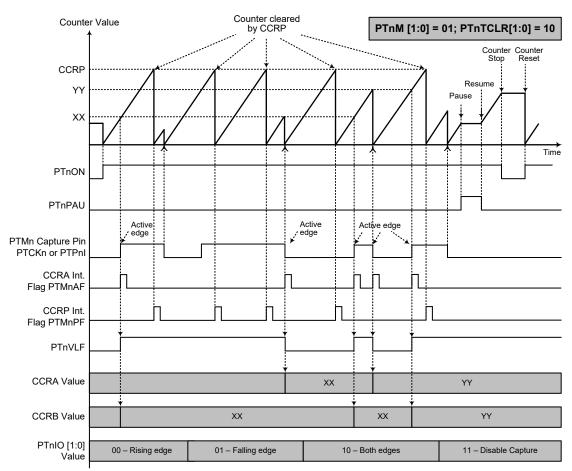
Capture Input Mode - PTnTCLR[1:0]=01 (n=0)

Note: 1. PTnM[1:0]=01, PTnTCLR[1:0]=01 and active edge set by the PTnIO[1:0] bits

- 2. A PTMn Capture input active edge transfers the counter value to CCRA or CCRB
- 3. Comparator P match or PTMn capture input pin rising edge will clear the counter
- 4. PTnCCLR bit is not used
- 5. No output function PTnOC and PTnPOL bits are not used

Rev. 1.00 131 August 27, 2021





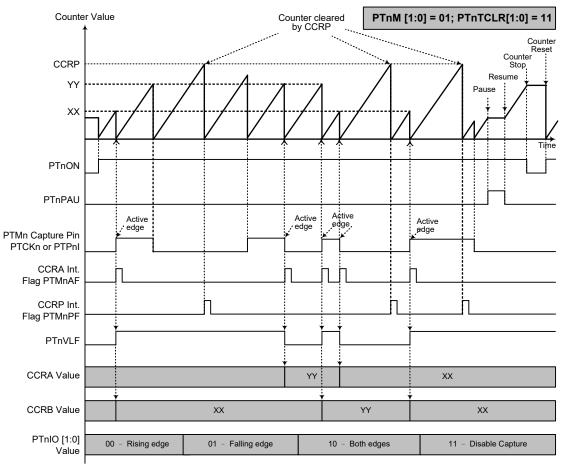
Capture Input Mode - PTnTCLR[1:0]=10 (n=0)

Note: 1. PTnM[1:0]=01, PTnTCLR[1:0]=10 and active edge set by the PTnIO[1:0] bits

- 2. A PTMn Capture input active edge transfers the counter value to CCRA or CCRB
- 3. Comparator P match or PTMn capture input pin falling edge will clear the counter
- 4. PTnCCLR bit is not used
- 5. No output function PTnOC and PTnPOL bits are not used

Rev. 1.00 132 August 27, 2021





Capture Input Mode - PTnTCLR[1:0]=11 (n=0)

Note: 1. PTnM[1:0]=01, PTnTCLR[1:0]=11 and active edge set by the PTnIO[1:0] bits

- 2. A PTMn Capture input active edge transfers the counter value to CCRA or CCRB
- 3. Comparator P match or PTMn capture input pin rising or falling edge will clear the counter
- 4. PTnCCLR bit is not used
- 5. No output function PTnOC and PTnPOL bits are not used

Rev. 1.00 133 August 27, 2021



#### Capture Input Mode (n=1~2)

To select this mode bits PTnM1 and PTnM0 in the PTMnC1 register should be set to 01 respectively. This mode enables external signals to capture and store the present value of the internal counter and can therefore be used for applications such as pulse width measurements. The external signal is supplied on the PTPnI or PTCKn pin which is selected using the PTnCAPTS bit in the PTMnC1 register. The input pin active edge can be either a rising edge, a falling edge or both rising and falling edges; the active edge transition type is selected using the PTnIO1 and PTnIO0 bits in the PTMnC1 register. The counter is started when the PTnON bit changes from low to high which is initiated using the application program.

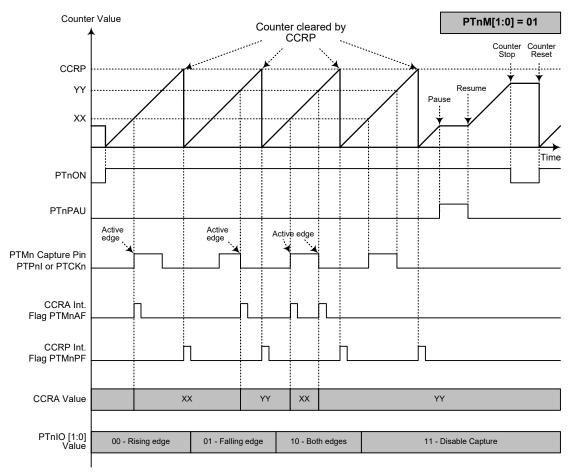
When the required edge transition appears on the PTCKn or PTPnI pin the present value in the counter will be latched into the CCRA registers and a PTMn interrupt generated. Irrespective of what events occur on the PTCKn or PTPnI pin, the counter will continue to free run until the PTnON bit changes from high to low. When a CCRP compare match occurs the counter will reset back to zero; in this way the CCRP value can be used to control the maximum counter value. When a CCRP compare match occurs from Comparator P, a PTM interrupt will also be generated. Counting the number of overflow interrupt signals from the CCRP can be a useful method in measuring long pulse widths. The PTnIO1 and PTnIO0 bits can select the active trigger edge on the PTCnK or PTPnI pin to be a rising edge, falling edge or both edge types. If the PTnIO1 and PTnIO0 bits are both set high, then no capture operation will take place irrespective of what happens on the PTCKn or PTPnI pin, however it must be noted that the counter will continue to run.

There are some considerations that should be noted. If PTCK is used as the capture input source, then it cannot be selected as the PTM clock source. If the captured pulse width is less than 2 timer clock periods, it may be ignored by hardware. After the counter value is latched to the CCRA or CCRB registers by an active capture edge, the PTMAF flag will be set high and the PTVLF flag status will be changed after 0.5 timer clock periods. The delay time from the active capture edge received to the action of latching counter value to CCRA or CCRB registers is less than 1.5 timer clock periods.

The PTnCCLR, PTnOC and PTnPOL bits are not used in this Mode.

Rev. 1.00 134 August 27, 2021





Capture Input Mode (n=1~2)

Note: 1. PTnM[1:0]=01 and active edge set by the PTnIO[1:0] bits

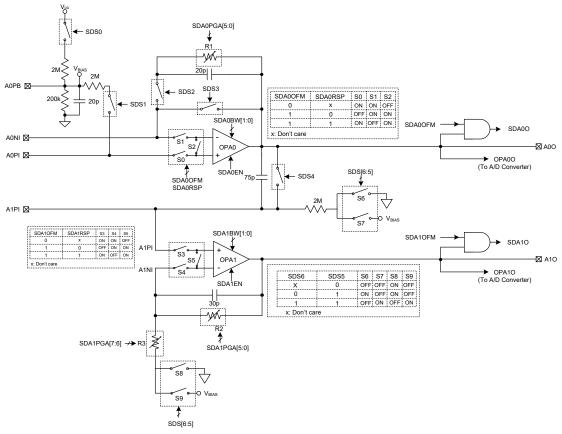
- 2. A PTMn Capture input pin active edge transfers the counter value to CCRA
- 3. PTnCCLR bit is not used
- 4. No output function PTnOC and PTnPOL bits are not used
- 5. CCRP determines the counter value and the counter has a maximum count value when CCRP is equal to zero

Rev. 1.00 135 August 27, 2021



# **Smoke Detector AFE**

The device provides a Smoke Detector AFE circuit which can be used for optical signal detection in Smoke Detector applications. The circuit consists of two fully integrated Operational Amplifiers. The optical signal can be detected and processed by the operational amplifiers.



Smoke Detector AFE Block Diagram

Note that although the SD OPAm bandwidth is determined by the SDAmBW1~SDAmBW0 bits there are some limitations when using the OPAm together with the A/D converter. As the OPAm bandwidth will result in a small current output, care must be taken for SD OPAm bandwidths. Refer to the following table for examples, where values marked with a " $\sqrt{}$ " are usable and ensure that the values read by the 12-bit A/D converter are less than 1 LSB.

SD OPAm		A/D Converter Clock Frequency (kHz)									
Bandwidth Selection	15.625	31.25	62.5	125	250	500	1000	2000			
SDAmBW[1:0]=00	√	_	_	_	_	_	_	_			
SDAmBW[1:0]=01	<b>√</b>	√	√	√	_	_	_	_			
SDAmBW[1:0]=10	√	√	√	√	√	$\checkmark$	√	√			
SDAmBW[1:0]=11	√	√	√	√	√	√	√	√			

Smoke Detector AFE SD OPAm Bandwidth Examples (m=0~1)

Rev. 1.00 136 August 27, 2021



# **Smoke Detector AFE Registers**

Overall operation of the Smoke Detector AFE circuit is controlled using a series of registers. The SDSW register is used to control the switches on or off thus controlling the OPAn Output voltage. The SDPGAC0 and SDPGAC1 register is used to select the R1, R2 and R3 resistance. The SDAnC register where  $n=0\sim1$ , is used to control the SD OPAn enable/disable and bandwidth functions as well as stores the output status. The SDAnVOS register is used to select and control the SD OPAn input offset voltage calibration function.

Register				В	it			
Name	7	6	5	4	3	2	1	0
SDSW	_	SDS6	SDS5	SDS4	SDS3	SDS2	SDS1	SDS0
SDPGAC0	_	_	SDA0PGA5	SDA0PGA4	SDA0PGA3	SDA0PGA2	SDA0PGA1	SDA0PGA0
SDPGAC1	SDA1PGA7	SDA1PGA6	SDA1PGA5	SDA1PGA4	SDA1PGA3	SDA1PGA2	SDA1PGA1	SDA1PGA0
SDA0C	_	SDA0EN	SDA00	_	_	_	SDA0BW1	SDA0BW0
SDA1C	_	SDA1EN	SDA10	_	_	_	SDA1BW1	SDA1BW0
SDA0VOS	SDA00FM	SDA0RSP	SDA00F5	SDA00F4	SDA00F3	SDA00F2	SDA00F1	SDA00F0
SDA1VOS	SDA10FM	SDA1RSP	SDA10F5	SDA10F4	SDA10F3	SDA10F2	SDA10F1	SDA10F0

## Smoke Detector AFE Register List

# SDSW Register

Bit	7	6	5	4	3	2	1	0
Name	_	SDS6	SDS5	SDS4	SDS3	SDS2	SDS1	SDS0
R/W	_	R/W						
POR	_	0	0	0	0	0	0	0

Bit 7 Unimplemented, read as "0"

Bit 6~5 **SDS6~SDS5**: Mode control

00: External mode 01: AC coupling mode 10: External mode

11: DC coupling mode (SDS1 can't ON at the same time)

Bit 4 SDS4: SDS4 switch on/off control

0: Off 1: On

Bit 3 SDS3: SDS3 switch on/off control

0: Off 1: On

Bit 2 SDS2: SDS2 switch on/off control

0: Off 1: On

Bit 1 SDS1: SDS1 switch on/off control

0: Off 1: On

Bit 0 SDS0: SDS0 switch on /off control

0: Off 1: On

## SDPGAC0 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	SDA0PGA5	SDA0PGA4	SDA0PGA3	SDA0PGA2	SDA0PGA1	SDA0PGA0
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5~0 **SDA0PGA5~SDA0PGA0**: R1 control

 $R1=(SDA0PGA[5:0]\times100k\Omega)$ 

# SDPGAC1 Register

Bit	7	6	5	4	3	2	1	0
Name	SDA1PGA7	SDA1PGA6	SDA1PGA5	SDA1PGA4	SDA1PGA3	SDA1PGA2	SDA1PGA1	SDA1PGA0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 **SDA1PGA7~SDA1PGA6**: R3 control

00: 10kΩ 01: 20kΩ 10: 30kΩ 11: 40kΩ

Bit 5~0 SDA1PGA5~SDA1PGA0: R2 control

 $R2=(SDA1PGA[5:0]\times100k\Omega)$ 

# SDA0C Register

Bit	7	6	5	4	3	2	1	0
Name	_	SDA0EN	SDA00	_	_	_	SDA0BW1	SDA0BW0
R/W	_	R/W	R	_	_	_	R/W	R/W
POR	_	0	0	_	_	_	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 SDA0EN: SD OPA0 enable or disable control

0: Disable 1: Enable

Bit 5 SDA00: SD OPA0 output status (positive logic)

This bit is read only.

When the SDA00FM bit is set to 1, SDA0O is defined as SD OPAO output status, refer to the "Operational Amplifier Input Offset Calibration" section for details. When the SDA00FM bit is cleared to 0, this bit will be fixed at a low level.

Bit 4~2 Unimplemented, read as "0"

Bit 1~0 SDA0BW1~SDA0BW0: SD OPA0 bandwidth control

00: 5kHz 01: 40kHz 10: 600kHz 11: 2MHz

Refer to "Operational Amplifier Electrical Characteristics" for details.

Rev. 1.00 138 August 27, 2021



## SDA1C Register

Bit	7	6	5	4	3	2	1	0
Name	_	SDA1EN	SDA10	_	_	_	SDA1BW1	SDA1BW0
R/W	_	R/W	R	_	_	_	R/W	R/W
POR	_	0	0	_	_	_	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 SDA1EN: SD OPA1 enable or disable control

0: Disable 1: Enable

Bit 5 SDA10: SD OPA1 output status (positive logic)

This bit is read only.

When the SDA10FM bit is set to 1, SDA10 is defined as SD OPA1 output status, refer to the "Operational Amplifier Input Offset Calibration" section for details. When the SDA10FM bit is cleared to 0, this bit will be fixed at a low level.

Bit 4~2 Unimplemented, read as "0"

Bit 1~0 **SDA1BW1~SDA1BW0**: SD OPA1 bandwidth control

00: 5kHz 01: 40kHz 10: 600kHz 11: 2MHz

Refer to "Operational Amplifier Electrical Characteristics" for details.

## SDA0VOS Register

Bit	7	6	5	4	3	2	1	0
Name	SDA00FM	SDA0RSP	SDA00F5	SDA00F4	SDA00F3	SDA00F2	SDA00F1	SDA0OF0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	1	0	0	0	0	0

Bit 7 SDA00FM: SD OPA0 normal operation or input offset voltage calibration mode selection

0: Normal operation

1: Offset calibration mode

Bit 6 SDA0RSP: SD OPA0 input offset voltage calibration reference selection

0: Input reference voltage comes from A0NI1: Input reference voltage comes from A0PI

Bit 5~0 SDA0OF5~SDA0OF0: SD OPA0 input offset voltage calibration control

This 6-bit field is used to perform the operational amplifier input offset calibration operation and the value for the SD OPA0 input offset Calibration can be restored into this bit field. More detailed information is described in the "Operational Amplifier Input Offset Calibration" section.

#### SDA1VOS Register

Bit	7	6	5	4	3	2	1	0
Name	SDA10FM	SDA1RSP	SDA10F5	SDA10F4	SDA10F3	SDA10F2	SDA10F1	SDA10F0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	1	0	0	0	0	0

Bit 7 SDA10FM: SD OPA1 normal operation or input offset voltage calibration mode selection

0: Normal operation

1: Offset calibration mode



# BA45F5360 Smoke Detector Flash MCU with 12V Piezoelectric Horn Driver

Bit 6 SDA1RSP: SD OPA1 input offset voltage calibration reference selection

0: Input reference voltage comes from A1NI 1: Input reference voltage comes from A1PI

Bit 5~0 SDA1OF5~SDA1OF0: SD OPA1 input offset voltage calibration control

This 6-bit field is used to perform the operational amplifier input offset calibration operation and the value for the SD OPA1 input offset Calibration can be restored into this bit field. More detailed information is described in the "Operational Amplifier Input Offset Calibration" section.

# **Operational Amplifier Operation**

There are two fully integrated Operational Amplifiers in the device, OPA1 and OPA0. These OPAs can be used for signal amplification according to specific user requirements. The OPAs can be disabled or enabled entirely under software control using internal registers. With specific control registers, some OPA related applications can be more flexible and easier to be implemented, such as Unit Gain Buffer, Non-Inverting Amplifier, Inverting Amplifier and various kinds of filters, etc.

# **Operational Amplifier Input Offset Calibration**

Note that if the SD Operational Amplifier inputs are pin-shared with I/O pins, they should be configured as the SD Operational Amplifier input function before the Input Offset Calibration.

- Step 1. Set SDAnOFM=1 and SDAnRSP=1, the SD Operational Amplifier n is now under the input offset Calibration mode, S0 and S2 on. To make sure the V<sub>AnOS</sub> as minimal as possible after calibration, the input reference voltage in calibration should be the same as input DC operating voltage in normal operation.
- Step 2. Set SDAnOF[5:0]=000000 and then read the SDAnO bit.
- Step 3. Increase the SDAnOF[5:0] value by 1 and then read the SDAnO bit.

If the SDAnO bit state has not changed, then repeat Step 3 until the SDAnO bit state has changed.

If the SDAnO bit state has changed, record the SDAnOF[5:0] value as  $V_{AnOS1}$  and then go to Step 4.

- Step 4. Set SDAnOF[5:0]=111111 and read the SDAnO bit.
- Step 5. Decrease the SDAnOF[5:0] value by 1 and then read the SDAnO bit.

If the SDAnO bit state has not changed, then repeat Step 5 until the SDAnO bit state has changed.

If the SDAnO bit state has changed, record the SDAnOF[5:0] value as  $V_{\text{AnOS2}}$  and then go to Step 6.

Step 6. Restore the SD Operational Amplifier n input offset calibration value V<sub>AnOS</sub> into the SDAnOF[5:0] bit field. The offset Calibration procedure is now finished.

 $V_{AnOS} = (V_{AnOS1} + V_{AnOS2})/2$ 

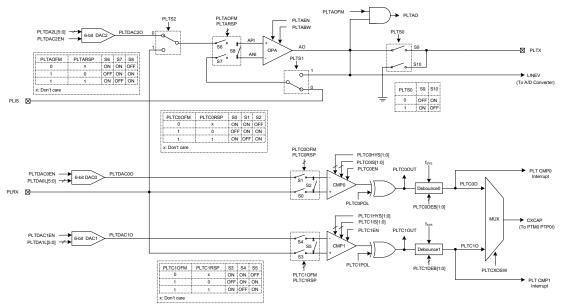
If  $(V_{AnOS1}+V_{AnOS2})/2$  is not integral, discard the decimal.

Rev. 1.00 August 27, 2021



# **Power Line Tranasceiver - PLT**

The device provides a power line transceiver circuit which can be used for power line data transmission and reception. The circuit consists of three 6-bit D/A Converters, one fully integrated Operational Amplifier and two Comparators.



Power Line Data Transceiver Block Diagram

# **Power Line Transceiver Registers**

Overall operation of the Power Line Transceiver circuit is controlled using a series of registers. The DACn outputs, the Operational Amplifier, Comparator input signal selection, operating modes, output signals all can be setup using these registers by application program.

Register					Bit			
Name	7	6	5	4	3	2	1	0
PLTSW	_	_	_	_	_	PLTS2	PLTS1	PLTS0
PLTDACC	_	_	_	_	_	PLTDAC2EN	PLTDAC1EN	PLTDAC0EN
PLTDA0L	_	_	D5	D4	D3	D2	D1	D0
PLTDA1L	_	_	D5	D4	D3	D2	D1	D0
PLTDA2L	_	_	D5	D4	D3	D2	D1	D0
PLTC0C	PLTC0OUT	PLTC0EN	PLTC0O	_	PLTC0DEB1	PLTC0DEB0	PLTC0IS1	PLTC0IS0
PLTC1C	PLTC10UT	PLTC1EN	PLTC10	_	PLTC1DEB1	PLTC1DEB0	PLTC1IS1	PLTC1IS0
PLTC0VOS	_	PLTC0OFM	PLTC0RSP	PLTC0OF4	PLTC0OF3	PLTC0OF2	PLTC0OF1	PLTC0OF0
PLTC1VOS	_	PLTC10FM	PLTC1RSP	PLTC10F4	PLTC1OF3	PLTC1OF2	PLTC1OF1	PLTC1OF0
PLTCHYC	_	PLTCXOSW	PLTC1POL	PLTC0POL	PLTC1HYS1	PLTC1HYS0	PLTC0HYS1	PLTC0HYS0
PLTAC	_	PLTAEN	PLTAO	_	_	_	_	PLTABW
PLTAVOS	PLTAOFM	PLTARSP	PLTAOF5	PLTAOF4	PLTAOF3	PLTAOF2	PLTAOF1	PLTAOF0

Power Line Data Tranasceiver Register List

Rev. 1.00 141 August 27, 2021



## PLTSW Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	PLTS2	PLTS1	PLTS0
R/W	_	_	_	_	_	R/W	R/W	R/W
POR	_	_	_	_	_	0	0	1

Bit 7~3 Unimplemented, read as "0"

Bit 2 **PLTS2**: PLTS2 switch selection

0: Connect to PLTDAC2O

1: Connect to PLRX

Bit 1 **PLTS1**: PLTS1 switch selection

0: Connect to PLIS1: Connect to LINEV

Bit 0 **PLTS0**: PLTX switch selection

0: PLTX switch to GND1: PLTX switch to AO

#### PLTDACC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	PLTDAC2EN	PLTDAC1EN	PLTDAC0EN
R/W	_	_	_	_	_	R/W	R/W	R/W
POR	_	_	_	_	_	0	0	0

Bit 7~3 Unimplemented, read as "0"

Bit 2 PLTDAC2EN: PLT DAC2 enable or disable control

0: Disable (PLTDAC2O high impedance)

1: Enable

Bit 1 PLTDAC1EN: PLT DAC1 enable or disable control

0: Disable (PLTDAC1O high impedance)

1: Enable

Bit 0 **PLTDAC0EN**: PLT DAC0 enable or disable control

0: Disable (PLTDAC0O high impedance)

1: Enable

# PLTDA0L Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	D5	D4	D3	D2	D1	D0
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5~0 **D5~D0**: PLT DAC0 output control code

PLTDAC0O=(DAC AV<sub>DD</sub>/2<sup>6</sup>)×PLTDA0L[5:0]

## PLTDA1L Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	D5	D4	D3	D2	D1	D0
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5~0 **D5~D0**: PLT DAC1 output control code

PLTDAC1O=(DAC AV<sub>DD</sub>/2<sup>6</sup>)×PLTDA1L[5:0]

Rev. 1.00 142 August 27, 2021



## • PLTDA2L Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	D5	D4	D3	D2	D1	D0
R/W	_	_	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5~0 **D5~D0**: PLT DAC2 output control code

PLTDAC2O=(DAC AV<sub>DD</sub>/2<sup>6</sup>)×PLTDA2L[5:0]

## PLTC0C Register

Bit	7	6	5	4	3	2	1	0
Name	PLTC0OUT	PLTC0EN	PLTC00	_	PLTC0DEB1	PLTC0DEB0	PLTC0IS1	PLTC0IS0
R/W	R	R/W	R	_	R/W	R/W	R/W	R/W
POR	0	0	0	_	0	0	0	0

Bit 7 PLTC0OUT: PLT Comparator 0 output bit

If PLTC0POL=0 and input voltages of the comparator are

 $C0PI > C0NI \rightarrow PLTC0OUT=1$  $C0NI > C0PI \rightarrow PLTC0OUT=0$ 

If PLTC0POL=1 and input voltages of the comparator are

 $COPI < CONI \rightarrow PLTCOOUT=1$  $CONI < COPI \rightarrow PLTCOOUT=0$ 

Bit 6 PLTC0EN: PLT Comparator 0 enable or disable control

0: Comparator disable1: Comparator enable

This is the PLT Comparator 0 on/off control bit. If the comparator is disabled, the comparator output will be cleared to 0. Therefore, set PLTC0OUT=0 when PLTC0POL=0, or set PLTC0OUT=1 when PLTC0POL=1.

Bit 5 PLTC00: PLT Comparator 0 debounced output

The PLTC0O is the de-bounce version of PLTC0OUT.

If PLTC0POL=0, the PLTC0O outputs "1" only when the current and previous N samples of PLTC0OUT are "1".

If PLTC0POL=1, The PLTC0O outputs "0" only when the current and previous N samples of PLTC0OUT are "0". N samples is depend on PLTC0DEB [1:0] configuration bits.

Bit 4 Unimplemented, read as "0"

Bit 3~2 PLTC0DEB1~PLTC0DEB0: PLT Comparator 0 debounce time control

00: No debounce 01: (31~32)×t<sub>SYS</sub> 10: (63~64)×t<sub>SYS</sub> 11: (126~127)×t<sub>SYS</sub>

Note:  $t_{SYS}=1/f_{SYS}$ 

Bit 1~0 PLTC0IS1~PLTC0IS0: PLT Comparator 0 current control

Refer to the "Comparator Electrical Characteristics" table for details.



# • PLTC1C Register

Bit	7	6	5	4	3	2	1	0
Name	PLTC10UT	PLTC1EN	PLTC10	_	PLTC1DEB1	PLTC1DEB0	PLTC1IS1	PLTC1IS0
R/W	R	R/W	R	_	R/W	R/W	R/W	R/W
POR	0	0	0	_	0	0	0	0

Bit 7 PLTC1OUT: PLT Comparator 1 output bit

If PLTC1POL=0 and input voltages of the comparator are

 $C1PI > C1NI \rightarrow PLTC1OUT=1$  $C1NI > C1PI \rightarrow PLTC1OUT=0$ 

If PLTC1POL=1 and input voltages of the comparator are

 $C1PI < C1NI \rightarrow PLTC1OUT=1$  $C1NI < C1PI \rightarrow PLTC1OUT=0$ 

Bit 6 PLTC1EN: PLT Comparator 1 enable or disable control

0: Comparator disable1: Comparator enable

This is the PLT Comparator 1 on/off control bit. If the comparator is disabled, the comparator output will be cleared to 0. Therefore, set PLTC1OUT=0 when PLTC1POL=0, or set PLTC1OUT=1 when PLTC1POL=1.

Bit 5 PLTC10: PLT Comparator 1 debounced output

The PLTC1O is the de-bounce version of PLTC1OUT.

If PLTC1POL=0, the PLTC0O outputs "1" only when the current and previous N samples of PLTC1OUT are "1". If PLTC1POL=1, The PLTC1O outputs "0" only when the current and previous N samples of PLTC1OUT are "0". N samples is depend on PLTC1DEB [1:0] configuration bits.

Bit 4 Unimplemented, read as "0"

Bit 3~2 PLTC1DEB1~PLTC1DEB0: PLT Comparator 1 debounce time control

00: No debounce 01: (31~32)×t<sub>SYS</sub> 10: (63~64)×t<sub>SYS</sub> 11: (126~127)×t<sub>SYS</sub> Note: t<sub>SYS</sub>=1/f<sub>SYS</sub>

Bit 1~0 PLTC1IS1~PLTC1IS0: PLT Comparator 1 current control

Refer to the "Comparator Electrical Characteristics" table for details.

#### PLTC0VOS Register

Bit	7	6	5	4	3	2	1	0
Name	_	PLTC0OFM	PLTC0RSP	PLTC0OF4	PLTC0OF3	PLTC0OF2	PLTC0OF1	PLTC0OF0
R/W	_	R/W						
POR	_	0	0	1	0	0	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 PLTC0OFM: PLT Comparator 0 normal operation or input offset voltage calibration mode selection

0: Normal operation

1: Offset calibration mode

Bit 5 PLTC0RSP: PLT Comparator 0 input offset voltage calibration reference selection

0: Input reference voltage comes from C0NI

1: Input reference voltage comes from C0PI

Bit 4~0 PLTC0OF4~PLTC0OF0: PLT Comparator 0 input offset voltage calibration control

This 5-bit field is used to perform the PLT comparator 0 input offset calibration operation and the value for the PLT Comparator 0 input offset calibration can be restored into this bit field. More detailed information is described in the "Comparator Input Offset Calibration" section.

Rev. 1.00 144 August 27, 2021



# • PLTC1VOS Register

Bit	7	6	5	4	3	2	1	0
Name	_	PLTC10FM	PLTC1RSP	PLTC1OF4	PLTC1OF3	PLTC1OF2	PLTC1OF1	PLTC1OF0
R/W	_	R/W						
POR	_	0	0	1	0	0	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 PLTC10FM: PLT Comparator 1 normal operation or input offset voltage calibration mode selection

0: Normal operation

1: Offset calibration mode

Bit 5 PLTC1RSP: PLT Comparator 1 input offset voltage calibration reference selection

0: Input reference voltage comes from C1NI

1: Input reference voltage comes from C1PI

Bit 4~0 PLTC1OF4~PLTC1OF0: PLT Comparator 1 input offset voltage calibration control

This 5-bit field is used to perform the PLT comparator 1 input offset calibration operation and the value for the PLT Comparator 1 input offset calibration can be restored into this bit field. More detailed information is described in the "Comparator Input Offset Calibration" section.

### PLTCHYC Register

Bit	7	6	5	4	3	2	1	0
Name	_	PLTCXOSW	PLTC1POL	PLTC0POL	PLTC1HYS1	PLTC1HYS0	PLTC0HYS1	PLTC0HYS0
R/W	_	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	0	0	0	0	0	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 PLTCXOSW: Comparator 0 or Comparator 1 output selection

0: Comparator 0 Output

1: Comparator 1 Output

This is the Comparator 0 or Comparator 1 output control bit. If the bit is zero then the PLTC0O bit will output condition of the comparator 1. If the bit is high the comparator PLTC1O bit will be output.

Bit 5 PLTC1POL: PLT Comparator 1 output polarity control

0: Non-invert

1: Invert

This is the PLT Comparator 1 polarity bit. If the bit is zero then the PLTC1OUT bit will reflect the non-inverted output condition of the comparator. If the bit is high the comparator PLTC1OUT bit will be inverted.

Bit 4 PLTC0POL: PLT Comparator 0 output polarity control

0: Non-invert

1: Invert

This is the PLT Comparator 0 polarity bit. If the bit is zero then the PLTC0OUT bit will reflect the non-inverted output condition of the comparator 0. If the bit is high the comparator PLTC0OUT bit will be inverted.

Bit 3~2 **PLTC1HYS1~PLTC1HYS0**: PLT Comparator 1 hysteresis voltage window control Refer to "Comparator Characteristics" table for details.

Bit 1~0 PLTC0HYS1~PLTC0HYS0: PLT Comparator 0 hysteresis voltage window control Refer to "Comparator Characteristics" table for details.



#### PLTAC Register

Bit	7	6	5	4	3	2	1	0
Name	_	PLTAEN	PLTAO	_	_	_	_	PLTABW
R/W	_	R/W	R	_	_	_	_	R/W
POR	_	0	0	_	_	_	_	0

Bit 7 Unimplemented, read as "0"

Bit 6 PLTAEN: PLT OPA enable or disable control

0: Disable (AO high impedence)

1: Enable

Bit 5 **PLTAO**: PLT OPA output status (positive logic)

This bit is read only.

When the PLTAOFM bit is set to 1, PLTAO is defined as PLT OPA output status, refer to Offset calibration procedure. When the PLTAOFM bit is cleared to 0, this bit will be

fixed at a low level.

Bit 4~1 Unimplemented, read as "0"

Bit 0 PLTABW: PLT OPA Gain bandwith control bit

0: 600kHz 1: 2MHz

Refer to "Operational Amplifier Electrical Characteristics" table for details.

#### PLTAVOS Register

Bit	7	6	5	4	3	2	1	0
Name	PLTAOFM	PLTARSP	PLTAOF5	PLTAOF4	PLTAOF3	PLTAOF2	PLTAOF1	PLTAOF0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	1	0	0	0	0	0

Bit 7 PLTAOFM: PLT OPA normal operation or input offset voltage cancellation mode

selection

0: Normal operation

1: Offset calibration mode

Bit 6 PLTARSP: PLT OPA input offset voltage calibration reference selection

0: Input reference voltage comes from ANI1: Input reference voltage comes from API

Bit 5~0 PLTAOF5~PLTAOF0: PLT OPA input offset voltage calibration control

This 6-bit field is used to perform the PLT OPA input offset calibration operation and the value for the PLT OPA input offset calibration can be restored into this bit filed. More detailed information is described in the "Operational Amplifier Input Offset

Calibration" section.

### Offset Calibration Procedure

To operate in the input offset calibration mode for the PLT Operational Amplifier or the Comparators, the PLTAOFM or PLTCnOFM bit should first be set to "1" to select the input offset voltage calibration mode. Note that as the comparator or Operational Amplifier input is from the PLRX or PLIS pin which is pin shared with I/O or other functions, before the calibration, they should be configured as PLT comparator or operational amplifier input pin function first.

### **Comparator Input Offset Calibration**

• Step 1

Set PLTCnOFM=1 and PLTCnRSP=1, the PLT Comparator n is now operating in the comparator input offset calibration mode, S0 and S2 on or S3 and S5 on. To make sure V<sub>CnOS</sub> as minimal as possible after calibration, the input reference voltage in calibration should be the same as input DC operating voltage in normal operation.

Rev. 1.00 146 August 27, 2021



• Step 2

Set PLTCnOF[4:0]=00000 and read the PLTCnOUT bit.

• Step 3

Increase the PLTCnOF[4:0] value by 1 and then read the PLTCnOUT bit.

If the PLTCnOUT bit state has not changed, then repeat Step 3 until the PLTCnOUT bit state has changed.

If the PLTCnOUT bit state has changed, record the PLTCnOF[4:0] value as  $V_{\text{CnOSI}}$  and then go to Step 4.

• Step 4

Set PLTCnOF[4:0]=11111 and then read the PLTCnOUT bit.

Step 5

Decrease the PLTCnOF[4:0] value by 1 and then read the PLTCnOUT bit.

If the PLTCnOUT bit state has not changed, then repeat Step 5 until the PLTCnOUT bit state has changed.

If the PLTCnOUT bit state has changed, record the PLTCnOF[4:0] value as  $V_{\text{CnOS2}}$  and then go to Step 6.

• Step 6

Restore the PLT Comparator n input offset calibration value  $V_{CnOS}$  into the PLTCnOF[4:0] bit field. The offset Calibration procedure is now finished.

 $V_{CnOS}=(V_{CnOS1}+V_{CnOS2})/2$ .

If (V<sub>CnOS1</sub>+V<sub>CnOS2</sub>)/2 is not integral, discard the decimal.

### **Operational Amplifier Input Offset Calibration**

• Step1

Set PLTAOFM=1 and PLTARSP=1, the PLT Operational Amplifier is now under offset calibration mode, S6 and S8 on. To make sure  $V_{AOS}$  as minimal as possible after calibration, the input reference voltage in calibration should be the same as input DC operating voltage in normal mode operation.

• Step2

Set PLTAOF[5:0]=000000 and then read PLTAO bit

• Step3

Increase the PLTAOF[5:0] value by 1 and then read the PLTAO bit.

If the PLTAO bit state has not changed, then repeat Step 3 until the PLTAO bit state has changed. If the PLTAO bit state has changed, record the PLTAOF[5:0] value as V<sub>AOS1</sub> and then go to Step 4.

• Step4

Set PLTAOF[5:0]=111111 then read PLTAO bit.

• Step5

Decrease the PLTAOF[5:0] value by 1 and then read the PLTAO bit.

If the PLTAO bit state has not changed, then repeat Step 5 until the PLTAO bit state has changed. If the PLTCAO bit state has changed, record the PLTAOF[5:0] value as  $V_{AOS2}$  and then go to Step 6.

• Sten6

Restore the PLT Operational Amplifier input offset calibration value V<sub>AOS</sub> into the PLTAOF[5:0] bit field. The offset Calibration procedure is now finished.

 $V_{AOS}=(V_{AOS1}+V_{AOS2})/2.$ 

If (V<sub>AOS1</sub>+V<sub>AOS2</sub>)/2 is not integral, discard the decimal.



# **Analog to Digital Converter**

The need to interface to real world analog signals is a common requirement for many electronic systems. However, to properly process these signals by a microcontroller, they must first be converted into digital signals by A/D converters. By integrating the A/D conversion electronic circuitry into the microcontroller, the need for external components is reduced significantly with the corresponding follow-on benefits of lower costs and reduced component space requirements.

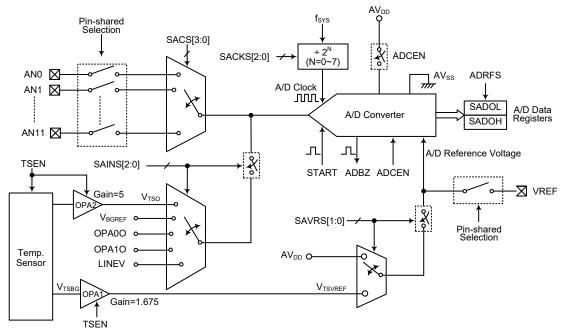
#### A/D Converter Overview

The device contains a multi-channel 12-bit analog to digital converter which can directly interface to external analog signals, such as that from sensors or other control signals and convert these signals directly into a 12-bit digital value. It also can convert the internal signals, the high performance bandgap reference voltage  $V_{BGREF}$ , the SD operational amplifier 0 output signal OPA0O and the SD operational amplifier 1 output signal OPA1O, PLT operational amplifier output signal, LINEV, or the temperature sensor output voltage,  $V_{TSO}$ , into a 12-bit digital value. The external or internal analog signal to be converted is determined by the SAINS2~SAINS0 bits together with the SACS3~SACS0 bits. More detailed information about the A/D input signal is described in the "A/D Converter Control Registers" and "A/D Converter Input Signals" sections respectively.

This A/D converter also includes a temperature sensor circuitry which contains a temperature sensor, two operational amplifiers and an internal reference voltage. The temperature sensor can detect the temperature and then output a voltage proportional to the temperature. The output voltage can be amplified by the OPA and then converted to a 12-bit digital data using the A/D converter.

External Input Channels	Internal Signals	Channel Select Bits
12: AN0~AN11	5: V <sub>BGREF</sub> , OPA0O,	SAINS2~SAINS0,
12. ANU~ANTI	OPA10, LINEV, V <sub>TSO</sub>	SACS3~SACS0

The accompanying block diagram shows the overall internal structure of the A/D converter with temperature sensor, together with its associated registers.



A/D Converter Structure with Temperature Sensor Diagram

Rev. 1.00 148 August 27, 2021



# A/D Converter Register Description

Overall operation of the A/D converter with Temperature sensor is controlled using several registers. A read only register pair exists to store the A/D converter data 12-bit value. Two registers SADC0 and SADC1, are control registers which setup the operating and control function of the A/D converter. The SADC2 is the temperature sensor circuitry control register. The VBGRC resigter is used to enable/disable the A/D converter internal bandgap reference voltage ouput. The remaining two registers, LMSADOH and LMSADOL, are read only registers and store a 12-bit A/D conversion result of certain temperature.

Dowinton				В	it			
Register Name	7	6	5	4	3	2	1	0
SADOH (ADRFS=0)	D11	D10	D9	D8	D7	D6	D5	D4
SADOH (ADRFS=1)	_	_	_	_	D11	D10	D9	D8
SADOL (ADRFS=0)	D3	D2	D1	D0	_	_	_	_
SADOL (ADRFS=1)	D7	D6	D5	D4	D3	D2	D1	D0
SADC0	START	ADBZ	ADCEN	ADRFS	SACS3	SACS2	SACS1	SACS0
SADC1	SAINS2	SAINS1	SAINS0	SAVRS1	SAVRS0	SACKS2	SACKS1	SACKS0
SADC2	_	_	_	_	_	_	G5XEN	TSEN
VBGRC	_	_	_	_	_	_	_	VBGREN
LMSADOH	D11	D10	D9	D8	D7	D6	D5	D4
LMSADOL	D3	D2	D1	D0	_	_	_	_

A/D Converter with Temperature Sensor Register List

# A/D Converter Data Registers - SADOL, SADOH

As the device contains an internal a 12-bit A/D converter, it requires two data registers to store the converted value. These are a high byte register, known as SADOH, and a low byte register, known as SADOL. After the conversion process takes place, these registers can be directly read by the microcontroller to obtain the digitised conversion value. As only 12 bits of the 16-bit register space is utilised, the format in which the data is stored is controlled by the ADRFS bit in the SADC0 register as shown in the accompanying table. D0~D11 are the A/D conversion result data bits. Any unused bits will be read as zero. Note that A/D Converter data register contents will be unchanged if the A/D converter is disabled.

ADDEC				SAE	ЮН							SAI	OOL			
ADRFS	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
0	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	0	0	0	0
1	0	0	0	0	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

A/D Converter Data Registers

# A/D Converter Control Registers - SADC0, SADC1

To control the function and operation of the A/D converter, two control registers known as SADC0 and SADC1 are provided. These 8-bit registers define functions such as the selection of which analog channel is connected to the internal A/D converter, the digitised data format, the A/D clock source as well as controlling the start function and monitoring the A/D converter busy status. As the device contains only one actual analog to digital converter hardware circuit, each of the external or internal analog signal inputs must be routed to the converter. The SACS3~SACS0 bits in the

Rev. 1.00 149 August 27, 2021



SADC0 register are used to determine which external channel input is selected to be converted. The SAINS2~SAINS0 bits in the SADC1 register are used to determine that the analog signal to be converted comes from the internal analog signal or external analog channel input.

The relevant pin-shared function selection bits determine which pins on I/O Ports are used as analog inputs for the A/D converter input and which pins are not to be used as the A/D converter input. When the pin is selected to be an A/D input, its original function whether it is an I/O or other pin-shared function will be removed. In addition, any internal pull-high resistor connected to the pin will be automatically removed if the pin is selected to be an A/D converter input.

### SADC0 Register

Bit	7	6	5	4	3	2	1	0
Name	START	ADBZ	ADCEN	ADRFS	SACS3	SACS2	SACS1	SACS0
R/W	R/W	R	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7 START: Start the A/D conversion

 $0 \rightarrow 1 \rightarrow 0$ : Start

This bit is used to initiate an A/D conversion process. The bit is normally low but if set high and then cleared low again, the A/D converter will initiate a conversion process.

Bit 6 ADBZ: A/D converter busy flag

0: No A/D conversion is in progress

1: A/D conversion is in progress

This read only flag is used to indicate whether the A/D conversion is in progress or not. When the START bit is set from low to high and then to low again, the ADBZ flag will be set to 1 to indicate that the A/D conversion is initiated. The ADBZ flag will be cleared to 0 after the A/D conversion is complete.

Bit 5 ADCEN: A/D converter function enable control

0: Disable 1: Enable

This bit controls the A/D internal function. This bit should be set to one to enable the A/D converter. If the bit is cleared to zero, then the A/D converter will be switched off reducing the device power consumption. When the A/D converter function is disabled, the contents of the A/D data register pair known as SADOH and SADOL will be unchanged.

Bit 4 ADRFS: A/D converter data format select

0: A/D converter data format → SADOH=D[11:4]; SADOL=D[3:0]

1: A/D converter data format  $\rightarrow$  SADOH=D[11:8]; SADOL=D[7:0]

This bit controls the format of the 12-bit converted A/D value in the two A/D data registers. Details are provided in the A/D data register section.

Bit 3~0 SACS3~SACS0: A/D converter external analog channel input select

0000: AN0 0001: AN1 0010: AN2 0011: AN3 0100: AN4 0101: AN5 0110: AN6 0111: AN7 1000: AN8 1001: AN9 1010: AN10

1011: AN11

1100~1111: Non-existed channel, the input will be floating

Rev. 1.00 150 August 27, 2021



# SADC1 Register

Bit	7	6	5	4	3	2	1	0
Name	SAINS2	SAINS1	SAINS0	SAVRS1	SAVRS0	SACKS2	SACKS1	SACKS0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~5 SAINS2~SAINS0: A/D converter input signal select

000: External input - External analog channel input

001: Internal input – Internal high performance bandgap reference voltage, V<sub>BGREF</sub>

010: Internal input – Internal temperature Sensor output voltage,  $V_{TSO}$ 

011: Internal input – Internal SD operational amplifier 0 output signal, OPA0O

100: Internal input – Internal SD operational amplifier 1 output signal, OPA10

101: Internal input – Internal PLT operational amplifier output signal, LINEV

110: External input – External analog channel input

111: Forbidden data, SAINS2~SAINS0 bits can not be written with "111"

Care must be taken if the SAINS2~SAINS0 bits are set from "001~101" to select the internal analog signal to be converted. When the internal analog signal is selected to be converted, the external input pin must never be selected as the A/D input signal by properly setting the SACS3~SACS0 bits. Otherwise, the external channel input will be connected together with the internal analog signal. This will result in unpredictable situations such as an irreversible damage.

#### Bit 4~3 SAVRS1~SAVRS0: A/D converter reference voltage select

00: From external VREF pin

01: Internal A/D converter power, AV<sub>DD</sub>

10: Internal Temperature Sensor reference voltage, V<sub>TSVREF</sub>

11: Internal A/D converter power, AV<sub>DD</sub>

These bits are used to select the A/D converter reference voltage. Care must be taken if the SAVRS1~SAVRS0 bits are set to "01~11" to select the internal A/D converter power or Temperature Sensor reference voltage as the reference voltage source. When the internal A/D converter power or Temperature Sensor reference voltage is selected as the reference voltage, the VREF pin cannot be configured as the reference voltage input by properly configuring the corresponding pin-shared function control bits. Otherwise, the external input voltage on VREF pin will be connected to the internal A/D converter power.

#### Bit 2~0 SACKS2~SACKS0: A/D conversion clock source select

000: f<sub>SYS</sub> 001: fsys/2

010: fsys/4

011:  $f_{SYS}/8$ 

100: f<sub>SYS</sub>/16

101: f<sub>SYS</sub>/32

110: f<sub>SYS</sub>/64

111: fsys/128

These three bits are used to select the clock source for the A/D converter.

Rev. 1.00 151 August 27, 2021



# Bandgap Referenc Voltage Control Register - VBGRC

A high performance bandgap voltage reference is included in the device. It has an accurate voltage reference output,  $V_{\text{BGREF}}$ , when input supply voltage change or temperature variation. The VBGRC register is used to control the bandgap reference voltage circuit enable or disable.

# VBGRC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	_	VBGREN
R/W	_	_	_	_	_	_	_	R/W
POR	_	_	_	_	_	_	_	0

Bit 7~1 Unimplemented, read as "0"

Bit 0 VBGREN: Bandgap enable/disable control

0: Disable 1: Enable

This bit is used to enable/disable the internal Bandgap reference circuit. The internal Bandgap reference circuit should first be enabled before the  $V_{\text{BGREF}}$  voltage is selected to be used.

When the VBGREN bit is cleared to zero, the Bandgap voltage output is in a high impedance state.

# **Temperature Sensor Control Register – SADC2**

To control the enable and disable of the integrated temperature sensor circuitry, a control register known as SADC2 is provided.

#### SADC2 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	G5XEN	TSEN
R/W	_	_	_	_	_	_	R/W	R/W
POR	_	_	_	_	_	_	1	0

Bit 7~2 Unimplemented, read as "0"

Bit 1 **G5XEN**: Reserved bit, should be fixed to 1

Bit 0 TSEN: Temperature sensor circuitry enable control

0: Disable 1: Enable

This bit controls the internal temperature sensor circuitry. If the temperature sensor output will be converted or the temperature sensor reference voltage will be selected as the A/D conversion reference voltage, the temperature sensor circuitry should be turned on by setting the TSEN bit high first. When the temperature sensor is enabled by setting the TSEN bit to 1, a time named as  $t_{TSS}$  should be allowed for the temperature sensor circuit to stabilise before implementing relevant temperature sensor operation.

Rev. 1.00 152 August 27, 2021



#### 85°C A/D Conversion Value Registers - LMSADOH, LMSADOL

A pair of read-only registers, LMSADOH and LMSADOL, are provided to store the 12-bit A/D converted value of 85°C temperature.

Register				LMSA	ADOH							LMS	ADOL			
Bit	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
Name	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	_	_	_	_
R/W	R	R	R	R	R	R	R	R	R	R	R	R	_	_	_	-
POR		85°C A/D Converted Value											_	_	_	—

"—": Unimplemented, read as "0"

85°C A/D Conversion Value Registers

# A/D Converter Operation

The START bit in the SADC0 register is used to start the AD conversion. When the microcontroller sets this bit from low to high and then low again, an analog to digital conversion cycle will be initiated.

The ADBZ bit in the SADC0 register is used to indicate whether the analog to digital conversion process is in progress or not. This bit will be automatically set to 1 by the microcontroller after an A/D conversion is successfully initiated. When the A/D conversion is complete, the ADBZ will be cleared to 0. In addition, the corresponding A/D interrupt request flag will be set in the interrupt control register, and if the interrupts are enabled, an appropriate internal interrupt signal will be generated. This A/D internal interrupt signal will direct the program flow to the associated A/D internal interrupt address for processing. If the A/D internal interrupt is disabled, the microcontroller can poll the ADBZ bit in the SADC0 register to check whether it has been cleared as an alternative method of detecting the end of an A/D conversion cycle.

The clock source for the A/D converter, which originates from the system clock f<sub>SYS</sub>, can be chosen to be either f<sub>SYS</sub> or a subdivided version of f<sub>SYS</sub>. The division ratio value is determined by the SACKS2~SACKS0 bits in the SADC1 register. Although the A/D clock source is determined by the system clock f<sub>SYS</sub> and by bits SACKS2~SACKS0, there are some limitations on the maximum A/D clock source speed that can be selected. As the recommended range of permissible A/D clock period, t<sub>ADCK</sub>, is from 0.5μs to 10μs, care must be taken for system clock frequencies. For example, as the system clock operates at a frequency of 8MHz, the SACKS2~SACKS0 bits should not be set to 000, 001 or 111. Doing so will give A/D clock periods that are less or larger than the minimum or maximum A/D clock period which may result in inaccurate A/D conversion values. Refer to the following table for examples, where values marked with an asterisk \* show where special care must be taken, as the values may be less or larger than the specified A/D Clock Period range.

If the input signal to be converted is the temperature sensor output voltage, the permissible A/D clock period is from  $1\mu$ s to  $2\mu$ s.

		A/D Clock Period (t <sub>ADCK</sub> )										
f <sub>SYS</sub>	SACKS[2:0] = 000 (f <sub>SYS</sub> )	SACKS[2:0] = 001 (f <sub>SYS</sub> /2)	SACKS[2:0] = 010 (f <sub>SYS</sub> /4)	SACKS[2:0] = 011 (f <sub>sys</sub> /8)	SACKS[2:0] = 100 (f <sub>SYS</sub> /16)	SACKS[2:0] = 101 (f <sub>SYS</sub> /32)	SACKS[2:0] = 110 (f <sub>SYS</sub> /64)	SACKS[2:0] = 111 (fsys/128)				
1MHz	1µs	2µs	4µs	8µs	16µs *	32µs *	64µs *	128µs *				
2MHz	500ns	1µs	2µs	4µs	8µs	16µs *	32µs *	64µs *				
4MHz	250ns *	500ns	1µs	2µs	4µs	8µs	16µs *	32µs *				
8MHz	125ns *	250ns *	500ns	1µs	2µs	4µs	8µs	16µs *				

A/D Clock Period Examples

Rev. 1.00 153 August 27, 2021



Controlling the power on/off function of the A/D converter circuitry is implemented using the ADCEN bit in the SADC0 register. This bit must be set high to power on the A/D converter. When the ADCEN bit is set high to power on the A/D converter internal circuitry a certain delay, as indicated in the timing diagram, must be allowed before an A/D conversion is initiated. Even if no pins are selected for use as A/D inputs, if the ADCEN bit is high, then some power will still be consumed. In power conscious applications it is therefore recommended that the ADCEN is set low to reduce power consumption when the A/D converter function is not being used.

# A/D Converter Reference Voltage

The reference voltage supply to the A/D converter can be supplied from the power supply  $AV_{DD}$ , or from an external reference source supplied on pin VREF. The desired selection is made using the SAVRS1~SAVRS0 bits. When the SAVRS bit field is set to "01" or "11", the A/D converter reference voltage will come from the  $AV_{DD}$ . If the temperature sensor reference voltage is required to use, the SAVRS bit field should be set to "10". As the temperature sensor circuitry is controlled by the TSEN bit, the TSEN bit should be set high to enable the temperature sensor. Otherwise, if the SAVRS bit field is set to "00", the A/D converter reference voltage will come from the VREF pin. As the VREF pin is pin-shared with other functions, when the VREF pin is selected as the reference voltage supply pin, the VREF pin-shared function control bit should be properly configured to disable other pin function. However, if the internal A/D converter power  $AV_{DD}$  is selected as the reference voltage, the VREF pin must not be configured as the reference voltage input function to avoid the internal connection between the VREF pin and the power supply. The analog input values must not be allowed to exceed the value of the selected A/D reference voltage.

# A/D Converter Input Signals

All the external A/D analog channel input pins are pin-shared with the I/O pins as well as other functions. The corresponding control bits for each A/D external input pin in the PxS0 and PxS1 registers determine whether the input pins are setup as A/D converter analog input channel or whether they have other functions. If the pin is setup to be as an A/D analog channel input, the original pin functions will be disabled. In this way, pins can be changed under program control to change their function between A/D inputs and other functions. All pull high resistors, which are setup through register programming, will be automatically disconnected if the pins are setup as A/D inputs. Note that it is not necessary to first setup the A/D pin as an input in the port control register to enable the A/D input as when the pin-shared function control bits enable an A/D input, the status of the port control register will be overridden.

There are some internal analog signals derived from the high performance bandgap reference voltage  $V_{BGREF}$ , the SD operational amplifier 0 output signal OPA0O and the SD operational amplifier 1 output signal OPA1O and PLT operational amplifier output signal, LINEV, or the temperature sensor output voltage which can be connected to the A/D converter as the analog input signal by configuring the SAINS2~SAINS0 bits. If the external channel input is selected to be converted, the SAINS2~SAINS0 bits should be set to "000" or "110" and the SACS3~SACS0 bits can determine which external channel is selected. If the internal analog signal is selected to be converted, the SACS3~SACS0 bits must be configured with an appropriate value to switch off the external analog channel input. Otherwise, the internal analog signal will be connected together with the external channel input. This will result in unpredictable situations.

This  $V_{\text{BGREF}}$  is the internal high performance bandgap voltage reference with driver capability. It has accurate voltage reference output when input supply voltage  $AV_{DD}$  change or temperature variation. And, this bandgap will startup at a low supply voltage. Therefore, this voltage reference has high power supply rejection ratio (PSRR) for low dropout regulator (LDO) is presented.

Rev. 1.00 154 August 27, 2021



SAINS[2:0]	SACS[3:0]	Input Signals	Description		
000, 110	0000~1011	AN0~AN11	External pin analog input		
000, 110	1100~1111	_	Non-existed channel, input is floating.		
001 1100~1111 V <sub>BGREF</sub>		V <sub>BGREF</sub>	Internal high performance Bandgap reference voltage		
010	010 1100~1111 V <sub>TSO</sub>		Internal Temperature Sensor output voltage		
011	1100~1111	OPA0O	Internal SD operational amplifier 0 output signal		
100	1100~1111	OPA10	Internal SD operational amplifier 1 output signal		
101	1100~1111	LINEV	Internal PLT operational amplifier output signal		
111 Forbidden data, SAINS2~SAINS0 bits can not be written with "111"					

A/D Converter Input Signal Selection

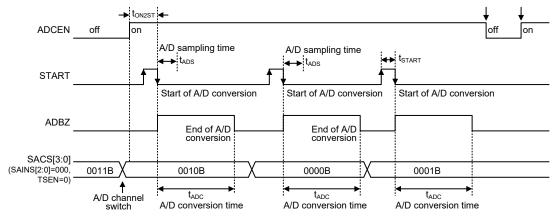
# **Conversion Rate and Timing Diagram**

A complete A/D conversion contains two parts, data sampling and data conversion. If the conversion input signal is not the temperature sensor output, the data sampling which is defined as t<sub>ADS</sub> takes 4 A/D clock cycles and the data conversion takes 12 A/D clock cycles. Therefore a total of 16 A/D clock cycles for an external input A/D conversion which is defined as t<sub>ADC</sub> are necessary. However, an A/D conversion for an internal temperature sensor signal will take a total of 58 A/D clock cycles, which includes 46 A/D clock cycles for data sampling and 12 A/D clock cycles for data conversion.

Maximum single A/D conversion rate = A/D clock period÷16 (Internal Temperature sensor output signal is not used)

Maximum single A/D conversion rate = A/D clock period $\div$ 58 (Internal Temperature sensor output signal is used)

The accompanying diagram shows graphically the various stages involved in an external channel input signal analog to digital conversion process and its associated timing. After an A/D conversion process has been initiated by the application program, the microcontroller internal hardware will begin to carry out the conversion, during which time the program can continue with other functions. The time taken for the A/D conversion is  $16 \ t_{ADCK}$  clock cycles where  $t_{ADCK}$  is equal to the A/D clock period.



A/D Conversion Timing – External Channel Inputs

Rev. 1.00 155 August 27, 2021



# **Summary of A/D Conversion Steps**

The following summarises the individual steps that should be executed in order to implement an A/D conversion process.

• Step 1

Select the required A/D conversion clock by correctly programming bits SACKS2~SACKS0 in the SADC1 register.

• Step 2

Enable the A/D by setting the ADCEN bit in the SADC0 register to 1.

• Step 3

Select which signal is to be connected to the internal A/D converter by correctly configuring the SAINS2~SAINS0 bits

Select the external channel input to be converted, go to Step 4.

Select the internal analog signal to be converted, go to Step 5.

• Step 4

If the A/D input signal comes from the external channel input selected by configuring the SAINS2~SAINS0 bit field, the corresponding pins should be configured as A/D input function by configuring the relevant pin-shared function control bits. The desired analog channel then should be selected by configuring the SACS3~SACS0 bit field. After this step, go to Step 6.

• Step 5

Before the A/D input signal is selected to come from the internal analog signal by configuring the SAINS2~SAINS0 bit field, the corresponding external input pin must be switched to a non-existed channel input by properly configured the SACS3~SACS0 bits. The desired internal analog signal then can be selected by configuring the SAINS2~SAINS0 bit field. After this step, go to Step 6.

• Step 6

Select the reference voltage source by configuring the SAVRS1~SAVRS0 bits in the SADC1 register. Care should be taken in this step which can refer to the A/D Converter Reference Voltage section for details.

• Step 7

Select A/D converter output data format by setting the ADRFS bit in the SADC0 register.

• Step 8

If A/D conversion interrupt is used, the interrupt control registers must be correctly configured to ensure the A/D interrupt function is active. The master interrupt control bit, EMI, and the A/D conversion interrupt control bit, ADE, must both be set high in advance.

• Step 9

The A/D conversion procedure can now be initialized by setting the START bit from low to high and then low again.

• Step 10

If A/D conversion is in progress, the ADBZ flag will be set high. After the A/D conversion process is complete, the ADBZ flag will go low and then the output data can be read from SADOH and SADOL registers.

Note: When checking for the end of the conversion process, if the method of polling the ADBZ bit in the SADC0 register is used, the interrupt enable step above can be omitted.

Rev. 1.00 156 August 27, 2021



# **Programming Considerations**

During microcontroller operations where the A/D converter is not being used, the A/D internal circuitry can be switched off to reduce power consumption, by clearing bit ADCEN to 0 in the SADC0 register. When this happens, the internal A/D converter circuits will not consume power irrespective of what analog voltage is applied to their input lines. If the A/D converter input lines are used as normal I/O pins, then care must be taken as if the input voltage is not at a valid logic level, then this may lead to some increase in power consumption.

# A/D Conversion Function

As the device contains a 12-bit A/D converter, its full-scale converted digitised value is equal to 1FFFH. Since the full-scale analog input value is equal to the actual A/D converter reference voltage,  $V_{\text{REF}}$ , this gives a single bit analog input value of  $V_{\text{REF}}$  divided by 4096.

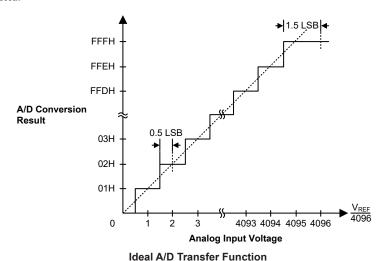
$$1 LSB = V_{REF} \div 4096$$

The A/D Converter input voltage value can be calculated using the following equation:

A/D input voltage = A/D output digital value×
$$(V_{REF} \div 4096)$$

The diagram shows the ideal transfer function between the analog input value and the digitised output value for the A/D converter. Except for the digitised zero value, the subsequent digitised values will change at a point 0.5 LSB below where they would change without the offset, and the last full scale digitised value will change at a point 1.5 LSB below the V<sub>REF</sub> level.

Note that here the  $V_{\text{REF}}$  voltage is the actual A/D converter reference voltage determined by the SAVRS field.



#### Temperature Measurement Function

As the temperature sensor output voltage,  $V_{TSO}$ , has a linear relationship with temperature, the  $V_{TSO}$  A/D converted data value will also have a linear relationship with temperature. The current temperature Tx can be proportionally calculated from its A/D converted value ADCx using the following formula.

$$Tx (^{\circ}C) = slope \times (ADCx - ADC2) + T2$$

Rev. 1.00 157 August 27, 2021



As the device has provided two sets of values which are (ADC1, T1) and (ADC2, T2). The T1 and T2 are two values of temperature and the ADC1 and ADC2 are their A/D converted values respectively. The slope can be calculated using the following formula.

$$slope = (T1-T2)/(ADC1-ADC2)$$

For the device, the T1 has a fixed value of 85°C. The ADC1 can be read from the LMSADOH and LMSADOL registers. The ADC2 and T2 code are stored in the Option Memory and can be read from the Program Memory last page using the table read instruction when the Option Memory mapping function is enabled.

Name	Mapped Address in Program Memory	Description
T1	_	A fixed value of 85°C
ADC1	_	12-bit T1 A/D converted value in LMSADOH & LMSADOL registers
T2	3FF5H	T2 code (00H(0°C)~FFH(51°C)) Temperature value can be converted from the code with 0.2°C/step
ADC2 3FF6H		12-bit T2 A/D converted value bit 11 ~ bit 4
ADC2	3FF7H	4-bit T2 A/D converted value bit 3 ~ bit 0

**Temperature Measurement Reference Items** 

The Option Memory mapping function is enabled by using the ORMC register. For more details, refer to the "Option Memory Mapping Register – ORMC" in the Special Function Register Description section.

# A/D Conversion Programming Examples

The following two programming examples illustrate how to setup and implement an A/D conversion. In the first example, the method of polling the ADBZ bit in the SADC0 register is used to detect when the conversion cycle is complete, whereas in the second example, the A/D interrupt is used to determine when the conversion is complete.

### Example: using an ADBZ polling method to detect the end of conversion

```
clr ADE
                       ; disable ADC interrupt
clr TSEN
                      ; disable temperature sensor circuitry
mov a,0Bh
                      ; select f_{\text{SYS}}/8 as A/D clock, external channel as A/D input signal
mov SADC1, a
                      ; and A/D internal power as reference voltage
                        ; setup PAS1 register to configure pin ANO
mov a,02h
mov PAS1,a
mov a,20h
mov SADCO, a
                      ; enable and connect ANO channel to A/D converter
start conversion:
clr START
                        ; high pulse on start bit to initiate conversion
set START
                        ; reset A/D
clr START
                        ; start A/D
polling EOC:
                        ; poll the SADCO register ADBZ bit to detect end of A/D conversion
sz ADBZ
jmp polling EOC
                      ; continue polling
                        ; read low byte conversion result value
mov a,SADOL
mov SADOL buffer,a
                      ; save result to user defined register
                      ; read high byte conversion result value
mov a, SADOH
mov SADOH buffer,a
                      ; save result to user defined register
:
jmp start conversion ; start next A/D conversion
```

Rev. 1.00 158 August 27, 2021



# Example: using the interrupt method to detect the end of conversion

```
clr ADE
                            ; disable ADC interrupt
clr ADE
clr TSEN
mov a,0Bh
                            ; disable temperature sensor circuitry
                           ; select f_{SYS}/8 as A/D clock, external channel as A/D input signal ; and A/D internal power as reference voltage
mov SADC1, a
                              ; setup PAS1 register to configure pin ANO
mov a,02h
mov PAS1,a
mov a,20h
mov SADCO, a
                            ; enable and connect ANO channel to A/D converter
Start conversion:
                            ; high pulse on START bit to initiate conversion
clr START
set START
                            ; reset A/D
clr START
                            ; start A/D
clr ADF
                            ; clear ADC interrupt request flag
set ADE
                            ; enable ADC interrupt
set EMI
                            ; enable global interrupt
; ADC interrupt service routine
mov acc stack,a
                            ; save ACC to user defined memory
mov a,STATUS
mov status_stack,a
                            ; save STATUS to user defined memory
mov a,SADOL
                            ; read low byte conversion result value
mov SADOL_buffer,a ; save result to user defined register mov a,SADOH ; read high byte conversion result value mov SADOH_buffer,a ; save result to user defined register
EXIT INT ISR:
mov a, status stack

      mov
      STATUS,a
      ; restore STATUS from user defined memory

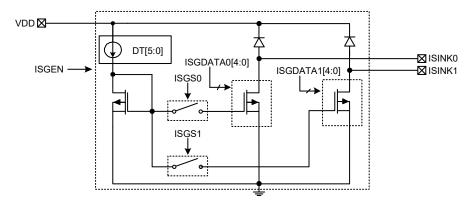
      mov
      a,acc_stack
      ; restore ACC from user defined memory

reti
```



# **Sink Current Generator**

The sink current source generator could provide constant current no matter what  $V_{ISINK}$  voltage is from 1.0V~4.5V. The constant current value is controlled by the ISGDATA0/ISGDATA1 register, and the sink current range is  $50mA\sim360mA$ .



# **Sink Current Generator Registers**

There are a series of registers control the overall operation of the Sink Current Generator function.

Register	Bit									
Name	7	6	5	4	3	2	1	0		
ISGENC	ISGEN	_	_	_	_	_	ISGS1	ISGS0		
ISGDATA0	_	_	_	D4	D3	D2	D1	D0		
ISGDATA1	_	_	_	D4	D3	D2	D1	D0		

Sink Current Generator Register List

# • ISGENC Register

Bit	7	6	5	4	3	2	1	0
Name	ISGEN	_	_	_	_	_	ISGS1	ISGS0
R/W	R/W	_	_	_	_	_	R/W	R/W
POR	0	_	_	_	_	_	0	0

Bit 7 ISGEN: Sink current generator enable control

0: Disable 1: Enable

When the ISGEN bit is cleared to zero to disable the sink current generator, the ISINK0 and ISINK1 pin status are  $V_{ISINK0/I}$ =floating,  $I_{ISINK0/I}$ =0.

Bit 6~2 Unimplemented, read as "0"

Bit 1 ISGS1: ISINK1 pin sink current control

0: Disable 1: Enable

Bit 0 ISGS0: ISINK0 pin sink current control

0: Disable 1: Enable

Rev. 1.00 160 August 27, 2021



# ISGDATA0 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	D4	D3	D2	D1	D0
R/W	_	_	_	R/W	R/W	R/W	R/W	R/W
POR	_	_	_	0	0	0	0	0

Bit 7~5 Unimplemented, read as "0"

Bit 4~0 **D4~D0**: Sink current generator control for ISINK0 pin

Current value (mA) =  $50+10\times(ISGDATA0[4:0])$ 

Refer to "Sink Current Generator Electrical Characteristics" table for more details.

# • ISGDATA1 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	D4	D3	D2	D1	D0
R/W	_	_	_	R/W	R/W	R/W	R/W	R/W
POR	_	_	_	0	0	0	0	0

Bit 7~5 Unimplemented, read as "0"

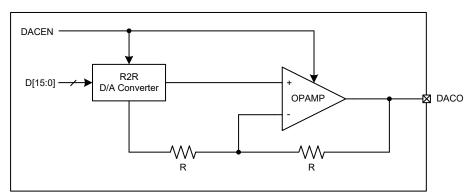
Bit 4~0 **D4~D0**: Sink current generator control for ISINK1 pin

Current value (mA) =  $50+5\times(ISGDATA1[4:0])$ 

Refer to "Sink Current Generator Electrical Characteristics" table for more details.

# 16-bit Voice D/A Converter

The device has a 16-bit D/A Converter. The circuit is a 16-bit R2R D/A Converter for audio application. Its reference voltage comes from analog supply voltage only, and can be power down to save power. The 16-bit D/A Converter is good for voice or audio application. Although this D/A Converter is not general one-to-one digital to analog conversion, it provides not bad and same audio quality no matter what small or big voice. Note that the D/A Converter voltage is amplified and buffer output by OPAMP.



16-bit D/A Converter Block Diagram

# **D/A Converter Registers**

Overall operation of the D/A Converter is controlled by using three registers. There are a 16-bit D/A Converter data high byte register, DAH, a 16-bit D/A Converter data low byte register, DAL, and a control register named as DACC is used to control the function and operation of the D/A converter.

Rev. 1.00 161 August 27, 2021

Register		Bit									
Name	7	6	5	4	3	2	1	0			
DAH	D15	D14	D13	D12	D11	D10	D9	D8			
DAL	D7	D6	D5	D4	D3	D2	D1	D0			
DACC	_	_	_	_	_	_	_	DACEN			

16-bit D/A Converter Register List

# DAH register

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0 **D15~D8**: 16-bit D/A converter data high byte

The 16-bit D/A converter Data low byte register, known as DAL, should first be modified and then followed by the DAH register modification. Each time when the DAH register is written, the whole 16-bit data will be loaded into the D/A converter and a conversion cycle will be initiated. Note that the D/A converter should first be enabled before the D/A converter data is updated.

# DAL register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0 **D7~D0**: 16-bit D/A converter data low byte

Writing this register will only write the data to the shadow buffer and writing the DAH register will simultaneously copy the shadow buffer data to the DAL register. Note that the D/A converter should first be enabled before the D/A converter is updated.

# DACC register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	_	DACEN
R/W	_	_	_	_	_	_	_	R/W
POR	_	_	_	_	_	_	_	0

Bit 7~1 Unimplemented, read as "0"

Bit 0 DACEN: D/A converter enable or disable control

0: Disable 1: Enable

If the D/A converter is enable, users must wait  $t_{DACS}$  time to ensure the D/A converter circuit is stable. A time  $t_{DACS}$  should be allowed for the D/A converter circuit to stabilize. And the 16-bit D/A converter data register should be updated after D/A converter circuit is stable.

Rev. 1.00 162 August 27, 2021



# Serial Interface Module - SIM

The device contains a Serial Interface Module, which includes both the four line SPI interface and the two line I<sup>2</sup>C interface types, to allow an easy method of communication with external peripheral hardware. Having relatively simple communication protocols, these serial interface types allow the microcontroller to interface to external SPI or I<sup>2</sup>C based hardware such as sensors, Flash or EEPROM memory, etc. The SIM interface pins are pin-shared with other I/O pins therefore the SIM interface functional pins must first be selected using the corresponding pin-shared function selection bits. As both interface types share the same pins and registers, the choice of whether the SPI or I<sup>2</sup>C type is used is made using the SIM operating mode control bits, named SIM2~SIM0, in the SIMC0 register. These pull-high resistors of the SIM pin-shared I/O are selected using pull-high control registers when the SIM function is enabled and the corresponding pins are used as SIM input pins.

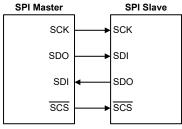
#### **SPI Interface**

The SPI interface is often used to communicate with external peripheral devices such as sensors, Flash or EEPROM memory devices etc. Originally developed by Motorola, the four line SPI interface is a synchronous serial data interface that has a relatively simple communication protocol simplifying the programming requirements when communicating with external hardware devices.

The communication is full duplex and operates as a slave/master type, where the device can be either master or slave. Although the SPI interface specification can control multiple slave devices from a single master, but the device provide only one  $\overline{SCS}$  pin. If the master needs to control multiple slave devices from a single master, the master can use I/O pin to select the slave devices.

### **SPI Interface Operation**

The SPI interface is a full duplex synchronous serial data link. It is a four line interface with pin names SDI, SDO, SCK and  $\overline{SCS}$ . Pins SDI and SDO are the Serial Data Input and Serial Data Output lines, the SCK pin is the Serial Clock line and  $\overline{SCS}$  is the Slave Select line. As the SPI interface pins are pin-shared with normal I/O pins and with the I<sup>2</sup>C function pins, the SPI interface pins must first be selected by configuring the pin-shared function selection bits and setting the correct bits in the SIMC0 and SIMC2 registers. Communication between devices connected to the SPI interface is carried out in a slave/master mode with all data transfer initiations being implemented by the master. The Master also controls the clock signal. As the device only contains a single  $\overline{SCS}$  pin only one slave device can be utilized. The  $\overline{SCS}$  pin is controlled by software, set CSEN bit to 1 to enable  $\overline{SCS}$  pin function, set CSEN bit to 0 the  $\overline{SCS}$  pin will be floating state.



**SPI Master/Slave Connection** 

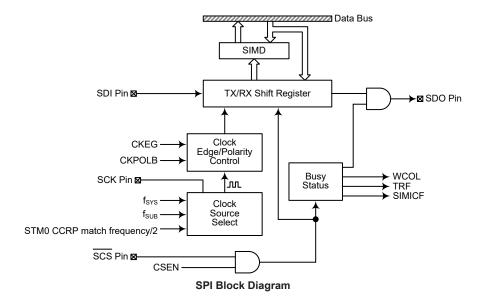
The SPI function in the device offers the following features:

- · Full duplex synchronous data transfer
- Both Master and Slave modes
- LSB first or MSB first data transmission modes
- · Transmission complete flag
- · Rising or falling active clock edge

Rev. 1.00 163 August 27, 2021



The status of the SPI interface pins is determined by a number of factors such as whether the device is in the master or slave mode and upon the condition of certain control bits such as CSEN and SIMEN.



# **SPI Registers**

There are three internal registers which control the overall operation of the SPI interface. These are the SIMD data register and two control registers, SIMC0 and SIMC2.

Register		Bit										
Name	7	6	5	4	3	2	1	0				
SIMC0	SIM2	SIM1	SIM0	_	SIMDEB1	SIMDEB0	SIMEN	SIMICF				
SIMC2	D7	D6	CKPOLB	CKEG	MLS	CSEN	WCOL	TRF				
SIMD	D7	D6	D5	D4	D3	D2	D1	D0				

**SPI Register List** 

# **SPI Data Register**

The SIMD register is used to store the data being transmitted and received. The same register is used by both the SPI and I<sup>2</sup>C functions. Before the device writes data to the SPI bus, the actual data to be transmitted must be placed in the SIMD register. After the data is received from the SPI bus, the device can read it from the SIMD register. Any transmission or reception of data from the SPI bus must be made via the SIMD register.

# SIMD Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	Х	Х	Х	Х	Х	Х	Х	Х

"x": unknown

Bit  $7 \sim 0$  **D7\simD0**: SIM data register bit  $7 \sim$  bit 0

Rev. 1.00 164 August 27, 2021



# **SPI Control Registers**

There are also two control registers for the SPI interface, SIMC0 and SIMC2. Note that the SIMC2 register also has the name SIMA which is used by the I2C function. The SIMC0 register is used to control the enable/disable function and to set the data transmission clock frequency. The SIMC2 register is used for other control functions such as LSB/MSB selection, write collision flag etc.

### SIMC0 Register

Bit	7	6	5	4	3	2	1	0
Name	SIM2	SIM1	SIM0	_	SIMDEB1	SIMDEB0	SIMEN	SIMICF
R/W	R/W	R/W	R/W	_	R/W	R/W	R/W	R/W
POR	1	1	1	_	0	0	0	0

Bit 7~5 SIM2~SIM0: SIM Operating Mode Control

> 000: SPI master mode; SPI clock is f<sub>SYS</sub>/4 001: SPI master mode; SPI clock is f<sub>SYS</sub>/16 010: SPI master mode; SPI clock is f<sub>SYS</sub>/64 011: SPI master mode; SPI clock is f<sub>SUB</sub>

100: SPI master mode; SPI clock is STM0 CCRP interrupt frequency/2

101: SPI slave mode 110: I2C slave mode

111: Unused

These bits setup the overall operating mode of the SIM function. As well as selecting if the I<sup>2</sup>C or SPI function, they are used to control the SPI Master/Slave selection and the SPI Master clock frequency. The SPI clock is a function of the system clock but can also be chosen to be sourced from STM0 CCRP interrupt and f<sub>SUB</sub>. If the SPI Slave Mode is selected then the clock will be supplied by an external Master device.

Bit 4 Unimplemented, read as "0"

Bit 3~2 SIMDEB1~SIMDEB0: I2C Debounce Time Selection

These bits are only available when the SIM is configured to operate in the I<sup>2</sup>C mode.

Refer to the I<sup>2</sup>C register section.

Bit 1 SIMEN: SIM Enable Control

0: Disable 1: Enable

The bit is the overall on/off control for the SIM interface. When the SIMEN bit is cleared to zero to disable the SIM interface, the SDI, SDO, SCK and SCS, or SDA and SCL lines will lose their SPI or I<sup>2</sup>C function and the SIM operating current will be reduced to a minimum value. When the bit is high the SIM interface is enabled. If the SIM is configured to operate as an SPI interface via the SIM2~SIM0 bits, the contents of the SPI control registers will remain at the previous settings when the SIMEN bit changes from low to high and should therefore be first initialised by the application program. If the SIM is configured to operate as an I<sup>2</sup>C interface via the SIM2~SIM0 bits and the SIMEN bit changes from low to high, the contents of the I<sup>2</sup>C control bits such as HTX and TXAK will remain at the previous settings and should therefore be first initialised by the application program while the relevant I<sup>2</sup>C flags such as HCF, HAAS, HBB, SRW and RXAK will be set to their default states.

Bit 0 **SIMICF**: SIM SPI Incomplete Flag

0: SIM SPI communication incompleted did not occur

1: SIM SPI communication incompleted occurred

This bit is only available when the SIM is configured to operate in an SPI slave mode. If the SPI operates in the slave mode with the SIMEN and CSEN bits both being set to 1 but the SCS line is pulled high by the external master device before the SPI data receive is completely finished, the SIMICF bit will be set to 1 together with the TRF bit set high. When this condition occurs, the corresponding interrupt will occur if the interrupt function is enabled. However, the TRF bit will not be set to 1 if the SIMICF bit is set to 1 by software application program.

### SIMC2 Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	CKPOLB	CKEG	MLS	CSEN	WCOL	TRF
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 **D7~D6**: Undefined bits

These bits can be read or written by application program.

Bit 5 **CKPOLB**: SPI clock line base condition selection

0: The SCK line will be high when the clock is inactive

1: The SCK line will be low when the clock is inactive

The CKPOLB bit determines the base condition of the clock line, if the bit is high, then the SCK line will be low when the clock is inactive. When the CKPOLB bit is low, then the SCK line will be high when the clock is inactive.

Bit 4 **CKEG**: SPI SCK clock active edge type selection

CKPOLB=0

- 0: SCK is high base level when the clock is inactive and data capture at SCK rising edge
- 1: SCK is high base level when the clock is inactive and data capture at SCK falling edge

CKPOLB=1

- 0: SCK is low base level when the clock is inactive and data capture at SCK falling edge
- 1: SCK is low base level when the clock is inactive and data capture at SCK rising edge

The CKEG and CKPOLB bits are used to setup the way that the clock signal outputs and inputs data on the SPI bus. These two bits must be configured before data transfer is executed otherwise an erroneous clock edge may be generated. The CKPOLB bit determines the base condition of the clock line, if the bit is high, then the SCK line will be low when the clock is inactive. When the CKPOLB bit is low, then the SCK line will be high when the clock is inactive. The CKEG bit determines active clock edge type which depends upon the condition of CKPOLB bit.

Bit 3 MLS: SPI data shift order

0: LSB first

1: MSB first

This is the data shift select bit and is used to select how the data is transferred, either MSB or LSB first. Setting the bit high will select MSB first and low for LSB first.

Bit 2 CSEN: SPI SCS pin control

0: Disable

1: Enable

The CSEN bit is used as an enable/disable for the  $\overline{SCS}$  pin. If this bit is low, then the  $\overline{SCS}$  pin will be disabled and placed into a floating condition. If the bit is high the  $\overline{SCS}$  pin will be enabled and used as a select pin.

Bit 1 WCOL: SPI write collision flag

0: No collision

1: Collision

The WCOL flag is used to detect if a data collision has occurred. If this bit is high it means that data has been attempted to be written to the SIMD register during a data transfer operation. This writing operation will be ignored if data is being transferred. The bit can be cleared by the application program.

Bit 0 TRF: SPI Transmit/Receive complete flag

0: SPI data is being transferred

1: SPI data transmission is completed

The TRF bit is the Transmit/Receive Complete flag and is set "1" automatically when an SPI data transmission is completed, but must set to "0" by the application program. It can be used to generate an interrupt.

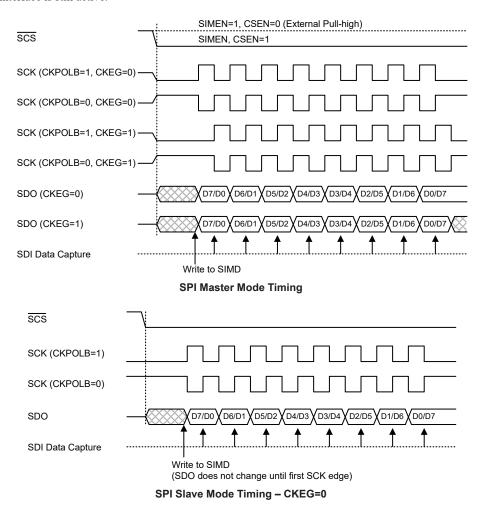
Rev. 1.00 166 August 27, 2021



#### **SPI Communication**

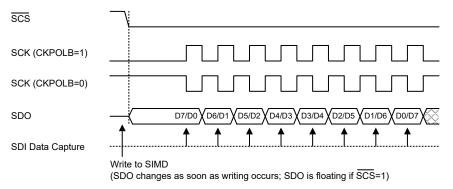
After the SPI interface is enabled by setting the SIMEN bit high, then in the Master Mode, when data is written to the SIMD register, transmission/reception will begin simultaneously. When the data transfer is complete, the TRF flag will be set automatically, but must be cleared using the application program. In the Slave Mode, when the clock signal from the master has been received, any data in the SIMD register will be transmitted and any data on the SDI pin will be shifted into the SIMD register. The master should output an  $\overline{SCS}$  signal to enable the slave devices before a clock signal is provided. The slave data to be transferred should be well prepared at the appropriate moment relative to the SCK signal depending upon the configurations of the CKPOLB bit and CKEG bit. The accompanying timing diagram shows the relationship between the slave data and  $\overline{SCS}$  signal for various configurations of the CKPOLB and CKEG bits.

The SPI will continue to function in certain IDLE Modes in which the clock source used by the SPI interface is still active.



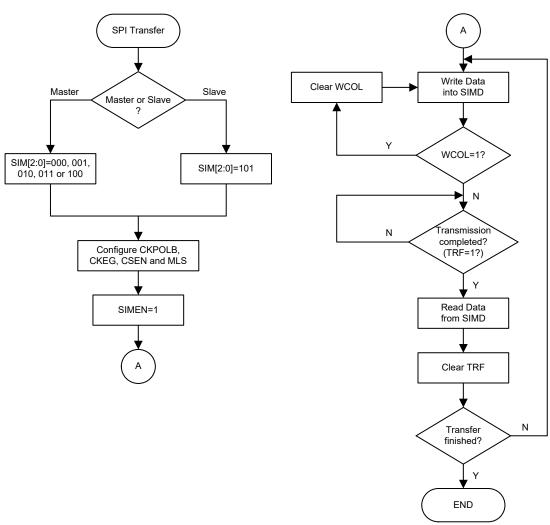
Rev. 1.00 167 August 27, 2021





Note: For SPI slave mode, if SIMEN=1 and CSEN=0, SPI is always enabled and ignores the  $\overline{\text{SCS}}$  level.

# SPI Slave Mode Timing - CKEG=1



**SPI Transfer Control Flowchart** 

Rev. 1.00 168 August 27, 2021



#### SPI Bus Enable/Disable

To enable the SPI bus, set CSEN=1 and  $\overline{SCS}$ =0, then wait for data to be written into the SIMD (TXRX buffer) register. For the Master Mode, after data has been written to the SIMD (TXRX buffer) register, then transmission or reception will start automatically. When all the data has been transferred, the TRF bit should be set high. For the Slave Mode, when clock pulses are received on SCK, data in the TXRX buffer will be shifted out or data on SDI will be shifted in.

When the SPI bus is disabled, SCK, SDI, SDO and  $\overline{SCS}$  can become I/O pins or other pin-shared functions using the corresponding pin-shared control bits.

# **SPI Operation Steps**

All communication is carried out using the 4-line interface for either Master or Slave Mode.

The CSEN bit in the SIMC2 register controls the overall function of the SPI interface. Setting this bit high will enable the SPI interface by allowing the  $\overline{SCS}$  line to be active, which can then be used to control the SPI interface. If the CSEN bit is low, the SPI interface will be disabled and the  $\overline{SCS}$  line will be in a floating condition and can therefore not be used for control of the SPI interface. If the CSEN bit and the SIMEN bit in the SIMC0 are set high, this will place the SDI line in a floating condition and the SDO line high. If in Master Mode the SCK line will be either high or low depending upon the clock polarity selection bit CKPOLB in the SIMC2 register. If in Slave Mode the SCK line will be in a floating condition. If the SIMEN bit is low, then the bus will be disabled and  $\overline{SCS}$ , SDI, SDO and SCK will all become I/O pins or the other functions using the corresponding pin-shared control bits. In the Master Mode the Master will always generate the clock signal. The clock and data transmission will be initiated after data has been written into the SIMD register. In the Slave Mode, the clock signal will be received from an external master device for both data transmission and reception. The following sequences show the order to be followed for data transfer in both Master and Slave Mode.

# **Master Mode:**

- Step 1
   Select the SPI Master mode and clock source using the SIM2~SIM0 bits in the SIMC0 control register.
- Step 2
   Setup the CSEN bit and setup the MLS bit to choose if the data is MSB or LSB first, this setting
  must be the same with the Slave devices.
- Step 3
   Setup the SIMEN bit in the SIMC0 control register to enable the SPI interface.
- Step 4
   For write operations: write the data to the SIMD register, which will actually place the data into the TXRX buffer. Then use the SCK and SCS lines to output the data. After this, go to step 5.

   For read operations: the data transferred in on the SDI line will be stored in the TXRX buffer until all the data has been received at which point it will be latched into the SIMD register.
- Step 5
   Check the WCOL bit if set high then a collision error has occurred so return to step 4. If equal to zero then go to the following step.
- Step 6
   Check the TRF bit or wait for a SIM SPI serial bus interrupt.
- Step 7
  Read data from the SIMD register.

Rev. 1.00 169 August 27, 2021

- Step 8 Clear TRF.
- Step 9
  Go to step 4.

#### Slave Mode:

• Step 1

Select the SPI Slave mode using the SIM2~SIM0 bits in the SIMC0 control register

• Sten 2

Setup the CSEN bit and setup the MLS bit to choose if the data is MSB or LSB first, this setting must be the same with the Master devices.

• Step 3
Setup the SIMEN bit in the SIMC0 control register to enable the SPI interface.

Step 4

For write operations: write the data to the SIMD register, which will actually place the data into the TXRX buffer. Then wait for the master clock SCK and  $\overline{SCS}$  signal. After this, go to step5. For read operations: the data transferred in on the SDI line will be stored in the TXRX buffer until all the data has been received at which point it will be latched into the SIMD register.

Step 5
 Check the WCOL bit if set high then a collision error has occurred so return to step 4. If equal to zero then go to the following step.

Step 6
 Check the TRF bit or wait for a SPI serial bus interrupt.

• Step 7
Read data from the SIMD register.

• Step 8 Clear TRF.

• Step 9
Go to step 4.

#### **Error Detection**

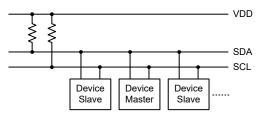
The WCOL bit in the SIMC2 register is provided to indicate errors during data transfer. The bit is set by the SPI serial Interface but must be cleared by the application program. This bit indicates a data collision has occurred which happens if a write to the SIMD register takes place during a data transfer operation and will prevent the write operation from continuing.

Rev. 1.00 170 August 27, 2021



# I<sup>2</sup>C Interface

The I<sup>2</sup>C interface is used to communicate with external peripheral devices such as sensors, EEPROM memory etc. Originally developed by Philips, it is a two line low speed serial interface for synchronous serial data transfer. The advantage of only two lines for communication, relatively simple communication protocol and the ability to accommodate multiple devices on the same bus has made it an extremely popular interface type for many applications.

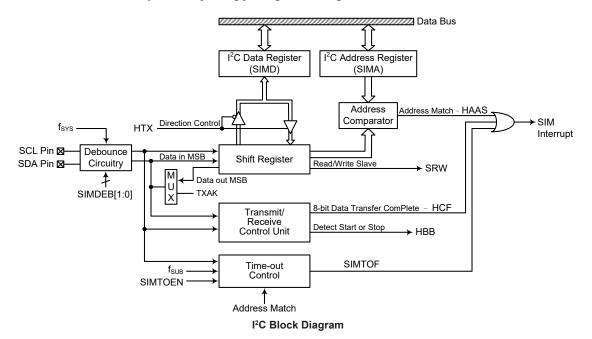


I<sup>2</sup>C Master Slave Bus Connection

### I<sup>2</sup>C Interface Operation

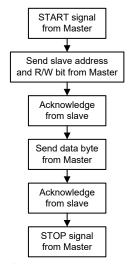
The I<sup>2</sup>C serial interface is a two line interface, a serial data line, SDA, and serial clock line, SCL. As many devices may be connected together on the same bus, their outputs are both open drain types. For this reason it is necessary that external pull-high resistors are connected to these outputs. Note that no chip select line exists, as each device on the I<sup>2</sup>C bus is identified by a unique address which will be transmitted and received on the I<sup>2</sup>C bus.

When two devices communicate with each other on the bidirectional I<sup>2</sup>C bus, one is known as the master device and one as the slave device. Both master and slave can transmit and receive data, however, it is the master device that has overall control of the bus. For the device, which only operates in slave mode, there are two methods of transferring data on the I<sup>2</sup>C bus, the slave transmit mode and the slave receive mode. The pull-high control function pin-shared with SCL/SDA pin is still applicable even if I<sup>2</sup>C device is activated and the related internal pull-high function could be controlled by its corresponding pull-high control register.



Rev. 1.00 171 August 27, 2021





I<sup>2</sup>C Interface Operation

The SIMDEB1 and SIMDEB0 bits determine the debounce time of the I<sup>2</sup>C interface. This uses the internal clock to in effect add a debounce time to the external clock to reduce the possibility of glitches on the clock line causing erroneous operation. The debounce time, if selected, can be chosen to be either 2 or 4 system clocks. To achieve the required I<sup>2</sup>C data transfer speed, there exists a relationship between the system clock, f<sub>SYS</sub>, and the I<sup>2</sup>C debounce time. For either the I<sup>2</sup>C Standard or Fast mode operation, users must take care of the selected system clock frequency and the configured debounce time to match the criterion shown in the following table.

I <sup>2</sup> C Debounce Time Selection	I <sup>2</sup> C Standard Mode (100kHz)	I <sup>2</sup> C Fast Mode (400kHz)		
No Debounce	f <sub>SYS</sub> > 2MHz	$f_{SYS} > 5MHz$		
2 system clock debounce	f <sub>SYS</sub> > 4MHz	$f_{SYS} > 10MHz$		
4 system clock debounce	f <sub>SYS</sub> > 8MHz	f <sub>SYS</sub> > 20MHz		

I<sup>2</sup>C Minimum f<sub>SYS</sub> Frequency

# I<sup>2</sup>C Registers

There are three control registers associated with the I<sup>2</sup>C bus, SIMC0, SIMC1 and SIMTOC, one address register SIMA and one data register, SIMD.

Register		Bit									
Name	7	6	5	4	3	2	1	0			
SIMC0	SIM2	SIM1	SIM0	_	SIMDEB1	SIMDEB0	SIMEN	SIMICF			
SIMC1	HCF	HAAS	HBB	HTX	TXAK	SRW	IAMWU	RXAK			
SIMD	D7	D6	D5	D4	D3	D2	D1	D0			
SIMA	SIMA6	SIMA5	SIMA4	SIMA3	SIMA2	SIMA1	SIMA0	D0			
SIMTOC	SIMTOEN	SIMTOF	SIMTOS5	SIMTOS4	SIMTOS3	SIMTOS2	SIMTOS1	SIMTOS0			

I<sup>2</sup>C Registers List

# I<sup>2</sup>C Data Register

The SIMD register is used to store the data being transmitted and received. The same register is used by both the SPI and I<sup>2</sup>C function. Before the device writes data to the I<sup>2</sup>C bus, the actual data to be transmitted must be placed in the SIMD register. After the data is received from the I<sup>2</sup>C bus, the device can read it from the SIMD register. Any transmission or reception of data from the I<sup>2</sup>C bus must be made via the SIMD register.

Rev. 1.00 172 August 27, 2021



# SIMD Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	Х	Х	Х	Х	Х	Х	Х	Х

"x": unknown

Bit  $7 \sim 0$  **D7\simD0**: SIM data register bit  $7 \sim$  bit 0

#### I<sup>2</sup>C Address Register

The SIMA register is also used by the SPI interface but has the name SIMC2. The SIMA register is the location where the 7-bit slave address is stored. Bits  $7\sim1$  of the SIMA register define the device slave address. Bit 0 is not defined. When a master device, which is connected to the  $I^2C$  bus, sends out an address, which matches the slave address in the SIMA register, the slave device will be selected. Note that the SIMA register is the same register address as SIMC2 which is used by the SPI interface.

# SIMA Register

Bit	7	6	5	4	3	2	1	0
Name	SIMA6	SIMA5	SIMA4	SIMA3	SIMA2	SIMA1	SIMA0	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	_
POR	0	0	0	0	0	0	0	_

Bit 7~1 **SIMA6~SIMA0**: I<sup>2</sup>C slave address

SIMA6~SIMA0 is the I<sup>2</sup>C slave address bit  $6 \sim$  bit 0.

Bit 0 **D0**: Reserved, can be read or written by application program

# I<sup>2</sup>C Control Registers

There are three control registers for the I<sup>2</sup>C interface, SIMC0, SIMC1 and SIMTOC. The SIMC0 register is used to control the enable/disable function and to set the data transmission clock frequency. The SIMC1 register contains the relevant flags which are used to indicate the I<sup>2</sup>C communication status. Another register, SIMTOC, is used to control the I<sup>2</sup>C time-out function and is described in the corresponding section.

# SIMC0 Register

Bit	7	6	5	4	3	2	1	0
Name	SIM2	SIM1	SIM0	_	SIMDEB1	SIMDEB0	SIMEN	SIMICF
R/W	R/W	R/W	R/W	_	R/W	R/W	R/W	R/W
POR	1	1	1	_	0	0	0	0

Bit 7~5 SIM2~SIM0: SIM Operating Mode Control

000: SPI master mode; SPI clock is f<sub>SYS</sub>/4

001: SPI master mode; SPI clock is f<sub>SYS</sub>/16

010: SPI master mode; SPI clock is f<sub>SYS</sub>/64

011: SPI master mode; SPI clock is  $f_{\text{SUB}}$ 

100: SPI master mode; SPI clock is STM0 CCRP interrupt frequency/2

101: SPI slave mode

110: I<sup>2</sup>C slave mode

111: Unused

These bits setup the overall operating mode of the SIM function. As well as selecting if the  $I^2C$  or SPI function, they are used to control the SPI Master/Slave selection and the SPI Master clock frequency. The SPI clock is a function of the system clock but can also be chosen to be sourced from STM0 CCRP interrupt and  $f_{SUB}$ . If the SPI Slave Mode is selected then the clock will be supplied by an external Master device.

# BA45F5360 Smoke Detector Flash MCU with 12V Piezoelectric Horn Driver

Bit 4 Unimplemented, read as "0"

Bit 3~2 **SIMDEB1~SIMDEB0**: I<sup>2</sup>C Debounce Time Selection

00: No debounce

01: 2 system clock debounce 1x: 4 system clock debounce

These bits are used to select the I<sup>2</sup>C debounce time when the SIM is configured as the I<sup>2</sup>C interface function by setting the SIM2~SIM0 bits to "110".

Bit 1 SIMEN: SIM Enable Control

0: Disable 1: Enable

The bit is the overall on/off control for the SIM interface. When the SIMEN bit is cleared to zero to disable the SIM interface, the SDI, SDO, SCK and  $\overline{\text{SCS}}$ , or SDA and SCL lines will lose their SPI or I²C function and the SIM operating current will be reduced to a minimum value. When the bit is high the SIM interface is enabled. If the SIM is configured to operate as an SPI interface via the SIM2~SIM0 bits, the contents of the SPI control registers will remain at the previous settings when the SIMEN bit changes from low to high and should therefore be first initialised by the application program. If the SIM is configured to operate as an I²C interface via the SIM2~SIM0 bits and the SIMEN bit changes from low to high, the contents of the I²C control bits such as HTX and TXAK will remain at the previous settings and should therefore be first initialised by the application program while the relevant I²C flags such as HCF, HAAS, HBB, SRW and RXAK will be set to their default states.

Bit 0 **SIMICF**: SIM SPI Incomplete Flag

This bit is only available when the SIM is configured to operate in an SPI slave mode. Refer to the SPI register section.

### SIMC1 Register

Bit	7	6	5	4	3	2	1	0
Name	HCF	HAAS	HBB	HTX	TXAK	SRW	IAMWU	RXAK
R/W	R	R	R	R/W	R/W	R	R/W	R
POR	1	0	0	0	0	0	0	1

Bit 7 HCF: I<sup>2</sup>C Bus data transfer completion flag

0: Data is being transferred

1: Completion of an 8-bit data transfer

The HCF flag is the data transfer flag. This flag will be zero when data is being transferred. Upon completion of an 8-bit data transfer the flag will go high and an interrupt will be generated.

Bit 6 HAAS: I<sup>2</sup>C Bus address match flag

0: Not address match1: Address match

The HAAS flag is the address match flag. This flag is used to determine if the slave device address is the same as the master transmit address. If the addresses match then this bit will be high, if there is no match then the flag will be low.

Bit 5 **HBB**: I<sup>2</sup>C Bus busy flag

0: I<sup>2</sup>C Bus is not busy

1: I<sup>2</sup>C Bus is busy

The HBB flag is the I<sup>2</sup>C busy flag. This flag will be "1" when the I<sup>2</sup>C bus is busy which will occur when a START signal is detected. The flag will be set to "0" when the bus is free which will occur when a STOP signal is detected.

Bit 4 HTX: Select I<sup>2</sup>C slave device is transmitter or receiver

0: Slave device is the receiver1: Slave device is the transmitter

Rev. 1.00 174 August 27, 2021



Bit 3 TXAK: I<sup>2</sup>C Bus transmit acknowledge flag

0: Slave send acknowledge flag

1: Slave do not send acknowledge flag

The TXAK bit is the transmit acknowledge flag. After the slave device receipt of 8 bits of data, this bit will be transmitted to the bus on the 9th clock from the slave device. The slave device must always set TXAK bit to "0" before further data is received.

Bit 2 SRW: I<sup>2</sup>C Slave Read/Write flag

0: Slave device should be in receive mode1: Slave device should be in transmit mode

The SRW flag is the I<sup>2</sup>C Slave Read/Write flag. This flag determines whether the master device wishes to transmit or receive data from the I<sup>2</sup>C bus. When the transmitted address and slave address is match, that is when the HAAS flag is set high, the slave device will check the SRW flag to determine whether it should be in transmit mode or receive mode. If the SRW flag is high, the master is requesting to read data from the bus, so the slave device should be in transmit mode. When the SRW flag is zero, the master will write data to the bus, therefore the slave device should be in receive mode to read this data.

Bit 1 IAMWU: I<sup>2</sup>C Address Match Wake-up MCU control

0: Disable 1: Enable

This bit should be set to 1 to enable the I<sup>2</sup>C address match wake up MCU from the SLEEP or IDLE Mode. If the IAMWU bit has been set high before entering either the SLEEP or IDLE mode to enable the I<sup>2</sup>C address match wake up MCU, then this bit must be cleared by the application program after wake-up to ensure correction device operation.

Bit 0 **RXAK**: I<sup>2</sup>C Bus Receive acknowledge flag

0: Slave receive acknowledge flag

1: Slave does not receive acknowledge flag

The RXAK flag is the receiver acknowledge flag. When the RXAK flag is "0", it means that a acknowledge signal has been received at the 9th clock, after 8 bits of data have been transmitted. When the slave device in the transmit mode, the slave device checks the RXAK flag to determine if the master receiver wishes to receive the next byte. The slave transmitter will therefore continue sending out data until the RXAK flag is "1". When this occurs, the slave transmitter will release the SDA line to allow the master to send a STOP signal to release the I<sup>2</sup>C Bus.

# I<sup>2</sup>C Bus Communication

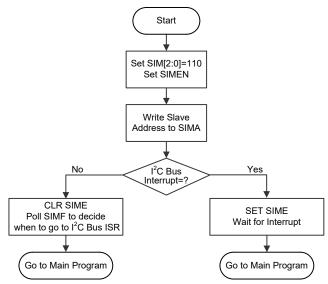
Communication on the I<sup>2</sup>C bus requires four separate steps, a START signal, a slave device address transmission, a data transmission and finally a STOP signal. When a START signal is placed on the I<sup>2</sup>C bus, all devices on the bus will receive this signal and be notified of the imminent arrival of data on the bus. The first seven bits of the data will be the slave address with the first bit being the MSB. If the address of the slave device matches that of the transmitted address, the HAAS bit in the SIMC1 register will be set and an I<sup>2</sup>C interrupt will be generated. After entering the interrupt service routine, the slave device must first check the condition of the HAAS and SIMTOF bits to determine whether the interrupt source originates from an address match or from the completion of an 8-bit data transfer completion or from the I<sup>2</sup>C bus time-out occurrence. During a data transfer, note that after the 7-bit slave address has been transmitted, the following bit, which is the 8th bit, is the read/write bit whose value will be placed in the SRW bit. This bit will be checked by the slave device to determine whether to go into transmit or receive mode. Before any transfer of data to or from the I<sup>2</sup>C bus, the microcontroller must initialise the bus, the following are steps to achieve this:

Step 1
 Set the SIM2~SIM0 and SIMEN bits in the SIMC0 register to "110" and "1" respectively to enable the I<sup>2</sup>C bus.

Rev. 1.00 175 August 27, 2021



- Step 2
   Write the slave address of the device to the I<sup>2</sup>C bus address register SIMA.
- Step 3
   Set the interrupt enable bit SIME of the interrupt control register to enable the SIM interrupt.



I<sup>2</sup>C Bus Initialisation Flow Chart

### I<sup>2</sup>C Bus Start Signal

The START signal can only be generated by the master device connected to the I<sup>2</sup>C bus and not by the slave device. This START signal will be detected by all devices connected to the I<sup>2</sup>C bus. When detected, this indicates that the I<sup>2</sup>C bus is busy and therefore the HBB bit will be set. A START condition occurs when a high to low transition on the SDA line takes place when the SCL line remains high.

#### I<sup>2</sup>C Slave Address

The transmission of a START signal by the master will be detected by all devices on the I<sup>2</sup>C bus. To determine which slave device the master wishes to communicate with, the address of the slave device will be sent out immediately following the START signal. All slave devices, after receiving this 7-bit address data, will compare it with their own 7-bit slave address. If the address sent out by the master matches the internal address of the microcontroller slave device, then an internal I<sup>2</sup>C bus interrupt signal will be generated. The next bit following the address, which is the 8th bit, defines the read/write status and will be saved to the SRW bit of the SIMC1 register. The slave device will then transmit an acknowledge bit, which is a low level, as the 9th bit. The slave device will also set the status flag HAAS when the addresses match.

As an SIM I<sup>2</sup>C bus interrupt can come from three sources, when the program enters the interrupt subroutine, the HAAS and SIMTOF bits should be examined to see whether the interrupt source has come from a matching slave address or from the completion of a data byte transfer or the I<sup>2</sup>C bus time-out occurrence. When a slave address is matched, the device must be placed in either the transmit mode and then write data to the SIMD register, or in the receive mode where it must implement a dummy read from the SIMD register to release the SCL line.

#### I<sup>2</sup>C Bus Read/Write Signal

The SRW bit in the SIMC1 register defines whether the master device wishes to read data from the I<sup>2</sup>C bus or write data to the I<sup>2</sup>C bus. The slave device should examine this bit to determine if it is to be a transmitter or a receiver. If the SRW flag is "1" then this indicates that the master device wishes

Rev. 1.00 176 August 27, 2021



to read data from the I<sup>2</sup>C bus, therefore the slave device must be setup to send data to the I<sup>2</sup>C bus as a transmitter. If the SRW flag is "0" then this indicates that the master wishes to send data to the I<sup>2</sup>C bus, therefore the slave device must be setup to read data from the I<sup>2</sup>C bus as a receiver.

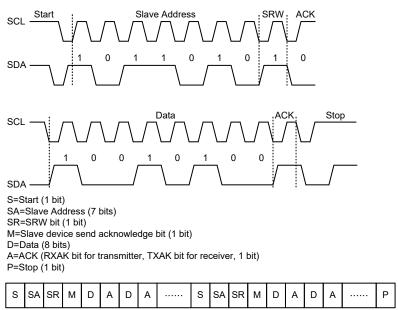
# I<sup>2</sup>C Bus Slave Address Acknowledge Signal

After the master has transmitted a calling address, any slave device on the I<sup>2</sup>C bus, whose own internal address matches the calling address, must generate an acknowledge signal. The acknowledge signal will inform the master that a slave device has accepted its calling address. If no acknowledge signal is received by the master then a STOP signal must be transmitted by the master to end the communication. When the HAAS flag is high, the addresses have matched and the slave device must check the SRW flag to determine if it is to be a transmitter or a receiver. If the SRW flag is high, the slave device should be setup to be a transmitter so the HTX bit in the SIMC1 register should be set to "1". If the SRW flag is low, then the microcontroller slave device should be setup as a receiver and the HTX bit in the SIMC1 register should be set to "0".

# I<sup>2</sup>C Bus Data and Acknowledge Signal

The transmitted data is 8-bit wide and is transmitted after the slave device has acknowledged receipt of its slave address. The order of serial bit transmission is the MSB first and the LSB last. After receipt of 8 bits of data, the receiver must transmit an acknowledge signal, level "0", before it can receive the next data byte. If the slave transmitter does not receive an acknowledge bit signal from the master receiver, then the slave transmitter will release the SDA line to allow the master to send a STOP signal to release the I<sup>2</sup>C Bus. The corresponding data will be stored in the SIMD register. If setup as a transmitter, the slave device must first write the data to be transmitted into the SIMD register. If setup as a receiver, the slave device must read the transmitted data from the SIMD register.

When the slave receiver receives the data byte, it must generate an acknowledge bit, known as TXAK, on the 9th clock. The slave device, which is setup as a transmitter will check the RXAK bit in the SIMC1 register to determine if it is to send another data byte, if not then it will release the SDA line and await the receipt of a STOP signal from the master.

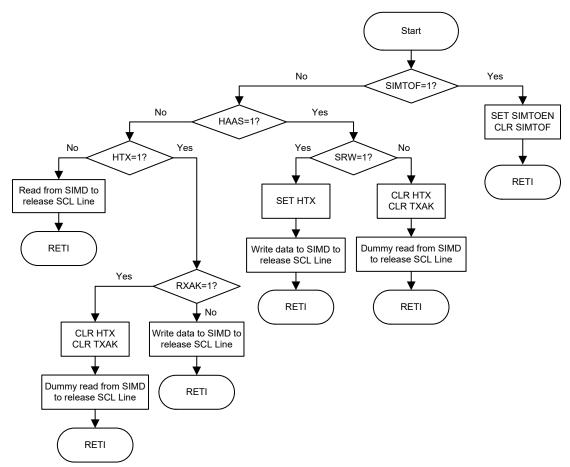


I<sup>2</sup>C Communication Timing Diagram

Note: When a slave address is matched, the device must be placed in either the transmit mode and then write data to the SIMD register, or in the receive mode where it must implement a dummy read from the SIMD register to release the SCL line.

Rev. 1.00 177 August 27, 2021





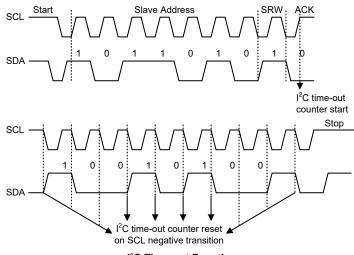
I<sup>2</sup>C Bus ISR Flow Chart

### I<sup>2</sup>C Time-out Control

In order to reduce the problem of I<sup>2</sup>C lockup due to reception of erroneous clock sources, a time-out function is provided. If the clock source to the I<sup>2</sup>C is not received for a while, then the I<sup>2</sup>C circuitry and registers will be reset after a certain time-out period. The time-out counter starts counting on an I<sup>2</sup>C bus "START" & "Address Match" condition, and is cleared by an SCL falling edge. Before the next SCL falling edge arrives, if the time elapsed is greater than the time-out setup by the SIMTOC register, then a time-out condition will occur. The time-out function will stop when an I<sup>2</sup>C "STOP" condition occurs.

Rev. 1.00 178 August 27, 2021





I<sup>2</sup>C Time-out Function

When an  $I^2C$  time-out counter overflow occurs, the counter will stop and the SIMTOEN bit will be cleared to zero and the SIMTOF bit will be set high to indicate that a time-out condition has occurred. The time-out condition will also generate an interrupt which uses the  $I^2C$  interrupt vector. When an  $I^2C$  time-out occurs, the  $I^2C$  internal circuitry will be reset and the registers will be reset into the following condition:

Registers	After I <sup>2</sup> C Time-out
SIMD, SIMA, SIMC0	No change
SIMC1	Reset to POR condition

I<sup>2</sup>C Registers after Time-out

The SIMTOF flag can be cleared by the application program. There are 64 time-out periods which can be selected using SIMTOS bit field in the SIMTOC register. The time-out time is given by the formula:  $((1\sim64)\times32)/f_{SUB}$ . This gives a time-out period which ranges from about 1ms to 64ms.

# SIMTOC Register

Bit	7	6	5	4	3	2	1	0
Name	SIMTOEN	SIMTOF	SIMTOS5	SIMTOS4	SIMTOS3	SIMTOS2	SIMTOS1	SIMTOS0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7 **SIMTOEN**: SIM I<sup>2</sup>C Time-out control

0: Disable 1: Enable

Bit 6 **SIMTOF**: SIM I<sup>2</sup>C Time-out flag

0: No time-out occurred1: Time-out occurred

Bit 5~0 **SIMTOS5~SIMTOS0**: SIM I<sup>2</sup>C Time-out period selection

I<sup>2</sup>C time-out clock source is f<sub>SUB</sub>/32.

 $I^2C$  time-out period=(SIMTOS[5:0]+1)×(32/ $f_{SUB}$ ).

Rev. 1.00 179 August 27, 2021

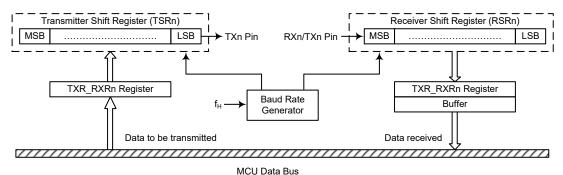


# **UART Interface**

The device contains two integrated full-duplex or half-duplex asynchronous serial communications UART interface that enables communication with external devices that contain a serial interface. The UART function has many features and can transmit and receive data serially by transferring a frame of data with eight or nine data bits per transmission as well as being able to detect errors when the data is overwritten or incorrectly framed. The UART function possesses its own internal interrupt which can be used to indicate when a reception occurs or when a transmission terminates.

The integrated UART function contains the following features:

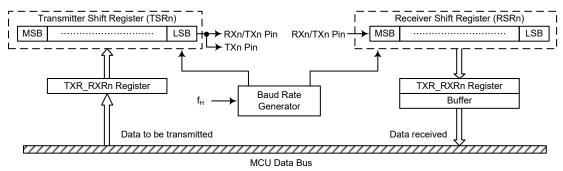
- Full-duplex or half-duplex (single wire mode) asynchronous communication
- 8 or 9 bits character length
- Even, odd or no parity options
- · One or two stop bits
- Baud rate generator with 8-bit prescaler
- · Parity, framing, noise and overrun error detection
- Support for interrupt on address detect (last character bit=1)
- Separately enabled transmitter and receiver
- 2-byte Deep FIFO Receive Data Buffer
- RXn/TXn pin wake-up function
- Transmit and receive interrupts
- Interrupts can be triggered by the following conditions:
  - · Transmitter Empty
  - · Transmitter Idle
  - · Receiver Full
  - · Receiver Overrun
  - Address Mode Detect



UARTn Data Transfer Block Diagram - SWMn=0 (n=0~1)

Rev. 1.00 180 August 27, 2021





UARTn Data Transfer Block Diagram - SWMn=1 (n=0~1)

## **UART External Pins**

To communicate with an external serial interface, the internal UARTn has two external pins known as TXn and RXn/TXn, which are pin-shared with I/O or other pin functions. The TXn and RXn/TXn pin function should first be selected by the pin-shared function selection register before the UARTn function is used. Along with the UARTENn bit, the TXENn and RXENn bits, if set, will setup these pins to transmitter output and receiver input conditions. At this time the internal pull-high resistor related to the transmitter output pin will be disabled, while the internal pull-high resistor related to the receiver input pin is controlled by the corresponding I/O pull-high function control bit. When the TXn or RXn/TXn pin function is disabled by clearing the UARTENn, TXENn or RXENn bit, the TXn or RXn/TXn pin will be set to a floating state. At this time whether the internal pull-high resistor is connected to the TXn or RXn/TXn pin or not is determined by the corresponding I/O pull-high function control bit.

# **UART Single Wire Mode**

The UARTn function also supports a Single Wire Mode communication which is selected using the SWMn bit in the UnCR3 register. When the SWMn bit is set high, the UARTn function will be in the single wire mode. In the single wire mode, a single RXn/TXn pin can be used to transmit and receive data depending upon the corresponding control bits. When the RXENn bit is set high, the RXn/TXn pin is used as a receiver pin. When the RXENn bit is cleared to zero and the TXENn bit is set high, the RXn/TXn pin will act as a transmitter pin.

It is recommended not to set both the RXENn and TXENn bits high in the single wire mode. If both the RXENn and TXENn bits are set high, the RXENn bit will have the priority and the UARTn will act as a receiver.

It is important to note that the functional description in this UARTn chapter, which is described from the full-duplex communication standpoint, also applies to the half-duplex (single wire mode) communication except the pin usage. In the single wire mode, the TXn pin mentioned in this chapter should be replaced by the RXn/TX npin to understand the whole UARTn single wire mode function.

In the single wire mode, the data can also be transmitted on the TXn pin in a transmission operation with proper software configurations. Therefore, the data will be output on the RXn/TXn and TXn pins.

#### **UART Data Transfer Scheme**

The above block diagram shows the overall data transfer structure arrangement for the UARTn. The actual data to be transmitted from the MCU is first transferred to the TXR\_RXRn register by the application program. The data will then be transferred to the Transmit Shift Register from where it will be shifted out, LSB first, onto the TXn pin at a rate controlled by the Baud Rate Generator. Only the TXR\_RXRn register is mapped onto the MCU Data Memory, the Transmit Shift Register is not mapped and is therefore inaccessible to the application program.

Rev. 1.00 181 August 27, 2021



Data to be received by the UARTn is accepted on the external RXn/TXn pin, from where it is shifted in, LSB first, to the Receiver Shift Register at a rate controlled by the Baud Rate Generator. When the shift register is full, the data will then be transferred from the shift register to the internal TXR\_RXRn register, where it is buffered and can be manipulated by the application program. Only the TXR\_RXRn register is mapped onto the MCU Data Memory, the Receiver Shift Register is not mapped and is therefore inaccessible to the application program.

It should be noted that the actual register for data transmission and reception only exists as a single shared register in the Data Memory. This shared register known as the TXR\_RXRn register is used for both data transmission and data reception.

# **UART Status and Control Registers**

There are six control registers associated with the UARTn function. The SWMn bit in the UnCR3 register is used to enable/disable the UARTn Single Wire Mode. The UnSR, UnCR1 and UnCR2 registers control the overall function of the UARTn, while the BRGn register controls the Baud rate. The actual data to be transmitted and received on the serial interface is managed through the TXR\_RXRn data register.

Register				t				
Name	7	6	5	4	3	2	1	0
UnSR	PERRn	NFn	FERRn	OERRn	RIDLEn	RXIFn	TIDLEn	TXIFn
UnCR1	UARTENn	BNOn	PRENn	PRTn	STOPSn	TXBRKn	RX8n	TX8n
UnCR2	TXENn	RXENn	BRGHn	ADDENn	WAKEn	RIEn	TIIEn	TEIEn
UnCR3	_	_	_	_	_	_	_	SWMn
TXR_RXRn	D7	D6	D5	D4	D3	D2	D1	D0
BRGn	D7	D6	D5	D4	D3	D2	D1	D0

UARTn Register List (n=0~1)

# UnSR Register

The UnSR register is the status register for the UARTn, which can be read by the program to determine the present status of the UARTn. All flags within the UnSR register are read only. Further explanation on each of the flags is given below:

Bit	7	6	5	4	3	2	1	0
Name	PERRn	NFn	FERRn	OERRn	RIDLEn	RXIFn	TIDLEn	TXIFn
R/W	R	R	R	R	R	R	R	R
POR	0	0	0	0	1	0	1	1

Bit 7 **PERRn**: Parity error flag

0: No parity error is detected

1: Parity error is detected

The PERRn flag is the parity error flag. When this read only flag is "0", it indicates a parity error has not been detected. When the flag is "1", it indicates that the parity of the received word is incorrect. This error flag is applicable only if Parity mode (odd or even) is selected. The flag can also be cleared to zero by a software sequence which involves a read to the status register UnSR followed by an access to the TXR\_RXRn data register.

Bit 6 **NFn**: Noise flag

0: No noise is detected 1: Noise is detected

Rev. 1.00 182 August 27, 2021



The NFn flag is the noise flag. When this read only flag is "0", it indicates no noise condition. When the flag is "1", it indicates that the UARTn has detected noise on the receiver input. The NFn flag is set during the same cycle as the RXIFn flag but will not be set in the case of as overrun. The NFn flag can be cleared to zero by a software sequence which will involve a read to the status register UnSR followed by an access to the TXR RXRn data register.

Bit 5 FERRn: Framing error flag

0: No framing error is detected

1: Framing error is detected

The FERRn flag is the framing error flag. When this read only flag is "0", it indicates that there is no framing error. When the flag is "1", it indicates that a framing error has been detected for the current character. The flag can also be cleared to zero by a software sequence which will involve a read to the status register UnSR followed by an access to the TXR\_RXRn data register.

Bit 4 **OERRn**: Overrun error flag

0: No overrun error is detected

1: Overrun error is detected

The OERRn flag is the overrun error flag which indicates when the receiver buffer has overflowed. When this read only flag is "0", it indicates that there is no overrun error. When the flag is "1", it indicates that an overrun error occurs which will inhibit further transfers to the TXR\_RXRn receive data register. The flag is cleared to zero by a software sequence, which is a read to the status register UnSR followed by an access to the TXR\_RXRn data register.

Bit 3 **RIDLEn**: Receiver status

0: Data reception is in progress (Data being received)

1: No data reception is in progress (Receiver is idle)

The RIDLEn flag is the receiver status flag. When this read only flag is "0", it indicates that the receiver is between the initial detection of the start bit and the completion of the stop bit. When the flag is "1", it indicates that the receiver is idle. Between the completion of the stop bit and the detection of the next start bit, the RIDLEn bit is "1" indicating that the UARTn receiver is idle and the RXn/TXn pin stays in logic high condition.

Bit 2 RXIFn: Receive TXR RXRn data register status

0: TXR\_RXRn data register is empty

1: TXR RXRn data register has available data

The RXIFn flag is the receive data register status flag. When this read only flag is "0", it indicates that the TXR\_RXRn read data register is empty. When the flag is "1", it indicates that the TXR\_RXRn read data register contains new data. When the contents of the shift register are transferred to the TXR\_RXRn register, an interrupt is generated if RIEn=1 in the UnCR2 register. If one or more errors are detected in the received word, the appropriate receive-related flags NFn, FERRn, and/or PERRn are set within the same clock cycle. The RXIFn flag will eventually be cleared to zero when the UnSR register is read with RXIFn set, followed by a read from the TXR\_RXRn register, and if the TXR\_RXRn register has no more new data available.

Bit 1 TIDLEn: Transmission idle

0: Data transmission is in progress (Data being transmitted)

1: No data transmission is in progress (Transmitter is idle)

The TIDLEn flag is known as the transmission complete flag. When this read only flag is "0", it indicates that a transmission is in progress. This flag will be set high when the TXIFn flag is "1" and when there is no transmit data or break character being transmitted. When TIDLEn is equal to "1", the TXn pin becomes idle with the pin state in logic high condition. The TIDLEn flag is cleared to zero by reading the UnSR register with TIDLEn set and then writing to the TXR\_RXRn register. The flag is not generated when a data character or a break is queued and ready to be sent.

Rev. 1.00 183 August 27, 2021

# BA45F5360 Smoke Detector Flash MCU with 12V Piezoelectric Horn Driver

Bit 0 TXIFn: Transmit TXR RXRn data register status

0: Character is not transferred to the transmit shift register

1: Character has transferred to the transmit shift register (TXR\_RXRn data register is empty)

The TXIFn flag is the transmit data register empty flag. When this read only flag is "0", it indicates that the character is not transferred to the transmitter shift register. When the flag is "1", it indicates that the transmitter shift register has received a character from the TXR\_RXRn data register. The TXIFn flag is cleared to zero by reading the UARTn status register (UnSR) with TXIFn set and then writing to the TXR\_RXRn data register. Note that when the TXENn bit is set, the TXIFn flag bit will also be set since the transmit data register is not yet full.

#### UnCR1 Register

The UnCR1 register together with the UnCR2 and UnCR3 registers are the three UARTn control registers that are used to set the various options for the UARTn function, such as overall on/off control, parity control, data transfer bit length, single wire mode communication etc. Further explanation on each of the bits is given below:

Bit	7	6	5	4	3	2	1	0
Name	UARTENn	BNOn	PRENn	PRTn	STOPSn	TXBRKn	RX8n	TX8n
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R	W
POR	0	0	0	0	0	0	Х	0

"x": unknown

Bit 7 UARTENn: UARTn function enable control

0: Disable UARTn. TXn and RXn/TXn pins are in a floating state

1: Enable UARTn. TXn and RXn/TXn pins can function as UARTn pins

The UARTENn bit is the UARTn enable bit. When this bit is equal to "0", the UARTn will be disabled and the RXn/TXn pin as well as the TXn pin will be in a floating state. When the bit is equal to "1", the UARTn will be enabled and the TXn and RXn/TXn pins will function as defined by the SWMn mode selection bit together with the TXENn and RXENn enable control bits.

When the UARTn is disabled, it will empty the buffer so any character remaining in the buffer will be discarded. In addition, the value of the baud rate counter will be reset. If the UARTn is disabled, all error and status flags will be reset. Also the TXENn, RXENn, TXBRKn, RXIFn, OERRn, FERRn, PERRn and NFn bits will be cleared to zero, while the TIDLEn, TXIFn and RIDLEn bits will be set high. Other control bits in UnCR1, UnCR2, UnCR3 and BRGn registers will remain unaffected. If the UARTn is active and the UARTENn bit is cleared to zero, all pending transmissions and receptions will be terminated and the module will be reset as defined above. When the UARTn is re-enabled, it will restart in the same configuration.

Bit 6 BNOn: Number of data transfer bits selection

0: 8-bit data transfer

1: 9-bit data transfer

This bit is used to select the data length format, which can have a choice of either 8-bit or 9-bit format. When this bit is equal to "1", a 9-bit data length format will be selected. If the bit is equal to "0", then an 8-bit data length format will be selected. If 9-bit data length format is selected, then bits RX8n and TX8n will be used to store the 9th bit of the received and transmitted data respectively.

Note that the 9th bit of data if BNOn=1, or the 8th bit of data if BNOn=0, which is used as the parity bit, does not transfer to RX8n or TXR\_RXRn.7 respectively when the parity function is enabled.

Bit 5 **PRENn**: Parity function enable control

0: Parity function is disabled

1: Parity function is enabled

This is the parity enable bit. When this bit is equal to "1", the parity function will be enabled. If the bit is equal to "0", then the parity function will be disabled.

Rev. 1.00 184 August 27, 2021



Bit 4 **PRTn**: Parity type selection bit

0: Even parity for parity generator1: Odd parity for parity generator

This bit is the parity type selection bit. When this bit is equal to "1", odd parity type will be selected. If the bit is equal to "0", then even parity type will be selected.

Bit 3 STOPSn: Number of Stop bits selection

0: One stop bit format is used1: Two stop bits format is used

This bit determines if one or two stop bits are to be used. When this bit is equal to "1", two stop bits are used. If this bit is equal to "0", then only one stop bit is used.

Bit 2 **TXBRKn**: Transmit break character

0: No break character is transmitted

1: Break characters transmit

The TXBRKn bit is the Transmit Break Character bit. When this bit is "0", there are no break characters and the TXn pin operates normally. When the bit is "1", there are transmit break characters and the transmitter will send logic zeros. When this bit is equal to "1", after the buffered data has been transmitted, the transmitter output is held low for a minimum of a 13-bit length and until the TXBRKn bit is reset.

Bit 1 **RX8n**: Receive data bit 8 for 9-bit data transfer format (read only)

This bit is only used if 9-bit data transfers are used, in which case this bit location will store the 9th bit of the received data known as RX8n. The BNOn bit is used to determine whether data transfers are in 8-bit or 9-bit format.

Bit 0 **TX8n**: Transmit data bit 8 for 9-bit data transfer format (write only)

This bit is only used if 9-bit data transfers are used, in which case this bit location will store the 9th bit of the transmitted data known as TX8n. The BNOn bit is used to determine whether data transfers are in 8-bit or 9-bit format.

## UnCR2 Register

The UnCR2 register is the second of the two UARTn control registers and serves several purposes. One of its main functions is to control the basic enable/disable operation of the UARTn Transmitter and Receiver as well as enabling the various UARTn interrupt sources. The register also serves to control the baud rate speed, receiver wake-up enable and the address detect enable. Further explanation on each of the bits is given below:

Bit	7	6	5	4	3	2	1	0
Name	TXENn	RXENn	BRGHn	ADDENn	WAKEn	RIEn	TIIEn	TEIEn
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7 TXENn: UARTn Transmitter enabled control

0: UARTn transmitter is disabled1: UARTn transmitter is enabled

The bit named TXENn is the Transmitter Enable Bit. When this bit is equal to "0", the transmitter will be disabled with any pending data transmissions being aborted. In addition the buffers will be reset. In this situation the TXn pin will be in a floating state.

If the TXENn bit is equal to "1" and the UARTENn bit is also equal to "1", the transmitter will be enabled and the TXn pin will be controlled by the UARTn. Clearing the TXENn bit during a transmission will cause the data transmission to be aborted and will reset the transmitter. If this situation occurs, the TXn pin will be in a floating state.

Bit 6 RXENn: UARTn Receiver enabled control

0: UARTn receiver is disabled1: UARTn receiver is enabled

# BA45F5360 Smoke Detector Flash MCU with 12V Piezoelectric Horn Driver

The bit named RXENn is the Receiver Enable Bit. When this bit is equal to "0", the receiver will be disabled with any pending data receptions being aborted. In addition the receive buffers will be reset. In this situation the RXn/TXn pin will be in a floating state. If the RXENn bit is equal to "1" and the UARTENn bit is also equal to "1", the receiver will be enabled and the RXn/TXn pin will be controlled by the UARTn. Clearing the RXENn bit during a reception will cause the data reception to be aborted and will reset the receiver. If this situation occurs, the RXn/TXn pin will be in a floating state.

Bit 5 BRGHn: Baud Rate speed selection

0: Low speed baud rate

1: High speed baud rate

The bit named BRGHn selects the high or low speed mode of the Baud Rate Generator. This bit, together with the value placed in the baud rate register BRGn, controls the Baud Rate of the UARTn. If this bit is equal to "1", the high speed mode is selected. If the bit is equal to "0", the low speed mode is selected.

Bit 4 ADDENn: Address detect function enable control

0: Address detect function is disabled

1: Address detect function is enabled

The bit named ADDENn is the address detect function enable control bit. When this bit is equal to "1", the address detect function is enabled. When it occurs, if the 8th bit, which corresponds to TXR\_RXRn.7 if BNOn=0 or the 9th bit, which corresponds to RX8n if BNOn=1, has a value of "1", then the received word will be identified as an address, rather than data. If the corresponding interrupt is enabled, an interrupt request will be generated each time the received word has the address bit set, which is the 8th or 9th bit depending on the value of BNOn. If the address bit known as the 8th or 9th bit of the received word is "0" with the address detect function being enabled, an interrupt will not be generated and the received data will be discarded.

Bit 3 WAKEn: RXn/TXn pin wake-up UARTn function enable control

0: RXn/TXn pin wake-up UARTn function is disabled

1: RXn/TXn pin wake-up UARTn function is enabled

This bit is used to control the wake-up UARTn function when a falling edge on the RXn/TXn pin occurs. Note that this bit is only available when the UARTn clock ( $f_H$ ) is switched off. There will be no RXn/TXn pin wake-up UARTn function if the UARTn clock ( $f_H$ ) exists. If the WAKEn bit is set to 1 as the UARTn clock ( $f_H$ ) is switched off, a UARTn wake-up request will be initiated when a falling edge on the RXn/TXn pin occurs. When this request happens and the corresponding interrupt is enabled, an RXn/TXn pin wake-up UARTn interrupt will be generated to inform the MCU to wake up the UARTn function by switching on the UARTn clock ( $f_H$ ) via the application program. Otherwise, the UARTn function can not resume even if there is a falling edge on the RXn/TXn pin when the WAKEn bit is cleared to 0.

Bit 2 **RIEn**: Receiver interrupt enable control

0: Receiver related interrupt is disabled

1: Receiver related interrupt is enabled

This bit enables or disables the receiver interrupt. If this bit is equal to "1" and when the receiver overrun flag OERRn or receive data available flag RXIFn is set, the UARTn interrupt request flag will be set. If this bit is equal to "0", the UARTn interrupt request flag will not be influenced by the condition of the OERRn or RXIFn flags.

Bit 1 THEn: Transmitter Idle interrupt enable control

0: Transmitter idle interrupt is disabled

1: Transmitter idle interrupt is enabled

This bit enables or disables the transmitter idle interrupt. If this bit is equal to "1" and when the transmitter idle flag TIDLEn is set, due to a transmitter idle condition, the UARTn interrupt request flag will be set. If this bit is equal to "0", the UARTn interrupt request flag will not be influenced by the condition of the TIDLEn flag.

Rev. 1.00 186 August 27, 2021



Bit 0 **TEIEn**: Transmitter Empty interrupt enable control

0: Transmitter empty interrupt is disabled

1: Transmitter empty interrupt is enabled

This bit enables or disables the transmitter empty interrupt. If this bit is equal to "1" and when the transmitter empty flag TXIFn is set, due to a transmitter empty condition, the UARTn interrupt request flag will be set. If this bit is equal to "0", the UARTn interrupt request flag will not be influenced by the condition of the TXIFn flag.

#### UnCR3 Register

The UnCR3 register is used to enable the UARTn Single Wire Mode communication. As the name suggests in the single wire mode the UARTn communication can be implemented in one single line, RXn/TXn, together with the control of the RXENn and TXENn bits in the UnCR2 register.

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	_	SWMn
R/W	_	_	_	_	_	_	_	R/W
POR	_	_	_	_	_	_	_	0

Bit 7~1 Unimplemented, read as "0"

Bit 0 **SWMn**: Single Wire Mode enable control

- 0: Disable, the RXn/TXn pin is used as UARTn receiver function only
- 1: Enable, the RXn/TXn pin can be used as UARTn receiver or transmitter function controlled by the RXENn and TXENn bits

Note that when the Single Wire Mode is enabled, if both the RXENn and TXENn bits are high, the RXn/TXn pin will just be used as UARTn receiver input.

## • TXR\_RXRn Register

The TXR\_RXRn register is the data register which is used to store the data to be transmitted on the TXn pin or being received from the RXn/TXn pin.

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	Х	х	х	х	Х	Х	х	Х

"x": unknown

Bit  $7 \sim 0$  D7 $\sim$ D0: UARTn Transmit/Receive Data bit  $7 \sim$  bit 0

# BRGn Register

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	Х	х	х	х	Х	х	Х	Х

"x": unknown

Bit  $7 \sim 0$  **D7\simD0**: Baud Rate values

By programming the BRGHn bit in UnCR2 Register which allows selection of the related formula described above and programming the required value in the BRGn register, the required baud rate can be setup.

Note: Baud rate= $f_H$ /[64×(N+1)] if BRGHn=0; Baud rate= $f_H$ /[16×(N+1)] if BRGHn=1.

Rev. 1.00 187 August 27, 2021



## **Baud Rate Generator**

To setup the speed of the serial data communication, the UARTn function contains its own dedicated baud rate generator. The baud rate is controlled by its own internal free running 8-bit timer, the period of which is determined by two factors. The first of these is the value placed in the baud rate register BRGn and the second is the value of the BRGHn bit with the control register UnCR2. The BRGHn bit decides if the baud rate generator is to be used in a high speed mode or low speed mode, which in turn determines the formula that is used to calculate the baud rate. The value N in the BRGn register which is used in the following baud rate calculation formula determines the division factor. Note that N is the decimal value placed in the BRGn register and has a range of between 0 and 255.

UnCR2 BRGHn Bit	0	1
Baud Rate (BR)	f <sub>H</sub> /[64×(N+1)]	f <sub>H</sub> /[16×(N+1)]

By programming the BRGHn bit which allows selection of the related formula and programming the required value in the BRGn register, the required baud rate can be setup. Note that because the actual baud rate is determined using a discrete value, N, placed in the BRGn register, there will be an error associated between the actual and requested value. The following example shows how the BRGn register value N and the error value can be calculated.

# Calculating the Baud Rate and Error Values

For a clock frequency of 4MHz, and with BRGHn cleared to zero determine the BRGn register value N, the actual baud rate and the error value for a desired baud rate of 4800.

From the above table the desired band rate  $BR=f_H/[64\times(N+1)]$ 

Re-arranging this equation gives  $N=[f_H/(BR\times64)] - 1$ 

Giving a value for N=[4000000/(4800×64)] - 1=12.0208

To obtain the closest value, a decimal value of 12 should be placed into the BRGn register. This gives an actual or calculated baud rate value of  $BR=4000000/[64\times(12+1)]=4808$ 

Therefore the error is equal to (4808 - 4800)/4800 = 0.16%.

## **UART Setup and Control**

For data transfer, the UARTn function utilizes a non-return-to-zero, more commonly known as NRZ, format. This is composed of one start bit, eight or nine data bits, and one or two stop bits. Parity is supported by the UARTn hardware, and can be setup to be even, odd or no parity. For the most common data format, 8 data bits along with no parity and one stop bit, denoted as 8, N, 1, is used as the default setting, which is the setting at power-on. The number of data bits and stop bits, along with the parity, are setup by programming the corresponding BNOn, PRTn, PRENn, and STOPSn bits in the UnCR1 register. The baud rate used to transmit and receive data is setup using the internal 8-bit baud rate generator, while the data is transmitted and received LSB first. Although the UARTn transmitter and receiver are functionally independent, they both use the same data format and baud rate. In all cases stop bits will be used for data transmission.

#### **Enabling/Disabling the UART Interface**

The basic on/off function of the internal UARTn function is controlled using the UARTENn bit in the UnCR1 register. If the UARTENn, TXENn and RXENn bits are set, then these two UARTn pins will act as normal TXn output pin and RXn/TXn input pin respectively. If no data is being transmitted on the TXn pin, then it will default to a logic high value.

Clearing the UARTENn bit will disable the TXn and RXn/TXn pins and allow these two pins to be used as normal I/O or other pin-shared functional pins. When the UARTn function is disabled the

Rev. 1.00 188 August 27, 2021



buffer will be reset to an empty condition, at the same time discarding any remaining residual data. Disabling the UARTn will also reset the error and status flags with bits TXENn, RXENn, TXBRKn, RXIFn, OERRn, FERRn, PERRn and NFn being cleared while bits TIDLEn, TXIFn and RIDLEn will be set. The remaining control bits in the UnCR1, UnCR2, UnCR3 and BRGn registers will remain unaffected. If the UARTENn bit in the UnCR1 register is cleared while the UARTn is active, then all pending transmissions and receptions will be immediately suspended and the UARTn will be reset to a condition as defined above. If the UARTn is then subsequently re-enabled, it will restart again in the same configuration.

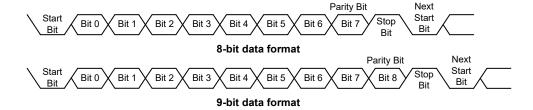
#### Data, Parity and Stop Bit Selection

The format of the data to be transferred is composed of various factors such as data bit length, parity on/off, parity type, address bits and the number of stop bits. These factors are determined by the setup of various bits within the UnCR1 register. The BNOn bit controls the number of data bits which can be set to either 8 or 9, the PRTn bit controls the choice of odd or even parity, the PRENn bit controls the parity on/off function and the STOPSn bit decides whether one or two stop bits are to be used. The following table shows various formats for data transmission. The address bit, which is the MSB of the data byte, identifies the frame as an address character or data if the address detect function is enabled. The number of stop bits, which can be either one or two, is independent of the data length and is only used for the transmitter. There is only one stop bit for the receiver.

Start Bit	Data Bits	Address Bit	Parity Bit	Stop Bit
Example of 8	-bit Data Forn	nats		
1	8	0	0	1
1	7	0	1	1
1	7	1	0	1
Example of 9	-bit Data Forn	nats		
1	9	0	0	1
1	8	0	1	1
1	8	1	0	1

**Transmitter Receiver Data Format** 

The following diagram shows the transmit and receive waveforms for both 8-bit and 9-bit data formats.



## **UART Transmitter**

Data word lengths of either 8 or 9 bits can be selected by programming the BNOn bit in the UnCR1 register. When BNOn bit is set, the word length will be set to 9 bits. In this case the 9th bit, which is the MSB, needs to be stored in the TX8n bit in the UnCR1 register. At the transmitter core lies the Transmitter Shift Register, more commonly known as the TSRn, whose data is obtained from the transmit data register, which is known as the TXR\_RXRn register. The data to be transmitted is loaded into this TXR\_RXRn register by the application program. The TSRn register is not written to with new data until the stop bit from the previous transmission has been sent out. As soon as this stop bit has been transmitted, the TSRn can then be loaded with new data from the TXR RXRn

Rev. 1.00 189 August 27, 2021

# BA45F5360 Smoke Detector Flash MCU with 12V Piezoelectric Horn Driver

register, if it is available. It should be noted that the TSRn register, unlike many other registers, is not directly mapped into the Data Memory area and as such is not available to the application program for direct read/write operations. An actual transmission of data will normally be enabled when the TXENn bit is set, but the data will not be transmitted until the TXR\_RXRn register has been loaded with data and the baud rate generator has defined a shift clock source. However, the transmission can also be initiated by first loading data into the TXR\_RXRn register, after which the TXENn bit can be set. When a transmission of data begins, the TSRn is normally empty, in which case a transfer to the TXR\_RXRn register will result in an immediate transfer to the TSRn. If during a transmission the TXENn bit is cleared, the transmission will immediately cease and the transmitter will be reset. The TXn output pin can then be configured as the I/O or other pin-shared function by configuring the corresponding pin-shared control bits.

#### **Transmitting Data**

When the UARTn is transmitting data, the data is shifted on the TXn pin from the shift register, with the least significant bit first. In the transmit mode, the TXR\_RXRn register forms a buffer between the internal bus and the transmitter shift register. It should be noted that if 9-bit data format has been selected, then the MSB will be taken from the TX8n bit in the UnCR1 register. The steps to initiate a data transfer can be summarized as follows:

- Make the correct selection of the BNOn, PRTn, PRENn and STOPSn bits to define the required word length, parity type and number of stop bits.
- Setup the BRGn register to select the desired baud rate.
- Set the TXENn bit to ensure that the TXn pin is used as a UARTn transmitter pin.
- Access the UnSR register and write the data that is to be transmitted into the TXR\_RXRn register. Note that this step will clear the TXIFn bit.

This sequence of events can now be repeated to send additional data.

It should be noted that when TXIFn=0, data will be inhibited from being written to the TXR\_RXRn register. Clearing the TXIFn flag is always achieved using the following software sequence:

- 1. A UnSR register access
- 2. A TXR\_RXRn register write execution

The read-only TXIFn flag is set by the UARTn hardware and if set indicates that the TXR\_RXRn register is empty and that other data can now be written into the TXR\_RXRn register without overwriting the previous data. If the TEIEn bit is set then the TXIFn flag will generate an interrupt.

During a data transmission, a write instruction to the TXR\_RXRn register will place the data into the TXR\_RXRn register, which will be copied to the shift register at the end of the present transmission. When there is no data transmission in progress, a write instruction to the TXR\_RXRn register will place the data directly into the shift register, resulting in the commencement of data transmission, and the TXIFn bit being immediately set. When a frame transmission is complete, which happens after stop bits are sent or after the break frame, the TIDLEn bit will be set. To clear the TIDLEn bit the following software sequence is used:

- 1. A UnSR register access
- 2. A TXR\_RXRn register write execution

Note that both the TXIFn and TIDLEn bits are cleared by the same software sequence.

Rev. 1.00 190 August 27, 2021



#### **Transmit Break**

If the TXBRKn bit is set high and the state keeps for a time greater than  $[(BRG+1)\times t_H]$ , then the break characters will be sent on the next transmission. Break character transmission consists of a start bit, followed by  $13\times N$  '0' bits and stop bits, where N=1, 2, etc. If a break character is to be transmitted then the TXBRKn bit must be first set by the application program, and then cleared to generate the stop bits. Transmitting a break character will not generate a transmit interrupt. Note that a break condition length is at least 13 bits long. If the TXBRKn bit is continually kept at a logic high level then the transmitter circuitry will transmit continuous break characters. After the application program has cleared the TXBRKn bit, the transmitter will finish transmitting the last break character and subsequently send out one or two stop bits. The automatic logic highs at the end of the last break character will ensure that the start bit of the next frame is recognized.

#### **UART Receiver**

The UARTn is capable of receiving word lengths of either 8 or 9 bits. If the BNOn bit is set, the word length will be set to 9 bits with the MSB being stored in the RX8n bit of the UnCR1 register. At the receiver core lies the Receive Serial Shift Register, commonly known as the RSRn. The data which is received on the RXn/TXn external input pin is sent to the data recovery block. The data recovery block operating speed is 16 times that of the baud rate, while the main receive serial shifter operates at the baud rate. After the RXn/TXn pin is sampled for the stop bit, the received data in RSRn is transferred to the receive data register, if the register is empty. The data which is received on the external RXn/TXn input pin is sampled three times by a majority detect circuit to determine the logic level that has been placed onto the RXn/TXn pin. It should be noted that the RSRn register, unlike many other registers, is not directly mapped into the Data Memory area and as such is not available to the application program for direct read/write operations.

# **Receiving Data**

When the UARTn receiver is receiving data, the data is serially shifted in on the external RXn/TXn pin input, LSB first. In the read mode, the TXR\_RXRn register forms a buffer between the internal bus and the receiver shift register. The TXR\_RXRn register is a two byte deep FIFO data buffer, where two bytes can be held in the FIFO while a third byte can continue to be received. Note that the application program must ensure that the data is read from TXR\_RXRn before the third byte has been completely shifted in, otherwise this third byte will be discarded and an overrun error OERRn will be subsequently indicated. The steps to initiate a data transfer can be summarized as follows:

- · Make the correct selection of BNOn, PRTn and PRENn bits to define the word length, parity type.
- Setup the BRGn register to select the desired baud rate.
- Set the RXENn bit to ensure that the RXn/TXn pin is used as a UARTn receiver pin.

At this point the receiver will be enabled which will begin to look for a start bit.

When a character is received the following sequence of events will occur:

- The RXIFn bit in the UnSR register will be set when the TXR\_RXRn register has data available.
   There will be at most one more character available before an overrun error occurs.
- When the contents of the shift register have been transferred to the TXR\_RXRn register, then if the RIEn bit is set, an interrupt will be generated.
- If during reception, a frame error, noise error, parity error, or an overrun error has been detected, then the error flags can be set.

The RXIFn bit can be cleared using the following software sequence:

- 1. A UnSR register access
- 2. A TXR RXRn register read execution

Rev. 1.00 191 August 27, 2021



#### **Receiving Break**

Any break character received by the UARTn will be managed as a framing error. The receiver will count and expect a certain number of bit times as specified by the values programmed into the BNOn bit plus one stop bit. If the break is much longer than 13 bit times, the reception will be considered as complete after the number of bit times specified by BNOn plus one stop bit. The RXIFn bit is set, FERRn is set, zeros are loaded into the receive data register, interrupts are generated if appropriate and the RIDLEn bit is set. A break is regarded as a character that contains only zeros with the FERRn flag set. If a long break signal has been detected, the receiver will regard it as a data frame including a start bit, data bits and the invalid stop bit and the FERRn flag will be set. The receiver must wait for a valid stop bit before looking for the next start bit. The receiver will not make the assumption that the break condition on the line is the next start bit. The break character will be loaded into the buffer and no further data will be received until stop bits are received. It should be noted that the RIDLEn read only flag will go high when the stop bits have not yet been received. The reception of a break character on the UARTn registers will result in the following:

- The framing error flag, FERRn, will be set.
- The receive data register, TXR RXRn, will be cleared.
- The OERRn, NFn, PERRn, RIDLEn or RXIFn flags will possibly be set.

#### **Idle Status**

When the receiver is reading data, which means it will be in between the detection of a start bit and the reading of a stop bit, the receiver status flag in the UnSR register, otherwise known as the RIDLEn flag, will have a zero value. In between the reception of a stop bit and the detection of the next start bit, the RIDLEn flag will have a high value, which indicates the receiver is in an idle condition.

# **Receiver Interrupt**

The read only receive interrupt flag RXIFn in the UnSR register is set by an edge generated by the receiver. An interrupt is generated if RIEn=1, when a word is transferred from the Receive Shift Register, RSRn, to the Receive Data Register, TXR\_RXRn. An overrun error can also generate an interrupt if RIEn=1.

## **Managing Receiver Errors**

Several types of reception errors can occur within the UARTn module, the following section describes the various types and how they are managed by the UARTn.

#### Overrun Error - OERR

The TXR\_RXRn register is composed of a two byte deep FIFO data buffer, where two bytes can be held in the FIFO register, while a third byte can continue to be received. Before this third byte has been entirely shifted in, the data should be read from the TXR\_RXRn register. If this is not done, the overrun error flag OERRn will be consequently indicated.

In the event of an overrun error occurring, the following will happen:

- · The OERRn flag in the UnSR register will be set.
- The TXR\_RXRn contents will not be lost.
- · The shift register will be overwritten.
- An interrupt will be generated if the RIEn bit is set.

The OERRn flag can be cleared by an access to the UnSR register followed by a read to the TXR\_RXRn register.

Rev. 1.00 192 August 27, 2021



#### Noise Error - NF

Over-sampling is used for data recovery to identify valid incoming data and noise. If noise is detected within a frame the following will occur:

- The read only noise flag, NFn, in the UnSR register will be set on the rising edge of the RXIFn bit.
- Data will be transferred from the Shift register to the TXR RXRn register.
- No interrupt will be generated. However this bit rises at the same time as the RXIFn bit which itself generates an interrupt.

Note that the NFn flag is reset by a UnSR register read operation followed by a TXR\_RXRn register read operation.

## Framing Error - FERR

The read only framing error flag, FERRn, in the UnSR register, is set if a zero is detected instead of stop bits. If two stop bits are selected, both stop bits must be high; otherwise the FERRn flag will be set. The FERRn flag and the received data will be recorded in the UnSR and TXR\_RXRn registers respectively, and the flag is cleared in any reset.

## Parity Error - PERR

The read only parity error flag, PERRn, in the UnSR register, is set if the parity of the received word is incorrect. This error flag is only applicable if the parity is enabled, PRENn=1, and if the parity type, odd or even is selected. The read only PERRn flag and the received data will be recorded in the UnSR and TXR\_RXRn registers respectively. It is cleared on any reset, it should be noted that the flags, FERRn and PERRn, in the UnSR register should first be read by the application program before reading the data word.

### **UART Interrupt Structure**

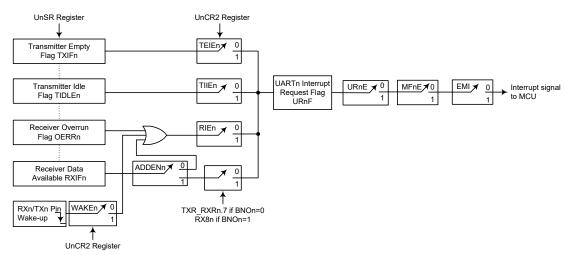
Several individual UARTn conditions can generate a UARTn interrupt. When these conditions exist, a low pulse will be generated to get the attention of the microcontroller. These conditions are a transmitter data register empty, transmitter idle, receiver data available, receiver overrun, address detect and an RXn/TXn pin wake-up. When any of these conditions are created, if the global interrupt enable bit and its corresponding interrupt control bit are enabled and the stack is not full, the program will jump to its corresponding interrupt vector where it can be serviced before returning to the main program. Four of these conditions have the corresponding UnSR register flags which will generate a UARTn interrupt if its associated interrupt enable control bit in the UnCR2 register is set. The two transmitter interrupt conditions have their own corresponding enable control bits, while the two receiver interrupt conditions have a shared enable control bit. These enable bits can be used to mask out individual UARTn interrupt sources.

The address detect condition, which is also a UARTn interrupt source, does not have an associated flag, but will generate a UARTn interrupt when an address detect condition occurs if its function is enabled by setting the ADDENn bit in the UnCR2 register. An RXn/TXn pin wake-up, which is also a UARTn interrupt source, does not have an associated flag, but will generate a UARTn interrupt if the UARTn clock ( $f_H$ ) source is switched off and the WAKEn and RIEn bits in the UnCR2 register are set when a falling edge on the RXn/TXn pin occurs.

Note that the UnSR register flags are read only and cannot be cleared or set by the application program, neither will they be cleared when the program jumps to the corresponding interrupt servicing routine, as is the case for some of the other interrupts. The flags will be cleared automatically when certain actions are taken by the UARTn, the details of which are given in the UARTn register section. The overall UARTn interrupt can be disabled or enabled by the related interrupt enable control bits in the interrupt control registers of the microcontroller to decide whether the interrupt requested by the UARTn module is masked out or allowed.

Rev. 1.00 193 August 27, 2021





UARTn Interrupt Structure (n=0~1)

#### **Address Detect Mode**

Setting the Address Detect Mode bit, ADDENn, in the UnCR2 register, enables this special mode. If this bit is enabled then an additional qualifier will be placed on the generation of a Receiver Data Available interrupt, which is requested by the RXIFn flag. If the ADDENn bit is enabled, then when data is available, an interrupt will only be generated, if the highest received bit has a high value. Note that the URnE, MFnE and EMI interrupt enable bits must also be enabled for correct interrupt generation. This highest address bit is the 9th bit if BNOn=1 or the 8th bit if BNOn=0. If this bit is high, then the received word will be defined as an address rather than data. A Data Available interrupt will be generated every time the last bit of the received word is set. If the ADDENn bit is not enabled, then a Receiver Data Available interrupt will be generated each time the RXIFn flag is set, irrespective of the data last bit status. The address detect mode and parity enable are mutually exclusive functions. Therefore if the address detect mode is enabled, then to ensure correct operation, the parity function should be disabled by resetting the parity enable bit PRENn to zero.

ADDENn	9th Bit if BNOn=1 8th Bit if BNOn=0	UARTn Interrupt Generated
0	0	$\sqrt{}$
	1	√
4	0	×
'	1	√

**ADDENn Bit Function** 

# **UART Power Down and Wake-up**

When the UARTn clock, f<sub>H</sub>, is switched off, the UARTn will cease to function. If the MCU switches off the UARTn clock, f<sub>H</sub>, and enters the power down mode while a transmission is still in progress, then the transmission will be paused until the UARTn clock source derived from the microcontroller is activated. In a similar way, if the MCU switches off the UARTn clock f<sub>H</sub> and enters the IDLE or SLEEP mode by executing the "HALT" instruction while receiving data, then the reception of data will likewise be paused. When the MCU enters the IDLE or SLEEP mode, note that the UnSR, UnCR1, UnCR2, transmit and receive registers, as well as the BRGn register will not be affected. It is recommended to make sure first that the UARTn data transmission or reception has been finished before the microcontroller enters the IDLE or SLEEP mode.

Rev. 1.00 194 August 27, 2021



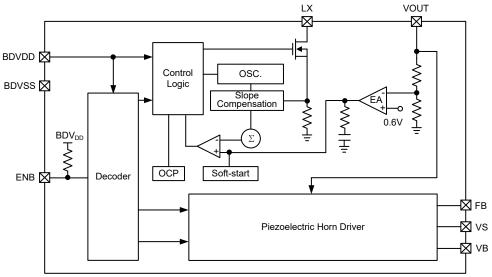
The UARTn function contains a receiver RXn/TXn pin wake-up function, which is enabled or disabled by the WAKEn bit in the UnCR2 register. If this bit, along with the UARTn enable bit, UARTENn, the receiver enable bit, RXENn and the receiver interrupt bit, RIEn, are all set when the MCU enters the power down mode with the UARTn clock f<sub>H</sub> being switched off, then a falling edge on the RXn/TXn pin will initiate an RXn/TXn pin wake-up UARTn interrupt. Note that as it takes certain system clock cycles after a wake-up, before normal microcontroller operation resumes, any data received during this time on the RXn/TXn pin will be ignored.

For a UARTn wake-up interrupt to occur, in addition to the bits for the wake-up being set, the global interrupt enable bit, EMI, and the UARTn interrupt enable bit, URnE, must be set. If the EMI, the multi-function interrupt enable bit, MFnE, and URnE bits are not set then only a wake up event will occur and no interrupt will be generated. Note also that as it takes certain system clock cycles after a wake-up before normal microcontroller resumes, the UARTn interrupt will not be generated until after this time has elapsed.

#### Piezoelectric Horn Driver

The device contains a piezoelectric horn driver with a 12V boost converter. The driver is used to drive an external-driving(2-pin) buzzer or a self-driving(3-pin) buzzer.

The ENB pin is used to select buzzer mode and boost converter on/off. When the ENB pin is set to high, the driver is in the shutdown mode, the buzzer driver and boost converter are both off.



Piezoelectric Horn Driver Diagram

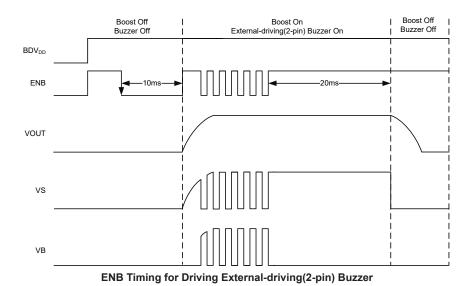
# External-driving(2-pin) Buzzer Driver Mode Settings

The driver is in the shutdown mode by default. Clear the ENB pin to 0 for 10ms, the driver will enter external-driving buzzer driver mode. The boost converter will be on. The control signal of external-driving buzzer is generated by the ENB pin. The VS pin outputs the non-inverted signal of the ENB pin, and the VB pin outputs the inverted signal of the ENB pin. The FB pin should be connect to VSS.

If the ENB pin is always high for 20ms, the driver will enter the shutdown mode.

Rev. 1.00 195 August 27, 2021





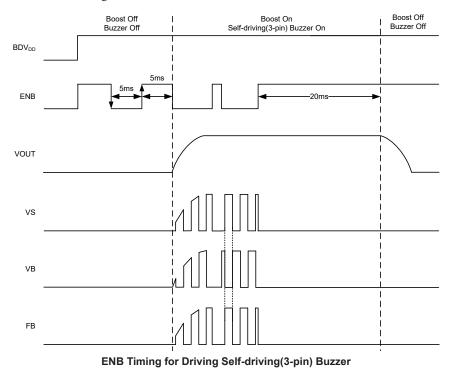
# Self-driving(3-pin) Buzzer Driver Mode Settings

The driver is in the shutdown mode by default. Clear the ENB pin to 0 for 5ms, after which set the ENB pin high for 5ms, the driver will enter self-driving buzzer driver mode. The boost converter will be on.

Clear the ENB pin to 0, the self-driving buzzer driver is enabled. Set the ENB pin high, the self-driving buzzer driver is disabled.

If the ENB pin is always high for 20ms, the driver will enter the shutdown mode.

Note: The buzzer mode and shutdown mode settings are achieved by time counting. Attention should be paid to the system noise to avoid IC misjudgment which may reset the internal counter and restart the counting.



Rev. 1.00 196 August 27, 2021



# Low Voltage Detector - LVD

The device has a Low Voltage Detector function, also known as LVD. This enables the device to monitor the power supply voltage,  $V_{DD}$ , and provide a warning signal should it fall below a certain level. This function may be especially useful in battery applications where the supply voltage will gradually reduce as the battery ages, as it allows an early warning battery low signal to be generated. The Low Voltage Detector also has the capability of generating an interrupt signal.

# **LVD Register**

The Low Voltage Detector function is controlled using a single register with the name LVDC. Three bits in this register, VLVD2 $\sim$ VLVD0, are used to select one of eight fixed voltages below which a low voltage condition will be determined. A low voltage condition is indicated when the LVDO bit is set. If the LVDO bit is low, this indicates that the  $V_{DD}$  voltage is above the preset low voltage value. The LVDEN bit is used to control the overall on/off function of the low voltage detector. Setting the bit high will enable the low voltage detector. Clearing the bit to zero will switch off the internal low voltage detector circuits. As the low voltage detector will consume a certain amount of power, it may be desirable to switch off the circuit when not in use, an important consideration in power sensitive battery powered applications.

## LVDC Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	LVDO	LVDEN	VBGEN	VLVD2	VLVD1	VLVD0
R/W	_	_	R	R/W	R/W	R/W	R/W	R/W
POR	_	_	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5 LVDO: LVD Output Flag

0: No Low Voltage Detected

1: Low Voltage Detected

Bit 4 LVDEN: Low Voltage Detector Control

0: Disable 1: Enable

Bit 3 VBGEN: Bandgap Buffer Control

0: Disable 1: Enable

Note that the Bandgap circuit is enabled when the LVD or the LVR function is enabled or when the VBGEN bit is set high.

Bit 2~0 VLVD2~VLVD0: Select LVD Voltage

000: 2.0V 001: 2.2V 010: 2.4V 011: 2.7V 100: 3.0V 101: 3.3V 110: 3.6V

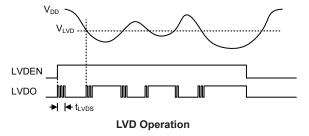
111: 4.0V

Rev. 1.00 197 August 27, 2021



# **LVD Operation**

The Low Voltage Detector function operates by comparing the power supply voltage,  $V_{DD}$ , with a pre-specified voltage level stored in the LVDC register. This has a range of between 2.0V and 4.0V. When the power supply voltage,  $V_{DD}$ , falls below this pre-determined value, the LVDO bit will be set high indicating a low power supply voltage condition. When the device is in the SLEEP mode, the low voltage detector will be disabled even if the LVDEN bit is high. After enabling the Low Voltage Detector, a time delay  $t_{\rm LVDS}$  should be allowed for the circuitry to stabilise before reading the LVDO bit. Note also that as the  $V_{\rm DD}$  voltage may rise and fall rather slowly, at the voltage nears that of  $V_{\rm LVD}$ , there may be multiple bit LVDO transitions.



The Low Voltage Detector also has its own interrupt, providing an alternative means of low voltage detection, in addition to polling the LVDO bit. The interrupt will only be generated after a delay of  $t_{\text{LVD}}$  after the LVDO bit has been set high by a low voltage condition. In this case, the LVF interrupt request flag will be set, causing an interrupt to be generated if  $V_{\text{DD}}$  falls below the preset LVD voltage. This will cause the device to wake-up from the IDLE Mode, however if the Low Voltage Detector wake up function is not required then the LVF flag should be first set high before the device enter the IDLE Mode.

# Interrupts

Interrupts are an important part of any microcontroller system. When an external event or an internal function such as a Timer Module or an A/D converter requires microcontroller attention, their corresponding interrupt will enforce a temporary suspension of the main program allowing the microcontroller to direct attention to their respective needs. The device contains several external interrupt and internal interrupts functions. The external interrupts are generated by the action of the external INT0~INT1 pins, while the internal interrupts are generated by various internal functions such as the TMs, Time Bases, SIM, LVD, EEPROM and the A/D converter.

## **Interrupt Registers**

Overall interrupt control, which basically means the setting of request flags when certain microcontroller conditions occur and the setting of interrupt enable bits by the application program, is controlled by a series of registers, located in the Special Purpose Data Memory. The registers fall into three categories. The first is the INTC0~INTC3 registers which setup the primary interrupts, the second is the MFnI register which setup the Multi-function interrupts. Finally there is the INTEG register which setup the external interrupt trigger edge type.

Each register contains a number of enable bits to enable or disable individual registers as well as interrupt flags to indicate the presence of an interrupt request. The naming convention of these follows a specific pattern. First is listed an abbreviated interrupt type, then the (optional) number of that interrupt followed by either an "E" for enable/disable bit or "F" for request flag.

Rev. 1.00 198 August 27, 2021



Function	Enable Bit	Request Flag	Notes
Global	EMI	_	_
INTn Pin	INTnE	INTnF	n=0~1
PLT Comparator	PLTCnE	PLTCnF	n=0~1
A/D Converter	ADE	ADF	_
Time Base	TBnE	TBnF	n=0~1
SIM	SIME	SIMF	_
UARTn	URnE	URnF	n=0~1
Multi-function	MFnE	MFnF	n=0~5
LVD	LVE	LVF	_
EEPROM	DEE	DEF	_
STMn	STMnPE	STMnPF	n=0~1
STIVITI	STMnAE	STMnAF	11-0~1
DTMn	PTMnPE	PTMnPF	n=0 · 2
PTMn	PTMnAE	PTMnAF	n=0~2

# **Interrupt Register Bit Naming Conventions**

Register				В	it			
Name	7	6	5	4	3	2	1	0
INTEG	_	_	_	_	INT1S1	INT1S0	INT0S1	INT0S0
INTC0	_	INT1F	INT0F	PLTC0F	INT1E	INT0E	PLTC0E	EMI
INTC1	MF1F	MF0F	LVF	SIMF	MF1E	MF0E	LVE	SIME
INTC2	PLTC1F	TB1F	TB0F	MF2F	PLTC1E	TB1E	TB0E	MF2E
INTC3	_	MF5F	MF4F	MF3F	_	MF5E	MF4E	MF3E
MFI0	_	_	DEF	ADF	_	_	DEE	ADE
MFI1	_	_	PTM0AF	PTM0PF	_	_	PTM0AE	PTM0PE
MFI2	_	_	STM0AF	STM0PF	_	_	STM0AE	STM0PE
MFI3	_	UR0F	STM1AF	STM1PF	_	UR0E	STM1AE	STM1PE
MFI4	_	UR1F	PTM1AF	PTM1PF	_	UR1E	PTM1AE	PTM1PE
MFI5	_	_	PTM2AF	PTM2PF	_	_	PTM2AE	PTM2PE

# Interrupt Register List

# • INTEG Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	INT1S1	INT1S0	INT0S1	INT0S0
R/W	_	_	_	_	R/W	R/W	R/W	R/W
POR	_	_	_	_	0	0	0	0

Bit 7~4 Unimplemented, read as "0"

Bit 3~2 **INT1S1~INT1S0**: interrupt edge control for INT1 pin

00: Disable

01: Rising edge

10: Falling edge

11: Rising and falling edges

Bit 1~0 INT0S1~INT0S0: interrupt edge control for INT0 pin

00: Disable

01: Rising edge

10: Falling edge

11: Rising and falling edges



## • INTC0 Register

Bit	7	6	5	4	3	2	1	0
Name	_	INT1F	INT0F	PLTC0F	INT1E	INT0E	PLTC0E	EMI
R/W	_	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	_	0	0	0	0	0	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 INT1F: INT1 interrupt request flag

0: No request1: Interrupt request

Bit 5 INT0F: INT0 interrupt request flag

0: No request1: Interrupt request

Bit 4 PLTC0F: PLT Comparator 0 interrupt request flag

0: No request1: Interrupt request

Bit 3 **INT1E**: INT1 interrupt control

0: Disable 1: Enable

Bit 2 **INT0E**: INT0 interrupt control

0: Disable 1: Enable

Bit 1 PLTC0E: PLT Comparator 0 interrupt control

0: Disable 1: Enable

Bit 0 **EMI**: Global interrupt control

0: Disable 1: Enable

# • INTC1 Register

Bit	7	6	5	4	3	2	1	0
Name	MF1F	MF0F	LVF	SIMF	MF1E	MF0E	LVE	SIME
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7 MF1F: Multi-function 1 interrupt request flag

0: No request1: Interrupt request

Bit 6 MF0F: Multi-function 0 interrupt request flag

0: No request1: Interrupt request

Bit 5 LVF: LVD interrupt request flag

0: No request1: Interrupt request

Bit 4 SIMF: SIM interrupt request flag

0: No request1: Interrupt request

Bit 3 MF1E: Multi-function 1 interrupt control

0: Disable 1: Enable

Bit 2 MF0E: Multi-function 0 interrupt control



Bit 1 LVE: LVD interrupt control

0: Disable 1: Enable

Bit 0 **SIME**: SIM interrupt control

0: Disable 1: Enable

## • INTC2 Register

Bit	7	6	5	4	3	2	1	0
Name	PLTC1F	TB1F	TB0F	MF2F	PLTC1E	TB1E	TB0E	MF2E
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7 PLTC1F: Comparator1 interrupt request flag

0: No request1: Interrupt request

Bit 6 TB1F: Time Base interrupt request flag

0: No request1: Interrupt request

Bit 5 TB0F: Time Base interrupt request flag

0: No request1: Interrupt request

Bit 4 MF2F: Multi-function 2 interrupt request flag

0: No request1: Interrupt request

Bit 3 **PLTC1E**: Comparator1 interrupt control

0: Disable 1: Enable

Bit 2 TB1E: Time Base interrupt control

0: Disable 1: Enable

Bit 1 **TB0E**: Time Base interrupt control

0: Disable 1: Enable

Bit 0 MF2E: Multi-function 2 interrupt control

0: Disable 1: Enable

# • INTC3 Register

Bit	7	6	5	4	3	2	1	0
Name	_	MF5F	MF4F	MF3F	_	MF5E	MF4E	MF3E
R/W	_	R/W	R/W	R/W	_	R/W	R/W	R/W
POR	_	0	0	0	_	0	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 MF5F: Multi-function 5 interrupt request flag

0: No request1: Interrupt request

Bit 5 MF4F: Multi-function 4 interrupt request flag

0: No request1: Interrupt request

Bit 4 MF3F: Multi-function 3 interrupt request flag

0: No request1: Interrupt request



Bit 3 Unimplemented, read as "0"

Bit 2 MF5E: Multi-function 5 interrupt control

0: Disable 1: Enable

Bit 1 MF4E: Multi-function 4 interrupt control

0: Disable 1: Enable

Bit 0 MF3E: Multi-function 3 interrupt control

0: Disable 1: Enable

#### • MFI0 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	DEF	ADF	_	_	DEE	ADE
R/W	_	_	R/W	R/W	_	_	R/W	R/W
POR	_	_	0	0	_	_	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5 **DEF**: Data EEPROM interrupt request flag

0: No request1: Interrupt request

Bit 4 ADF: A/D converter interrupt request flag

0: No request1: Interrupt request

Bit 3~2 Unimplemented, read as "0"

Bit 1 **DEE**: Data EEPROM interrupt control

0: Disable 1: Enable

Bit 0 ADE: A/D converter interrupt control

0: Disable 1: Enable

## MFI1 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	PTM0AF	PTM0PF	_	_	PTM0AE	PTM0PE
R/W	_	_	R/W	R/W	_	_	R/W	R/W
POR	_	_	0	0	_	_	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5 **PTM0AF**: PTM0 Comparator A match interrupt request flag

0: No request1: Interrupt request

Bit 4 PTM0PF: PTM0 Comparator P match interrupt request flag

0: No request1: Interrupt request

Bit 3~2 Unimplemented, read as "0"

Bit 1 **PTM0AE**: PTM0 Comparator A match interrupt control

0: Disable 1: Enable

Bit 0 **PTM0PE**: PTM0 Comparator P match interrupt control



## • MFI2 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	STM0AF	STM0PF	_	_	STM0AE	STM0PE
R/W	_	_	R/W	R/W	_	_	R/W	R/W
POR	_	_	0	0	_	_	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5 STM0AF: STM0 Comparator A match interrupt request flag

0: No request1: Interrupt request

Bit 4 STM0PF: STM0 Comparator P match interrupt request flag

0: No request1: Interrupt request

Bit 3~2 Unimplemented, read as "0"

Bit 1 STM0AE: STM0 Comparator A match interrupt control

0: Disable 1: Enable

Bit 0 STM0PE: STM0 Comparator P match interrupt control

0: Disable 1: Enable

## • MFI3 Register

Bit	7	6	5	4	3	2	1	0
Name	_	UR0F	STM1AF	STM1PF	_	UR0E	STM1AE	STM1PE
R/W	_	R/W	R/W	R/W	_	R/W	R/W	R/W
POR	_	0	0	0	_	0	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 UR0F: UART0 interrupt request flag

0: No request1: Interrupt request

Bit 5 STM1AF: STM1 Comparator A match interrupt request flag

0: No request1: Interrupt request

Bit 4 STM1PF: STM1 Comparator P match interrupt request flag

0: No request1: Interrupt request

Bit 3 Unimplemented, read as "0"

Bit 2 UR0E: UART0 interrupt control

0: Disable 1: Enable

Bit 1 STM1AE: STM1 Comparator A match interrupt control

0: Disable 1: Enable

Bit 0 STM1PE: STM1 Comparator P match interrupt control

## • MFI4 Register

Bit	7	6	5	4	3	2	1	0
Name	_	UR1F	PTM1AF	PTM1PF	_	UR1E	PTM1AE	PTM1PE
R/W	_	R/W	R/W	R/W	_	R/W	R/W	R/W
POR	_	0	0	0	_	0	0	0

Bit 7 Unimplemented, read as "0"

Bit 6 UR1F: UART1 interrupt request flag

0: No request1: Interrupt request

Bit 5 PTM1AF: PTM1 Comparator A match interrupt request flag

0: No request1: Interrupt request

Bit 4 **PTM1PF**: PTM1 Comparator P match interrupt request flag

0: No request1: Interrupt request

Bit 3 Unimplemented, read as "0"

Bit 2 UR1E: UART1 interrupt control

0: Disable 1: Enable

Bit 1 **PTM1AE**: PTM1 Comparator A match interrupt control

0: Disable 1: Enable

Bit 0 **PTM1PE**: PTM1 Comparator P match interrupt control

0: Disable 1: Enable

## MFI5 Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	PTM2AF	PTM2PF	_	_	PTM2AE	PTM2PE
R/W	_	_	R/W	R/W	_	_	R/W	R/W
POR	_	_	0	0	_	_	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5 PTM2AF: PTM2 Comparator A match interrupt request flag

0: No request1: Interrupt request

Bit 4 **PTM2PF**: PTM2 Comparator P match interrupt request flag

0: No request1: Interrupt request

Bit 3~2 Unimplemented, read as "0"

Bit 1 **PTM2AE**: PTM2 Comparator A match interrupt control

0: Disable 1: Enable

Bit 0 **PTM2PE**: PTM2 Comparator P match interrupt control



# **Interrupt Operation**

When the conditions for an interrupt event occur, such as a TM Comparator P, Comparator A match or A/D conversion completion etc., the relevant interrupt request flag will be set. Whether the request flag actually generates a program jump to the relevant interrupt vector is determined by the condition of the interrupt enable bit. If the enable bit is set high then the program will jump to its relevant vector; if the enable bit is zero then although the interrupt request flag is set an actual interrupt will not be generated and the program will not jump to the relevant interrupt vector. The global interrupt enable bit, if cleared to zero, will disable all interrupts.

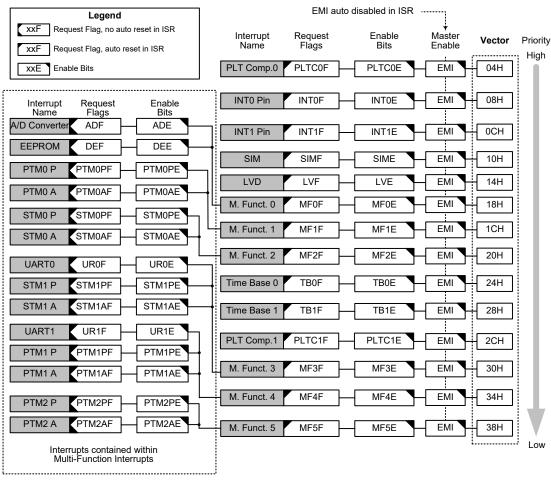
When an interrupt is generated, the Program Counter, which stores the address of the next instruction to be executed, will be transferred onto the stack. The Program Counter will then be loaded with a new address which will be the value of the corresponding interrupt vector. The microcontroller will then fetch its next instruction from this interrupt vector. The instruction at this vector will usually be a "JMP" which will jump to another section of program which is known as the interrupt service routine. Here is located the code to control the appropriate interrupt. The interrupt service routine must be terminated with a "RETI", which retrieves the original Program Counter address from the stack and allows the microcontroller to continue with normal execution at the point where the interrupt occurred.

The various interrupt enable bits, together with their associated request flags, are shown in the accompanying diagrams with their order of priority. Some interrupt sources have their own individual vector while others share the same multi-function interrupt vector. Once an interrupt subroutine is serviced, all the other interrupts will be blocked, as the global interrupt enable bit, EMI bit will be cleared automatically. This will prevent any further interrupt nesting from occurring. However, if other interrupt requests occur during this interval, although the interrupt will not be immediately serviced, the request flag will still be recorded.

If an interrupt requires immediate servicing while the program is already in another interrupt service routine, the EMI bit should be set after entering the routine, to allow interrupt nesting. If the stack is full, the interrupt request will not be acknowledged, even if the related interrupt is enabled, until the Stack Pointer is decremented. If immediate service is desired, the stack must be prevented from becoming full. In case of simultaneous requests, the accompanying diagram shows the priority that is applied. All of the interrupt request flags when set will wake-up the device if it is in SLEEP or IDLE Mode, however to prevent a wake-up from occurring the corresponding flag should be set before the device are in SLEEP or IDLE Mode.

Rev. 1.00 205 August 27, 2021





Interrupt Structure

#### **External Interrupts**

The external interrupts are controlled by signal transitions on the pins INT0~INT1. An external interrupt request will take place when the external interrupt request flags, INT0F~INT1F, are set, which will occur when a transition, whose type is chosen by the edge select bits, appears on the external interrupt pins. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and respective external interrupt enable bit, INT0E~INT1E, must first be set. Additionally the correct interrupt edge type must be selected using the INTEG register to enable the external interrupt function and to choose the trigger edge type. As the external interrupt pins are pin-shared with I/O pins, they can only be configured as external interrupt pins if their external interrupt enable bit in the corresponding interrupt register has been set and the external interrupt pin is selected by the corresponding pin-shared function selection bits. The pin must also be setup as an input by setting the corresponding bit in the port control register. When the interrupt is enabled, the stack is not full and the correct transition type appears on the external interrupt pin, a subroutine call to the external interrupt vector, will take place. When the interrupt is serviced, the external interrupt request flags, INT0F~INT1F, will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts. Note that any pull-high resistor selections on the external interrupt pins will remain valid even if the pin is used as an external interrupt input.

Rev. 1.00 206 August 27, 2021



The INTEG register is used to select the type of active edge that will trigger the external interrupt. A choice of either rising or falling or both edge types can be chosen to trigger an external interrupt. Note that the INTEG register can also be used to disable the external interrupt function.

# **PLT Comparator Interrupts**

The PLT comparator interrupts are controlled by the Powerline Transceiver circuit internal comparators. A PLT comparator n interrupt request will take place when the PLT comparator n interrupt request flag, PLTCnF, is set, a situation that will occur when the PLT comparator n output bit changes state. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and PLT comparator n interrupt enable bit, PLTCnE, must first be set. When the interrupt is enabled, the stack is not full and the PLT comparator n inputs generate a comparator output transition, a subroutine call to the PLT comparator interrupt vector, will take place. When the interrupt is serviced, the PLT comparator interrupt request flag, PLTCnF, will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts.

# A/D Converter Interrupt

The A/D Converter Interrupt is contained within the Multi-function Interrupt. An A/D Converter Interrupt request will take place when the A/D Converter Interrupt request flag, ADF, is set, which occurs when the A/D conversion process finishes. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and A/D Interrupt enable bit, ADE, must first be set. When the interrupt is enabled, the stack is not full and the A/D conversion process has ended, a subroutine call to the A/D Converter Interrupt vector, will take place. When the interrupt is serviced, the EMI bit will be automatically cleared to disable other interrupts, however only the Multi-function interrupt request flag will be also automatically cleared. As the ADF flag will not be automatically cleared, it has to be cleared by the application program.

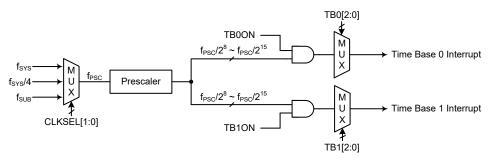
#### **Time Base Interrupts**

The function of the Time Base Interrupts is to provide regular time signal in the form of an internal interrupt. They are controlled by the overflow signals from their respective timer functions. When these happens their respective interrupt request flags, TB0F or TB1F will be set. To allow the program to branch to their respective interrupt vector addresses, the global interrupt enable bit, EMI and Time Base enable bits, TB0E or TB1E, must first be set. When the interrupt is enabled, the stack is not full and the Time Base overflows, a subroutine call to their respective vector locations will take place. When the interrupt is serviced, the respective interrupt request flag, TB0F or TB1F, will be automatically reset and the EMI bit will be cleared to disable other interrupts.

The purpose of the Time Base Interrupt is to provide an interrupt signal at fixed time periods. Its clock source,  $f_{PSC}$ , originates from the internal clock source  $f_{SYS}$ ,  $f_{SYS}/4$  or  $f_{SUB}$  and then passes through a divider, the division ratio of which is selected by programming the appropriate bits in the TB0C or TB1C register to obtain longer interrupt periods whose value ranges. The clock source which in turn controls the Time Base interrupt period is selected using the CLKSEL1~CLKSEL0 bits in the PSCR register.

Rev. 1.00 207 August 27, 2021





**Time Base Interrupt** 

# PSCR Register

Bit	7	6	5	4	3	2	1	0
Name	_	_	_	_	_	_	CLKSEL1	CLKSEL0
R/W	_	_	_	_	_	_	R/W	R/W
POR	_	_	_	_	_	_	0	0

Bit 7~2 Unimplemented, read as "0"

Bit 1~0 CLKSEL1~CLKSEL0: Prescaler clock source selection

00: f<sub>SYS</sub> 01: f<sub>SYS</sub>/4 1x: f<sub>SUB</sub>

# • TBnC Register (n=0 or 1)

Bit	7	6	5	4	3	2	1	0
Name	TBnON	_	_	_	_	TBn2	TBn1	TBn0
R/W	R/W	_	_	_	_	R/W	R/W	R/W
POR	0	_	_	_	_	0	0	0

Bit 7 **TBnON**: Time Base n Control

0: Disable 1: Enable

Bit 6~3 Unimplemented, read as "0"

Bit 2~0 **TBn2~TBn0**: Select Time Base n Time-out Period

 $\begin{array}{l} 000:\ 2^8/f_{PSC} \\ 001:\ 2^9/f_{PSC} \\ 010:\ 2^{10}/f_{PSC} \\ 011:\ 2^{11}/f_{PSC} \\ 100:\ 2^{12}/f_{PSC} \\ 101:\ 2^{13}/f_{PSC} \\ 110:\ 2^{14}/f_{PSC} \\ 111:\ 2^{15}/f_{PSC} \end{array}$ 

Rev. 1.00 208 August 27, 2021



# **Multi-function Interrupts**

Within the device there is several Multi-function interrupt. Unlike the other independent interrupts, this interrupt has no independent source, but rather are formed from other existing interrupt sources, namely the ADC Interrupt, Data EEPROM Interrupt, PTM Interrupt, STM Interrupt and UART Interrupt.

A Multi-function interrupt request will take place when any of the Multi-function interrupt request flag, MFnF is set. The Multi-function interrupt flags will be set when any of their included functions generate an interrupt request flag. When the Multi-function interrupt is enabled and the stack is not full, and either one of the interrupts contained within each of Multi-function interrupt occurs, a subroutine call to one of the Multi-function interrupt vectors will take place. When the interrupt is serviced, the related Multi-Function request flag will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts.

However, it must be noted that, although the Multi-function Interrupt flag will be automatically reset when the interrupt is serviced, the request flags from the original source of the Multi-function interrupt will not be automatically reset and must be manually reset by the application program.

# SIM Interrupt

The Serial Interface Module Interrupt, also known as the SIM Interrupt. A SIM Interrupt repuest will take place when the SIM Interrupt request flag, SIMF, is set, which occurs when a byte of data has been received or transmitted by the SIM interface, an I<sup>2</sup>C address match, or an I<sup>2</sup>C time-out situation has occurred. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and the Serial Interface Interrupt enable bit, SIME, must first be set. When the interrupt is enabled, the stack is not full and any of the above described situations occurs, a subroutine call to the respective Interrupt vector, will take place. When the interrupt is serviced, the Serial Interface Interrupt flag, SIMF, will be automatically cleared. The EMI bit will also be automatically cleared to disable other interrupts.

# **UART Interrupts**

The UART Interrupts are contained within the Multi-function Interrupt. Several individual UART conditions can generate a UART interrupt. When these conditions exist, a low pulse will be generated to get the attention of the microcontroller. These conditions are a transmitter data register empty, transmitter idle, receiver data available, receiver overrun, address detect and an RXn/TXn pin wake-up. To allow the program to branch to the respective interrupt vector addresses, the global interrupt enable bit, EMI, and the UART interrupt enable bit, URnE, and associated Multi-function interrupt enable bit, must first be set. When the interrupt is enabled, the stack is not full and any of these conditions are created, a subroutine call to the Multi-function Interrupt vector will take place. When the Interrupt is serviced, the EMI bit will also be automatically cleared to disable other interrupts, however only the Multi-function interrupt request flag will be also automatically cleared. As the URnF flag will not be automatically cleared, it has to be cleared by the application program.

# **LVD** Interrupt

An LVD Interrupt request will take place when the LVD Interrupt request flag, LVF, is set, which occurs when the Low Voltage Detector function detects a low power supply voltage. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and Low Voltage Interrupt enable bit, LVE, must first be set. When the interrupt is enabled, the stack is not full and a low voltage condition occurs, a subroutine call to the LVD Interrupt vector, will take place. When the Low Voltage Interrupt is serviced, the LVD Interrupt flag, LVF, will be automatically cleared. The EMI bit will also be automatically cleared to disable other interrupts.

Rev. 1.00 209 August 27, 2021



# **EEPROM Interrupt**

The EEPROM Interrupt is contained within the Multi-function Interrupt. An EEPROM Interrupt request will take place when the EEPROM Interrupt request flag, DEF, is set, which occurs when an EEPROM Write cycle ends. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and EEPROM Interrupt enable bit, DEE, must first be set. When the interrupt is enabled, the stack is not full and an EEPROM Write cycle ends, a subroutine call to the EEPROM Interrupt vector will take place. When the EEPROM Interrupt is serviced, the EMI bit will be automatically cleared to disable other interrupts. However, only the Multi-function interrupt request flag will be automatically cleared. As the DEF flag will not be automatically cleared, it has to be cleared by the application program.

# **TM Interrupts**

The Standard and Periodic Type TMs each has two interrupts. All of the TM interrupts are contained within the Multi-function Interrupts. For all of the TM types there are two interrupt request flags PTMnP, PTMnAF, STMnPF and STMnAF and two enable bits PTMnPE, PTMnAE, STMnPE and STMnAE. A TM interrupt request will take place when any of the TM request flags are set, a situation which occurs when a TM comparator P or A match situation happens.

To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, respective TM Interrupt enable bit, and relevant Multi-function Interrupt enable bit, MFnE, must first be set. When the interrupt is enabled, the stack is not full and a TM comparator match situation occurs, a subroutine call to the relevant Multi-function Interrupt vector locations, will take place. When the TM interrupt is serviced, the EMI bit will be automatically cleared to disable other interrupts, however only the related MFnF flag will be automatically cleared. As the TM interrupt request flag will not be automatically cleared, they have to be cleared by the application program.

# **Interrupt Wake-up Function**

Each of the interrupt functions has the capability of waking up the microcontroller when in the SLEEP or IDLE Mode. A wake-up is generated when an interrupt request flag changes from low to high and is independent of whether the interrupt is enabled or not. Therefore, even though the device is in the SLEEP or IDLE Mode and its system oscillator stopped, situations such as external edge transitions on the external interrupt pins or a low power supply voltage may cause their respective interrupt flag to be set high and consequently generate an interrupt. Care must therefore be taken if spurious wake-up situations are to be avoided. If an interrupt wake-up function is to be disabled then the corresponding interrupt request flag should be set high before the device enter the SLEEP or IDLE Mode. The interrupt enable bits have no effect on the interrupt wake-up function.

Rev. 1.00 210 August 27, 2021



# **Programming Considerations**

By disabling the relevant interrupt enable bits, a requested interrupt can be prevented from being serviced, however, once an interrupt request flag is set, it will remain in this condition in the interrupt register until the corresponding interrupt is serviced or until the request flag is cleared by the application program.

Where a certain interrupt is contained within a Multi-function interrupt, then when the interrupt service routine is executed, as only the Multi-function interrupt request flag, MFnF, will be automatically cleared, the individual request flag for the function needs to be cleared by the application program.

It is recommended that programs do not use the "CALL" instruction within the interrupt service subroutine. Interrupts often occur in an unpredictable manner or need to be serviced immediately. If only one stack is left and the interrupt is not well controlled, the original control sequence will be damaged once a CALL subroutine is executed in the interrupt subroutine.

Every interrupt has the capability of waking up the microcontroller when it is in SLEEP or IDLE Mode, the wake up being generated when the interrupt request flag changes from low to high. If it is required to prevent a certain interrupt from waking up the microcontroller then its respective request flag should be first set high before enter SLEEP or IDLE Mode.

As only the Program Counter is pushed onto the stack, then when the interrupt is serviced, if the contents of the accumulator, status register or other registers are altered by the interrupt service program, their contents should be saved to the memory at the beginning of the interrupt service routine.

To return from an interrupt subroutine, either a RET or RETI instruction may be executed. The RETI instruction in addition to executing a return to the main program also automatically sets the EMI bit high to allow further interrupts. The RET instruction however only executes a return to the main program leaving the EMI bit in its present zero state and therefore disabling the execution of further interrupts.

# **Configuration Options**

Configuration options refer to certain options within the MCU that are programmed into the device during the programming process. During the development process, these options are selected using the HT-IDE software development tools. All options must be defined for proper system function, the details of which are shown in the table.

No.	Options			
Oscillator Option				
1	HIRC frequency selection – f <sub>HIRC</sub> : 2MHz, 4MHz or 8MHz			

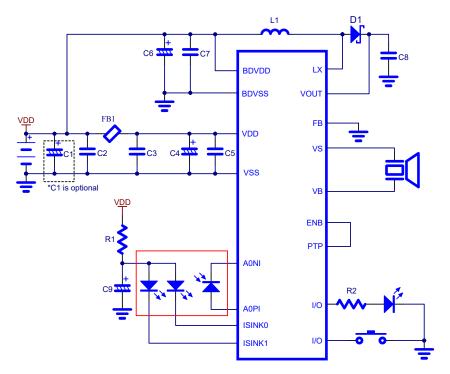
Note: When the HIRC has been configured at a frequency shown in this table, the HIRC1 and HIRC0 bits should also be setup to select the same frequency to achieve the HIRC frequency accuracy specified in the A.C. Characteristics.

Rev. 1.00 211 August 27, 2021

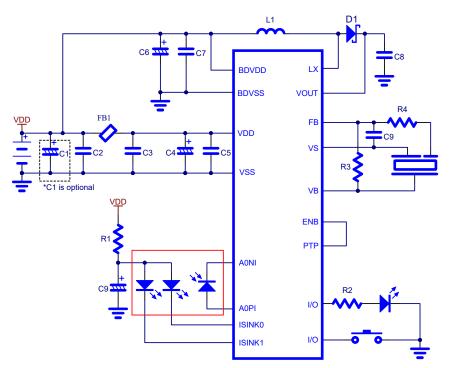


# **Application Circuits**

# External-driving (2-pin) Buzzer



# Self-driving (3-pin) Buzzer



Note: L1=10 $\mu$ H; C8=2.2 $\mu$ F; C6=47 $\mu$ F; C7=0.1 $\mu$ F.

Rev. 1.00 212 August 27, 2021



## Instruction Set

#### Introduction

Central to the successful operation of any microcontroller is its instruction set, which is a set of program instruction codes that directs the microcontroller to perform certain operations. In the case of Holtek microcontroller, a comprehensive and flexible set of over 60 instructions is provided to enable programmers to implement their application with the minimum of programming overheads.

For easier understanding of the various instruction codes, they have been subdivided into several functional groupings.

# **Instruction Timing**

Most instructions are implemented within one instruction cycle. The exceptions to this are branch, call, or table read instructions where two instruction cycles are required. One instruction cycle is equal to 4 system clock cycles, therefore in the case of an 8MHz system oscillator, most instructions would be implemented within 0.5µs and branch or call instructions would be implemented within 1µs. Although instructions which require one more cycle to implement are generally limited to the JMP, CALL, RET, RETI and table read instructions, it is important to realize that any other instructions which involve manipulation of the Program Counter Low register or PCL will also take one more cycle to implement. As instructions which change the contents of the PCL will imply a direct jump to that new address, one more cycle will be required. Examples of such instructions would be "CLR PCL" or "MOV PCL, A". For the case of skip instructions, it must be noted that if the result of the comparison involves a skip operation then this will also take one more cycle, if no skip is involved then only one cycle is required.

# Moving and Transferring Data

The transfer of data within the microcontroller program is one of the most frequently used operations. Making use of several kinds of MOV instructions, data can be transferred from registers to the Accumulator and vice-versa as well as being able to move specific immediate data directly into the Accumulator. One of the most important data transfer applications is to receive data from the input ports and transfer data to the output ports.

# **Arithmetic Operations**

The ability to perform certain arithmetic operations and data manipulation is a necessary feature of most microcontroller applications. Within the Holtek microcontroller instruction set are a range of add and subtract instruction mnemonics to enable the necessary arithmetic to be carried out. Care must be taken to ensure correct handling of carry and borrow data when results exceed 255 for addition and less than 0 for subtraction. The increment and decrement instructions such as INC, INCA, DEC and DECA provide a simple means of increasing or decreasing by a value of one of the values in the destination specified.

Rev. 1.00 213 August 27, 2021



# **Logical and Rotate Operation**

The standard logical operations such as AND, OR, XOR and CPL all have their own instruction within the Holtek microcontroller instruction set. As with the case of most instructions involving data manipulation, data must pass through the Accumulator which may involve additional programming steps. In all logical data operations, the zero flag may be set if the result of the operation is zero. Another form of logical data manipulation comes from the rotate instructions such as RR, RL, RRC and RLC which provide a simple means of rotating one bit right or left. Different rotate instructions exist depending on program requirements. Rotate instructions are useful for serial port programming applications where data can be rotated from an internal register into the Carry bit from where it can be examined and the necessary serial bit set high or low. Another application which rotate data operations are used is to implement multiplication and division calculations.

#### **Branches and Control Transfer**

Program branching takes the form of either jumps to specified locations using the JMP instruction or to a subroutine using the CALL instruction. They differ in the sense that in the case of a subroutine call, the program must return to the instruction immediately when the subroutine has been carried out. This is done by placing a return instruction "RET" in the subroutine which will cause the program to jump back to the address right after the CALL instruction. In the case of a JMP instruction, the program simply jumps to the desired location. There is no requirement to jump back to the original jumping off point as in the case of the CALL instruction. One special and extremely useful set of branch instructions are the conditional branches. Here a decision is first made regarding the condition of a certain data memory or individual bits. Depending upon the conditions, the program will continue with the next instruction or skip over it and jump to the following instruction. These instructions are the key to decision making and branching within the program perhaps determined by the condition of certain input switches or by the condition of internal data bits.

#### **Bit Operations**

The ability to provide single bit operations on Data Memory is an extremely flexible feature of all Holtek microcontrollers. This feature is especially useful for output port bit programming where individual bits or port pins can be directly set high or low using either the "SET [m].i" or "CLR [m].i" instructions respectively. The feature removes the need for programmers to first read the 8-bit output port, manipulate the input data to ensure that other bits are not changed and then output the port with the correct new data. This read-modify-write process is taken care of automatically when these bit operation instructions are used.

# **Table Read Operations**

Data storage is normally implemented by using registers. However, when working with large amounts of fixed data, the volume involved often makes it inconvenient to store the fixed data in the Data Memory. To overcome this problem, Holtek microcontrollers allow an area of Program Memory to be setup as a table where data can be directly stored. A set of easy to use instructions provides the means by which this fixed data can be referenced and retrieved from the Program Memory.

#### Other Operations

In addition to the above functional instructions, a range of other instructions also exist such as the "HALT" instruction for Power-down operations and instructions to control the operation of the Watchdog Timer for reliable program operations under extreme electric or electromagnetic environments. For their relevant operations, refer to the functional related sections.

Rev. 1.00 214 August 27, 2021



# **Instruction Set Summary**

The instructions related to the data memory access in the following table can be used when the desired data memory is located in Data Memory sector 0.

## **Table Conventions**

x: Bits immediate data

m: Data Memory address

A: Accumulator

i: 0~7 number of bits

addr: Program memory address

Mnemonic	Description	Cycles	Flag Affected				
Arithmetic		_	-				
ADD A,[m]	Add Data Memory to ACC	1	Z, C, AC, OV, SC				
ADDM A,[m]	Add ACC to Data Memory	1 Note	Z, C, AC, OV, SC				
ADD A,x	Add immediate data to ACC	1	Z, C, AC, OV, SC				
ADC A,[m]	Add Data Memory to ACC with Carry	1	Z, C, AC, OV, SC				
ADCM A,[m]	Add ACC to Data memory with Carry	1 Note	Z, C, AC, OV, SC				
SUB A,x	Subtract immediate data from the ACC	1	Z, C, AC, OV, SC, CZ				
SUB A,[m]	Subtract Data Memory from ACC	1	Z, C, AC, OV, SC, CZ				
SUBM A,[m]	Subtract Data Memory from ACC with result in Data Memory	1 Note	Z, C, AC, OV, SC, CZ				
SBC A,x	Subtract immediate data from ACC with Carry	1	Z, C, AC, OV, SC, CZ				
SBC A,[m]	Subtract Data Memory from ACC with Carry	1	Z, C, AC, OV, SC, CZ				
SBCM A,[m]	Subtract Data Memory from ACC with Carry, result in Data Memory	1 Note	Z, C, AC, OV, SC, CZ				
DAA [m]	Decimal adjust ACC for Addition with result in Data Memory	1 Note	С				
Logic Operatio	on .						
AND A,[m]	Logical AND Data Memory to ACC	1	Z				
OR A,[m]	Logical OR Data Memory to ACC	1	Z				
XOR A,[m]	Logical XOR Data Memory to ACC	1	Z				
ANDM A,[m]	Logical AND ACC to Data Memory	1 Note	Z				
ORM A,[m]	Logical OR ACC to Data Memory	1 Note	Z				
XORM A,[m]	Logical XOR ACC to Data Memory	1 Note	Z				
AND A,x	Logical AND immediate Data to ACC	1	Z				
OR A,x	Logical OR immediate Data to ACC	1	Z				
XOR A,x	Logical XOR immediate Data to ACC	1	Z				
CPL [m]	Complement Data Memory	1 Note	Z				
CPLA [m]	Complement Data Memory with result in ACC	1	Z				
Increment & De	Increment & Decrement						
INCA [m]	Increment Data Memory with result in ACC	1	Z				
INC [m]	Increment Data Memory	1 Note	Z				
DECA [m]	Decrement Data Memory with result in ACC	1	Z				
DEC [m]	Decrement Data Memory	1 <sup>Note</sup>	Z				
Rotate							
RRA [m]	Rotate Data Memory right with result in ACC	1	None				
RR [m]	Rotate Data Memory right	1 Note	None				
RRCA [m]	Rotate Data Memory right through Carry with result in ACC	1	С				
RRC [m]	Rotate Data Memory right through Carry	1 Note	С				
RLA [m]	Rotate Data Memory left with result in ACC	1	None				
RL [m]	Rotate Data Memory left	1 <sup>Note</sup>	None				
RLCA [m]	Rotate Data Memory left through Carry with result in ACC	1	С				
RLC [m]	Rotate Data Memory left through Carry	1 Note	С				

Mnemonic	Description	Cycles	Flag Affected				
Data Move							
MOV A,[m]	Move Data Memory to ACC		None				
MOV [m],A	Move ACC to Data Memory	1 <sup>Note</sup>	None				
MOV A,x	Move immediate data to ACC		None				
Bit Operation							
CLR [m].i	Clear bit of Data Memory	1 <sup>Note</sup>	None				
SET [m].i	Set bit of Data Memory	1 <sup>Note</sup>	None				
Branch Oper	ation						
JMP addr	Jump unconditionally	2	None				
SZ [m]	Skip if Data Memory is zero	1 <sup>Note</sup>	None				
SZA [m]	Skip if Data Memory is zero with data movement to ACC	1 <sup>Note</sup>	None				
SZ [m].i	Skip if bit i of Data Memory is zero	1 <sup>Note</sup>	None				
SNZ [m]	Skip if Data Memory is not zero	1 <sup>Note</sup>	None				
SNZ [m].i	Skip if bit i of Data Memory is not zero	1 <sup>Note</sup>	None				
SIZ [m]	Skip if increment Data Memory is zero	1 <sup>Note</sup>	None				
SDZ [m]	Skip if decrement Data Memory is zero	1 <sup>Note</sup>	None				
SIZA [m]	Skip if increment Data Memory is zero with result in ACC	1 <sup>Note</sup>	None				
SDZA [m]	Skip if decrement Data Memory is zero with result in ACC	1 <sup>Note</sup>	None				
CALL addr	Subroutine call	2	None				
RET	Return from subroutine	2	None				
RET A,x	Return from subroutine and load immediate data to ACC	2	None				
RETI	Return from interrupt	2	None				
Table Read C	Table Read Operation						
TABRD [m]	Read table (specific page) to TBLH and Data Memory	2 <sup>Note</sup>	None				
TABRDL [m]	Read table (last page) to TBLH and Data Memory	2 <sup>Note</sup>	None				
ITABRD [m]	Increment table pointer TBLP first and Read table (specific page) to TBLH and Data Memory	2 <sup>Note</sup>	None				
ITABRDL [m]	Increment table pointer TBLP first and Read table (last page) to TBLH and Data Memory	2 <sup>Note</sup>	None				
Miscellaneou	s						
NOP	No operation	1	None				
CLR [m]	Clear Data Memory	1 <sup>Note</sup>	None				
SET [m]	Set Data Memory	1 <sup>Note</sup>	None				
CLR WDT	Clear Watchdog Timer	1	TO, PDF				
SWAP [m]	Swap nibbles of Data Memory	1 <sup>Note</sup>	None				
SWAPA [m]	Swap nibbles of Data Memory with result in ACC	1	None				
HALT	Enter power down mode	1	TO, PDF				

Note: 1. For skip instructions, if the result of the comparison involves a skip then two cycles are required, if no skip takes place only one cycle is required.

2. Any instruction which changes the contents of the PCL will also require 2 cycles for execution.

Rev. 1.00 216 August 27, 2021



#### **Extended Instruction Set**

The extended instructions are used to support the full range address access for the data memory. When the accessed data memory is located in any data memory sector except sector 0, the extended instruction can be used to directly access the data memory instead of using the indirect addressing access. This can not only reduce the use of Flash memory space but also improve the CPU execution efficiency.

Arithmetic	Mnemonic	Description	Cycles	Flog Affootod	
Add Data Memory to ACC		Description	Cycles	Flag Affected	
LADDM A,[m]         Add Data Memory to ACC with Carry         2 None         Z, C, AC, OV, SC           LADCA,[m]         Add Data Memory to ACC with Carry         2 Z, C, AC, OV, SC           LSUB A,[m]         Subtract Data Memory from ACC         2 Z, C, AC, OV, SC           LSUBM A,[m]         Subtract Data Memory from ACC         2 Z, C, AC, OV, SC, CZ           LSBCA,[m]         Subtract Data Memory from ACC with result in Data Memory         2 None           LSBCM,[m]         Subtract Data Memory from ACC with Carry         2 Z, C, AC, OV, SC, CZ           LSBCM,[m]         Subtract Data Memory from ACC with Carry         2 Z, C, AC, OV, SC, CZ           LBSCM,[m]         Subtract Data Memory from ACC with Carry         2 Z, C, AC, OV, SC, CZ           LDAA [m]         Decimal adjust ACC for Addition with result in Data Memory         2 None           LDAA [m]         Logical AND Data Memory to ACC         2 Z         Z           LAND A,[m]         Logical OR Data Memory to ACC         2 Z         Z           LAND A,[m]         Logical XOR Data Memory to ACC         2 Z         Z           LAND A,[m]         Logical AND ACC to Data Memory         2 None         Z           LOFWA A,[m]         Logical AND ACC to Data Memory         2 None         Z           LOFWA M,[m]         Logical AND ACC to Data Memory					
LADC A,   m	LADD A,[m]	Add Data Memory to ACC			
LADCM A.[m]         Add ACC to Data memory with Carry         2 Note         Z, C, AC, OV, SC           LSUB B.(m]         Subtract Data Memory from ACC         2 Z, C, AC, OV, SC, CZ           LSUBM A.[m]         Subtract Data Memory from ACC with result in Data Memory         2 Note         Z, C, AC, OV, SC, CZ           LSBCM A.[m]         Subtract Data Memory from ACC with Carry         2 Z, C, AC, OV, SC, CZ         LSBCM A.[m]         Subtract Data Memory from ACC with Carry, result in Data Memory         2 Note         Z, C, AC, OV, SC, CZ           LSBCM A.[m]         Decimal adjust ACC for Addition with result in Data Memory         2 Note         Z, C, AC, OV, SC, CZ           LOBGO Peration         LAND A.[m]         Logical AND Data Memory to ACC         2 Z         Z           LAND A.[m]         Logical AND Data Memory to ACC         2 Z         Z           LAND A.[m]         Logical AND ACC and Memory         2 Note         Z           LORM A.[m]         Logical AND ACC to Data Memory         2 Note         Z           LORM A.[m]         Logical AND ACC to Data Memory         2 Note         Z           LOPLA [m]         Complement Data Memory         2 Note         Z           LOPLA [m]         Complement Data Memory with result in ACC         2 Z         Z           LOPLA [m]         Increment Data Memory with resu		•	_		
Subtract Data Memory from ACC   2   Z, C, AC, OV, SC, CZ			_		
LSUBM A, m   Subtract Data Memory from ACC with result in Data Memory   2 Note   Z, C, AC, OV, SC, CZ   LSBC A, m   Subtract Data Memory from ACC with Carry   2   Z, C, AC, OV, SC, CZ   LSBCM A, m   Subtract Data Memory from ACC with Carry, result in Data Memory   2 Note   Z, C, AC, OV, SC, CZ   LSBCM A, m   Subtract Data Memory from ACC with Carry, result in Data Memory   2 Note   Z, C, AC, OV, SC, CZ   Z, C, AC, OV, SC, CZ, C, C, AC, C, C	LADCM A,[m]		2 <sup>Note</sup>	Z, C, AC, OV, SC	
LSBC A,[m] Subtract Data Memory from ACC with Carry 2 Z, C, AC, OV, SC, CZ LSBCMA,[m] Subtract Data Memory from ACC with Carry, result in Data Memory 2 Note C, CZ LDAA [m] Decimal adjust ACC for Addition with result in Data Memory 2 Note C LOGIC Operation  LAND A,[m] Logical AND Data Memory to ACC 2 Z Z LAND A,[m] Logical OR Data Memory to ACC 2 Z Z LAND A,[m] Logical OR Data Memory to ACC 2 Z Z LAND A,[m] Logical AND ACC to Data Memory to ACC 2 Z Z LAND A,[m] Logical AND ACC to Data Memory to ACC 2 Z Z LAND A,[m] Logical AND ACC to Data Memory 2 Note Z LORM A,[m] Logical AND ACC to Data Memory 2 Note Z LORM A,[m] Logical AND ACC to Data Memory 2 Note Z LORM A,[m] Logical XOR ACC to Data Memory 2 Note Z LOPL [m] Complement Data Memory 2 Note Z LOPL A,[m] Logical XOR ACC to Data Memory 2 Note Z LOPL A,[m] Logical XOR ACC to Data Memory 2 Note Z LOPL A,[m] Logical XOR ACC to Data Memory 2 Note Z LOPL A,[m] Logical XOR ACC to Data Memory 2 Note Z LOPL A,[m] Logical XOR ACC to Data Memory 2 Note Z LOPL A,[m] LOGICAL A,[m] Logical XOR ACC TO DATA MEMORY 2 Note Z LOPL A,[m] LORD	LSUB A,[m]	-		Z, C, AC, OV, SC, CZ	
LSBCM A,[m] Subtract Data Memory from ACC with Carry, result in Data Memory 2 Note	LSUBM A,[m]	· · · · · · · · · · · · · · · · · · ·	2 <sup>Note</sup>	Z, C, AC, OV, SC, CZ	
LDAA [m] Decimal adjust ACC for Addition with result in Data Memory 2 Note C  Logic Operation  LAND A,[m] Logical AND Data Memory to ACC 2 Z Z  LOR A,[m] Logical OR Data Memory to ACC 2 Z Z  LXOR A,[m] Logical OR Data Memory to ACC 2 Z Z  LXOR A,[m] Logical OR Data Memory to ACC 2 Z Z  LXOR A,[m] Logical AND ACC to Data Memory to ACC 2 Z  LANDM A,[m] Logical OR ACC to Data Memory 2 Note Z  LORM A,[m] Logical OR ACC to Data Memory 2 Note Z  LCPL [m] Complement Data Memory 2 Note Z  LCPLA [m] Complement Data Memory 3 Z  LCPLA [m] Complement Data Memory with result in ACC 3 Z  LINCA [m] Increment Data Memory with result in ACC 4 Z  LINC [m] Increment Data Memory with result in ACC 2 Z  LINC [m] Decrement Data Memory with result in ACC 2 Z  LDEC [m] Decrement Data Memory with result in ACC 2 Z  LDEC [m] Decrement Data Memory with result in ACC 2 Z  LOBEC [m] Decrement Data Memory with result in ACC 2 Z  Rotate  LRRA [m] Rotate Data Memory right with result in ACC 2 None CARCA [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRRC [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left with result in ACC 2 None CARCA [m] Rotate Data Memory left with result in ACC 2 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 2 None CARCA [m] Rotate Data Memory left with result in ACC 2 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 2 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 3 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 3 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 3 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 3 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 3 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 3 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 3 None CARCA [m] Rotate Data Memory left through Carry with result in ACC 4 None C	LSBC A,[m]			Z, C, AC, OV, SC, CZ	
Logic Operation  LAND A.[m] Logical AND Data Memory to ACC 2 Z  LOR A.[m] Logical OR Data Memory to ACC 2 Z  LXOR A.[m] Logical XOR Data Memory to ACC 2 Z  LXOR A.[m] Logical XOR Data Memory to ACC 2 Z  LANDM A.[m] Logical AND ACC to Data Memory to ACC 2 Z  LANDM A.[m] Logical AND ACC to Data Memory 2 Note Z  LXORM A.[m] Logical AND ACC to Data Memory 2 Note Z  LXORM A.[m] Logical XOR ACC to Data Memory 2 Note Z  LXORM A.[m] Logical XOR ACC to Data Memory 2 Note Z  LXORM A.[m] Logical XOR ACC to Data Memory 2 Note Z  LXORM A.[m] Logical XOR ACC to Data Memory 2 Note Z  LXORM A.[m] Complement Data Memory with result in ACC 2 Z  LX LCPL [m] Complement Data Memory with result in ACC 2 Z  LINC [m] Increment Data Memory with result in ACC 2 Z  LINC [m] Increment Data Memory with result in ACC 2 Z  LIDEC A [m] Decrement Data Memory with result in ACC 2 Z  Rotate  LRRA [m] Rotate Data Memory right with result in ACC 2 None LRR [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRRC [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRRC [m] Rotate Data Memory left with result in ACC 2 C  LRLA [m] Rotate Data Memory left with result in ACC 2 C  LRLA [m] Rotate Data Memory left with result in ACC 2 C  LRLA [m] Rotate Data Memory left with result in ACC 2 C  LRLA [m] Rotate Data Memory left with result in ACC 2 C  LRLA [m] Rotate Data Memory left with result in ACC 2 C  LRLA [m] Rotate Data Memory left with result in ACC 2 C  LRLA [m] Rotate Data Memory left with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 None LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 None LRLC [m] Rotate	LSBCM A,[m]	Subtract Data Memory from ACC with Carry, result in Data Memory	_	Z, C, AC, OV, SC, CZ	
LAND A.[m]	LDAA [m]	Decimal adjust ACC for Addition with result in Data Memory	2 <sup>Note</sup>	С	
Logical OR Data Memory to ACC   2   Z   Z   Z   Z   Z   Z   Z   Z   Z	Logic Operatio	n			
LOR A, m   Logical XOR Data Memory to ACC   2   Z	LAND A,[m]	Logical AND Data Memory to ACC	2	Z	
LANDM A,[m] Logical AND ACC to Data Memory 2 Note Z LORM A,[m] Logical OR ACC to Data Memory 2 Note Z LXORM A,[m] Logical XOR ACC to Data Memory 2 Note Z LXORM A,[m] Logical XOR ACC to Data Memory 2 Note Z LCPL [m] Complement Data Memory 2 Note Z LCPLA [m] Complement Data Memory with result in ACC 2 Z Increment & Decrement LINCA [m] Increment Data Memory with result in ACC 2 Z LINC [m] Increment Data Memory with result in ACC 2 Z LINC [m] Increment Data Memory with result in ACC 2 Z LINCE [m] Decrement Data Memory with result in ACC 2 Z LDECA [m] Decrement Data Memory with result in ACC 2 Z LDEC [m] Decrement Data Memory with result in ACC 2 Z Rotate LRRA [m] Rotate Data Memory right with result in ACC 2 None LRRA [m] Rotate Data Memory right through Carry with result in ACC 2 C LRRC [m] Rotate Data Memory right through Carry with result in ACC 2 C LRLA [m] Rotate Data Memory left with result in ACC 2 C LRLA [m] Rotate Data Memory left with result in ACC 2 C LRLA [m] Rotate Data Memory left with result in ACC 2 C LRLA [m] Rotate Data Memory left with result in ACC 2 C LRLA [m] Rotate Data Memory left with result in ACC 2 C LRLA [m] Rotate Data Memory left with result in ACC 2 C LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C Data Move LMCV [m] Move Data Memory to ACC 2 None LMOV A,[m] Move Data Memory to ACC 2 None LMOV [m], Move Data Memory to ACC 2 None LMOV [m], Move Data Memory to ACC 2 None Bit Operation LCLR [m]. Clear bit of Data Memory None	LOR A,[m]	Logical OR Data Memory to ACC	2	Z	
LORM A,[m] Logical OR ACC to Data Memory 2 Note Z LXORM A,[m] Logical XOR ACC to Data Memory 2 Note Z LCPL [m] Complement Data Memory 2 Note Z LCPLA [m] Complement Data Memory with result in ACC 2 Z Increment & Decrement  LINCA [m] Increment Data Memory with result in ACC 2 Z LINCE [m] Increment Data Memory with result in ACC 3 Z LINCE [m] Increment Data Memory with result in ACC 3 Z LINCE [m] Increment Data Memory 3 Z LDECA [m] Decrement Data Memory with result in ACC 3 Z LDEC [m] Decrement Data Memory 3 Z Rotate  LRRA [m] Rotate Data Memory right with result in ACC 3 None 1 LRRA [m] Rotate Data Memory right with result in ACC 4 None 1 LRRACA [m] Rotate Data Memory right through Carry with result in ACC 4 C LRRCA [m] Rotate Data Memory right through Carry with result in ACC 4 C LRLA [m] Rotate Data Memory right through Carry 2 LRLA [m] Rotate Data Memory left with result in ACC 4 None 1 LRLC [m] Rotate Data Memory left with result in ACC 5 C LRLA [m] Rotate Data Memory left with result in ACC 6 C LRLA [m] Rotate Data Memory left with result in ACC 7 C LRLA [m] Rotate Data Memory left with result in ACC 8 None 1 LRLC [m] Rotate Data Memory left through Carry with result in ACC 9 C LRLC [m] Rotate Data Memory left through Carry with result in ACC 9 C LRLC [m] Rotate Data Memory left through Carry with result in ACC 9 C Data Move  LMOV A, [m] Move Data Memory to ACC 9 None 1 LMOV A, [m] Move Data Memory to ACC 9 None 1 LMOV [m], A Move ACC to Data Memory 9 None 1 Bit Operation  LCLR [m]. Clear bit of Data Memory 9 None 1	LXOR A,[m]	Logical XOR Data Memory to ACC	2	Z	
LXORM A,[m] Logical XOR ACC to Data Memory 2 Note Z LCPL [m] Complement Data Memory 2 Note Z LCPLA [m] Complement Data Memory with result in ACC 2 Z Increment & Decrement  LINCA [m] Increment Data Memory with result in ACC 2 Z LINC [m] Increment Data Memory with result in ACC 2 Z LINC [m] Increment Data Memory with result in ACC 2 Z LINC [m] Decrement Data Memory with result in ACC 2 Z LDECA [m] Decrement Data Memory with result in ACC 2 Z LDEC [m] Decrement Data Memory with result in ACC 2 Z Rotate  LRRA [m] Rotate Data Memory right with result in ACC 2 None LRRCA [m] Rotate Data Memory right through Carry with result in ACC 2 C LRRCA [m] Rotate Data Memory right through Carry with result in ACC 2 C LRRCA [m] Rotate Data Memory left with result in ACC 2 None LRLA [m] Rotate Data Memory left with result in ACC 2 None LRLA [m] Rotate Data Memory left through Carry with result in ACC 2 None LRLCA [m] Rotate Data Memory left through Carry with result in ACC 2 C LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C Data Move  LMOV A, [m] Move Data Memory to ACC 2 None LMOV [m], A Move ACC to Data Memory ACC 2 None Bit Operation  LCLR [m]. Clear bit of Data Memory 2 None	LANDM A,[m]	Logical AND ACC to Data Memory	2 <sup>Note</sup>	Z	
Complement Data Memory   2 Note   Z   Z   Z   Increment & Decrement   Data Memory with result in ACC   2   Z   Z   Increment & Decrement   Data Memory with result in ACC   2   Z   Z   Z   LINC [m]   Increment Data Memory with result in ACC   2   Z   Z   LINC [m]   Increment Data Memory   Decrement Data Memory   2 Note   Z   Z   Z   LINC [m]   Decrement Data Memory with result in ACC   2   Z   Z   LINC [m]   Decrement Data Memory   Decrement Data Memory   2 Note   Z   Z   Z   Z   Z   Z   Z   Z   Z	LORM A,[m]	Logical OR ACC to Data Memory	2 <sup>Note</sup>	Z	
Complement Data Memory with result in ACC   2   Z   Z   Increment & Decrement	LXORM A,[m]		2 <sup>Note</sup>	Z	
ILCPLA [m] Complement Data Memory with result in ACC 2 Z  Increment & Decrement  LINCA [m] Increment Data Memory with result in ACC 2 Z  LINC [m] Increment Data Memory With result in ACC 2 Z  LDECA [m] Decrement Data Memory With result in ACC 2 Z  LDEC [m] Decrement Data Memory With result in ACC 2 Z  LDEC [m] Decrement Data Memory With result in ACC 2 Z  Rotate  LRRA [m] Rotate Data Memory right with result in ACC 2 None  LRRA [m] Rotate Data Memory right With result in ACC 2 None  LRRCA [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRRC [m] Rotate Data Memory right through Carry With result in ACC 2 C  LRRC [m] Rotate Data Memory left with result in ACC 2 None  LRLA [m] Rotate Data Memory left with result in ACC 2 None  LRLA [m] Rotate Data Memory left with result in ACC 2 None  LRLCA [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry With result in ACC 2 C  Data Move  LMOV A, [m] Move Data Memory to ACC 2 None  LMOV [m], A Move ACC to Data Memory None  Bit Operation  LCLR [m]. Clear bit of Data Memory None	LCPL [m]	Complement Data Memory	2 <sup>Note</sup>	Z	
Increment Data Memory with result in ACC	LCPLA [m]	Complement Data Memory with result in ACC	2	Z	
LINC [m] Increment Data Memory	Increment & De	ecrement			
LDECA [m] Decrement Data Memory with result in ACC  LDEC [m] Decrement Data Memory  Rotate  LRRA [m] Rotate Data Memory right with result in ACC  LRR [m] Rotate Data Memory right through Carry with result in ACC  LRRCA [m] Rotate Data Memory right through Carry with result in ACC  LRRCA [m] Rotate Data Memory right through Carry with result in ACC  LRRC [m] Rotate Data Memory right through Carry  ROTATE C C  LRLA [m] Rotate Data Memory left with result in ACC  LRLA [m] Rotate Data Memory left with result in ACC  LRLCA [m] Rotate Data Memory left Carry with result in ACC  LRLCA [m] Rotate Data Memory left through Carry with result in ACC  LRLCA [m] Rotate Data Memory left through Carry with result in ACC  LRLC [m] Rotate Data Memory left through Carry  Data Move  LMOV A,[m] Move Data Memory to ACC  LMOV [m],A Move ACC to Data Memory  Clear bit of Data Memory  Anone  None  None	LINCA [m]	Increment Data Memory with result in ACC		Z	
LDECA [m] Decrement Data Memory with result in ACC  LDEC [m] Decrement Data Memory  Rotate  LRRA [m] Rotate Data Memory right with result in ACC  LRRA [m] Rotate Data Memory right through Carry with result in ACC  LRRCA [m] Rotate Data Memory right through Carry with result in ACC  LRRCA [m] Rotate Data Memory right through Carry with result in ACC  LRRC [m] Rotate Data Memory right through Carry  ROTATE CA [m] Rotate Data Memory left with result in ACC  LRLA [m] Rotate Data Memory left with result in ACC  LRLA [m] Rotate Data Memory left  ROTATE CA [m] Rotate Data Memory left through Carry with result in ACC  LRLCA [m] Rotate Data Memory left through Carry with result in ACC  LRLC [m] Rotate Data Memory left through Carry  Data Move  LMOV A, [m] Move Data Memory to ACC  LMOV [m], A Move ACC to Data Memory  Clear bit of Data Memory  Clear bit of Data Memory  A None  None	LINC [m]	Increment Data Memory	2 <sup>Note</sup>	Z	
Rotate  LRRA [m] Rotate Data Memory right with result in ACC 2 None  LRRA [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRRCA [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRRCA [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRRC [m] Rotate Data Memory right through Carry 2 None  LRLA [m] Rotate Data Memory left with result in ACC 2 None  LRL [m] Rotate Data Memory left 2 None  LRLCA [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLCA [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry 2 None  LRLC [m] Rotate Data Memory left through Carry 2 None  LMOV A, [m] Move Data Memory to ACC 2 None  LMOV [m], A Move ACC to Data Memory 2 None  Bit Operation  LCLR [m]. Clear bit of Data Memory 2 None	LDECA [m]	Decrement Data Memory with result in ACC	2	Z	
LRRA [m] Rotate Data Memory right with result in ACC  LRR [m] Rotate Data Memory right  Rotate Data Memory right through Carry with result in ACC  LRRC [m] Rotate Data Memory right through Carry with result in ACC  LRRC [m] Rotate Data Memory right through Carry  Rotate Data Memory left with result in ACC  LRLA [m] Rotate Data Memory left with result in ACC  LRL [m] Rotate Data Memory left  Rotate Data Memory left through Carry with result in ACC  LRLC [m] Rotate Data Memory left through Carry with result in ACC  C  LRLC [m] Rotate Data Memory left through Carry  Rotate Data Memory left through Carry  Data Move  LMOV A,[m] Move Data Memory to ACC  LMOV [m],A Move ACC to Data Memory  Clear bit of Data Memory  Clear bit of Data Memory  None  None	LDEC [m]	Decrement Data Memory	2 <sup>Note</sup>	Z	
LRR [m] Rotate Data Memory right 2 None  LRRCA [m] Rotate Data Memory right through Carry with result in ACC 2 C  LRRC [m] Rotate Data Memory right through Carry 2 Note C  LRLA [m] Rotate Data Memory left with result in ACC 2 None  LRL [m] Rotate Data Memory left 2 None  LRL [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLCA [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry 2 None  LRLC [m] Rotate Data Memory left through Carry 2 None  LMOV A,[m] Move Data Memory to ACC 2 None  LMOV [m], A Move ACC to Data Memory 2 None  Bit Operation  LCLR [m]. Clear bit of Data Memory 2 None	Rotate	,			
LRRCA [m] Rotate Data Memory right through Carry with result in ACC  LRRC [m] Rotate Data Memory right through Carry  Rotate Data Memory left with result in ACC  LRLA [m] Rotate Data Memory left with result in ACC  LRL [m] Rotate Data Memory left  Rotate Data Memory left through Carry with result in ACC  LRLCA [m] Rotate Data Memory left through Carry with result in ACC  LRLC [m] Rotate Data Memory left through Carry  Rotate Data Memory left through Carry  Data Move  LMOV A,[m] Move Data Memory to ACC  LMOV [m], A Move ACC to Data Memory  Bit Operation  LCLR [m]. Clear bit of Data Memory  None	LRRA [m]	Rotate Data Memory right with result in ACC	2	None	
LRRC [m] Rotate Data Memory right through Carry 2 None  LRLA [m] Rotate Data Memory left with result in ACC 2 None  LRL [m] Rotate Data Memory left 2 None  LRLCA [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry 2 None  LMOV A,[m] Move Data Memory to ACC 2 None  LMOV [m], A Move ACC to Data Memory 2 None  Bit Operation  LCLR [m]. Clear bit of Data Memory None	LRR [m]	Rotate Data Memory right	2 <sup>Note</sup>	None	
LRRC [m] Rotate Data Memory right through Carry 2 None  LRLA [m] Rotate Data Memory left with result in ACC 2 None  LRL [m] Rotate Data Memory left 2 None  LRLCA [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry with result in ACC 2 C  LRLC [m] Rotate Data Memory left through Carry 2 None  LMOV A,[m] Move Data Memory to ACC 2 None  LMOV [m], A Move ACC to Data Memory 2 None  Bit Operation  LCLR [m]. Clear bit of Data Memory None	LRRCA [m]	Rotate Data Memory right through Carry with result in ACC	2	С	
LRLA [m]         Rotate Data Memory left with result in ACC         2         None           LRL [m]         Rotate Data Memory left         2 <sup>Note</sup> None           LRLCA [m]         Rotate Data Memory left through Carry with result in ACC         2         C           LRLC [m]         Rotate Data Memory left through Carry         2 <sup>Note</sup> C           Data Move         LMOV A,[m]         Move Data Memory to ACC         2         None           LMOV [m],A         Move ACC to Data Memory         2 <sup>Note</sup> None           Bit Operation           LCLR [m].i         Clear bit of Data Memory         2 <sup>Note</sup> None	LRRC [m]		2 <sup>Note</sup>	С	
LRL [m]         Rotate Data Memory left         2 None         None           LRLCA [m]         Rotate Data Memory left through Carry with result in ACC         2 C         C           LRLC [m]         Rotate Data Memory left through Carry         2 Note         C           Data Move         LMOV A,[m]         Move Data Memory to ACC         2 None         None           LMOV [m], A         Move ACC to Data Memory         2 None         None           Bit Operation         LCLR [m].i         Clear bit of Data Memory         2 None         None	LRLA [m]	Rotate Data Memory left with result in ACC	2	None	
LRLC [m]         Rotate Data Memory left through Carry         2 <sup>Note</sup> C           Data Move         LMOV A,[m]         Move Data Memory to ACC         2         None           LMOV [m],A         Move ACC to Data Memory         2 <sup>Note</sup> None           Bit Operation         LCLR [m].i         Clear bit of Data Memory         2 <sup>Note</sup> None	LRL [m]	Rotate Data Memory left	2 <sup>Note</sup>	None	
Data Move         2         None           LMOV A,[m]         Move Data Memory to ACC         2         None           LMOV [m],A         Move ACC to Data Memory         2 <sup>Note</sup> None           Bit Operation           LCLR [m].i         Clear bit of Data Memory         2 <sup>Note</sup> None	LRLCA [m]	Rotate Data Memory left through Carry with result in ACC	2	С	
LMOV A,[m]         Move Data Memory to ACC         2         None           LMOV [m],A         Move ACC to Data Memory         2 <sup>Note</sup> None           Bit Operation         LCLR [m].i         Clear bit of Data Memory         2 <sup>Note</sup> None	LRLC [m]	Rotate Data Memory left through Carry	2 <sup>Note</sup>	С	
LMOV [m],A         Move ACC to Data Memory         2 <sup>Note</sup> None           Bit Operation         LCLR [m].i         Clear bit of Data Memory         2 <sup>Note</sup> None	Data Move				
LMOV [m],A         Move ACC to Data Memory         2 <sup>Note</sup> None           Bit Operation         LCLR [m].i         Clear bit of Data Memory         2 <sup>Note</sup> None	LMOV A,[m]	Move Data Memory to ACC	2	None	
Bit Operation  LCLR [m].i Clear bit of Data Memory 2 <sup>Note</sup> None	LMOV [m],A		2 <sup>Note</sup>	None	
LCLR [m].i Clear bit of Data Memory 2 <sup>Note</sup> None	Bit Operation				
	LCLR [m].i	Clear bit of Data Memory	2 <sup>Note</sup>	None	
LSET [m].1   Set bit of Data Memory   2 <sup>Note</sup>   None	LSET [m].i	Set bit of Data Memory	2 <sup>Note</sup>	None	



Mnemonic	Description	Cycles	Flag Affected
Branch			
LSZ [m]	Skip if Data Memory is zero	2 <sup>Note</sup>	None
LSZA [m]	Skip if Data Memory is zero with data movement to ACC	2 <sup>Note</sup>	None
LSNZ [m]	Skip if Data Memory is not zero	2 <sup>Note</sup>	None
LSZ [m].i	Skip if bit i of Data Memory is zero	2 <sup>Note</sup>	None
LSNZ [m].i	Skip if bit i of Data Memory is not zero	2 <sup>Note</sup>	None
LSIZ [m]	Skip if increment Data Memory is zero	2 <sup>Note</sup>	None
LSDZ [m]	Skip if decrement Data Memory is zero	2 <sup>Note</sup>	None
LSIZA [m]	Skip if increment Data Memory is zero with result in ACC	2 <sup>Note</sup>	None
LSDZA [m]	Skip if decrement Data Memory is zero with result in ACC	2 <sup>Note</sup>	None
Table Read			
LTABRD [m]	Read table (specific page) to TBLH and Data Memory	3 <sup>Note</sup>	None
LTABRDL [m]	Read table (last page) to TBLH and Data Memory	3 <sup>Note</sup>	None
LITABRD [m]	Increment table pointer TBLP first and Read table (specific page) to TBLH and Data Memory	3 <sup>Note</sup>	None
LITABRDL [m]	Increment table pointer TBLP first and Read table (last page) to TBLH and Data Memory	3 <sup>Note</sup>	None
Miscellaneous	5		
LCLR [m]	Clear Data Memory	2 <sup>Note</sup>	None
LSET [m]	Set Data Memory	2 <sup>Note</sup>	None
LSWAP [m]	Swap nibbles of Data Memory	2 <sup>Note</sup>	None
LSWAPA [m]	Swap nibbles of Data Memory with result in ACC	2	None

Note: 1. For these extended skip instructions, if the result of the comparison involves a skip then three cycles are required, if no skip takes place two cycles is required.

Rev. 1.00 218 August 27, 2021

<sup>2.</sup> Any extended instruction which changes the contents of the PCL register will also require three cycles for execution.



### **Instruction Definition**

ADC A,[m] Add Data Memory to ACC with Carry

Description The contents of the specified Data Memory, Accumulator and the carry flag are added.

The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC + [m] + C$ Affected flag(s) OV, Z, AC, C, SC

ADCM A,[m] Add ACC to Data Memory with Carry

Description The contents of the specified Data Memory, Accumulator and the carry flag are added.

The result is stored in the specified Data Memory.

Operation  $[m] \leftarrow ACC + [m] + C$ Affected flag(s) OV, Z, AC, C, SC

ADD A,[m] Add Data Memory to ACC

Description The contents of the specified Data Memory and the Accumulator are added.

The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC + [m]$ Affected flag(s) OV, Z, AC, C, SC

**ADD A,x** Add immediate data to ACC

Description The contents of the Accumulator and the specified immediate data are added.

The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC + x$ Affected flag(s) OV, Z, AC, C, SC

ADDM A,[m] Add ACC to Data Memory

Description The contents of the specified Data Memory and the Accumulator are added.

The result is stored in the specified Data Memory.

Operation  $[m] \leftarrow ACC + [m]$ Affected flag(s) OV, Z, AC, C, SC

AND A,[m] Logical AND Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise logical AND

operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC "AND" [m]$ 

Affected flag(s) Z

AND A,x Logical AND immediate data to ACC

Description Data in the Accumulator and the specified immediate data perform a bit wise logical AND

operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC$  "AND" x

Affected flag(s) Z

ANDM A,[m] Logical AND ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical AND

operation. The result is stored in the Data Memory.

Operation  $[m] \leftarrow ACC "AND" [m]$ 

Affected flag(s) Z



CALL addr Subroutine call

Description Unconditionally calls a subroutine at the specified address. The Program Counter then

increments by 1 to obtain the address of the next instruction which is then pushed onto the stack. The specified address is then loaded and the program continues execution from this new address. As this instruction requires an additional operation, it is a two cycle instruction.

Operation Stack  $\leftarrow$  Program Counter + 1

Program Counter ← addr

Affected flag(s) None

**CLR [m]** Clear Data Memory

Description Each bit of the specified Data Memory is cleared to 0.

Operation  $[m] \leftarrow 00H$ Affected flag(s) None

CLR [m].i Clear bit of Data Memory

Description Bit i of the specified Data Memory is cleared to 0.

Operation [m].i  $\leftarrow$  0 Affected flag(s) None

**CLR WDT** Clear Watchdog Timer

Description The TO, PDF flags and the WDT are all cleared.

Operation WDT cleared

 $TO \leftarrow 0$  $PDF \leftarrow 0$ 

Affected flag(s) TO, PDF

**CPL [m]** Complement Data Memory

Description Each bit of the specified Data Memory is logically complemented (1's complement). Bits which

previously contained a 1 are changed to 0 and vice versa.

Operation  $[m] \leftarrow \overline{[m]}$ 

Affected flag(s) Z

**CPLA [m]** Complement Data Memory with result in ACC

Description Each bit of the specified Data Memory is logically complemented (1's complement). Bits which

previously contained a 1 are changed to 0 and vice versa. The complemented result is stored in

the Accumulator and the contents of the Data Memory remain unchanged.

Operation  $ACC \leftarrow [m]$ 

Affected flag(s) Z

**DAA [m]** Decimal-Adjust ACC for addition with result in Data Memory

Description Convert the contents of the Accumulator value to a BCD (Binary Coded Decimal) value

resulting from the previous addition of two BCD variables. If the low nibble is greater than 9 or if AC flag is set, then a value of 6 will be added to the low nibble. Otherwise the low nibble remains unchanged. If the high nibble is greater than 9 or if the C flag is set, then a value of 6 will be added to the high nibble. Essentially, the decimal conversion is performed by adding 00H, 06H, 60H or 66H depending on the Accumulator and flag conditions. Only the C flag may be affected by this instruction which indicates that if the original BCD sum is greater than

100, it allows multiple precision decimal addition.

Operation  $[m] \leftarrow ACC + 00H$  or

 $[m] \leftarrow ACC + 06H \text{ or}$   $[m] \leftarrow ACC + 60H \text{ or}$  $[m] \leftarrow ACC + 66H$ 

Affected flag(s) C



**DEC [m]** Decrement Data Memory

Description Data in the specified Data Memory is decremented by 1.

Operation  $[m] \leftarrow [m] - 1$ 

Affected flag(s) Z

**DECA [m]** Decrement Data Memory with result in ACC

Description Data in the specified Data Memory is decremented by 1. The result is stored in the

Accumulator. The contents of the Data Memory remain unchanged.

Operation  $ACC \leftarrow [m] - 1$ 

Affected flag(s) Z

**HALT** Enter power down mode

Description This instruction stops the program execution and turns off the system clock. The contents of

the Data Memory and registers are retained. The WDT and prescaler are cleared. The power

down flag PDF is set and the WDT time-out flag TO is cleared.

Operation  $TO \leftarrow 0$ 

PDF ← 1

Affected flag(s) TO, PDF

**INC [m]** Increment Data Memory

Description Data in the specified Data Memory is incremented by 1.

Operation  $[m] \leftarrow [m] + 1$ 

Affected flag(s) Z

**INCA [m]** Increment Data Memory with result in ACC

Description Data in the specified Data Memory is incremented by 1. The result is stored in the Accumulator.

The contents of the Data Memory remain unchanged.

Operation  $ACC \leftarrow [m] + 1$ 

Affected flag(s) Z

JMP addr Jump unconditionally

Description The contents of the Program Counter are replaced with the specified address. Program

execution then continues from this new address. As this requires the insertion of a dummy

instruction while the new address is loaded, it is a two cycle instruction.

Operation Program Counter ← addr

Affected flag(s) None

MOV A,[m] Move Data Memory to ACC

Description The contents of the specified Data Memory are copied to the Accumulator.

Operation  $ACC \leftarrow [m]$ Affected flag(s) None

**MOV A,x** Move immediate data to ACC

Description The immediate data specified is loaded into the Accumulator.

Operation  $ACC \leftarrow x$ Affected flag(s) None

**MOV [m],A** Move ACC to Data Memory

Description The contents of the Accumulator are copied to the specified Data Memory.

Operation  $[m] \leftarrow ACC$ Affected flag(s) None



**NOP** No operation

Description No operation is performed. Execution continues with the next instruction.

Operation No operation
Affected flag(s) None

OR A,[m] Logical OR Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise

logical OR operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC "OR" [m]$ 

Affected flag(s) Z

**OR A,x** Logical OR immediate data to ACC

Description Data in the Accumulator and the specified immediate data perform a bitwise logical OR

operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC "OR" x$ 

Affected flag(s) Z

ORM A,[m] Logical OR ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical OR

operation. The result is stored in the Data Memory.

Operation  $[m] \leftarrow ACC "OR" [m]$ 

Affected flag(s) Z

**RET** Return from subroutine

Description The Program Counter is restored from the stack. Program execution continues at the restored

address.

Operation Program Counter ← Stack

Affected flag(s) None

**RET A,x** Return from subroutine and load immediate data to ACC

Description The Program Counter is restored from the stack and the Accumulator loaded with the specified

immediate data. Program execution continues at the restored address.

Operation Program Counter ← Stack

 $ACC \leftarrow x$ 

Affected flag(s) None

**RETI** Return from interrupt

Description The Program Counter is restored from the stack and the interrupts are re-enabled by setting the

EMI bit. EMI is the master interrupt global enable bit. If an interrupt was pending when the RETI instruction is executed, the pending Interrupt routine will be processed before returning

to the main program.

Operation Program Counter ← Stack

 $EMI \leftarrow 1$ 

Affected flag(s) None

RL [m] Rotate Data Memory left

Description The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0.

Operation  $[m].(i+1) \leftarrow [m].i; (i=0\sim6)$ 

 $[m].0 \leftarrow [m].7$ 

Affected flag(s) None

Rev. 1.00 222 August 27, 2021



**RLA [m]** Rotate Data Memory left with result in ACC

Description The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0.

The rotated result is stored in the Accumulator and the contents of the Data Memory remain

unchanged.

Operation ACC.(i+1)  $\leftarrow$  [m].i; (i=0 $\sim$ 6)

 $ACC.0 \leftarrow [m].7$ 

Affected flag(s) None

RLC [m] Rotate Data Memory left through Carry

Description The contents of the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7

replaces the Carry bit and the original carry flag is rotated into bit 0.

Operation  $[m].(i+1) \leftarrow [m].i; (i=0\sim6)$ 

 $[m].0 \leftarrow C$ 

 $C \leftarrow [m].7$ 

Affected flag(s) C

**RLCA [m]** Rotate Data Memory left through Carry with result in ACC

Description Data in the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7 replaces the

Carry bit and the original carry flag is rotated into the bit 0. The rotated result is stored in the

Accumulator and the contents of the Data Memory remain unchanged.

Operation ACC.(i+1)  $\leftarrow$  [m].i; (i=0 $\sim$ 6)

 $ACC.0 \leftarrow C$ 

 $C \leftarrow [m].7$ 

Affected flag(s) C

**RR [m]** Rotate Data Memory right

Description The contents of the specified Data Memory are rotated right by 1 bit with bit 0 rotated into bit 7.

Operation [m].i  $\leftarrow$  [m].(i+1); (i=0 $\sim$ 6)

 $[m].7 \leftarrow [m].0$ 

Affected flag(s) None

**RRA** [m] Rotate Data Memory right with result in ACC

Description Data in the specified Data Memory is rotated right by 1 bit with bit 0

rotated into bit 7. The rotated result is stored in the Accumulator and the contents of the

Data Memory remain unchanged.

Operation ACC.i  $\leftarrow$  [m].(i+1); (i=0 $\sim$ 6)

 $ACC.7 \leftarrow [m].0$ 

Affected flag(s) None

**RRC [m]** Rotate Data Memory right through Carry

Description The contents of the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0

replaces the Carry bit and the original carry flag is rotated into bit 7.

Operation [m].i  $\leftarrow$  [m].(i+1); (i=0 $\sim$ 6)

 $[m].7 \leftarrow C$ 

 $C \leftarrow [m].0$ 

Affected flag(s) C



RRCA [m] Rotate Data Memory right through Carry with result in ACC

Description Data in the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0 replaces

the Carry bit and the original carry flag is rotated into bit 7. The rotated result is stored in the

Accumulator and the contents of the Data Memory remain unchanged.

Operation ACC.i  $\leftarrow$  [m].(i+1); (i=0 $\sim$ 6)

 $ACC.7 \leftarrow C$  $C \leftarrow [m].0$ 

Affected flag(s) C

SBC A,[m] Subtract Data Memory from ACC with Carry

Description The contents of the specified Data Memory and the complement of the carry flag are

subtracted from the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is

positive or zero, the C flag will be set to 1.

Operation  $ACC \leftarrow ACC - [m] - \overline{C}$ Affected flag(s) OV, Z, AC, C, SC, CZ

**SBC A, x** Subtract immediate data from ACC with Carry

Description The immediate data and the complement of the carry flag are subtracted from the

Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag

will be set to 1.

Operation  $ACC \leftarrow ACC - [m] - \overline{C}$ Affected flag(s) OV, Z, AC, C, SC, CZ

SBCM A,[m] Subtract Data Memory from ACC with Carry and result in Data Memory

Description The contents of the specified Data Memory and the complement of the carry flag are

subtracted from the Accumulator. The result is stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is

positive or zero, the C flag will be set to 1.

Operation  $[m] \leftarrow ACC - [m] - C$ Affected flag(s) OV, Z, AC, C, SC, CZ

**SDZ [m]** Skip if decrement Data Memory is 0

Description The contents of the specified Data Memory are first decremented by 1. If the result is 0 the

following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program

proceeds with the following instruction.

Operation  $[m] \leftarrow [m] - 1$ 

Skip if [m]=0

Affected flag(s) None

**SDZA [m]** Skip if decrement Data Memory is zero with result in ACC

Description The contents of the specified Data Memory are first decremented by 1. If the result is 0, the

following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy

instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0,

the program proceeds with the following instruction.

Operation  $ACC \leftarrow [m] - 1$ 

Skip if ACC=0

Affected flag(s) None

Rev. 1.00 224 August 27, 2021



SET [m] Set Data Memory

Description Each bit of the specified Data Memory is set to 1.

Operation  $[m] \leftarrow FFH$ Affected flag(s) None

SET [m].i Set bit of Data Memory

Description Bit i of the specified Data Memory is set to 1.

 $\begin{array}{ll} \text{Operation} & \quad [m].i \leftarrow 1 \\ \text{Affected flag(s)} & \quad \text{None} \end{array}$ 

**SIZ [m]** Skip if increment Data Memory is 0

Description The contents of the specified Data Memory are first incremented by 1. If the result is 0, the

following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program

proceeds with the following instruction.

Operation  $[m] \leftarrow [m] + 1$ 

Skip if [m]=0

Affected flag(s) None

**SIZA [m]** Skip if increment Data Memory is zero with result in ACC

Description The contents of the specified Data Memory are first incremented by 1. If the result is 0, the

following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not

0 the program proceeds with the following instruction.

Operation  $ACC \leftarrow [m] + 1$ 

Skip if ACC=0

Affected flag(s) None

**SNZ [m].i** Skip if Data Memory is not 0

Description If the specified Data Memory is not 0, the following instruction is skipped. As this requires the

insertion of a dummy instruction while the next instruction is fetched, it is a two cycle

instruction. If the result is 0 the program proceeds with the following instruction.

 $Operation \qquad \qquad Skip \ if \ [m].i \neq 0$ 

Affected flag(s) None

**SNZ [m]** Skip if Data Memory is not 0

Description The contents of the specified Data Memory are read out and then written back to the specified

Data Memory again. If the specified Data Memory is not 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is 0 the program proceeds with the following

instruction.

Operation Skip if  $[m] \neq 0$ 

Affected flag(s) None

**SUB A,[m]** Subtract Data Memory from ACC

Description The specified Data Memory is subtracted from the contents of the Accumulator. The result is

stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be

cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

Operation  $ACC \leftarrow ACC - [m]$ Affected flag(s) OV, Z, AC, C, SC, CZ



**SUBM A,[m]** Subtract Data Memory from ACC with result in Data Memory

Description The specified Data Memory is subtracted from the contents of the Accumulator. The result is

stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be

cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

 $\begin{aligned} & \text{Operation} & & [m] \leftarrow ACC - [m] \\ & \text{Affected flag(s)} & & \text{OV, Z, AC, C, SC, CZ} \end{aligned}$ 

**SUB A,x** Subtract immediate data from ACC

Description The immediate data specified by the code is subtracted from the contents of the Accumulator.

The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

Operation  $ACC \leftarrow ACC - x$ Affected flag(s) OV, Z, AC, C, SC, CZ

**SWAP [m]** Swap nibbles of Data Memory

Description The low-order and high-order nibbles of the specified Data Memory are interchanged.

Operation [m].3 $\sim$ [m].0  $\leftrightarrow$  [m].7 $\sim$ [m].4

Affected flag(s) None

**SWAPA [m]** Swap nibbles of Data Memory with result in ACC

Description The low-order and high-order nibbles of the specified Data Memory are interchanged. The

result is stored in the Accumulator. The contents of the Data Memory remain unchanged.

Operation  $ACC.3 \sim ACC.0 \leftarrow [m].7 \sim [m].4$ 

 $ACC.7 \sim ACC.4 \leftarrow [m].3 \sim [m].0$ 

Affected flag(s) None

**SZ [m]** Skip if Data Memory is 0

Description The contents of the specified Data Memory are read out and then written back to the specified

Data Memory again. If the contents of the specified Data Memory is 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program proceeds

with the following instruction.

Operation Skip if [m]=0

Affected flag(s) None

**SZA [m]** Skip if Data Memory is 0 with data movement to ACC

Description The contents of the specified Data Memory are copied to the Accumulator. If the value is zero,

the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the

program proceeds with the following instruction.

Operation  $ACC \leftarrow [m]$ 

Skip if [m]=0

Affected flag(s) None

**SZ [m].i** Skip if bit i of Data Memory is 0

Description If bit i of the specified Data Memory is 0, the following instruction is skipped. As this requires

the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0, the program proceeds with the following instruction.

Operation Skip if [m].i=0

Affected flag(s) None

Rev. 1.00 226 August 27, 2021



**TABRD [m]** Read table (specific page) to TBLH and Data Memory

Description The low byte of the program code (specific page) addressed by the table pointer (TBLP and

TBHP) is moved to the specified Data Memory and the high byte moved to TBLH.

Operation  $[m] \leftarrow program code (low byte)$ 

TBLH ← program code (high byte)

Affected flag(s) None

**TABRDL [m]** Read table (last page) to TBLH and Data Memory

Description The low byte of the program code (last page) addressed by the table pointer (TBLP) is moved

to the specified Data Memory and the high byte moved to TBLH.

Operation  $[m] \leftarrow \text{program code (low byte)}$ 

TBLH ← program code (high byte)

Affected flag(s) None

**ITABRD [m]** Increment table pointer low byte first and read table (specific page) to TBLH and Data

Memory

Description Increment table pointer low byte, TBLP, first and then the program code (specific page)

addressed by the table pointer (TBHP and TBLP) is moved to the specified Data Memory and

the high byte moved to TBLH.

Operation  $[m] \leftarrow program code (low byte)$ 

TBLH ← program code (high byte)

Affected flag(s) None

**ITABRDL [m]** Increment table pointer low byte first and read table (last page) to TBLH and Data Memory

Description Increment table pointer low byte, TBLP, first and then the low byte of the program code

(last page) addressed by the table pointer (TBLP) is moved to the specified Data Memory and

the high byte moved to TBLH.

Operation  $[m] \leftarrow program code (low byte)$ 

TBLH ← program code (high byte)

Affected flag(s) None

XOR A,[m] Logical XOR Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise logical XOR

operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC "XOR" [m]$ 

Affected flag(s) Z

**XORM A,[m]** Logical XOR ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical XOR

operation. The result is stored in the Data Memory.

Operation  $[m] \leftarrow ACC "XOR" [m]$ 

Affected flag(s) Z

**XOR A,x** Logical XOR immediate data to ACC

Description Data in the Accumulator and the specified immediate data perform a bitwise logical XOR

operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC "XOR" x$ 

Affected flag(s) Z

Rev. 1.00 227 August 27, 2021



#### **Extended Instruction Definition**

The extended instructions are used to directly access the data stored in any data memory sections.

**LADC A,[m]** Add Data Memory to ACC with Carry

Description The contents of the specified Data Memory, Accumulator and the carry flag are added.

The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC + [m] + C$ Affected flag(s) OV, Z, AC, C, SC

**LADCM A,[m]** Add ACC to Data Memory with Carry

Description The contents of the specified Data Memory, Accumulator and the carry flag are added.

The result is stored in the specified Data Memory.

 $\begin{aligned} & \text{Operation} & & & [m] \leftarrow ACC + [m] + C \\ & \text{Affected flag(s)} & & \text{OV, Z, AC, C, SC} \end{aligned}$ 

LADD A,[m] Add Data Memory to ACC

Description The contents of the specified Data Memory and the Accumulator are added.

The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC + [m]$ Affected flag(s) OV, Z, AC, C, SC

**LADDM A,[m]** Add ACC to Data Memory

Description The contents of the specified Data Memory and the Accumulator are added.

The result is stored in the specified Data Memory.

Operation  $[m] \leftarrow ACC + [m]$ Affected flag(s) OV, Z, AC, C, SC

LAND A,[m] Logical AND Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise logical AND

operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC "AND" [m]$ 

Affected flag(s) Z

**LANDM A,[m]** Logical AND ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical AND

operation. The result is stored in the Data Memory.

Operation  $[m] \leftarrow ACC "AND" [m]$ 

Affected flag(s) Z

LCLR [m] Clear Data Memory

Description Each bit of the specified Data Memory is cleared to 0.

Operation  $[m] \leftarrow 00H$ Affected flag(s) None

LCLR [m].i Clear bit of Data Memory

Description Bit i of the specified Data Memory is cleared to 0.

Operation [m].i  $\leftarrow 0$ Affected flag(s) None

Rev. 1.00 228 August 27, 2021



LCPL [m] Complement Data Memory

Description Each bit of the specified Data Memory is logically complemented (1's complement). Bits which

previously contained a 1 are changed to 0 and vice versa.

Operation  $[m] \leftarrow [m]$ 

Affected flag(s) Z

**LCPLA [m]** Complement Data Memory with result in ACC

Description Each bit of the specified Data Memory is logically complemented (1's complement). Bits which

previously contained a 1 are changed to 0 and vice versa. The complemented result is stored in

the Accumulator and the contents of the Data Memory remain unchanged.

Operation  $ACC \leftarrow [m]$ 

Affected flag(s) Z

**LDAA [m]** Decimal-Adjust ACC for addition with result in Data Memory

Description Convert the contents of the Accumulator value to a BCD (Binary Coded Decimal) value

resulting from the previous addition of two BCD variables. If the low nibble is greater than 9 or if AC flag is set, then a value of 6 will be added to the low nibble. Otherwise the low nibble remains unchanged. If the high nibble is greater than 9 or if the C flag is set, then a value of 6 will be added to the high nibble. Essentially, the decimal conversion is performed by adding 00H, 06H, 60H or 66H depending on the Accumulator and flag conditions. Only the C flag may be affected by this instruction which indicates that if the original BCD sum is greater than

100, it allows multiple precision decimal addition.

Operation  $[m] \leftarrow ACC + 00H$  or

 $[m] \leftarrow ACC + 06H \text{ or}$   $[m] \leftarrow ACC + 60H \text{ or}$  $[m] \leftarrow ACC + 66H$ 

Affected flag(s) C

**LDEC [m]** Decrement Data Memory

Description Data in the specified Data Memory is decremented by 1.

Operation  $[m] \leftarrow [m] - 1$ 

Affected flag(s) Z

**LDECA [m]** Decrement Data Memory with result in ACC

Description Data in the specified Data Memory is decremented by 1. The result is stored in the

Accumulator. The contents of the Data Memory remain unchanged.

Operation  $ACC \leftarrow [m] - 1$ 

Affected flag(s) Z

**LINC** [m] Increment Data Memory

Description Data in the specified Data Memory is incremented by 1.

Operation  $[m] \leftarrow [m] + 1$ 

Affected flag(s) Z

**LINCA [m]** Increment Data Memory with result in ACC

Description Data in the specified Data Memory is incremented by 1. The result is stored in the Accumulator.

The contents of the Data Memory remain unchanged.

Operation  $ACC \leftarrow [m] + 1$ 

Affected flag(s) Z



**LMOV A,[m]** Move Data Memory to ACC

Description The contents of the specified Data Memory are copied to the Accumulator.

Operation  $ACC \leftarrow [m]$ Affected flag(s) None

**LMOV [m],A** Move ACC to Data Memory

Description The contents of the Accumulator are copied to the specified Data Memory.

 $\begin{array}{ll} \text{Operation} & & [m] \leftarrow ACC \\ \text{Affected flag(s)} & & \text{None} \end{array}$ 

LOR A,[m] Logical OR Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise

logical OR operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC "OR" [m]$ 

Affected flag(s) Z

**LORM A,[m]** Logical OR ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical OR

operation. The result is stored in the Data Memory.

Operation  $[m] \leftarrow ACC "OR" [m]$ 

Affected flag(s) Z

LRL [m] Rotate Data Memory left

Description The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0.

Operation  $[m].(i+1) \leftarrow [m].i; (i=0\sim6)$ 

 $[m].0 \leftarrow [m].7$ 

Affected flag(s) None

**LRLA [m]** Rotate Data Memory left with result in ACC

Description The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0.

The rotated result is stored in the Accumulator and the contents of the Data Memory remain

unchanged.

Operation ACC.(i+1)  $\leftarrow$  [m].i; (i=0 $\sim$ 6)

 $ACC.0 \leftarrow [m].7$ 

Affected flag(s) None

LRLC [m] Rotate Data Memory left through Carry

Description The contents of the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7

replaces the Carry bit and the original carry flag is rotated into bit 0.

Operation  $[m].(i+1) \leftarrow [m].i; (i=0\sim6)$ 

 $[m].0 \leftarrow C$ 

 $C \leftarrow [m].7$ 

Affected flag(s) C

**LRLCA [m]** Rotate Data Memory left through Carry with result in ACC

Description Data in the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7 replaces the

Carry bit and the original carry flag is rotated into the bit 0. The rotated result is stored in the

Accumulator and the contents of the Data Memory remain unchanged.

Operation ACC.(i+1)  $\leftarrow$  [m].i; (i=0 $\sim$ 6)

 $ACC.0 \leftarrow C$ 

 $C \leftarrow [m].7$ 

Affected flag(s) C



LRR [m] Rotate Data Memory right

Description The contents of the specified Data Memory are rotated right by 1 bit with bit 0 rotated into bit 7.

Operation [m].i  $\leftarrow$  [m].(i+1); (i=0 $\sim$ 6)

 $[m].7 \leftarrow [m].0$ 

Affected flag(s) None

**LRRA [m]** Rotate Data Memory right with result in ACC

Description Data in the specified Data Memory is rotated right by 1 bit with bit 0

rotated into bit 7. The rotated result is stored in the Accumulator and the contents of the

Data Memory remain unchanged.

Operation ACC.i  $\leftarrow$  [m].(i+1); (i=0 $\sim$ 6)

 $ACC.7 \leftarrow [m].0$ 

Affected flag(s) None

LRRC [m] Rotate Data Memory right through Carry

Description The contents of the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0

replaces the Carry bit and the original carry flag is rotated into bit 7.

Operation  $[m].i \leftarrow [m].(i+1); (i=0\sim6)$ 

 $[m].7 \leftarrow C$   $C \leftarrow [m].0$ 

G

**LRRCA [m]** Rotate Data Memory right through Carry with result in ACC

Description Data in the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0 replaces

the Carry bit and the original carry flag is rotated into bit 7. The rotated result is stored in the

Accumulator and the contents of the Data Memory remain unchanged.

Operation ACC.i  $\leftarrow$  [m].(i+1); (i=0 $\sim$ 6)

 $ACC.7 \leftarrow C$ 

 $C \leftarrow [m].0$ 

Affected flag(s) C

Affected flag(s)

**LSBC A,[m]** Subtract Data Memory from ACC with Carry

Description The contents of the specified Data Memory and the complement of the carry flag are

subtracted from the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is

positive or zero, the C flag will be set to 1.

Operation  $ACC \leftarrow ACC - [m] - \overline{C}$ Affected flag(s) OV, Z, AC, C, SC, CZ

**LSBCM A,[m]** Subtract Data Memory from ACC with Carry and result in Data Memory

Description The contents of the specified Data Memory and the complement of the carry flag are

subtracted from the Accumulator. The result is stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is

positive or zero, the C flag will be set to 1.

Operation  $[m] \leftarrow ACC - [m] - \overline{C}$ Affected flag(s) OV, Z, AC, C, SC, CZ



**LSDZ [m]** Skip if decrement Data Memory is 0

Description The contents of the specified Data Memory are first decremented by 1. If the result is 0 the

following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the program

proceeds with the following instruction.

Operation  $[m] \leftarrow [m] - 1$ 

Skip if [m]=0

Affected flag(s) None

**LSDZA [m]** Skip if decrement Data Memory is zero with result in ACC

Description The contents of the specified Data Memory are first decremented by 1. If the result is 0, the

following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is

not 0, the program proceeds with the following instruction.

Operation  $ACC \leftarrow [m] - 1$ 

Skip if ACC=0

Affected flag(s) None

LSET [m] Set Data Memory

Description Each bit of the specified Data Memory is set to 1.

Operation  $[m] \leftarrow FFH$ Affected flag(s) None

LSET [m].i Set bit of Data Memory

Description Bit i of the specified Data Memory is set to 1.

Operation [m].i  $\leftarrow$  1 Affected flag(s) None

**LSIZ** [m] Skip if increment Data Memory is 0

Description The contents of the specified Data Memory are first incremented by 1. If the result is 0, the

following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the program

proceeds with the following instruction.

Operation  $[m] \leftarrow [m] + 1$ 

Skip if [m]=0

Affected flag(s) None

**LSIZA [m]** Skip if increment Data Memory is zero with result in ACC

Description The contents of the specified Data Memory are first incremented by 1. If the result is 0, the

following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is

not 0 the program proceeds with the following instruction.

Operation  $ACC \leftarrow [m] + 1$ 

Skip if ACC=0

Affected flag(s) None

**LSNZ [m].i** Skip if Data Memory is not 0

Description If the specified Data Memory is not 0, the following instruction is skipped. As this requires the

insertion of a dummy instruction while the next instruction is fetched, it is a three cycle

instruction. If the result is 0 the program proceeds with the following instruction.

Operation Skip if [m]. $i \neq 0$ 

Affected flag(s) None

Rev. 1.00 232 August 27, 2021



LSNZ [m] Skip if Data Memory is not 0

Description The contents of the specified Data Memory are read out and then written to the specified Data

Memory again. If the content of the specified Data Memory is not 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is 0 the program proceeds with the following

instruction.

Operation Skip if  $[m] \neq 0$ 

Affected flag(s) None

LSUB A,[m] Subtract Data Memory from ACC

Description The specified Data Memory is subtracted from the contents of the Accumulator. The result is

stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be

cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

Operation  $ACC \leftarrow ACC - [m]$ Affected flag(s) OV, Z, AC, C, SC, CZ

LSUBM A,[m] Subtract Data Memory from ACC with result in Data Memory

Description The specified Data Memory is subtracted from the contents of the Accumulator. The result is

stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be

cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

Operation  $[m] \leftarrow ACC - [m]$ Affected flag(s) OV, Z, AC, C, SC, CZ

LSWAP [m] Swap nibbles of Data Memory

Description The low-order and high-order nibbles of the specified Data Memory are interchanged.

Operation  $[m].3\sim[m].0 \leftrightarrow [m].7\sim[m].4$ 

Affected flag(s) None

LSWAPA [m] Swap nibbles of Data Memory with result in ACC

Description The low-order and high-order nibbles of the specified Data Memory are interchanged. The

result is stored in the Accumulator. The contents of the Data Memory remain unchanged.

Operation  $ACC.3 \sim ACC.0 \leftarrow [m].7 \sim [m].4$ 

 $ACC.7 \sim ACC.4 \leftarrow [m].3 \sim [m].0$ 

Affected flag(s) None

LSZ [m] Skip if Data Memory is 0

Description The contents of the specified Data Memory are read out and then written to the specified Data

> Memory again. If the contents of the specified Data Memory is 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the program proceeds with the

following instruction.

Operation Skip if [m]=0

Affected flag(s) None

LSZA [m] Skip if Data Memory is 0 with data movement to ACC

Description The contents of the specified Data Memory are copied to the Accumulator. If the value is zero,

> the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the

program proceeds with the following instruction.

Operation  $ACC \leftarrow [m]$ 

Skip if [m]=0

Affected flag(s) None



**LSZ [m].i** Skip if bit i of Data Memory is 0

Description If bit i of the specified Data Memory is 0, the following instruction is skipped. As this requires

the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0, the program proceeds with the following instruction.

Operation Skip if [m].i=0

Affected flag(s) None

**LTABRD [m]** Read table (specific page) to TBLH and Data Memory

Description The low byte of the program code (specific page) addressed by the table pointer (TBHP and

TBLP) is moved to the specified Data Memory and the high byte moved to TBLH.

Operation  $[m] \leftarrow program code (low byte)$ 

TBLH ← program code (high byte)

Affected flag(s) None

**LTABRDL [m]** Read table (last page) to TBLH and Data Memory

Description The low byte of the program code (last page) addressed by the table pointer (TBLP) is moved

to the specified Data Memory and the high byte moved to TBLH.

Operation  $[m] \leftarrow program code (low byte)$ 

TBLH ← program code (high byte)

Affected flag(s) None

**LITABRD [m]** Increment table pointer low byte first and read table (specific page) to TBLH and Data

Memory

Description Increment table pointer low byte, TBLP, first and then the program code (specific page)

addressed by the table pointer (TBHP and TBLP) is moved to the specified Data Memory and

the high byte moved to TBLH.

Operation  $[m] \leftarrow program code (low byte)$ 

TBLH ← program code (high byte)

Affected flag(s) None

**LITABRDL [m]** Increment table pointer low byte first and read table (last page) to TBLH and Data Memory

Description Increment table pointer low byte, TBLP, first and then the low byte of the program code

(last page) addressed by the table pointer (TBLP) is moved to the specified Data Memory and

the high byte moved to TBLH.

Operation  $[m] \leftarrow \text{program code (low byte)}$ 

TBLH ← program code (high byte)

Affected flag(s) None

**LXOR A.[m]** Logical XOR Data Memory to ACC

Description Data in the Accumulator and the specified Data Memory perform a bitwise logical XOR

operation. The result is stored in the Accumulator.

Operation  $ACC \leftarrow ACC "XOR" [m]$ 

Affected flag(s) Z

**LXORM A,[m]** Logical XOR ACC to Data Memory

Description Data in the specified Data Memory and the Accumulator perform a bitwise logical XOR

operation. The result is stored in the Data Memory.

Operation  $[m] \leftarrow ACC "XOR" [m]$ 

Affected flag(s) Z

Rev. 1.00 234 August 27, 2021



### **Package Information**

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the <u>Holtek website</u> for the latest version of the <u>Package/Carton Information</u>.

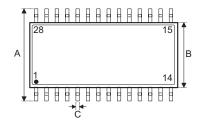
Additional supplementary information with regard to packaging is listed below. Click on the relevant section to be transferred to the relevant website page.

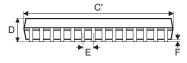
- Package Information (include Outline Dimensions, Product Tape and Reel Specifications)
- The Operation Instruction of Packing Materials
- · Carton information

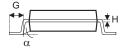
Rev. 1.00 235 August 27, 2021



# 28-pin SOP (300mil) Outline Dimensions







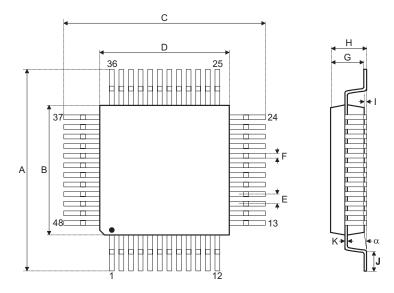
Symbol	Dimensions in inch			
Symbol	Min.	Nom.	Max.	
A	_	0.406 BSC	_	
В	_	0.295 BSC	_	
С	0.012	_	0.020	
C'	_	0.705 BSC	_	
D	_	_	0.104	
E	_	0.050 BSC	_	
F	0.004	_	0.012	
G	0.016	_	0.050	
Н	0.008	_	0.013	
α	0°	_	8°	

Symbol	Dimensions in mm			
Symbol	Min.	Nom.	Max.	
A	_	10.300 BSC	_	
В	_	7.500 BSC	_	
С	0.31	_	0.51	
C'	_	17.900 BSC	_	
D	_	_	2.65	
E	_	1.270 BSC	_	
F	0.10	_	0.30	
G	0.40	_	1.27	
Н	0.20	_	0.33	
α	0°	_	8°	

Rev. 1.00 236 August 27, 2021



# 48-pin LQFP (7mm×7mm) Outline Dimensions



Cumbal	Dimensions in inch			
Symbol	Min.	Nom.	Max.	
А	_	0.354 BSC	_	
В	_	0.276 BSC	_	
С	_	0.354 BSC	_	
D	_	0.276 BSC	_	
E	_	0.020 BSC	_	
F	0.007	0.009	0.011	
G	0.053	0.055	0.057	
Н	_	_	0.063	
1	0.002	_	0.006	
J	0.018	0.024	0.030	
K	0.004	_	0.008	
α	0°	_	7°	

Complete	Dimensions in mm			
Symbol	Min.	Nom.	Max.	
A	_	9.00 BSC	_	
В	_	7.00 BSC	_	
С	_	9.00 BSC	_	
D	_	7.00 BSC	_	
E	_	0.50 BSC	_	
F	0.17	0.22	0.27	
G	1.35	1.40	1.45	
Н	_	_	1.60	
I	0.05	_	0.15	
J	0.45	0.60	0.75	
K	0.09	_	0.20	
α	0°	_	7°	

Rev. 1.00 237 August 27, 2021



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Rev. 1.00 238 August 27, 2021